**Preliminary Information** 

# AMD-K6<sup>®</sup>-2 Processor Data Sheet



© 1999 Advanced Micro Devices, Inc. All rights reserved.

The contents of this document are provided in connection with Advanced Micro Devices, Inc. ("AMD") products. AMD makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this publication. Except as set forth in AMD's Standard Terms and Conditions of Sale, AMD assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

AMD's products are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of AMD's product could create a situation where personal injury, death, or severe property or environmental damage may occur. AMD reserves the right to discontinue or make changes to its products at any time without notice.

#### Trademarks

AMD, the AMD logo, K6, 3DNow!, and combinations thereof, K86, and Super7 are trademarks, and AMD-K6 and RISC86 are registered trademarks of Advanced Micro Devices, Inc.

Microsoft, Windows, and Windows NT are registered trademarks of Microsoft Corporation.

NetWare is a registered trademark of Novell, Inc.

MMX is a trademark of Intel Corporation.

The TAP State Diagram is reprinted from IEEE Std 1149.1-1990 "IEEE Standard Test Access Port and Boundary-Scan Architecture," Copyright © 1990 by the Institute of Electrical and Electronics Engineers, Inc. The IEEE disclaims any responsibility or liability resulting from the placement and use in the described manner. Information is reprinted with the permission of the IEEE.

Other product names used in this publication are for identification purposes only and may be trademarks of their respective companies.

# Contents

Revision Historyxix		
1	AMI	D-K6 <sup>®</sup> -2 Processor
	1.1	Super7 <sup>™</sup> Platform Initiative
2	Inte	rnal Architecture5
	2.1 2.2	Introduction
	2.3	Cache, Instruction Prefetch, and Predecode Bits9Cache9Prefetching10Predecode Bits10
	2.4	Instruction Fetch and Decode11Instruction Fetch11Instruction Decode12
	2.5	Centralized Scheduler14
	2.6	Execution Units15Register X and Y Pipelines16
	2.7	Branch-Prediction Logic17Branch History Table18Branch Target Cache18Return Address Stack18Branch Execution Unit19
3	Soft	ware Environment
	3.1	Registers21General-Purpose Registers22Integer Data Types23Segment Registers24Segment Usage24Instruction Pointer25Floating-Point Registers25Floating-Point Register Data Types28MMX™/3DNow!™ Registers29MMX™ Data Types293DNow!™ Data Types30EFLAGS Register31Control Registers32Debug Registers34Madel Spacific Degisters37
		Model-Specific Registers (MSR)

4

	Momowy Management Pagistans	40
	Memory Management RegistersTask State Segment	
	Paging	
	Descriptors and Gates.	
	Exceptions and Interrupts	
3.2	AMD-K6 <sup>®</sup> -2 Processor Model 8/[F:8] Registers	
5.2	Extended Feature Enable Register (EFER) –	50
	Model 8/[F:8]	50
	Write Handling Control Register (WHCR) –	50
	Model 8/[F:8]	51
	UC/WC Cacheability Control Register(UWCCR)	
	Processor State Observability Register (PSOR)	
	Page Flush/Invalidate Register (PFIR)	
3.3	Instructions Supported by the AMD-K6 <sup>®</sup> -2 Processor .	54
Sign	al Descriptions	85
4.1	Signal Terminology	85
4.2	A20M# (Address Bit 20 Mask)	
4.3	A[31:3] (Address Bus)	
4.4	ADS# (Address Strobe)	
4.5	ADSC# (Address Strobe Copy)	
4.6	AHOLD (Address Hold)	
4.7	AP (Address Parity)	91
4.8	APCHK# (Address Parity Check)	
4.9	BE[7:0]# (Byte Enables)	
4.10	BF[2:0] (Bus Frequency)	94
4.11	BOFF# (Backoff)	95
4.12	BRDY# (Burst Ready)	96
4.13	BRDYC# (Burst Ready Copy)	
4.14	BREQ (Bus Request)	
4.15	CACHE# (Cacheable Access)	
4.16	CLK (Clock)	
4.17	D/C# (Data/Code)	
4.18	D[63:0] (Data Bus)	
4.19	DP[7:0] (Data Parity)	
4.20	EADS# (External Address Strobe)	
4.21	EWBE# (External Write Buffer Empty)	
4.22	FERR# (Floating-Point Error)	
4.23	FLUSH# (Cache Flush)	
4.24	HIT# (Inquire Cycle Hit)	
4.25	HITM# (Inquire Cycle Hit To Modified Line)	
4.26	HLDA (Hold Acknowledge)	10/
4.27	HOLD (Bus Hold Request)	
4.28	IGNNE# (Ignore Numeric Exception)	
4.29	INIT (Initialization)	
4.30	INTR (Maskable Interrupt)	
4.31	INV (Invalidation Request)	110

4.32	KEN# (Cache Enable)	. 111
4.33	LOCK# (Bus Lock)	
4.34	M/IO# (Memory or I/O)	
4.35	NA# (Next Address)	
4.36	NMI (Non-Maskable Interrupt)	
4.37	PCD (Page Cache Disable)	
4.37	PCHK# (Parity Check)	116
4.39	PWT (Page Writethrough)	
4.39 4.40		
	RESET (Reset)	
4.41	RSVD (Reserved)	
4.42	SCYC (Split Cycle)	
4.43	SMI# (System Management Interrupt)	
4.44	SMIACT# (System Management Interrupt Active)	
4.45	STPCLK# (Stop Clock)	
4.46	TCK (Test Clock)	
4.47	TDI (Test Data Input)	
4.48	TDO (Test Data Output)	. 122
4.49	TMS (Test Mode Select)	. 122
4.50	TRST# (Test Reset)	. 123
4.51	VCC2DET (VCC2 Detect)	. 123
4.52	VCC2H/L# (VCC2 High/Low)	. 123
4.53	W/R# (Write/Read)	. 124
4.54	WB/WT# (Writeback or Writethrough)	
	_	
Bus C	ycles	. 129
5.1	Timing Diagrams	. 129
	Timing DiagramsBus State Machine Diagram	. 129
5.1	Timing DiagramsBus State Machine DiagramIdle	. 129 . 131 . 132
5.1	Timing DiagramsBus State Machine DiagramIdleAddress	. 129 . 131 . 132 . 132
5.1	Timing DiagramsBus State Machine DiagramIdleAddressData	. 129 . 131 . 132 . 132 . 132 . 132
5.1	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# Requested	. 129 . 131 . 132 . 132 . 132 . 132 . 132
5.1	Timing DiagramsBus State Machine DiagramIdleAddressData.Data-NA# RequestedPipeline Address	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132
5.1	Timing Diagrams Bus State Machine Diagram Idle Address Data Data-NA# Requested Pipeline Address Pipeline Data	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 132 . 133
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransition	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133
5.1	Timing DiagramsBus State Machine DiagramIdleIdleAddressData.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and Writes	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressData.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and Write	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 133 . 134 . 134
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Read and Write	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134 . 134 . 136
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst Reads	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134 . 134 . 136 . 138
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressData.Data.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst ReadsBurst Writeback	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 133 . 134 . 134 . 136 . 138 . 140
5.1 5.2	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory ReadsBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and Write	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142
5.1 5.2 5.3	Timing DiagramsBus State Machine DiagramIdleAddressData.Data.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst ReadsBurst Writeback	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142
5.1 5.2 5.3	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory ReadsBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and Write	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142 . 142
5.1 5.2 5.3	Timing DiagramsBus State Machine DiagramIdleAddressDataData-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory ReadsBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and WriteMisaligned I/O Read and Write	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142 . 142 . 143
<ul><li>5.1</li><li>5.2</li><li>5.3</li><li>5.4</li></ul>	Timing Diagrams Bus State Machine Diagram Idle Address. Data. Data. Data-NA# Requested. Pipeline Address Pipeline Data Transition Memory Reads and Writes Single-Transfer Memory Read and Write Misaligned Single-Transfer Memory Read and Write Burst Reads and Pipelined Burst Reads Burst Writeback. I/O Read and Write Basic I/O Read and Write Misaligned I/O Read and Write Inquire and Bus Arbitration Cycles	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142 . 143 . 144
<ul><li>5.1</li><li>5.2</li><li>5.3</li><li>5.4</li></ul>	Timing DiagramsBus State Machine DiagramIdleAddressData.Data.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and WriteMisaligned I/O Read and WriteMisaligned I/O Read and WriteInquire and Bus Arbitration CyclesHold and Hold Acknowledge Cycle	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 134 . 134 . 134 . 134 . 136 . 138 . 140 . 142 . 142 . 143 . 144
<ul><li>5.1</li><li>5.2</li><li>5.3</li><li>5.4</li></ul>	Timing DiagramsBus State Machine DiagramIdleAddressData.Data.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and WriteBasic I/O Read and WriteMisaligned I/O Read and WriteInquire and Bus Arbitration CyclesHold and Hold Acknowledge CycleHOLD-Initiated Inquire Hit to Shared or Exclusive Line	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 133 . 134 . 134 . 136 . 138 . 140 . 142 . 142 . 143 . 144 . 144
<ul><li>5.1</li><li>5.2</li><li>5.3</li><li>5.4</li></ul>	Timing DiagramsBus State Machine DiagramIdleAddressData.Data.Data-NA# RequestedPipeline AddressPipeline DataTransitionMemory Reads and WritesSingle-Transfer Memory Read and WriteMisaligned Single-Transfer Memory Reads and WriteBurst Reads and Pipelined Burst ReadsBurst WritebackI/O Read and WriteMisaligned I/O Read and WriteMisaligned I/O Read and WriteInquire and Bus Arbitration CyclesHold and Hold Acknowledge Cycle	. 129 . 131 . 132 . 132 . 132 . 132 . 132 . 132 . 132 . 133 . 134 . 134 . 134 . 134 . 134 . 134 . 134 . 134 . 142 . 142 . 142 . 144 . 144 . 144 . 144

AMD-K6<sup>®</sup>-2 Processor Data Sheet

6

7

	AHOLD-Initiated Inquire Hit to Shared or Exclusive Line.	
	AHOLD-Initiated Inquire Hit to Modified Line	
	AHOLD Restriction.	
	Bus Backoff (BOFF#)	
	Locked Cycles	
	Basic Locked Operation	
	Locked Operation with BOFF# Intervention	
5.6	Interrupt Acknowledge         Special Bus Cycles	
5.0	Basic Special Bus Cycle	
	Shutdown Cycle	
	Stop Grant and Stop Clock States	
	INIT-Initiated Transition from Protected Mode to	100
	Real Mode	. 172
Powe	er-on Configuration and Initialization	175
6.1	Signals Sampled During the Falling Transition of RESET	175
	FLUSH#	
	BF[2:0]	. 175
	BRDYC#	. 175
6.2	RESET Requirements	
6.3	State of Processor After RESET	
	Output Signals	
	Registers	
6.4	State of Processor After INIT	
Cach	e Organization	181
7.1	MESI States in the Data Cache	
7.2	Predecode Bits	
7.3	Cache Operation	
	Cache-Related Signals	
7.4	Cache Disabling and Flushing	
7.5	Cache-Line Fills	
7.6	Cache-Line Replacements	
7.7	Write Allocate	
	Write to a Cacheable PageWrite to a Sector	
	Write Allocate Limit	
	Write Allocate Logic Mechanisms and Conditions	
7.8	Prefetching	
7.0	Hardware Prefetching	194
	Software Prefetching.	
7.9	Cache States	
7.10	Cache Coherency	
	Inquire Cycles	
	Internal Snooping	
	FLUSH#	

	7.11	PFIRWBINVD and INVDCache-Line ReplacementCache SnoopingWritethrough versus Writeback Coherency States	. 198 . 198 . 200
	7.12	A20M# Masking of Cache Accesses	
8	Write	e Merge Buffer	. 203
	8.1 8.2	EWBE ControlMemory Type Range RegistersUC/WC Cacheability Control Register (UWCCR)	. 205
9	Float	ing-Point and Multimedia Execution Units	. 209
	9.1 9.2 9.3	Floating-Point Execution Unit         Handling Floating-Point Exceptions         External Logic Support of Floating-Point Exceptions         Multimedia and 3DNow!™ Execution Units         Floating-Point and MMX™/3DNow!™ Instruction         Compatibility         Registers         Exceptions         FleRR# and IGNNE#	. 209 . 209 . 211 . 211 . 211 . 211 . 211
10	Syste	m Management Mode (SMM)	. 213
	10.1 10.2 10.3 10.4 10.5 10.6 10.7 10.8 10.9	OverviewSMM Operating Mode and Default Register ValuesSMM State-Save AreaSMM Revision IdentifierSMM Base AddressHalt Restart SlotI/O Trap DwordI/O Trap Restart SlotExceptions, Interrupts, and Debug in SMM	. 213 . 216 . 218 . 219 . 219 . 220 . 221 . 222
11	Test a	and Debug	. 223
	11.1 11.2 11.3 11.4 11.5	Built-In Self-Test (BIST)Tri-State Test ModeBoundary-Scan Test Access Port (TAP)Test Access Port.TAP SignalsTAP RegistersTAP InstructionsTAP Controller State MachineL1 Cache InhibitPurpose.Debug	. 224 . 225 . 225 . 225 . 226 . 233 . 234 . 237 . 237
	11.0	Debug Registers.	

		Debug Exceptions
12	Cloc	k Control
	12.1	Halt State
		Enter Halt State246
		Exit Halt State
	12.2	Stop Grant State
		Enter Stop Grant State
		Exit Stop Grant State
	12.3	Stop Grant Inquire State
		Enter Stop Grant Inquire State
		Exit Stop Grant Inquire State
	12.4	Stop Clock State
		Enter Stop Clock State
		Exit Stop Clock State
13	Powe	er and Grounding 251
15		C C
	13.1	Power Connections
	13.2	Decoupling Recommendations
	13.3	Pin Connection Requirements253
14	Elect	trical Data 255
	14.1	Electrical Data for OPN Suffixes AHX, 400AFQ,
		and AFR
		Operating Ranges
		Absolute Ratings
		DC Characteristics
		Power Dissipation
	14.2	Electrical Data for OPN Suffixes AGR, AFX,
		and 400AFR
		Operating Ranges
		Absolute Ratings
		DC Characteristics
		Power Dissipation
		-
15	I/O B	Suffer Characteristics    265
	15.1	Selectable Drive Strength
	15.2	I/O Buffer Model
	15.3	I/O Model Application Note
	15.4	I/O Buffer AC and DC Characteristics
16	Signa	al Switching Characteristics
	16.1	CLK Switching Characteristics
	16.2	Clock Switching Characteristics for 100-MHz Bus
		Operation
	16.3	Clock Switching Characteristics for 66-MHz Bus
		Operation

	16.4	Valid Delay, Float, Setup, and Hold Timings
	16.5	Output Delay Timings for 100-MHz Bus Operation272
	16.6	Input Setup and Hold Timings for 100-MHz Bus
		Operation
	16.7	Output Delay Timings for 66-MHz Bus Operation276
	16.8	Input Setup and Hold Timings for 66-MHz Bus
	10.0	Operation
	16.9	RESET and Test Signal Timing    280
17	Ther	mal Design 287
	17.1	Package Thermal Specifications
		Heat Dissipation Path 292
		Measuring Case Temperature
	17.2	Layout and Airflow Considerations
		Voltage Regulator
		Airflow Management in a System Design294
18	Pin I	Description Diagram 297
19	Pin I	Designations
20	Pack	age Specifications
	20.1	321-Pin Staggered CPGA Package Specification
21	Orde	ring Information
	Inde	x

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# List of Figures

Figure 1.	AMD-K6 <sup>®</sup> -2 Processor Block Diagram7
Figure 2.	Cache Sector Organization10
Figure 3.	The Instruction Buffer
Figure 4.	AMD-K6 <sup>®</sup> -2 Processor Decode Logic12
Figure 5.	AMD-K6 <sup>®</sup> -2 Processor Scheduler
Figure 6.	Register X and Y Functional Units17
Figure 7.	EAX Register with 16-Bit and 8-Bit Name Components22
Figure 8.	Integer Data Registers23
Figure 9.	Segment Register
Figure 10.	Segment Usage
Figure 11.	Floating-Point Register
Figure 12.	FPU Status Word Register
Figure 13.	FPU Control Word Register
Figure 14.	FPU Tag Word Register27
Figure 15.	Packed Decimal Data Register
Figure 16.	Precision Real Data Registers
Figure 17.	MMX <sup>TM</sup> /3DNow! <sup>TM</sup> Registers
Figure 18.	MMX <sup>TM</sup> Data Types
Figure 19.	3DNow! <sup>TM</sup> Data Types
Figure 20.	EFLAGS Registers
Figure 21.	Control Register 4 (CR4)
Figure 22.	Control Register 3 (CR3) 32
Figure 23.	Control Register 2 (CR2)
Figure 24.	Control Register 1 (CR1)
Figure 25.	Control Register 0 (CR0)
Figure 26.	Debug Register DR734
Figure 27.	Debug Register DR635
Figure 28.	Debug Registers DR5 and DR435
Figure 29.	Debug Registers DR3, DR2, DR1, and DR036
Figure 30.	Machine-Check Address Register (MCAR)
Figure 31.	Machine-Check Type Register (MCTR)38
Figure 32.	Test Register 12 (TR12)
Figure 33.	Time Stamp Counter (TSC)
Figure 34.	Extended Feature Enable Register (EFER)-Model 8[7:0] 39
Figure 35.	SYSCALL/SYSRET Target Address Register (STAR) 39
Figure 36.	Write Handling Control Register (WHCR)-Model 8/[7:0]40

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Figure 37.	Memory Management Registers
Figure 38.	Task State Segment (TSS)    42
Figure 39.	4-Kbyte Paging Mechanism
Figure 40.	4-Mbyte Paging Mechanism44
Figure 41.	Page Directory Entry 4-Kbyte Page Table (PDE)
Figure 42.	Page Directory Entry 4-Mbyte Page Table (PDE)45
Figure 43.	Page Table Entry (PTE)46
Figure 44.	Application Segment Descriptor
Figure 45.	System Segment Descriptor
Figure 46.	Gate Descriptor
Figure 47.	Extended Feature Enable Register (EFER)—
	Model 8/[F:8]51
Figure 48.	Write Handling Control Register (WHCR)—
	Model 8/[F:8]52
Figure 49.	UC/WC Cacheability Control Register (UWCCR)52
Figure 50.	Processor State Observability Register (PSOR)53
Figure 51.	Page Flush/Invalidate Register (PFIR)53
Figure 52.	Logic Symbol Diagram
Figure 53.	Waveform Definitions
Figure 54.	Bus State Machine Diagram131
Figure 55.	Non-Pipelined Single-Transfer Memory Read/Write and
	Write Delayed by EWBE#
Figure 56.	Misaligned Single-Transfer Memory Read and Write 137
Figure 57.	Burst Reads and Pipelined Burst Reads
Figure 58.	Burst Writeback due to Cache-Line Replacement141
Figure 59.	Basic I/O Read and Write142
Figure 60.	Misaligned I/O Transfer143
Figure 61.	Basic HOLD/HLDA Operation
Figure 62.	
rigule 02.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147
Figure 63.	-
0	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147
Figure 63.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147 HOLD-Initiated Inquire Hit to Modified Line
Figure 63. Figure 64.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147 HOLD-Initiated Inquire Hit to Modified Line
Figure 63. Figure 64. Figure 65.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147 HOLD-Initiated Inquire Hit to Modified Line
Figure 63. Figure 64. Figure 65. Figure 66.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147 HOLD-Initiated Inquire Hit to Modified Line
Figure 63. Figure 64. Figure 65. Figure 66. Figure 67.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147HOLD-Initiated Inquire Hit to Modified Line 149AHOLD-Initiated Inquire Miss
Figure 63. Figure 64. Figure 65. Figure 66. Figure 67. Figure 68.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line 147HOLD-Initiated Inquire Hit to Modified Line
Figure 63. Figure 64. Figure 65. Figure 66. Figure 67. Figure 68. Figure 69.	HOLD-Initiated Inquire Hit to Shared or Exclusive Line147HOLD-Initiated Inquire Hit to Modified Line149AHOLD-Initiated Inquire Miss151AHOLD-Initiated Inquire Hit to Shared or Exclusive Line153AHOLD-Initiated Inquire Hit to Modified Line155AHOLD Restriction157BOFF# Timing159Basic Locked Operation161

Figure 73.	Shutdown Cycle
Figure 74.	Stop Grant and Stop Clock Modes, Part 1
Figure 75.	Stop Grant and Stop Clock Modes, Part 2 171
Figure 76.	INIT-Initiated Transition from Protected Mode to
	Real Mode
Figure 77.	Cache Organization
Figure 78.	Cache Sector Organization
Figure 79.	Write Handling Control Register (WHCR) —
	Model 8/[7:0]
Figure 80.	Write Handling Control Register (WHCR)—
	Model 8/[F:8]190
Figure 81.	Write Allocate Logic Mechanisms and Conditions 192
Figure 82.	Page Flush/Invalidate Register (PFIR)—
	MSR C000_0088h
Figure 83.	UC/WC Cacheability Control Register (UWCCR)—
	MSR C000_0085h (Model 8/[F:8])206
Figure 84.	External Logic for Supporting Floating-Point Exceptions 210
Figure 85.	SMM Memory
Figure 86.	TAP State Diagram    235
Figure 87.	Debug Register DR7239
Figure 88.	Debug Register DR6240
Figure 89.	Debug Registers DR5 and DR4240
Figure 90.	Debug Registers DR3, DR2, DR1, and DR0241
Figure 91.	Clock Control State Transitions
Figure 92.	Suggested Component Placement252
Figure 93.	K6STD Pulldown V/I Curves
Figure 94.	K6STD Pullup V/I Curves
Figure 95.	CLK Waveform
Figure 96.	Diagrams Key
Figure 97.	Output Valid Delay Timing
Figure 98.	Maximum Float Delay Timing
Figure 99.	Input Setup and Hold Timing 284
Figure 100.	Reset and Configuration Timing285
Figure 101.	TCK Waveform
Figure 102.	TRST# Timing
Figure 103.	Test Signal Timing Diagram
Figure 104.	Thermal Model
Figure 105.	Power Consumption versus Thermal Resistance
Figure 106.	Processor Heat Dissipation Path

Figure 107. Measuring Case Temperature
Figure 108. Voltage Regulator Placement
Figure 109. Airflow for a Heatsink with Fan
Figure 110. Airflow Path in a Dual-Fan System
Figure 111. Airflow Path in an ATX Form-Factor System
Figure 112. AMD-K6 <sup>®</sup> -2 Processor Top-Side View
Figure 113. AMD-K6 <sup>®</sup> -2 Processor Pin-Side View
Figure 114. 321-Pin Staggered CPGA Package Specification

# **List of Tables**

Table 1.	Execution Latency and Throughput of Execution Units 16
Table 2.	General-Purpose Registers
Table 3.	General-Purpose Register Doubleword, Word, and
	Byte Names
Table 4.	Segment Registers
Table 5.	AMD-K6 <sup>®</sup> -2 Processor Model 8/[7:0] MSRs
Table 6.	Extended Feature Enable Register (EFER)–
	Model 8[7:0] Definition
Table 7.	SYSCALL/SYSRET Target Address Register (STAR)
	Definition
Table 8.	Memory Management Registers
Table 9.	Application Segment Types47
Table 10.	System Segment and Gate Types
Table 11.	Summary of Exceptions and Interrupts
Table 12.	AMD-K6 <sup>®</sup> -2 Processor Model 8/[F:8] MSRs
Table 13.	Extended Feature Enable Register (EFER) –
	Model 8/[F:8] Definition
Table 14.	Integer Instructions
Table 15.	Floating-Point Instructions74
Table 16.	MMX <sup>TM</sup> Instructions
Table 17.	3DNow! <sup>TM</sup> Instructions
Table 18.	Processor-to-Bus Clock Ratios
Table 19.	Output Pin Float Conditions
Table 20.	Input Pin Types
Table 21.	Output Pin Float Conditions
Table 22.	Input/Output Pin Float Conditions
Table 23.	Test Pins
Table 24.	Bus Cycle Definition128
Table 25.	Special Cycles
Table 26.	Bus-Cycle Order During Misaligned Transfers
Table 27.	A[4:3] Address-Generation Sequence During Bursts 138
Table 28.	Bus-Cycle Order During Misaligned I/O Transfers 143
Table 29.	Interrupt Acknowledge Operation Definition164
Table 30.	Encodings For Special Bus Cycles
Table 31.	Output Signal State After RESET
Table 32.	Register State After RESET    177
Table 33.	PWT Signal Generation
Table 34.	PCD Signal Generation
Table 35.	CACHE# Signal Generation
Table 36.	Data Cache States for Read and Write Accesses

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Table 37.	Cache States for Inquire Cycles, Snoops, Flushes,
	and Invalidation
Table 38.	Snoop Action
Table 39.	EWBEC Settings
Table 40.	WC/UC Memory Type
Table 41.	Valid Masks and Range Sizes
Table 42.	Initial State of Registers in SMM
Table 43.	SMM State-Save Area Map
Table 44.	SMM Revision Identifier
Table 45.	I/O Trap Dword Configuration
Table 46.	I/O Trap Restart Slot
Table 47.	Boundary Scan Bit Definitions for Model 8/[7:0]
Table 48.	Boundary Scan Bit Definitions for Model 8/[F:8]231
Table 49.	Device Identification Register
Table 50.	Supported Tap Instructions
Table 51.	DR7 LEN and RW Definitions
Table 52.	Operating Ranges for OPN Suffixes AHX, 400AFQ,
	and AFR
Table 53.	Absolute Ratings for OPN Suffixes AHX, 400AFQ,
	and AFR
Table 54.	DC Characteristics for OPN Suffixes AHX, 400AFQ,
	and AFR
Table 55.	Typical and Maximum Power Dissipation for OPN
	Suffixes AHX, 400AFQ, and AFR
Table 56.	Operating Ranges for OPN Suffixes AGR, AFX,
	and 400AFR
Table 57.	Absolute Ratings for OPN Suffixes AGR, AFX,
	and 400AFR
Table 58.	DC Characteristics for OPN Suffixes AGR, AFX,
	and 400AFR
Table 59.	Typical and Maximum Power Dissipation for OPN
	Suffixes AGR, AFX, and 400AFR
Table 60.	A[20:3], ADS#, HITM#, and W/R# Strength Selection 265
Table 61.	CLK Switching Characteristics for 100-MHz Bus Operation . 270
Table 62.	CLK Switching Characteristics for 66-MHz Bus Operation 270
Table 63.	Output Delay Timings for 100-MHz Bus Operation
Table 64.	Input Setup and Hold Timings for 100-MHz Bus Operation . 274
Table 65.	Output Delay Timings for 66-MHz Bus Operation
Table 66.	Input Setup and Hold Timings for 66-MHz Bus Operation 278
Table 67.	RESET and Configuration Signals for 100-MHz Bus
	Operation
Table 68.	RESET and Configuration Signals for 66-MHz Bus
	Operation
Table 69.	TCK Waveform and TRST# Timing at 25 MHz

Table 70.	Test Signal Timing at 25 MHz282
Table 71.	Package Thermal Specification for OPN Suffixes
	AHX, AFQ, and AFR
Table 72.	Package Thermal Specification for OPN Suffixes
	AGR, AFX, and 400AFR
Table 73.	321-Pin Staggered CPGA Package Specification
Table 74.	Valid Ordering Part Number Combinations

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# **Revision History**

Date	Rev	Description				
Feb 1999	F	Revised Replacement and Internal Snoop conditions in "Burst Writeback" on page 140.				
Feb 1999	F	Revised Chapter 7, "Cache Organization" and added Figure 82,"Page Flush/Invalidate Registe (PFIR)–MSR C000_0088h," and PFIR's bit descriptions.				
Feb 1999	F	Added 450 MHz (V <sub>CC2</sub> = 2.4 V) specifications to tables in Chapter 14, "Electrical Data".				
Feb 1999	F	Revised Table 71, "Package Thermal Specification for OPN Suffixes AHX, AFQ, and AFR," on page 287, Figure 105, "Power Consumption versus Thermal Resistance," on page 290, and the example on page 292.				
Feb 1999	F	Updated Chapter 21, "Ordering Information" on page 303.				
Apr 1999	G Added 475 MHz specifications to Table 54, "DC Characteristics for OPN Suffixes AHX, 400A AFR," on page 256, Table 55, "Typical and Maximum Power Dissipation for OPN Suffixes A 400AFQ, and AFR," on page 259, Table 71, "Package Thermal Specification for OPN Suffixes AFQ, and AFR," on page 287, and Chapter 21, "Ordering Information" on page 303.					
July 1999	Н	Added 500 MHz specifications. Rearranged Chapter 14, "Electrical Data" into 14.1 "Electrical Data for OPN Suffixes AHX, 400AFQ, and AFR" on page 255 and 14.2 "Electrical Data for OPN Suffixes AGR, AFX, and 400AFR" on page 260. In Chapter 17, "Thermal Design", provided thermal specifications in Table 71, "Package Thermal Specification for OPN Suffixes AHX, AFQ, and AFR" and Table 72, "Package Thermal Specification for OPN Suffixes AGR, AFX, and 400AFR". Updated Chapter 21, "Ordering Information".				
July 1999	Н	Changed AMD-K6-2/400AFX to AMD-K6-2/400AFR in Chapter 14, "Electrical Data", Chapter 17, "Thermal Design", and Chapter 21, "Ordering Information" to reflect the change to the maximum T <sub>CASE</sub> temperature from 65°C to 70°C. Added definition of Boundary Scan Register (BSR) for Model 8/[F:8] in Table 48 on page 231.				
Dec 1999	I	Added 533 MHz specifications. Changed Stop Grant, Halt, and Stop Clock power specifications in Table 55, "Typical and Maximum Power Dissipation for OPN Suffixes AHX, 400AFQ, and AFR," on page 259 and Table 71, "Package Thermal Specification for OPN Suffixes AHX, AFQ, and AFR," on page 287.				
Feb 2000	J	Added 550 MHz specifications. Added MOV to/from CRx, RDMSR, RDTSC, RSM, and WRMSR instructions to Table 14, "Integer Instructions," on page 55.				

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# 1 AMD-K6<sup>®</sup>-2 Processor

- Advanced 6-Issue RISC86<sup>®</sup> Superscalar Microarchitecture
  - Ten parallel specialized execution units
  - Multiple sophisticated x86-to-RISC86 instruction decoders
  - Advanced two-level branch prediction
  - Speculative execution
  - Out-of-order execution
  - Register renaming and data forwarding
  - Issues up to six RISC86 instructions per clock
- Large Internal Split 64-Kbyte Level-One (L1) Cache
  - 32-Kbyte instruction cache with additional 20-Kbytes of predecode cache
  - 32-Kbyte writeback dual-ported data cache
  - Two-way set associative
  - MESI protocol support
- 3DNow!<sup>™</sup> Technology
  - Additional instructions to improve 3D graphics and multimedia performance
  - Separate multiplier and ALU for superscalar instruction execution
- Compatible with Super7<sup>TM</sup> platform
  - Leverages high-speed 100-MHz processor bus
  - Accelerated Graphic Port (AGP) support
- High-Performance IEEE 754-Compatible and 854-Compatible Floating-Point Unit
- High-Performance Industry-Standard MMX<sup>TM</sup> Instructions
  - Dual integer ALU for superscalar execution
- 321-Pin Ceramic Pin Grid Array (CPGA) Package
- Industry-Standard System Management Mode (SMM)
- IEEE 1149.1 Boundary Scan
- **x86** Binary Software Compatibility

The innovative AMD-K6<sup>®</sup>-2 processor brings industry-leading performance to PC systems running the extensive installed base of x86 software. Its Super7<sup>™</sup> compatible, 321-pin ceramic pin grid array (CPGA) package enables the processor to reduce time-to-market by leveraging today's cost-effective industry-standard infrastructure to deliver a superior-performing PC solution.

The AMD-K6-2 processor is the first to incorporate 3DNow!<sup>™</sup> technology, a significant innovation to the x86 processor architecture that drives today's personal computers. With 3DNow! technology, new, more powerful hardware and software applications enable a more entertaining and productive PC platform. Improvements include fast frame rates on high-resolution scenes, superior modeling of real world environments and physics, life-like images and graphics, and big-screen sound and video.

AMD has taken a leadership role in developing new instructions that enable exciting new levels of performance and realism. 3DNow! technology was defined and implemented in collaboration with Microsoft<sup>®</sup>, application developers, and graphics vendors, and has received an enthusiastic reception. It is compatible with today's existing x86 software, is supported by industry-standard APIs, and requires no operating system support, thereby enabling a broad class of applications to benefit from 3DNow! technology.

To provide state-of-the-art performance, the processor incorporates the innovative and efficient RISC86<sup>®</sup> microarchitecture, a large 64-Kbyte level-one cache (32-Kbyte dual-ported data cache, 32-Kbyte instruction cache with an additional 20-Kbytes of predecode cache), a powerful IEEE 754-compatible and 854-compatible floating-point execution unit, and a high-performance industry-standard multimedia execution unit for executing MMX<sup>TM</sup> instructions. The processor includes additional high-performance Single Instruction Multiple Data (SIMD) execution resources to support the 3DNow! technology. These techniques have been combined to deliver leading-edge performance on leading consumer and business applications in both the Microsoft Windows<sup>®</sup> 98 and Windows NT<sup>®</sup> operating environments.

The AMD-K6-2 processor's 6-issue RISC86 microarchitecture is a decoupled decode/execution superscalar design that implements state-of-the-art design techniques to achieve leading-edge performance. Advanced design techniques implemented in the AMD-K6-2 processor include multiple x86 instruction decode, single-clock internal RISC operations, ten execution units that support superscalar operation, out-of-order execution, data forwarding, speculative execution, and register renaming. In addition, the processor supports advanced branch prediction logic by implementing an 8192-entry branch history table, a branch target cache, and a return address stack, which combine to deliver better than a 95% prediction rate. These design techniques enable the AMD-K6-2 processor to issue, execute, and retire multiple x86 instructions per clock, resulting in excellent scaleable performance.

The AMD-K6-2 processor is x86 binary code compatible. AMD's extensive experience through six generations of x86 processors has been carefully integrated into the processor to enable compatibility with Windows 98, Windows 95, Windows 3.x, Windows NT, DOS, OS/2, Unix, Solaris, NetWare<sup>®</sup>, Vines, and other leading x86 operating systems and applications. The AMD-K6-2 processor is Super7 and Socket 7-compatible. The Super7 platform is an extension to today's popular and robust Socket 7 platform. See "Super7<sup>™</sup> Platform Initiative" for more information.

AMD is the world's second-leading supplier of Windows-compatible PC processors, having shipped more than 120 million x86 microprocessors, including more than 60 million Windows-compatible processors. With its combination of state-of-the-art features, industry-leading performance, high-performance 3DNow! technology and multimedia engines, x86 compatibility, and low-cost infrastructure, the AMD-K6-2 is the superior choice for mainstream personal computers.

## 1.1 Super7<sup>™</sup> Platform Initiative

AMD and its industry partners launched the Super7 platform initiative in order to maintain the competitive vitality of the Socket 7 infrastructure through a series of enhancements, including the development of an industry-standard 100-MHz processor bus protocol.

In addition to the 100-MHz processor bus protocol, the Super7 initiative includes the introduction of chipsets that support the AGP specification, and support for a backside L2 cache and frontside L3 cache. Currently, over 40 motherboard vendors and all major BIOS and chipset vendors offer Super7 based products.

#### Super7<sup>™</sup> Platform Enhancements

The Super7 platform has the following enhancements:

- 100-MHz processor bus—The AMD-K6-2 processor supports a 100-MHz, 800 Mbyte/second frontside bus to provide a high-speed interface to Super7 platform-based chipsets. The 100-MHz interface to the frontside Level 2 (L2) cache and main system memory speeds up access to the frontside cache and main memory by 50 percent over the 66-MHz Socket 7 interface—resulting in a significant increase of 10% in overall system performance.
- Accelerated graphics port support—AGP improves the performance of mid-range PCs that have small amounts of video memory on the graphics card. The industry-standard AGP specification enables a 133-MHz graphics interface and will scale to even higher levels of performance.
- Support for backside L2 and frontside L3 cache—The Super7 platform has the 'headroom' to support higher-performance AMD-K6 processors, with clock speeds scaling to 550 MHz and beyond. The Super7 platform also supports the AMD-K6-III processor which features a full-speed, internal backside 256-Kbyte L2 cache designed to enable new levels of performance to leading-edge desktop systems. This processor also supports an optional 100-MHz external L3 cache for even higher-performance system configurations.

#### Super7<sup>™</sup> Platform Advantages

The Super7 platform has the following advantages:

- Delivers performance and features competitive with alternate platforms at the same clock speed, and at a significantly lower cost
- Takes advantage of existing system designs for superior value
- Enables OEMs and resellers to take advantage of mature, high-volume infrastructure supported by multiple BIOS, chipset, graphics, and motherboard suppliers
- Reduces inventory and design costs with one motherboard for a wide range of products
- Builds on a huge installed base of more than 100 million motherboards
- Provides an easy upgrade path for future PC users, as well as a bridge to legacy users

By taking advantage of the low-cost, mature Socket 7 infrastructure, the Super7 platform will continue to provide superior value and leading-edge performance for desktop PC systems.

# 2 Internal Architecture

## 2.1 Introduction

The AMD-K6-2 processor implements advanced design techniques known as the RISC86 microarchitecture. The RISC86 microarchitecture is a decoupled decode/execution design approach that yields superior sixth-generation performance for x86-based software. This chapter describes the techniques used and the functional elements of the RISC86 microarchitecture.

# 2.2 AMD-K6<sup>®</sup>-2 Processor Microarchitecture Overview

When discussing processor design, it is important to understand the terms *architecture*, *microarchitecture*, and *design implementation*. The term *architecture* refers to the instruction set and features of a processor that are visible to software programs running on the processor. The architecture determines what software the processor can run. The architecture of the AMD-K6-2 processor is the industry-standard x86 instruction set.

The term *microarchitecture* refers to the design techniques used in the processor to reach the target cost, performance, and functionality goals. The AMD-K6 family of processors are based on a sophisticated RISC core known as the Enhanced RISC86 microarchitecture. The Enhanced RISC86 microarchitecture is an advanced, second-order decoupled decode/execution design approach that enables industry-leading performance for x86-based software.

The term *design implementation* refers to the actual logic and circuit designs from which the processor is created according to the microarchitecture specifications.

Enhanced RISC86<sup>®</sup> Microarchitecture

The Enhanced RISC86 microarchitecture defines the characteristics of the AMD-K6 family. The innovative RISC86 microarchitecture approach implements the x86 instruction set by internally translating x86 instructions into RISC86 operations. These RISC86 operations were specially designed to include direct support for the x86 instruction set while observing the RISC performance principles of fixed length encoding, regularized instruction fields, and a large register set. The Enhanced RISC86 microarchitecture used in the AMD-K6-2 processor enables higher processor core performance and promotes straightforward extensions, such as those added in the current AMD-K6-2 processor and those planned for the future. Instead of directly executing complex x86 instructions, which have lengths of 1 to 15 bytes, the AMD-K6-2 processor executes the simpler and easier fixed-length RISC86 operations, while maintaining the instruction coding efficiencies found in x86 programs.

The AMD-K6-2 processor contains parallel decoders, a centralized RISC86 operation scheduler, and ten execution units that support superscalar operation—multiple decode, execution, and retirement—of x86 instructions. These elements are packed into an aggressive and highly efficient six-stage pipeline.

AMD-K6<sup>®</sup>-2 Processor Block Diagram. As shown in Figure 1 on page 7, the high-performance, out-of-order execution engine of the AMD-K6-2 processor is mated to a split level-one 64-Kbyte writeback cache with 32 Kbytes of instruction cache and 32 Kbytes of data cache. The instruction cache feeds the decoders and, in turn, the decoders feed the scheduler. The ICU issues and retires RISC86 operations contained in the scheduler. The system bus interface is an industry-standard 64-bit Super7 and Socket 7 demultiplexed bus.

The AMD-K6-2 processor combines the latest in processor microarchitecture to provide the highest x86 performance for today's personal computers. The AMD-K6-2 processor offers true sixth-generation performance and x86 binary software compatibility.

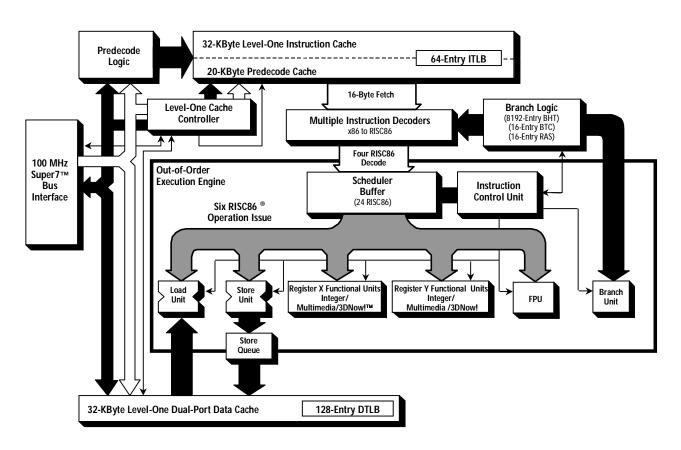


Figure 1. AMD-K6<sup>®</sup>-2 Processor Block Diagram

**Decoders.** Decoding of the x86 instructions begins when the on-chip instruction cache is filled. Predecode logic determines the length of an x86 instruction on a byte-by-byte basis. This predecode information is stored, along with the x86 instructions, in the instruction cache, to be used later by the decoders. The decoders translate on-the-fly, with no additional latency, up to two x86 instructions per clock into RISC86 operations.

Note: In this chapter, "clock" refers to a processor clock.

The AMD-K6-2 processor categorizes x86 instructions into three types of decodes—short, long, and vector. The decoders process either two short, one long, or one vector decode at a time. The three types of decodes have the following characteristics:

- Short decodes—x86 instructions less than or equal to seven bytes in length
- Long decodes—x86 instructions less than or equal to 11 bytes in length
- Vector decodes—complex x86 instructions

Short and long decodes are processed completely within the decoders. Vector decodes are started by the decoders and then completed by fetched sequences from an on-chip ROM. After decoding, the RISC86 operations are delivered to the scheduler for dispatching to the executions units.

Scheduler/Instruction Control Unit. The centralized scheduler or buffer is managed by the Instruction Control Unit (ICU). The ICU buffers and manages up to 24 RISC86 operations at a time. This equals from 6 to 12 x86 instructions. This buffer size (24) is perfectly matched to the processor's six-stage RISC86 pipeline and four RISC86-operations decode rate. The scheduler accepts as many as four RISC86 operations at a time from the decoders and retires up to four RISC86 operations per clock cycle. The ICU is capable of simultaneously issuing up to six RISC86 operations at a time to the execution units. This consists of the following types of operations:

- Memory load operation
- Memory store operation
- Complex integer, MMX or 3DNow! register operation
- Simple integer, MMX or 3DNow! register operation
- Floating-point register operation
- Branch condition evaluation

Registers. When managing the 24 RISC86 operations, the ICU uses 69 physical registers contained within the RISC86 microarchitecture. 48 of the physical registers are located in a general register file and are grouped as 24 committed or architectural registers plus 24 rename registers. The 24 architectural registers consist of 16 scratch registers and 8 registers that correspond to the x86 general-purpose registers— EAX, EBX, ECX, EDX, EBP, ESP, ESI, and EDI. There is an analogous set of registers specifically for MMX and 3DNow! operations. There are 9 MMX/3DNow! committed or architectural registers plus 12 MMX/3DNow! rename registers. The 9 architectural registers consist of one scratch register and 8 registers that correspond to the MMX registers (mm0-mm7), as shown in Figure 17 on page 29.

**Branch Logic.** The AMD-K6-2 processor is designed with highly sophisticated dynamic branch logic consisting of the following:

- Branch history/Prediction table
- Branch target cache
- Return address stack

The AMD-K6-2 processor implements a two-level branch prediction scheme based on an 8192-entry branch history table. The branch history table stores prediction information that is used for predicting conditional branches. Because the branch history table does not store predicted target addresses, special address ALUs calculate target addresses on-the-fly during instruction decode. The branch target cache augments predicted branch performance by avoiding a one clock cache-fetch penalty. This specialized target cache does this by supplying the first 16 bytes of target instructions to the decoders when branches are predicted. The return address stack is a unique device specifically designed for optimizing CALL and RETURN pairs. In summary, the AMD-K6-2 processor uses dynamic branch logic to minimize delays due to the branch instructions that are common in x86 software.

**3DNow!™** Technology. AMD has taken a lead role in improving the multimedia and 3D capabilities of the x86 processor family with the introduction of 3DNow! technology, which uses a packed, single-precision, floating-point data format and Single Instruction Multiple Data (SIMD) operations based on the MMX technology model.

## 2.3 Cache, Instruction Prefetch, and Predecode Bits

The writeback level-one cache on the AMD-K6-2 processor is organized as a separate 32-Kbyte instruction cache and a 32-Kbyte data cache with two-way set associativity. The cache line size is 32 bytes and lines are prefetched from main memory using an efficient pipelined burst transaction. As the instruction cache is filled, each instruction byte is analyzed for instruction boundaries using predecoding logic. Predecoding annotates information (5 bits per byte) to each instruction byte that later enables the decoders to efficiently decode multiple instructions simultaneously.

CacheThe processor cache design takes advantage of a sectored<br/>organization (see Figure 2 on page 10). Each sector consists of<br/>64 bytes configured as two 32-byte cache lines. The two cache<br/>lines of a sector share a common tag but have separate pairs of<br/>MESI (Modified, Exclusive, Shared, Invalid) bits that track the<br/>state of each cache line.

	Two forms of cache misses and associated cache fills can take place—a tag-miss cache fill and a tag-hit cache fill. In the case of a tag-miss cache fill, the miss is due to a tag mismatch, in which case the required cache line is filled from external memory, and the cache line within the sector that was not required is marked as invalid. In the case of a tag-hit cache fill, the address matches the tag, but the requested cache line is marked as invalid. The required cache line is filled from external memory, and the cache line within the sector that is not required remains in the same cache state.
Prefetching	The AMD-K6-2 processor conditionally performs cache prefetching which results in the filling of the required cache line first, and a prefetch of the second cache line making up the other half of the sector. From the perspective of the external bus, the two cache-line fills typically appear as two 32-byte burst read cycles occurring back-to-back or, if allowed, as pipelined cycles.
	The 3DNow! technology includes an instruction called PREFETCH that allows a cache line to be prefetched into the data cache. The PREFETCH instruction format is defined in Table 17, "3DNow!™ Instructions," on page 81. For more detailed information, see the <i>3DNow!™ Technology Manual</i> , order# 21928.
Predecode Bits	Decoding x86 instructions is particularly difficult because the instructions are variable-length and can be from 1 to 15 bytes long. Predecode logic supplies the five predecode bits that are associated with each instruction byte. The predecode bits indicate the number of bytes to the start of the next x86 instruction. The predecode bits are stored in an extended instruction cache alongside each x86 instruction byte as shown in Figure 2. The predecode bits are passed with the instruction bytes to the decoders where they assist with parallel x86 instruction decoding.

Tag	Cache Line 0	Byte 31	Predecode Bits	Byte 30	Predecode Bits	 	Byte 0	Predecode Bits	MESI Bits
Address	Cache Line 1	Byte 31	Predecode Bits	Byte 30	Predecode Bits	 	Byte 0	Predecode Bits	MESI Bits

### Figure 2. Cache Sector Organization

## 2.4 Instruction Fetch and Decode

**Instruction Fetch** The processor can fetch up to 16 bytes per clock out of the instruction cache or branch target cache. The fetched information is placed into a 16-byte instruction buffer that feeds directly into the decoders (see Figure 3). Fetching can occur along a single execution stream with up to seven outstanding branches taken.

The instruction fetch logic is capable of retrieving any 16 contiguous bytes of information within a 32-byte boundary. There is no additional penalty when the 16 bytes of instructions lie across a cache line boundary. The instruction bytes are loaded into the instruction buffer as they are consumed by the decoders. Although instructions can be consumed with byte granularity, the instruction buffer is managed on a memory-aligned word (two bytes) organization. Therefore, instructions are loaded and replaced with word granularity. When a control transfer occurs—such as a JMP instruction—the entire instruction buffer is flushed and reloaded with a new set of 16 instruction bytes.

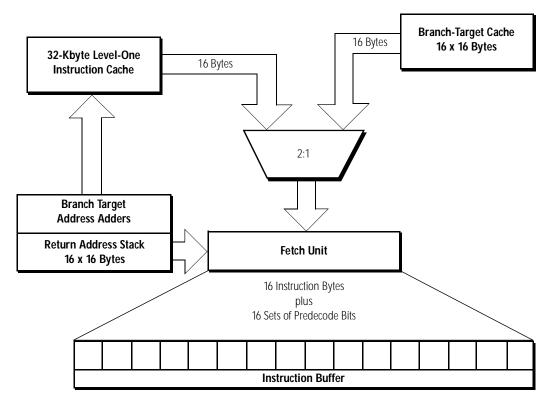


Figure 3. The Instruction Buffer

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Instruction Decode The AMD-K6-2 processor decode logic is designed to decode multiple x86 instructions per clock (see Figure 4). The decode logic accepts x86 instruction bytes and their predecode bits from the instruction buffer, locates the actual instruction boundaries, and generates RISC86 operations from these x86 instructions.

RISC86 operations are fixed-length internal instructions. Most RISC86 operations execute in a single clock. RISC86 operations are combined to perform every function of the x86 instruction set. Some x86 instructions are decoded into as few as zero RISC86 operations—for instance a NOP—or one RISC86 operation—a register-to-register add. More complex x86 instructions are decoded into several RISC86 operations.

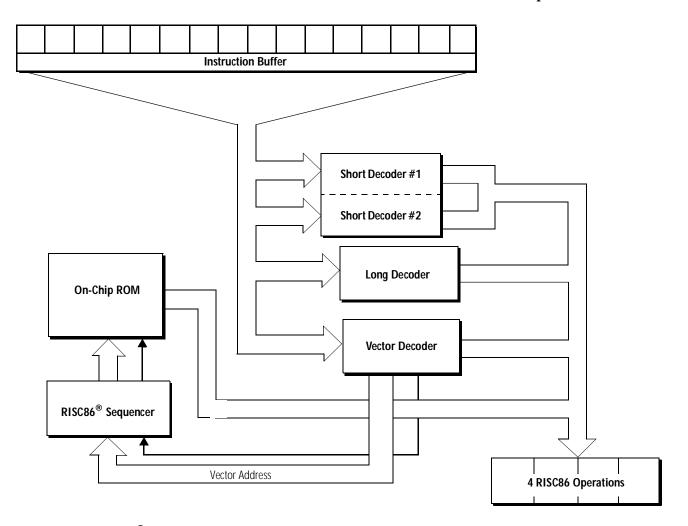


Figure 4. AMD-K6<sup>®</sup>-2 Processor Decode Logic

The AMD-K6-2 processor uses a combination of decoders to convert x86 instructions into RISC86 operations. The hardware consists of three sets of decoders—two parallel short decoders, one long decoder, and one vector decoder. The two parallel short decoders translate the most commonly-used x86 instructions (moves, shifts, branches, ALU, FPU) and the extensions to the x86 instruction set (including MMX and 3DNow! instructions) into zero, one, or two RISC86 operations each. The short decoders only operate on x86 instructions that are up to seven bytes long. In addition, they are designed to decode up to two x86 instructions that are greater than seven bytes but not more than 11 bytes long, and semi-commonly-used x86 instructions that are up to seven bytes long are handled by the long decoder.

The long decoder only performs one decode per clock and generates up to four RISC86 operations. All other translations (complex instructions, serializing conditions, interrupts and exceptions, etc.) are handled by a combination of the vector decoder and RISC86 operation sequences fetched from an on-chip ROM. For complex operations, the vector decoder logic provides the first set of RISC86 operations and a vector (initial ROM address) to a sequence of further RISC86 operations. The same types of RISC86 operations are fetched from the ROM as those that are generated by the hardware decoders.

*Note:* Although all three sets of decoders are simultaneously fed a copy of the instruction buffer contents, only one of the three types of decoders is used during any one decode clock.

The decoders or the on-chip RISC86 ROM always generate a group of four RISC86 operations. For decodes that cannot fill the entire group with four RISC86 operations, RISC86 NOP operations are placed in the empty locations of the grouping. For example, a long-decoded x86 instruction that converts to only three RISC86 operations is padded with a single RISC86 NOP operation and then passed to the scheduler. Up to six groups or 24 RISC86 operations can be placed in the scheduler at a time.

All of the common, and a few of the uncommon, floating-point instructions (also known as ESC instructions) are hardware decoded as short decodes. This decode generates a RISC86 floating-point operation and, optionally, an associated floating-point load or store operation. Floating-point or ESC

AMD-K6<sup>®</sup>-2 Processor Data Sheet

instruction decode is only allowed in the first short decoder, but non-ESC instructions can be decoded simultaneously by the second short decoder along with an ESC instruction decode in the first short decoder.

All of the MMX and 3DNow! instructions, with the exception of the EMMS, FEMMS, and PREFETCH instructions, are hardware decoded as short decodes. The MMX instruction decode generates a RISC86 MMX operation and, optionally, an associated MMX load or store operation. A 3DNow! instruction decode generates a RISC86 3DNow! operation and, optionally, an associated load or store operation. MMX and 3DNow! instructions can be decoded in either or both of the short decoders.

# 2.5 Centralized Scheduler

The scheduler is the heart of the AMD-K6-2 processor (see Figure 5 on page 15). It contains the logic necessary to manage out-of-order execution, data forwarding, register renaming, simultaneous issue and retirement of multiple RISC86 operations, and speculative execution. The scheduler's buffer can hold up to 24 RISC86 operations. This equates to a maximum of 12 x86 instructions. The scheduler can issue RISC86 operations from any of the 24 locations in the buffer. When possible, the scheduler can simultaneously issue a RISC86 operation to any available execution unit (store, load, branch, register X integer/multimedia, register Y integer/multimedia, or floating-point). In total, the scheduler can issue up to six and retire up to four RISC86 operations per clock.

The main advantage of the scheduler and its operation buffer is the ability to examine an x86 instruction window equal to 12 x86 instructions at one time. This advantage is due to the fact that the scheduler operates on the RISC86 operations in parallel and allows the AMD-K6-2 processor to perform dynamic on-the-fly instruction code scheduling for optimized execution. Although the scheduler can issue RISC86 operations for out-of-order execution, it always retires x86 instructions in order.

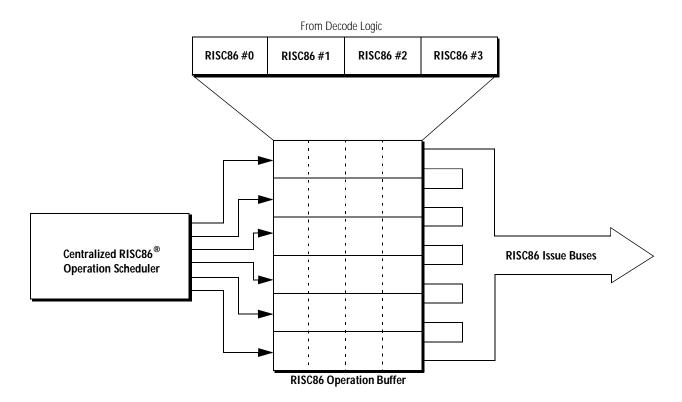


Figure 5. AMD-K6<sup>®</sup>-2 Processor Scheduler

# 2.6 Execution Units

The AMD-K6-2 processor contains ten parallel execution units—store, load, integer X ALU, integer Y ALU, MMX ALU (X), MMX ALU (Y), MMX/3DNow! multiplier, 3DNow! ALU, floating-point, and branch condition. Each unit is independent and capable of handling the RISC86 operations. Table 1 on page 16 details the execution units, functions performed within these units, operation latency, and operation throughput.

The store and load execution units are two-stage pipelined designs. The store unit performs data writes and register calculation for LEA/PUSH. Data memory and register writes from stores are available after one clock. Store operations are held in a store queue prior to execution. From there, they execute in order. The load unit performs data memory reads. Data is available from the load unit after two clocks.

The Integer X execution unit can operate on all ALU operations, multiplies, divides (signed and unsigned), shifts, and rotates.

The Integer Y execution unit can operate on the basic word and doubleword ALU operations—ADD, AND, CMP, OR, SUB, XOR, zero-extend and sign-extend operands.

Functional Unit	Function	Latency	Throughput
Store	LEA/PUSH, Address (Pipelined)	1	1
Store	Memory Store (Pipelined)	1	1
Load	Memory Loads (Pipelined)	2	1
	Integer ALU	1	1
Integer X	Integer Multiply	2–3	2–3
	Integer Shift	1	1
Multimedia	MMX ALU	1	1
(processes	MMX Shifts, Packs, Unpack	1	1
MMX instructions)	MMX Multiply	2	1
Integer Y	Basic ALU (16-bit and 32-bit operands)	1	1
Branch	Resolves Branch Conditions	1	1
FPU	FADD, FSUB, FMUL	2	2
	3DNow! ALU	2	1
3DNow!	3DNow! Multiply	2	1
	3DNow! Convert	2	1

 Table 1.
 Execution Latency and Throughput of Execution Units

#### Register X and Y Pipelines

The functional units that execute MMX and 3DNow! instructions share pipeline control with the Integer X and Integer Y units.

The register X and Y functional units are attached to the issue bus for the register X execution pipeline or the issue bus for the register Y execution pipeline or both. Each register pipeline has dedicated resources that consist of an integer execution unit and an MMX ALU execution unit, therefore allowing superscalar operation on integer and MMX instructions. In addition, both the X and Y issue buses are connected to the 3DNow! ALU, the MMX/3DNow! multiplier and MMX shifter, which allows the appropriate RISC86 operation to be issued through either bus. Figure 6 on page 17 shows the details of the X and Y register pipelines.

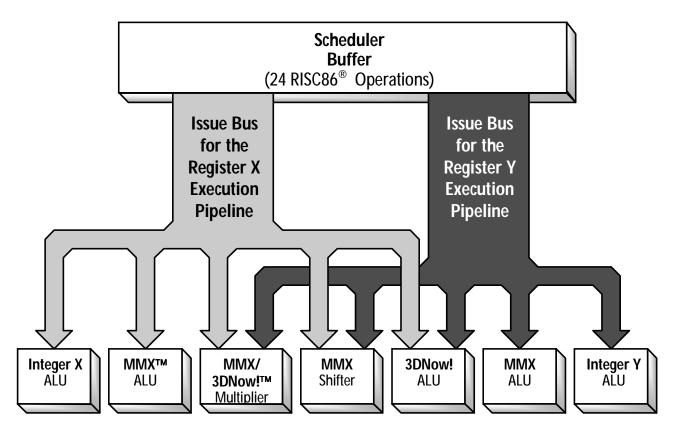


Figure 6. Register X and Y Functional Units

The branch condition unit is separate from the branch prediction logic in that it resolves conditional branches such as JCC and LOOP after the branch condition has been evaluated.

### 2.7 Branch-Prediction Logic

Sophisticated branch logic that can minimize or hide the impact of changes in program flow is designed into the AMD-K6-2 processor. Branches in x86 code fit into two categories unconditional branches, which always change program flow (that is, the branches are always taken) and conditional branches, which may or may not divert program flow (that is, the branches are taken or not-taken). When a conditional branch is not taken, the processor simply continues decoding and executing the next instructions in memory.

Typical applications have up to 10% of unconditional branches and another 10% to 20% conditional branches. The AMD-K6-2 processor branch logic has been designed to handle this type of AMD-K6<sup>®</sup>-2 Processor Data Sheet

program behavior and its negative effects on instruction execution, such as stalls due to delayed instruction fetching and the draining of the processor pipeline. The branch logic contains an 8192-entry branch history table, a 16-entry by 16-byte branch target cache, a 16-entry return address stack, and a branch execution unit.

**Branch History Table** The AMD-K6-2 processor handles unconditional branches without any penalty by redirecting instruction fetching to the target address of the unconditional branch. However, conditional branches require the use of the dynamic branch-prediction mechanism built into the AMD-K6-2 processor. A two-level adaptive history algorithm is implemented in an 8192-entry branch history table. This table stores executed branch information, predicts individual branches, and predicts the behavior of groups of branches. To accommodate the large branch history table, the AMD-K6-2 processor does not store predicted target addresses. Instead, the branch target addresses are calculated on-the-fly using ALUs during the decode stage. The adders calculate all possible target addresses before the instructions are fully decoded and the processor chooses which addresses are valid.

**Branch Target Cache** To avoid a one clock cache-fetch penalty when a branch is predicted taken, a built-in branch target cache supplies the first 16 bytes of instructions directly to the instruction buffer (assuming the target address hits this cache). (See Figure 3 on page 11.) The branch target cache is organized as 16 entries of 16 bytes. In total, the branch prediction logic achieves branch prediction rates greater than 95%.

**Return Address Stack** The return address stack is a special device designed to optimize CALL and RET pairs. Software is typically compiled with subroutines that are frequently called from various places in a program. This is usually done to save space. Entry into the subroutine occurs with the execution of a CALL instruction. At that time, the processor pushes the address of the next instruction in memory following the CALL instruction onto the stack (allocated space in memory). When the processor encounters a RET instruction (within or at the end of the subroutine), the branch logic pops the address from the stack and begins fetching from that location. To avoid the latency of main memory accesses during CALL and RET operations, the return address stack caches the pushed addresses.

21850J/0-February 2000

Branch Execution Unit The branch execution unit enables efficient speculative execution. This unit gives the processor the ability to execute instructions beyond conditional branches before knowing whether the branch prediction was correct. The AMD-K6-2 processor does not permanently update the x86 registers or memory locations until all speculatively executed conditional branch instructions are resolved. When a prediction is incorrect, the processor backs out to the point of the mispredicted branch instruction and restores all registers. The AMD-K6-2 processor can support up to seven outstanding branches.

### 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# 3 Software Environment

This chapter provides a general overview of the AMD-K6-2 processor's x86 software environment and briefly describes the data types, registers, operating modes, interrupts, and instructions supported by the AMD-K6-2 architecture and design implementation.

The stepping of the Model 8 determines the implementation and format of five Model-Specific Registers (MSRs). This document covers the following two stepping ranges of the AMD-K6-2 processor:

- Model 8/[7:0] is any of eight possible model/steppings— Models 8/0, 8/1, 8/2, 8/3, 8/4, 8/5, 8/6, or 8/7. Model 8/[7:0] implements seven MSRs, and the bits and fields within these seven MSRs are defined identically.
- Model 8/[F:8] is any of eight possible model/steppings— Models 8/8, 8/9, 8/A, 8/B, 8/C, 8/D, 8/E, or 8/F. Model 8/[F:8] implements the same seven MSRs as the Model 8/[7:0], but the bits and fields within two of these MSRs are not defined identically. Also, Model 8/[F:8] supports three additional MSRs for a total of ten MSRs.

The name *AMD-K6-2 processor* by itself refers to all steppings of the Model 8. See "AMD-K6®-2 Processor Model 8/[F:8] Registers" on page 50 for the MSRs that are implemented only on the Model 8/[F:8].

#### 3.1 Registers

The AMD-K6-2 processor contains all the registers defined by the x86 architecture, including general-purpose, segment, floating-point, MMX/3DNow!, EFLAGS, control, task, debug, test, and descriptor/memory-management registers. In addition, this chapter provides information on the AMD-K6-2 processor MSRs.

*Note:* Areas of the register designated as Reserved should not be modified by software.

# General-PurposeThe eight 32-bit x86 general-purpose registers are used to hold<br/>integer data or memory pointers used by instructions. Table 2<br/>contains a list of the general-purpose registers and the<br/>functions for which they are used.

Register	Function
EAX	Commonly used as an accumulator
EBX	Commonly used as a pointer
ECX	Commonly used for counting in loop operations
EDX	Commonly used to hold I/O information and to pass parameters
EDI	Commonly used as a destination pointer by the ES segment
ESI	Commonly used as a source pointer by the DS segment
ESP	Used to point to the stack segment
EBP	Used to point to data within the stack segment

Table 2. General-Purpose Registers

In order to support byte and word operations, EAX, EBX, ECX, and EDX can also be used as 8-bit and 16-bit registers. The shorter registers are overlaid on the longer ones. For example, the name of the 16-bit version of EAX is AX (low 16 bits of EAX) and the 8-bit names for AX are AH (high order bits) and AL (low order bits). The same naming convention applies to EBX, ECX, and EDX. EDI, ESI, ESP, and EBP can be used as smaller 16-bit registers called DI, SI, SP, and BP respectively, but these registers do not have 8-bit versions. Figure 7 shows the EAX register with its name components, and Table 3 lists the doubleword (32-bit) general-purpose registers and their corresponding word (16-bit) and byte (8-bit) versions.

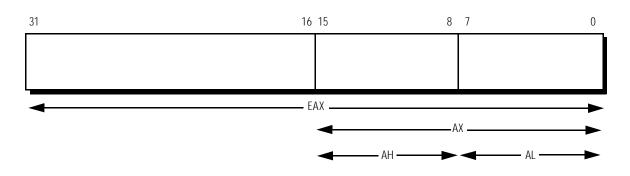


Figure 7. EAX Register with 16-Bit and 8-Bit Name Components

32-Bit Name (Doubleword)	16-Bit Name (Word)	8-Bit Name (High-order Bits)	8-Bit Name (Low-order Bits)
EAX	AX	AH	AL
EBX	ВХ	BH	BL
ECX	СХ	СН	CL
EDX	DX	DH	DL
EDI	DI	-	-
ESI	SI	-	-
ESP	SP	-	-
EBP	BP	-	-

#### Table 3. General-Purpose Register Doubleword, Word, and Byte Names

Integer Data Types

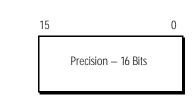
Four types of data are used in general-purpose registers—byte, word, doubleword, and quadword integers. Figure 8 shows the format of the integer data registers.

Byte Integer



0

Word Integer



**Doubleword Integer** 

Precision – 32 Bits

Quadword Integer 63 0 Precision – 64 Bits

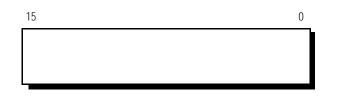
31

#### Figure 8. Integer Data Registers

**Segment Registers** The six 16-bit segment registers are used as pointers to areas (segments) of memory. Table 4 lists the segment registers and their functions. Figure 9 shows the format for all six segment registers.

Table 4.	Segment	Registers
----------	---------	-----------

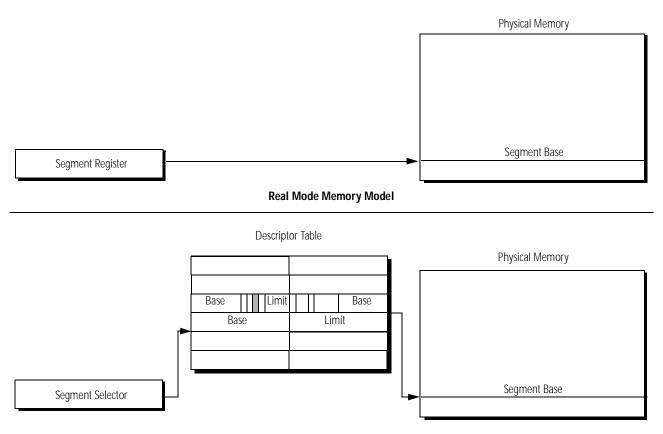
Segment Register	Segment Register Function
CS	Code segment, where instructions are located
DS	Data segment, where data is located
ES	Data segment, where data is located
FS	Data segment, where data is located
GS	Data segment, where data is located
SS	Stack segment





#### **Segment Usage**

The operating system determines the type of memory model that is implemented. The segment register usage is determined by the operating system's memory model. In a Real mode memory model the segment register points to the base address in memory. In a Protected mode memory model the segment register is called a selector and it selects a segment descriptor in a descriptor table. This descriptor contains a pointer to the base of the segment, the limit of the segment, and various protection attributes. For more information on descriptor formats, see "Descriptors and Gates" on page 46. Figure 10 on page 25 shows segment usage for Real mode and Protected mode memory models.





#### Figure 10. Segment Usage

Instruction Pointer	The instruction pointer (EIP or IP) is used in conjunction with the code segment register (CS). The instruction pointer is either a 32-bit register (EIP) or a 16-bit register (IP) that keeps track of where the next instruction resides within memory. This register cannot be directly manipulated, but can be altered by modifying return pointers when a JMP or CALL instruction is used.
Floating-Point Registers	The floating-point execution unit in the AMD-K6-2 processor is designed to perform mathematical operations on non-integer numbers. This floating-point unit conforms to the IEEE 754 and 854 standards and uses several registers to meet these standards—eight numeric floating-point registers, a status word register, a control word register, and a tag word register.



The eight floating-point registers are physically 80 bits wide and labeled FPR0–FPR7. Figure 11 shows the format of these floating-point registers. See "Floating-Point Register Data Types" on page 28 for information on allowable floating-point data types.

79 78	64	4 63 0
Sign	Exponent	Significand

#### Figure 11. Floating-Point Register

The 16-bit FPU status word register contains information about the state of the floating-point unit. Figure 12 shows the format of this register.

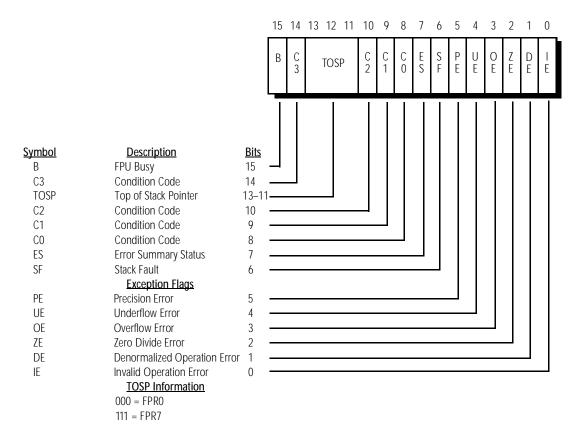
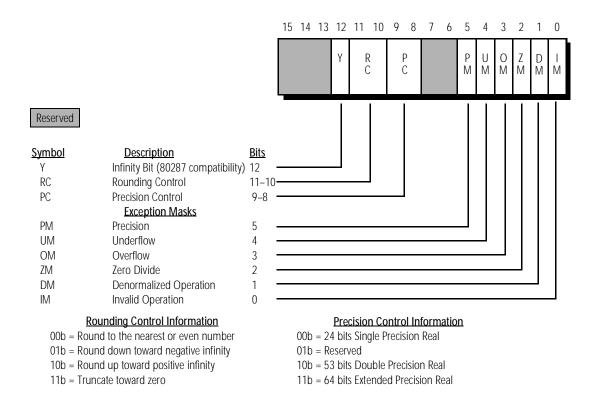


Figure 12. FPU Status Word Register

The FPU control word register allows a programmer to manage the FPU processing options. Figure 13 shows the format of this register.



#### Figure 13. FPU Control Word Register

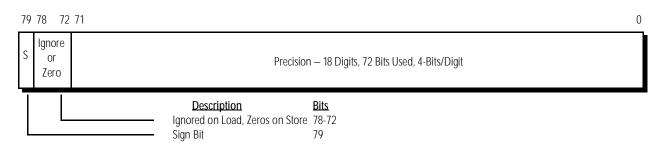
The FPU tag word register contains information about the registers in the register stack. Figure 14 shows the format of this register.

15 1	4 13 12	2 11 10	9 8	676	5 4	3 2	1 0
TAG (FPR7)	TAG (FPR6)	TAG (FPR5)	TAG (FPR4)	TAG (FPR3)	TAG (FPR2)	TAG (FPR1)	TAG (FPRO)
			Tag Values 00 = Valid 01 = Zero 10 = Specia 11 = Empty	ıl			

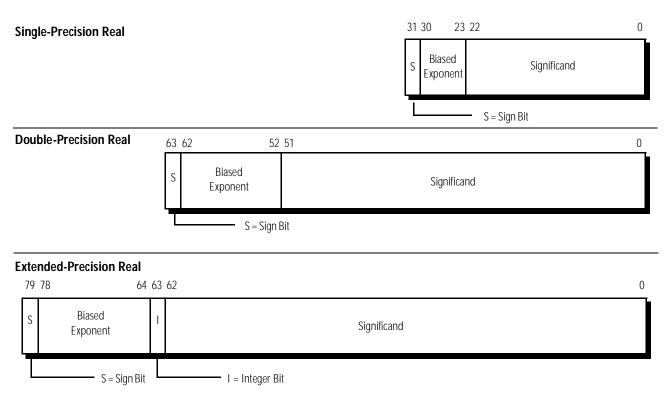
#### Figure 14. FPU Tag Word Register

AMD-K6<sup>®</sup>-2 Processor Data Sheet

#### **Floating-Point Register Data Types** Floating-point registers use four different types of data packed decimal, single-precision real, double-precision real, and extended-precision real. Figures 15 and 16 show the formats for these registers.









#### MMX<sup>™</sup>/3DNow!<sup>™</sup> Registers

The AMD-K6-2 processor implements eight 64-bit MMX/3DNow! registers for use by multimedia software. These registers are mapped on the floating-point register stack. The MMX and 3DNow! instructions refer to these registers as mm0 to mm7. Figure 17 shows the format of these registers. For more information, see the AMD-K6<sup>®</sup> Processor Multimedia Technology Manual, order# 20726 and the 3DNow! Technology Manual, order# 21928.

63	0
mm0	
mm1	
mm2	
mm3	
mm4	
mm5	
mm6	
mm7	

Figure 17. MMX<sup>™</sup>/3DNow!<sup>™</sup> Registers

MMX<sup>™</sup> Data Types For the MMX instructions, the MMX registers use three types of data—packed eight-byte integer, packed quadword integer, and packed dual doubleword integer. Figure 18 on page 30 shows the format of these data types.



21850J/0-February 2000

#### Packed Bytes Integer

63 56	55 48	47 40	39 32	31 24	23 16	15 8	7 0
Byte 7	Byte 6	Byte 5	Byte 4	Byte 3	Byte 2	Byte 1	Byte 0

#### Packed Words Integer

63 4	8 47 32		15 0
Word 3	Word 2	Word 1	Word 0

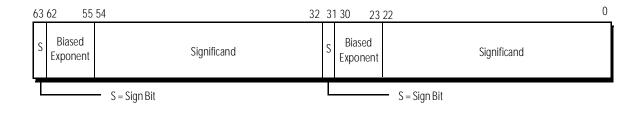
#### Packed Doubleword Integer

63	32	31	0
	Doubleword 1		Doubleword 0

#### Figure 18. MMX<sup>™</sup> Data Types

**3DNow!™ Data Types** For 3DNow! instructions, the MMX/3DNow! registers use packed single-precision real data. Figure 19 shows the format of the 3DNow! data type.

#### Packed Single Precision Floating Point





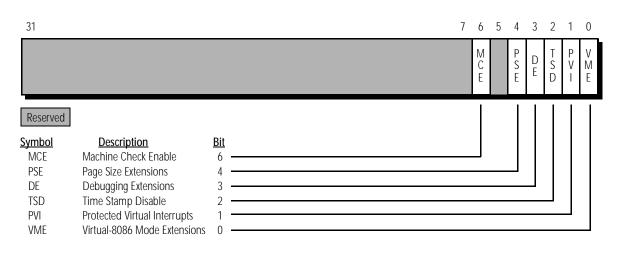
**EFLAGS Register** The EFLAGS register provides for three different types of flags—system, control, and status. The system flags provide operating system controls, the control flag provides directional information for string operations, and the status flags provide information resulting from logical and arithmetic operations. Figure 20 shows the format of this register.

3	1 30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
										I D	V I P	V I F	A C	V M	R F		N T	I O P L		O F	D F	 F	T F	S F	Z F		A F		P F		C F
Symbol	Reserv		Desc	cript	ion			I	<u>Bits</u>																						
ID VIP		ID	Flag	-		Don	dina		21																						
VIP			tual I tual I						20 19	_																					
AC			gnme						18																						
VM			tual-8						17																						
RF			sume						16																						
NT			sted						14																						
IOPL		I/C	) Priv	ilege	e Lev	/el		13-	-12	-																					
OF		Ov	erflo	w Fla	ag				11	-																					
DF		Dir	ectio	n Fla	ag				10																						
IF		Inte	errup	ot Fla	ig				9	-																					
TF		Tra	ip Fla	ag					8																						
SF		Sig	n Fla	g					7																						
ZF		Zer	ro Fla	ag					6																						
AF		Au	xiliar	y Fla	g				4																						
PF			rity Fl						2																						
CF		Cai	rry Fl	ag					0	-																					

Figure 20. EFLAGS Registers

AMD-K6<sup>®</sup>-2 Processor Data Sheet

# **Control Registers** The five control registers contain system control bits and pointers. Figures 21 through 25 show the formats of these registers.



#### Figure 21. Control Register 4 (CR4)

31 30 29	28 27 26 25 24 2	23 22 21	20 1	9 18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		Page Direc	tory B	ise														P C D	P W T			
Reserved Symbol	Description	B	it																			
PCD PWT	Page Cache Disable Page Writethrough		<u>1</u> 3 —																			

#### Figure 22. Control Register 3 (CR3)



#### Figure 23. Control Register 2 (CR2)





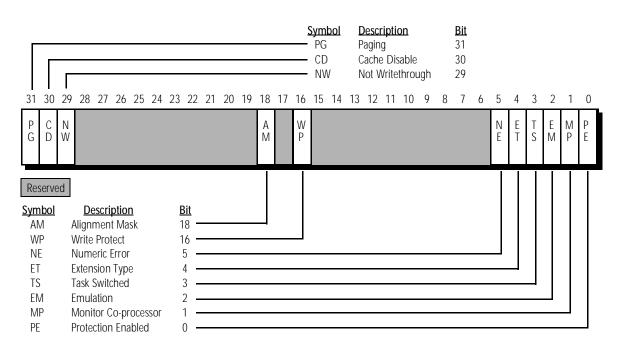
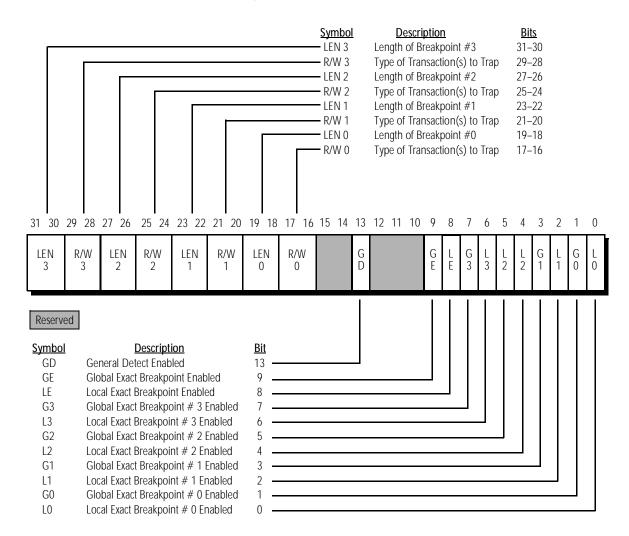
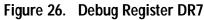
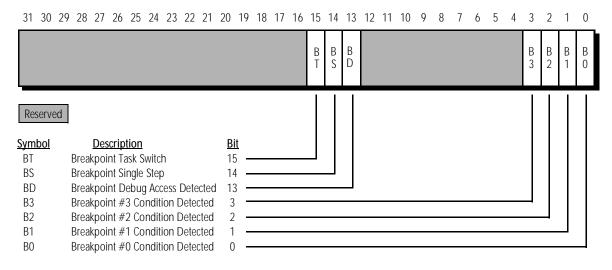


Figure 25. Control Register 0 (CR0)

# **Debug Registers** Figures 26 through 29 show the 32-bit debug registers supported by the processor.







#### Figure 27. Debug Register DR6

DR5

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Reserved

DR4

```
31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
```

Reserved

#### Figure 28. Debug Registers DR5 and DR4

DR3

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 3 32-bit Linear Address

DR2

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 2 32-bit Linear Address

DR1

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 1 32-bit Linear Address

DR0

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 0 32-bit Linear Address

Figure 29. Debug Registers DR3, DR2, DR1, and DR0

#### Model-Specific Registers (MSR)

The AMD-K6-2 processor Model 8/[7:0] provides seven MSRs. The value in the ECX register selects the MSR to be addressed by the RDMSR and WRMSR instructions. The values in EAX and EDX are used as inputs and outputs by the RDMSR and WRMSR instructions. Table 5 lists the MSRs and the corresponding value of the ECX register. Figures 30 through 36 show the MSR formats.

Table 5.	AMD-K6 <sup>®</sup> -2 Processor Model 8/[7:0] MSRs
----------	---

Model-Specific Register	Value of ECX
Machine Check Address Register (MCAR)	00h
Machine Check Type Register (MCTR)	01h
Test Register 12 (TR12)	0Eh
Time Stamp Counter (TSC)	10h
Extended Feature Enable Register (EFER)	C000_0080h
SYSCALL/SYSRET Target Address Register (STAR)	C000_0081h
Write Handling Control Register (WHCR)	C000_0082h

For more information about the RDMSR and WRMSR instructions, see the *AMD K86™ Family BIOS and Software Tools Development Guide*, order# 21062.

MCAR and MCTR. The AMD-K6-2 processor does not support the generation of a machine check exception. However, the processor does provide a 64-bit machine check address register (MCAR), a 64-bit machine check type register (MCTR), and a machine check enable (MCE) bit in CR4. Because the processor does not support machine check exceptions, the contents of the MCAR and MCTR are only affected by the WRMSR instruction and by RESET being sampled asserted (where all bits in each register are reset to 0).

63

MCAR

Figure 30. Machine-Check Address Register (MCAR)

0



Figure 31. Machine-Check Type Register (MCTR)

Test Register 12 (TR12). Test register 12 provides a method for disabling the L1 caches. Figure 32 shows the format of TR12.



#### Figure 32. Test Register 12 (TR12)

Time Stamp Counter. With each processor clock cycle, the processor increments the 64-bit time stamp counter (TSC) MSR. Figure 33 shows the format of the TSC.

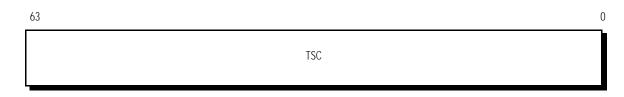


Figure 33. Time Stamp Counter (TSC)

**Extended Feature Enable Register (EFER)–Model 8**[7:0]. The extended feature enable register (EFER) contains the control bits that enable the extended features of the AMD-K6-2 processor. Figure 34 shows the format of the EFER register, and Table 6 defines the function of each bit in the EFER register.

**Note:** The EFER register as defined in the Model 8/[7:0] has changed in the Model 8/[F:8]. See "Extended Feature Enable Register (EFER)–Model 8/[F:8]" on page 50.

63				1	0	
				Reserved	S C E	
	<u>Symbol</u> SCE	Description System Call/Return Extension	<u>Bit</u> 0 —			

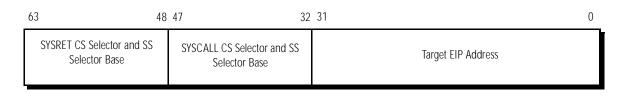
#### Figure 34. Extended Feature Enable Register (EFER)-Model 8[7:0]

Idble 0. Extended realure chable Register (CFER)-would of	Table 6.	Extended Feature Enable Register (EFER)–Model 8[7:0] Definit	tion
---	----------	--	------

Bit	Description	R/W
63–1	Reserved	R
0	System Call Extension (SCE)	R/W

#### SYSCALL/SYSRET Target Address Register (STAR).

The SYSCALL/SYSRET target address register (STAR) contains the target EIP address used by the SYSCALL instruction and the 16-bit code and stack segment selector bases used by the SYSCALL and SYSRET instructions. Figure 35 shows the format of the STAR register, and Table 7 on page 40 defines the function of each bit of the STAR register. For more information, see the SYSCALL and SYSRET Instruction Specification Application Note, order# 21086.



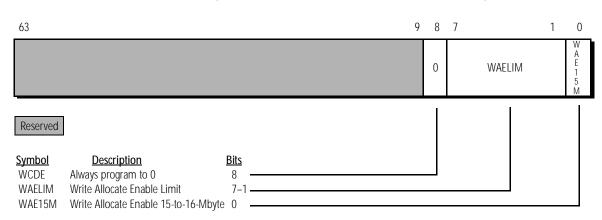
#### Figure 35. SYSCALL/SYSRET Target Address Register (STAR)

Table 7.	SYSCALL/SYSRET	<b>Target Address</b>	Register	(STAR) Definition
----------	----------------	-----------------------	----------	-------------------

Bit	Description	R/W
63–48	SYSRET CS and SS Selector Base	R/W
47–32	SYSCALL CS and SS Selector Base	R/W
31–0	Target EIP Address	R/W

Write Handling Control Register (WHCR)-Model 8/[7:0]. The write handling control register (WHCR) is a MSR that contains three fields—the WCDE bit, write allocate enable limit (WAELIM) field, and the write allocate enable 15-to-16-Mbyte (WAE15M) bit. Figure 36 shows the format of

WHCR. See "Write Allocate" on page 188 for more information.
Note: The WHCR register as defined in the Model 8/[7:0] has changed in the Model 8/[F:8]. See "Write Handling Control Register (WHCR)-Model 8/[F:8]" on page 51.



Note: Hardware RESET initializes this MSR to all zeros.

#### Figure 36. Write Handling Control Register (WHCR)-Model 8/[7:0]

MemoryThe AMD-K6-2 processor controls segmented memoryManagementmanagement with the registers listed in Table 8. Figure 37 onRegisterspage 41 shows the formats of these registers.

Register Name	Function
Global Descriptor Table Register	Contains a pointer to the base of the global descriptor table
Interrupt Descriptor Table Register	Contains a pointer to the base of the interrupt descriptor table
Local Descriptor Table Register	Contains a pointer to the local descriptor table of the current task
Task Register	Contains a pointer to the task state segment of the current task

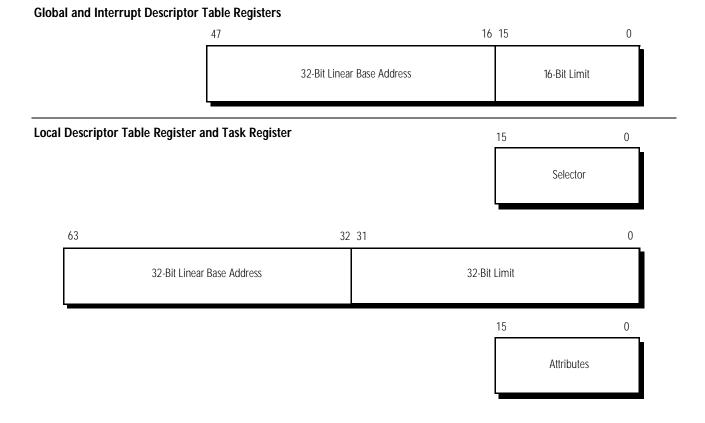


Figure 37. Memory Management Registers

#### Task State Segment

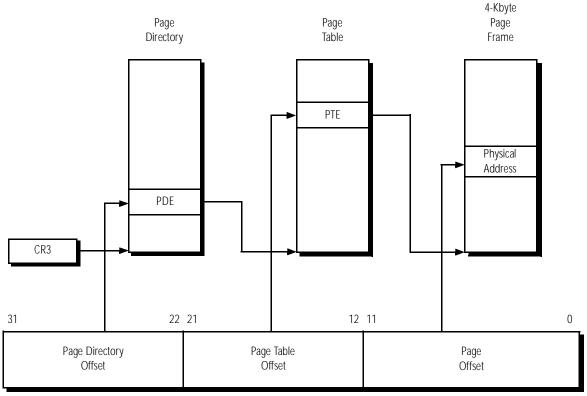
Figure 38 shows the format of the task state segment (TSS).

31		0	TSS Limit					
	I/O Permission Bitmap (IOPB) (up to 8 Kbytes)							
Interro	upt Redirection Bitmap (IRB) (eight 32-bit locations)							
L T	Operating System Data Structure	_	-					
Base Address of IOPB	0000h	T	( /h					
0000h	LDT Selector		64h					
0000h	GS							
0000h	FS							
0000h	DS							
0000h	SS							
0000h	CS							
0000h	ES							
	EDI							
	ESI							
	EBP							
	ESP							
	EBX							
	EDX ECX							
	EAX							
	EFLAGS							
	EIP							
	CR3							
0000h	SS2							
	ESP2							
0000h	SS1							
	ESP1							
0000h	SSO							
	ESPO							
0000h	Link (Prior TSS Selector)		0					

Figure 38. Task State Segment (TSS)

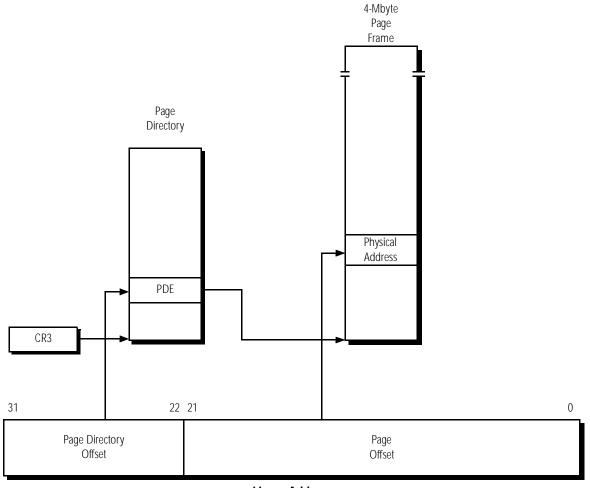
Paging

The AMD-K6-2 processor can physically address up to four Gbytes of memory. This memory can be segmented into pages. The size of these pages is determined by the operating system design and the values set up in the page directory entries (PDE) and page table entries (PTE). The processor can access both 4-Kbyte pages and 4-Mbyte pages, and the page sizes can be intermixed within a page directory. When the page size extension (PSE) bit in CR4 is set, the processor translates linear addresses using either the 4-Kbyte translation lookaside buffer (TLB) or the 4-Mbyte TLB, depending on the state of the page size (PS) bit in the page directory entry. Figures 39 and 40 show how 4-Kbyte and 4-Mbyte page translations work.



Linear Address

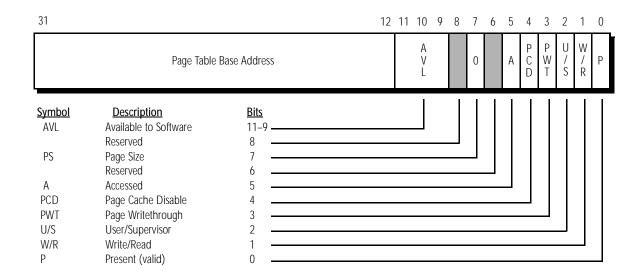
Figure 39. 4-Kbyte Paging Mechanism



Linear Address

Figure 40. 4-Mbyte Paging Mechanism

Figures 41 through 43 show the formats of the PDE and PTE. These entries contain information regarding the location of pages and their status.



#### Figure 41. Page Directory Entry 4-Kbyte Page Table (PDE)

31		22 21	12	11	10	9	8	7	6	5	4	3	2	1	0	
PI	hysical Page Base Address	Reserved			A V L			1		A	P C D	P W T	U / S	W / R	Ρ	
<mark>Symbol</mark> AVL PS	Description Available to Software Reserved Page Size Reserved	Bits 11-9 8														
A PCD PWT U/S W/R P	Accessed Page Cache Disable Page Writethrough User/Supervisor Write/Read Present (valid)	6 5 4 3 2 1 0														

#### Figure 42. Page Directory Entry 4-Mbyte Page Table (PDE)

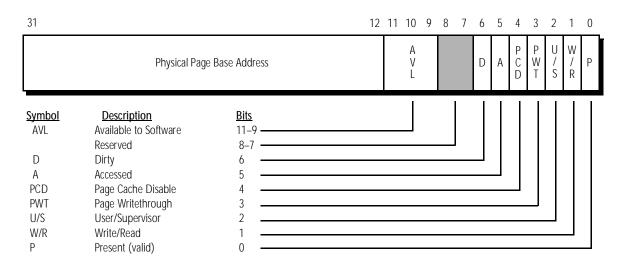


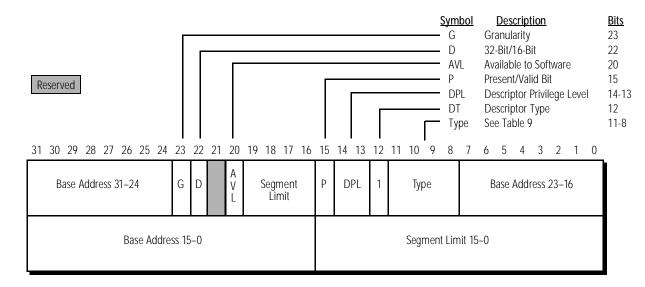
Figure 43. Page Table Entry (PTE)

**Descriptors and Gates** There are various types of structures and registers in the x86 architecture that define, protect, and isolate code segments, data segments, task state segments, and gates. These structures are called descriptors.

Figure 44 on page 47 shows the application segment descriptor format. Table 9 contains information describing the memory segment type to which the descriptor points. The application segment descriptor is used to point to either a data or code segment.

Figure 45 on page 48 shows the system segment descriptor format. Table 10 contains information describing the type of segment or gate to which the descriptor points. The system segment descriptor is used to point to a task state segment, a call gate, or a local descriptor table.

The AMD-K6-2 processor uses gates to transfer control between executable segments with different privilege levels. Figure 46 on page 49 shows the format of the gate descriptor types. Table 10 contains information describing the type of segment or gate to which the descriptor points.



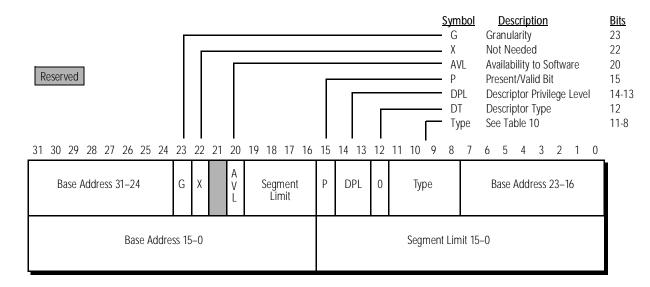
#### Figure 44. Application Segment Descriptor

Туре	Data/Code	Description	
0		Read-Only	
1		Read-Only-Accessed	
2		Read/Write	
3	- Data -	Read/Write-Accessed	
4		Read-Only-Expand-down	
5		Read-Only-Expand-down, Accessed	
6		Read/Write-Expand-down	
7		Read/Write-Expand-down, Accessed	
8		Execute-Only	
9	Code	Execute-Only-Accessed	
Α		Execute/Read	
В		Execute/Read-Accessed	
С		Execute-Only-Conforming	
D		Execute-Only-Conforming, Accessed	
E		Execute/Read-Only-Conforming	
F		Execute/Read-Only-Conforming, Accessed	

#### Table 9. Application Segment Types

AMD-K6<sup>®</sup>-2 Processor Data Sheet

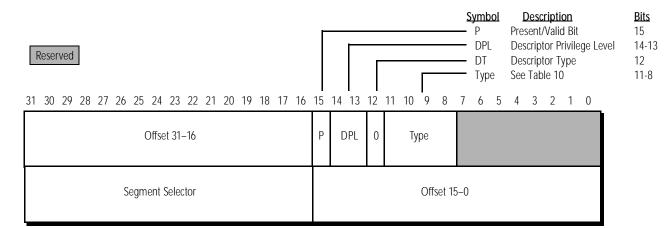
21850J/0-February 2000



#### Figure 45. System Segment Descriptor

Туре	Description
0	Reserved
1	Available 16-bit TSS
2	LDT
3	Busy 16-bit TSS
4	16-bit Call Gate
5	Task Gate
6	16-bit Interrupt Gate
7	16-bit Trap Gate
8	Reserved
9	Available 32-bit TSS
Α	Reserved
В	Busy 32-bit TSS
С	32-bit Call Gate
D	Reserved
E	32-bit Interrupt Gate
F	32-bit Trap Gate

#### Table 10. System Segment and Gate Types



#### Figure 46. Gate Descriptor

**Exceptions and** Table 11 summarizes the exceptions and interrupts. Interrupts

Table 11.	Summary of Exceptions and Interrupts
-----------	--------------------------------------

Interrupt Number	Interrupt Type	Cause	
0	Divide by Zero Error	DIV, IDIV	
1	Debug	Debug trap or fault	
2	Non-Maskable Interrupt	NMI signal sampled asserted	
3	Breakpoint	Int 3	
4	Overflow	INTO	
5	Bounds Check	BOUND	
6	Invalid Opcode	Invalid instruction	
7	Device Not Available	ESC and WAIT	
8	Double Fault	Fault occurs while handling a fault	
9	Reserved - Interrupt 13	-	
10	Invalid TSS	Task switch to an invalid segment	
11	Segment Not Present	Instruction loads a segment and present bit is 0 (invalid segment)	
12	Stack Segment	Stack operation causes limit violation or present bit is 0	
13	General Protection Segment related or miscellaneous invalid actions		
14	Page Fault         Page protection violation or a reference to missing page		
16	Floating-Point Error	Floating-Point Error Arithmetic error generated by floating-point instruction	
17	Alignment Check	Data reference to an unaligned operand. (The AC flag and the AM bit of CR0 are set to 1.)	
0–255	Software Interrupt	INT n	

## 3.2 AMD-K6<sup>®</sup>-2 Processor Model 8/[F:8] Registers

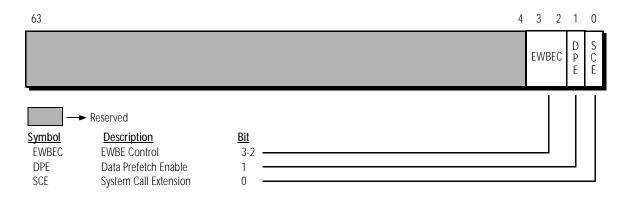
AMD-K6-2 processor Model 8/[F:8] implements the same seven MSRs as the Model 8/[7:0], but the bits and fields within the EFER and WHCR MSRs are not defined identically. Model 8/[F:8] also supports three additional MSRs: UWCCR, PSOR, and PFIR. For more information, see the *AMD-K6<sup>®</sup>* Processor BIOS Design Application Note, order# 21329. Table 12 lists the MSRs and the corresponding value of the ECX register.

Table 12. AMD-K6<sup>®</sup>-2 Processor Model 8/[F:8] MSRs

Model-Specific Register	Value of ECX
Machine Check Address Register (MCAR)	00h
Machine Check Type Register (MCTR)	01h
Test Register 12 (TR12)	0Eh
Time Stamp Counter (TSC)	10h
Extended Feature Enable Register (EFER)	C000_0080h
SYSCALL/SYSRET Target Address Register (STAR)	C000_0081h
Write Handling Control Register (WHCR)	C000_0082h
UC/WC Cacheability Control Register (UWCCR)	C000_0085h
Processor State Observability Register (PSOR)	C000_0087h
Page Flush/Invalidate Register (PFIR)	C000_0088h

Extended Feature Enable Register (EFER)–Model 8/[F:8] The Extended Feature Enable Register (EFER) contains the control bits that enable the extended features of the processor. Figure 47 shows the format of the EFER register, and Table 13 on page 51 defines the function of each bit of the EFER register.

**Note:** The EFER register as defined in the Model 8/[7:0] has changed in the Model 8/[F:8]. See "Extended Feature Enable Register (EFER)–Model 8[7:0]" on page 39.



#### Figure 47. Extended Feature Enable Register (EFER)-Model 8/[F:8]

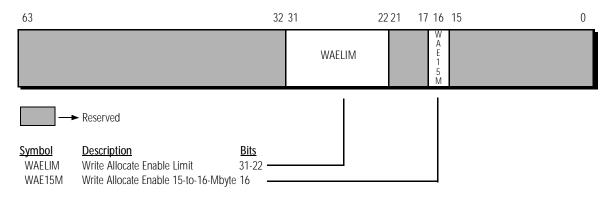
Table 13.	Extended Feature Enable Registe	er (EFEI	R)-Model 8/[F:8] Definition
Bit	Description	R/W	Function

Bit	Description	R/W	Function
63–4	Reserved	R	Writing a 1 to any reserved bit causes a general protection fault to occur. All reserved bits are always read as 0.
3-2	EWBE Control (EWBEC)	R/W	This 2-bit field controls the behavior of the processor with respect to the ordering of write cycles and the EWBE# signal. EFER[3] and EFER[2] are Global EWBE Disable (GEWBED) and Speculative EWBE Disable (SEWBED), respectively.
1	Data Prefetch Enable (DPE)	R/W	DPE must be set to 1 to enable data prefetching (this is the default setting following reset). If enabled, cache misses initiated by a memory read within a 32-byte cache line are conditionally followed by cache-line fetches of the other line in the 64-byte sector.
0	System Call Extension (SCE)	R/W	SCE must be set to 1 to enable the usage of the SYSCALL and SYSRET instructions.

For more information on EWBEC, see "EWBE Control" on page 203.

Write Handling Control Register (WHCR)–Model 8/[F:8] The Write Handling Control Register (WHCR) is a MSR that contains two fields—the Write Allocate Enable Limit (WAELIM) field, and the Write Allocate Enable 15-to-16-Mbyte (WAE15M) bit (see Figure 48). For more information, see "Write Allocate" on page 188.

**Note:** The WHCR register as defined in the Model 8/[7:0] has changed in the Model 8/[F:8]. See "Write Handling Control Register (WHCR)-Model 8/[7:0]" on page 40.



Note: Hardware RESET initializes this MSR to all zeros.

#### Figure 48. Write Handling Control Register (WHCR)-Model 8/[F:8]

UC/WC Cacheability<br/>Control Register<br/>(UWCCR)The AMD-K6-2 processor Model 8/[F:8] provides two variable-<br/>range Memory Type Range Registers (MTRRs)—MTRR0 and<br/>MTRR1—that each specify a range of memory. Each range can<br/>be defined as uncacheable (UC) or write-combining (WC)<br/>memory. For more detailed information on UWCCR, see<br/>"UC/WC Cacheability Control Register (UWCCR)" on page<br/>205.

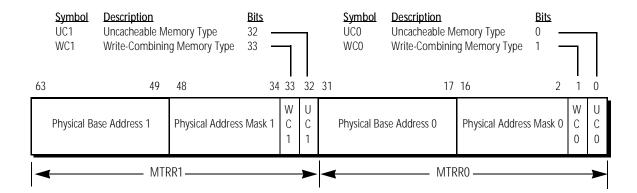


Figure 49. UC/WC Cacheability Control Register (UWCCR)

#### Processor State Observability Register (PSOR)

The AMD-K6-2 processor Model 8/[F:8] provides the Processor State Observability Register (PSOR) (see Figure 50).

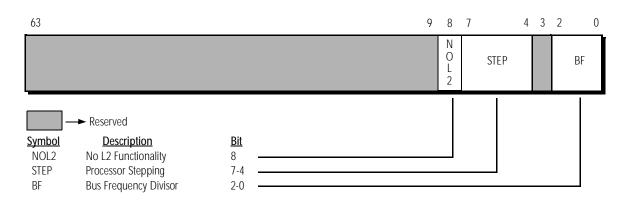


Figure 50. Processor State Observability Register (PSOR)

Page Flush/Invalidate<br/>Register (PFIR)The AMD-K6-2 processor Model 8/[F:8] contains the Page<br/>Flush/Invalidate Register (PFIR) (see Figure 51) that allows<br/>cache invalidation and optional flushing of a specific 4-Kbyte<br/>page from the linear address space. For more detailed<br/>information on PFIR, see "PFIR" on page 197.

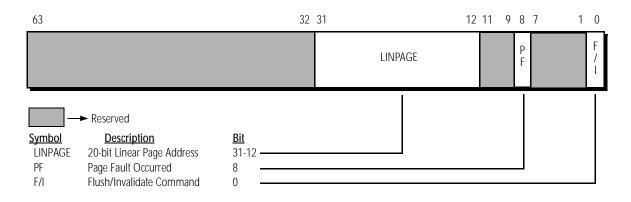


Figure 51. Page Flush/Invalidate Register (PFIR)

## 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 3.3 Instructions Supported by the AMD-K6<sup>®</sup>-2 Processor

This section documents all of the x86 instructions supported by the AMD-K6-2 processor. The following tables show the instruction mnemonic, opcode, modR/M byte, decode type, and RISC86 operation(s) for each instruction. Tables 14 through 17 define the integer, floating-point, MMX, and 3DNow! instructions for the AMD-K6-2 processor, respectively.

The first column in these tables indicates the instruction mnemonic and operand types with the following notations:

- *reg8*—byte integer register defined by instruction byte(s) or bits 5, 4, and 3 of the modR/M byte
- mreg8—byte integer register or byte integer value in memory defined by the modR/M byte
- *reg16/32*—word or doubleword integer register defined by instruction byte(s) or bits 5, 4, and 3 of the modR/M byte
- mreg16/32—word or doubleword integer register, or word or doubleword integer value in memory defined by the modR/M byte
- *mem8*—byte integer value in memory
- *mem16/32*—word or doubleword integer value in memory
- *mem32/48*—doubleword or 48-bit integer value in memory
- *mem48*—48-bit integer value in memory
- *mem64*—64-bit value in memory
- *imm8*—8-bit immediate value
- *imm16/32*—16-bit or 32-bit immediate value
- *disp8*—8-bit displacement value
- disp16/32—16-bit or 32-bit displacement value
- *disp32/48*—doubleword or 48-bit displacement value
- *eXX*—register width depending on the operand size
- *mem32real*—32-bit floating-point value in memory
- *mem64real*—64-bit floating-point value in memory
- *mem80real*—80-bit floating-point value in memory
- *mmreg*—MMX/3DNow! register
- *mmreg1*—MMX/3DNow! register defined by bits 5, 4, and 3 of the modR/M byte
- *mmreg2*—MMX/3DNow! register defined by bits 2, 1, and 0 of the modR/M byte

The second and third columns list all applicable opcode bytes.

The fourth column lists the modR/M byte when used by the instruction. The modR/M byte defines the instruction as a register or memory form. If modR/M bits 7 and 6 are documented as mm (memory form), mm can only be 10b, 01b or 00b.

The fifth column lists the type of instruction decode—short, long, and vector. The AMD-K6-2 processor decode logic can process two short, one long, or one vector decode per clock.

The sixth column lists the type of RISC86 operation(s) required for the instruction. The operation types and corresponding execution units are as follows:

- *load, fload, mload*—load unit
- *store, fstore, mstore*—store unit
- *alu*—either of the integer execution units
- *alux*—integer X execution unit only
- branch—branch condition unit
- *float*—floating-point execution unit
- *meu*—Multimedia execution units for MMX and 3DNow! instructions
- *limm*—load immediate, instruction control unit

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
ААА	37h			vector	
AAD	D5h	0Ah		vector	
AAM	D4h	0Ah		vector	
AAS	3Fh			vector	
ADC mreg8, reg8	10h		11-ххх-ххх	vector	
ADC mem8, reg8	10h		mm-xxx-xxx	vector	
ADC mreg16/32, reg16/32	11h		11-xxx-xxx	vector	
ADC mem16/32, reg16/32	11h		mm-xxx-xxx	vector	
ADC reg8, mreg8	12h		11-ххх-ххх	vector	
ADC reg8, mem8	12h		mm-xxx-xxx	vector	
ADC reg16/32, mreg16/32	13h		11-ххх-ххх	vector	
ADC reg16/32, mem16/32	13h		mm-xxx-xxx	vector	
ADC AL, imm8	14h			vector	

Table 14. Integer Instructions

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
ADC EAX, imm16/32	15h			vector	
ADC mreg8, imm8	80h		11-010-xxx	vector	
ADC mem8, imm8	80h		mm-010-xxx	vector	
ADC mreg16/32, imm16/32	81h		11-010-xxx	vector	
ADC mem16/32, imm16/32	81h		mm-010-xxx	vector	
ADC mreg16/32, imm8 (signed ext.)	83h		11-010-xxx	vector	
ADC mem16/32, imm8 (signed ext.)	83h		mm-010-xxx	vector	
ADD mreg8, reg8	00h		11-xxx-xxx	short	alux
ADD mem8, reg8	00h		mm-xxx-xxx	long	load, alux, store
ADD mreg16/32, reg16/32	01h		11-xxx-xxx	short	alu
ADD mem16/32, reg16/32	01h		mm-xxx-xxx	long	load, alu, store
ADD reg8, mreg8	02h		11-ххх-ххх	short	alux
ADD reg8, mem8	02h		mm-xxx-xxx	short	load, alux
ADD reg16/32, mreg16/32	03h		11-ххх-ххх	short	alu
ADD reg16/32, mem16/32	03h		mm-xxx-xxx	short	load, alu
ADD AL, imm8	04h			short	alux
ADD EAX, imm16/32	05h			short	alu
ADD mreg8, imm8	80h		11-000-ххх	short	alux
ADD mem8, imm8	80h		mm-000-xxx	long	load, alux, store
ADD mreg16/32, imm16/32	81h		11-000-ххх	short	alu
ADD mem16/32, imm16/32	81h		mm-000-xxx	long	load, alu, store
ADD mreg16/32, imm8 (signed ext.)	83h		11-000-ххх	short	alux
ADD mem16/32, imm8 (signed ext.)	83h		mm-000-xxx	long	load, alux, store
AND mreg8, reg8	20h		11-xxx-xxx	short	alux
AND mem8, reg8	20h		mm-xxx-xxx	long	load, alux, store
AND mreg16/32, reg16/32	21h		11-xxx-xxx	short	alu
AND mem16/32, reg16/32	21h		mm-xxx-xxx	long	load, alu, store
AND reg8, mreg8	22h		11-xxx-xxx	short	alux
AND reg8, mem8	22h		mm-xxx-xxx	short	load, alux
AND reg16/32, mreg16/32	23h		11-xxx-xxx	short	alu
AND reg16/32, mem16/32	23h		mm-xxx-xxx	short	load, alu
AND AL, imm8	24h			short	alux
AND EAX, imm16/32	25h			short	alu

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
AND mreg8, imm8	80h		11-100-xxx	short	alux
AND mem8, imm8	80h		mm-100-xxx	long	load, alux, store
AND mreg16/32, imm16/32	81h		11-100-xxx	short	alu
AND mem16/32, imm16/32	81h		mm-100-xxx	long	load, alu, store
AND mreg16/32, imm8 (signed ext.)	83h		11-100-xxx	short	alux
AND mem16/32, imm8 (signed ext.)	83h		mm-100-xxx	long	load, alux, store
ARPL mreg16, reg16	63h		11-xxx-xxx	vector	
ARPL mem16, reg16	63h		mm-xxx-xxx	vector	
BOUND	62h			vector	
BSF reg16/32, mreg16/32	0Fh	BCh	11-xxx-xxx	vector	
BSF reg16/32, mem16/32	0Fh	BCh	mm-xxx-xxx	vector	
BSR reg16/32, mreg16/32	0Fh	BDh	11-xxx-xxx	vector	
BSR reg16/32, mem16/32	0Fh	BDh	mm-xxx-xxx	vector	
BSWAP EAX	0Fh	C8h		long	alu
BSWAP ECX	0Fh	C9h		long	alu
BSWAP EDX	0Fh	CAh		long	alu
BSWAP EBX	0Fh	CBh		long	alu
BSWAP ESP	0Fh	CCh		long	alu
BSWAP EBP	0Fh	CDh		long	alu
BSWAP ESI	0Fh	CEh		long	alu
BSWAP EDI	0Fh	CFh		long	alu
BT mreg16/32, reg16/32	0Fh	A3h	11-xxx-xxx	vector	
BT mem16/32, reg16/32	0Fh	A3h	mm-xxx-xxx	vector	
BT mreg16/32, imm8	0Fh	BAh	11-100-xxx	vector	
BT mem16/32, imm8	0Fh	BAh	mm-100-xxx	vector	
BTC mreg16/32, reg16/32	0Fh	BBh	11-ххх-ххх	vector	
BTC mem16/32, reg16/32	0Fh	BBh	mm-xxx-xxx	vector	
BTC mreg16/32, imm8	0Fh	BAh	11-111-ххх	vector	
BTC mem16/32, imm8	0Fh	BAh	mm-111-xxx	vector	
BTR mreg16/32, reg16/32	0Fh	B3h	11-xxx-xxx	vector	
BTR mem16/32, reg16/32	0Fh	B3h	mm-xxx-xxx	vector	
BTR mreg16/32, imm8	0Fh	BAh	11-110-ххх	vector	
BTR mem16/32, imm8	0Fh	BAh	mm-110-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
BTS mreg16/32, reg16/32	0Fh	ABh	11-xxx-xxx	vector	-
BTS mem16/32, reg16/32	0Fh	ABh	mm-xxx-xxx	vector	
BTS mreg16/32, imm8	0Fh	BAh	11-101-xxx	vector	
BTS mem16/32, imm8	0Fh	BAh	mm-101-xxx	vector	
CALL full pointer	9Ah			vector	
CALL near imm16/32	E8h			short	store
CALL mem16:16/32	FFh		11-011-ххх	vector	
CALL near mreg32 (indirect)	FFh		11-010-xxx	vector	
CALL near mem32 (indirect)	FFh		mm-010-xxx	vector	
CBW/CWDE EAX	98h			vector	
CLC	F8h			vector	
CLD	FCh			vector	
CLI	FAh			vector	
CLTS	0Fh	06h		vector	
СМС	F5h			vector	
CMP mreg8, reg8	38h		11-xxx-xxx	short	alux
CMP mem8, reg8	38h		mm-xxx-xxx	short	load, alux
CMP mreg16/32, reg16/32	39h		11-ххх-ххх	short	alu
CMP mem16/32, reg16/32	39h		mm-xxx-xxx	short	load, alu
CMP reg8, mreg8	3Ah		11-xxx-xxx	short	alux
CMP reg8, mem8	3Ah		mm-xxx-xxx	short	load, alux
CMP reg16/32, mreg16/32	3Bh		11-ххх-ххх	short	alu
CMP reg16/32, mem16/32	3Bh		mm-xxx-xxx	short	load, alu
CMP AL, imm8	3Ch			short	alux
CMP EAX, imm16/32	3Dh			short	alu
CMP mreg8, imm8	80h		11-111-xxx	short	alux
CMP mem8, imm8	80h		mm-111-xxx	short	load, alux
CMP mreg16/32, imm16/32	81h		11-111-ххх	short	alu
CMP mem16/32, imm16/32	81h		mm-111-xxx	short	load, alu
CMP mreg16/32, imm8 (signed ext.)	83h		11-111-xxx	long	load, alu
CMP mem16/32, imm8 (signed ext.)	83h		mm-111-xxx	long	load, alu
CMPSB mem8, mem8	A6h			vector	
CMPSW mem16, mem32	A7h			vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
CMPSD mem32, mem32	A7h	_		vector	
CMPXCHG mreg8, reg8	0Fh	B0h	11-xxx-xxx	vector	
CMPXCHG mem8, reg8	0Fh	B0h	mm-xxx-xxx	vector	
CMPXCHG mreg16/32, reg16/32	0Fh	B1h	11-ххх-ххх	vector	
CMPXCHG mem16/32, reg16/32	0Fh	B1h	mm-xxx-xxx	vector	
CMPXCHG8B EDX:EAX	0Fh	C7h	11-ххх-ххх	vector	
CMPXCHG8B mem64	0Fh	C7h	mm-xxx-xxx	vector	
CPUID	0Fh	A2h		vector	
CWD/CDQ EDX, EAX	99h			vector	
DAA	27h			vector	
DAS	2Fh			vector	
DEC EAX	48h			short	alu
DEC ECX	49h			short	alu
DEC EDX	4Ah			short	alu
DEC EBX	4Bh			short	alu
DEC ESP	4Ch			short	alu
DEC EBP	4Dh			short	alu
DEC ESI	4Eh			short	alu
DEC EDI	4Fh			short	alu
DEC mreg8	FEh		11-001-ххх	vector	
DEC mem8	FEh		mm-001-xxx	long	load, alux, store
DEC mreg16/32	FFh		11-001-xxx	vector	
DEC mem16/32	FFh		mm-001-xxx	long	load, alu, store
DIV AL, mreg8	F6h		11-110-ххх	vector	
DIV AL, mem8	F6h		mm-110-xxx	vector	
DIV EAX, mreg16/32	F7h		11-110-ххх	vector	
DIV EAX, mem16/32	F7h		mm-110-xxx	vector	
IDIV mreg8	F6h		11-111-ххх	vector	
IDIV mem8	F6h		mm-111-xxx	vector	
IDIV EAX, mreg16/32	F7h		11-111-ххх	vector	
IDIV EAX, mem16/32	F7h		mm-111-xxx	vector	
IMUL reg16/32, imm16/32	69h		11-ххх-ххх	vector	
IMUL reg16/32, mreg16/32, imm16/32	69h		11-ххх-ххх	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
IMUL reg16/32, mem16/32, imm16/32	69h		mm-xxx-xxx	vector	
IMUL reg16/32, imm8 (sign extended)	6Bh		11-xxx-xxx	vector	
IMUL reg16/32, mreg16/32, imm8 (signed)	6Bh		11-xxx-xxx	vector	
IMUL reg16/32, mem16/32, imm8 (signed)	6Bh		mm-xxx-xxx	vector	
IMUL AX, AL, mreg8	F6h		11-101-xxx	vector	
IMUL AX, AL, mem8	F6h		mm-101-xxx	vector	
IMUL EDX:EAX, EAX, mreg16/32	F7h		11-101-xxx	vector	
IMUL EDX:EAX, EAX, mem16/32	F7h		mm-101-xxx	vector	
IMUL reg16/32, mreg16/32	0Fh	AFh	11-xxx-xxx	vector	
IMUL reg16/32, mem16/32	0Fh	AFh	mm-xxx-xxx	vector	
IN AL, imm8	E4h			vector	
IN AX, imm8	E5h			vector	
IN EAX, imm8	E5h			vector	
IN AL, DX	ECh			vector	
IN AX, DX	EDh			vector	
IN EAX, DX	EDh			vector	
INC EAX	40h			short	alu
INC ECX	41h			short	alu
INC EDX	42h			short	alu
INC EBX	43h			short	alu
INC ESP	44h			short	alu
INC EBP	45h			short	alu
INC ESI	46h			short	alu
INC EDI	47h			short	alu
INC mreg8	FEh		11-000-ххх	vector	
INC mem8	FEh		mm-000-xxx	long	load, alux, store
INC mreg16/32	FFh		11-000-xxx	vector	
INC mem16/32	FFh		mm-000-xxx	long	load, alu, store
INVD	0Fh	08h		vector	
INVLPG	0Fh	01h	mm-111-xxx	vector	
JO short disp8	70h			short	branch
JB/JNAE short disp8	71h			short	branch

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
JNO short disp8	71h			short	branch
JNB/JAE short disp8	73h			short	branch
JZ/JE short disp8	74h			short	branch
JNZ/JNE short disp8	75h			short	branch
JBE/JNA short disp8	76h			short	branch
JNBE/JA short disp8	77h			short	branch
JS short disp8	78h			short	branch
JNS short disp8	79h			short	branch
JP/JPE short disp8	7Ah			short	branch
JNP/JPO short disp8	7Bh			short	branch
JL/JNGE short disp8	7Ch			short	branch
JNL/JGE short disp8	7Dh			short	branch
JLE/JNG short disp8	7Eh			short	branch
JNLE/JG short disp8	7Fh			short	branch
JCXZ/JEC short disp8	E3h			vector	
JO near disp16/32	0Fh	80h		short	branch
JNO near disp16/32	0Fh	81h		short	branch
JB/JNAE near disp16/32	0Fh	82h		short	branch
JNB/JAE near disp16/32	0Fh	83h		short	branch
JZ/JE near disp16/32	0Fh	84h		short	branch
JNZ/JNE near disp16/32	0Fh	85h		short	branch
JBE/JNA near disp16/32	0Fh	86h		short	branch
JNBE/JA near disp16/32	0Fh	87h		short	branch
JS near disp16/32	0Fh	88h		short	branch
JNS near disp16/32	0Fh	89h		short	branch
JP/JPE near disp16/32	0Fh	8Ah		short	branch
JNP/JPO near disp16/32	0Fh	8Bh		short	branch
JL/JNGE near disp16/32	0Fh	8Ch		short	branch
JNL/JGE near disp16/32	0Fh	8Dh		short	branch
JLE/JNG near disp16/32	0Fh	8Eh		short	branch
JNLE/JG near disp16/32	0Fh	8Fh		short	branch
JMP near disp16/32 (direct)	E9h			short	branch
JMP far disp32/48 (direct)	EAh			vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
JMP disp8 (short)	EBh	5		short	branch
JMP far mreg32 (indirect)	EFh		11-101-xxx	vector	
JMP far mem32 (indirect)	EFh		mm-101-xxx	vector	
JMP near mreg16/32 (indirect)	FFh		11-100-xxx	vector	
JMP near mem16/32 (indirect)	FFh		mm-100-xxx	vector	
LAHF	9Fh			vector	
LAR reg16/32, mreg16/32	0Fh	02h	11-xxx-xxx	vector	
LAR reg16/32, mem16/32	0Fh	02h	mm-xxx-xxx	vector	
LDS reg16/32, mem32/48	C5h		mm-xxx-xxx	vector	
LEA reg16/32, mem16/32	8Dh		mm-xxx-xxx	short	load, alu
LEAVE	C9h			long	load, alu, alu
LES reg16/32, mem32/48	C4h		mm-xxx-xxx	vector	
LFS reg16/32, mem32/48	0Fh	B4h		vector	
LGDT mem48	0Fh	01h	mm-010-xxx	vector	
LGS reg16/32, mem32/48	0Fh	B5h		vector	
LIDT mem48	0Fh	01h	mm-011-xxx	vector	
LLDT mreg16	0Fh	00h	11-010-xxx	vector	
LLDT mem16	0Fh	00h	mm-010-xxx	vector	
LMSW mreg16	0Fh	01h	11-100-xxx	vector	
LMSW mem16	0Fh	01h	mm-100-xxx	vector	
LODSB AL, mem8	ACh			long	load, alu
LODSW AX, mem16	ADh			long	load, alu
LODSD EAX, mem32	ADh			long	load, alu
LOOP disp8	E2h			short	alu, branch
LOOPE/LOOPZ disp8	E1h			vector	
LOOPNE/LOOPNZ disp8	E0h			vector	
LSL reg16/32, mreg16/32	0Fh	03h	11-ххх-ххх	vector	
LSL reg16/32, mem16/32	0Fh	03h	mm-xxx-xxx	vector	
LSS reg16/32, mem32/48	0Fh	B2h	mm-xxx-xxx	vector	
LTR mreg16	0Fh	00h	11-011-ххх	vector	
LTR mem16	0Fh	00h	mm-011-xxx	vector	
MOV mreg8, reg8	88h		11-xxx-xxx	short	alux
MOV mem8, reg8	88h		mm-xxx-xxx	short	store

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
MOV mreg16/32, reg16/32	89h	-	11-xxx-xxx	short	alu
MOV mem16/32, reg16/32	89h		mm-xxx-xxx	short	store
MOV reg8, mreg8	8Ah		11-xxx-xxx	short	alux
MOV reg8, mem8	8Ah		mm-xxx-xxx	short	load
MOV reg16/32, mreg16/32	8Bh		11-ххх-ххх	short	alu
MOV reg16/32, mem16/32	8Bh		mm-xxx-xxx	short	load
MOV mreg16, segment reg	8Ch		11-xxx-xxx	long	load
MOV mem16, segment reg	8Ch		mm-xxx-xxx	vector	
MOV segment reg, mreg16	8Eh		11-ххх-ххх	vector	
MOV segment reg, mem16	8Eh		mm-xxx-xxx	vector	
MOV AL, mem8	A0h			short	load
MOV EAX, mem16/32	A1h			short	load
MOV mem8, AL	A2h			short	store
MOV mem16/32, EAX	A3h			short	store
MOV AL, imm8	B0h			short	limm
MOV CL, imm8	B1h			short	limm
MOV DL, imm8	B2h			short	limm
MOV BL, imm8	B3h			short	limm
MOV AH, imm8	B4h			short	limm
MOV CH, imm8	B5h			short	limm
MOV DH, imm8	B6h			short	limm
MOV BH, imm8	B7h			short	limm
MOV EAX, imm16/32	B8h			short	limm
MOV ECX, imm16/32	B9h			short	limm
MOV EDX, imm16/32	BAh			short	limm
MOV EBX, imm16/32	BBh			short	limm
MOV ESP, imm16/32	BCh			short	limm
MOV EBP, imm16/32	BDh			short	limm
MOV ESI, imm16/32	BEh			short	limm
MOV EDI, imm16/32	BFh			short	limm
MOV mreg8, imm8	C6h		11-000-ххх	short	limm
MOV mem8, imm8	C6h		mm-000-xxx	long	store
MOV mreg16/32, imm16/32	C7h		11-000-xxx	short	limm

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
MOV mem16/32, imm16/32	C7h	-	mm-000-xxx	long	store
MOV reg32, CR0	0Fh	20h	11-000-xxx	vector	
MOV reg32, CR2	0Fh	20h	11-010-xxx	vector	
MOV reg32, CR3	0Fh	20h	11-011-ххх	vector	
MOV reg32, CR4	0Fh	20h	11-100-ххх	vector	
MOV CR0, reg32	0Fh	22h	11-000-xxx	vector	
MOV CR2, reg32	0Fh	22h	11-010-xxx	vector	
MOV CR3, reg32	0Fh	22h	11-011-ххх	vector	
MOV CR4, reg32	0Fh	22h	11-100-ххх	vector	
MOVSB mem8,mem8	A4h			long	load, store, alux, alux
MOVSD mem16, mem16	A5h			long	load, store, alu, alu
MOVSW mem32, mem32	A5h			long	load, store, alu, alu
MOVSX reg16/32, mreg8	0Fh	BEh	11-ххх-ххх	short	alu
MOVSX reg16/32, mem8	0Fh	BEh	mm-xxx-xxx	short	load, alu
MOVSX reg32, mreg16	0Fh	BFh	11-ххх-ххх	short	alu
MOVSX reg32, mem16	0Fh	BFh	mm-xxx-xxx	short	load, alu
MOVZX reg16/32, mreg8	0Fh	B6h	11-ххх-ххх	short	alu
MOVZX reg16/32, mem8	0Fh	B6h	mm-xxx-xxx	short	load, alu
MOVZX reg32, mreg16	0Fh	B7h	11-xxx-xxx	short	alu
MOVZX reg32, mem16	0Fh	B7h	mm-xxx-xxx	short	load, alu
MUL AL, mreg8	F6h		11-100-xxx	vector	
MUL AL, mem8	F6h		mm-100-xxx	vector	
MUL EAX, mreg16/32	F7h		11-100-xxx	vector	
MUL EAX, mem16/32	F7h		mm-100-xxx	vector	
NEG mreg8	F6h		11-011-xxx	short	alux
NEG mem8	F6h		mm-011-xxx	vector	
NEG mreg16/32	F7h		11-011-xxx	short	alu
NEG mem16/32	F7h		mm-011-xxx	vector	
NOP (XCHG EAX, EAX)	90h			short	limm
NOT mreg8	F6h		11-010-xxx	short	alux
NOT mem8	F6h		mm-010-xxx	vector	
NOT mreg16/32	F7h		11-010-xxx	short	alu
NOT mem16/32	F7h		mm-010-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
OR mreg8, reg8	08h		11-xxx-xxx	short	alux
OR mem8, reg8	08h		mm-xxx-xxx	long	load, alux, store
OR mreg16/32, reg16/32	09h		11-ххх-ххх	short	alu
OR mem16/32, reg16/32	09h		mm-xxx-xxx	long	load, alu, store
OR reg8, mreg8	0Ah		11-xxx-xxx	short	alux
OR reg8, mem8	0Ah		mm-xxx-xxx	short	load, alux
OR reg16/32, mreg16/32	0Bh		11-xxx-xxx	short	alu
OR reg16/32, mem16/32	0Bh		mm-xxx-xxx	short	load, alu
OR AL, imm8	0Ch			short	alux
OR EAX, imm16/32	0Dh			short	alu
OR mreg8, imm8	80h		11-001-ххх	short	alux
OR mem8, imm8	80h		mm-001-xxx	long	load, alux, store
OR mreg16/32, imm16/32	81h		11-001-ххх	short	alu
OR mem16/32, imm16/32	81h		mm-001-xxx	long	load, alu, store
OR mreg16/32, imm8 (signed ext.)	83h		11-001-ххх	short	alux
OR mem16/32, imm8 (signed ext.)	83h		mm-001-xxx	long	load, alux, store
OUT imm8, AL	E6h			vector	
OUT imm8, AX	E7h			vector	
OUT imm8, EAX	E7h			vector	
OUT DX, AL	EEh			vector	
OUT DX, AX	EFh			vector	
OUT DX, EAX	EFh			vector	
POP ES	07h			vector	
POP SS	17h			vector	
POP DS	1Fh			vector	
POP FS	0Fh	A1h		vector	
POP GS	0Fh	A9h		vector	
POP EAX	58h			short	load, alu
POP ECX	59h			short	load, alu
POP EDX	5Ah			short	load, alu
POP EBX	5Bh			short	load, alu
POP ESP	5Ch			short	load, alu
POP EBP	5Dh			short	load, alu

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
POP ESI	5Eh			short	load, alu
POP EDI	5Fh			short	load, alu
POP mreg 16/32	8Fh		11-000-xxx	short	load, alu
POP mem 16/32	8Fh		mm-000-xxx	long	load, store, alu
POPA/POPAD	61h			vector	
POPF/POPFD	9Dh			vector	
PUSH ES	06h			long	load, store
PUSH CS	0Eh			vector	
PUSH FS	0Fh	A0h		vector	
PUSH GS	0Fh	A8h		vector	
PUSH SS	16h			vector	
PUSH DS	1Eh			long	load, store
PUSH EAX	50h			short	store
PUSH ECX	51h			short	store
PUSH EDX	52h			short	store
PUSH EBX	53h			short	store
PUSH ESP	54h			short	store
PUSH EBP	55h			short	store
PUSH ESI	56h			short	store
PUSH EDI	57h			short	store
PUSH imm8	6Ah			long	store
PUSH imm16/32	68h			long	store
PUSH mreg16/32	FFh		11-110-xxx	vector	
PUSH mem16/32	FFh		mm-110-xxx	long	load, store
PUSHA/PUSHAD	60h			vector	
PUSHF/PUSHFD	9Ch			vector	
RCL mreg8, imm8	C0h		11-010-xxx	vector	
RCL mem8, imm8	C0h		mm-010-xxx	vector	
RCL mreg16/32, imm8	C1h		11-010-xxx	vector	
RCL mem16/32, imm8	C1h		mm-010-xxx	vector	
RCL mreg8, 1	D0h		11-010-xxx	vector	
RCL mem8, 1	D0h		mm-010-xxx	vector	
RCL mreg16/32, 1	D1h		11-010-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
RCL mem16/32, 1	D1h		mm-010-xxx	vector	
RCL mreg8, CL	D2h		11-010-xxx	vector	
RCL mem8, CL	D2h		mm-010-xxx	vector	
RCL mreg16/32, CL	D3h		11-010-xxx	vector	
RCL mem16/32, CL	D3h		mm-010-xxx	vector	
RCR mreg8, imm8	C0h		11-011-xxx	vector	
RCR mem8, imm8	C0h		mm-011-xxx	vector	
RCR mreg16/32, imm8	C1h		11-011-xxx	vector	
RCR mem16/32, imm8	C1h		mm-011-xxx	vector	
RCR mreg8, 1	D0h		11-011-xxx	vector	
RCR mem8, 1	D0h		mm-011-xxx	vector	
RCR mreg16/32, 1	D1h		11-011-xxx	vector	
RCR mem16/32, 1	D1h		mm-011-xxx	vector	
RCR mreg8, CL	D2h		11-011-xxx	vector	
RCR mem8, CL	D2h		mm-011-xxx	vector	
RCR mreg16/32, CL	D3h		11-011-xxx	vector	
RCR mem16/32, CL	D3h		mm-011-xxx	vector	
RDMSR	0Fh	32h		vector	
RDTSC	0Fh	31h		vector	
RET near imm16	C2h			vector	
RET near	C3h			vector	
RET far imm 16	CAh			vector	
RET far	CBh			vector	
ROL mreg8, imm8	C0h		11-000-xxx	vector	
ROL mem8, imm8	C0h		mm-000-xxx	vector	
ROL mreg16/32, imm8	C1h		11-000-ххх	vector	
ROL mem16/32, imm8	C1h		mm-000-xxx	vector	
ROL mreg8, 1	D0h		11-000-xxx	vector	
ROL mem8, 1	D0h		mm-000-xxx	vector	
ROL mreg16/32, 1	D1h		11-000-xxx	vector	
ROL mem16/32, 1	D1h		mm-000-xxx	vector	
ROL mreg8, CL	D2h		11-000-xxx	vector	
ROL mem8, CL	D2h		mm-000-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
ROL mreg16/32, CL	D3h	,	11-000-xxx	vector	
ROL mem16/32, CL	D3h		mm-000-xxx	vector	
ROR mreg8, imm8	C0h		11-001-xxx	vector	
ROR mem8, imm8	C0h		mm-001-xxx	vector	
ROR mreg16/32, imm8	C1h		11-001-xxx	vector	
ROR mem16/32, imm8	C1h		mm-001-xxx	vector	
ROR mreg8, 1	D0h		11-001-xxx	vector	
ROR mem8, 1	D0h		mm-001-xxx	vector	
ROR mreg16/32, 1	D1h		11-001-ххх	vector	
ROR mem16/32, 1	D1h		mm-001-xxx	vector	
ROR mreg8, CL	D2h		11-001-xxx	vector	
ROR mem8, CL	D2h		mm-001-xxx	vector	
ROR mreg16/32, CL	D3h		11-001-xxx	vector	
ROR mem16/32, CL	D3h		mm-001-xxx	vector	
RSM	0Fh	AAh		vector	
SAHF	9Eh			vector	
SAR mreg8, imm8	C0h		11-111-ххх	short	alux
SAR mem8, imm8	C0h		mm-111-xxx	vector	
SAR mreg16/32, imm8	C1h		11-111-ххх	short	alu
SAR mem16/32, imm8	C1h		mm-111-xxx	vector	
SAR mreg8, 1	D0h		11-111-ххх	short	alux
SAR mem8, 1	D0h		mm-111-xxx	vector	
SAR mreg16/32, 1	D1h		11-111-ххх	short	alu
SAR mem16/32, 1	D1h		mm-111-xxx	vector	
SAR mreg8, CL	D2h		11-111-ххх	short	alux
SAR mem8, CL	D2h		mm-111-xxx	vector	
SAR mreg16/32, CL	D3h		11-111-ххх	short	alu
SAR mem16/32, CL	D3h		mm-111-xxx	vector	
SBB mreg8, reg8	18h		11-xxx-xxx	vector	
SBB mem8, reg8	18h		mm-xxx-xxx	vector	
SBB mreg16/32, reg16/32	19h		11-xxx-xxx	vector	
SBB mem16/32, reg16/32	19h		mm-xxx-xxx	vector	
SBB reg8, mreg8	1Ah		11-xxx-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
SBB reg8, mem8	1Ah	-	mm-xxx-xxx	vector	-
SBB reg16/32, mreg16/32	1Bh		11-xxx-xxx	vector	
SBB reg16/32, mem16/32	1Bh		mm-xxx-xxx	vector	
SBB AL, imm8	1Ch			vector	
SBB EAX, imm16/32	1Dh			vector	
SBB mreg8, imm8	80h		11-011-ххх	vector	
SBB mem8, imm8	80h		mm-011-xxx	vector	
SBB mreg16/32, imm16/32	81h		11-011-ххх	vector	
SBB mem16/32, imm16/32	81h		mm-011-xxx	vector	
SBB mreg16/32, imm8 (signed ext.)	83h		11-011-ххх	vector	
SBB mem16/32, imm8 (signed ext.)	83h		mm-011-xxx	vector	
SCASB AL, mem8	AEh			vector	
SCASW AX, mem16	AFh			vector	
SCASD EAX, mem32	AFh			vector	
SETO mreg8	0Fh	90h	11-xxx-xxx	vector	
SETO mem8	0Fh	90h	mm-xxx-xxx	vector	
SETNO mreg8	0Fh	91h	11-ххх-ххх	vector	
SETNO mem8	0Fh	91h	mm-xxx-xxx	vector	
SETB/SETNAE mreg8	0Fh	92h	11-xxx-xxx	vector	
SETB/SETNAE mem8	0Fh	92h	mm-xxx-xxx	vector	
SETNB/SETAE mreg8	0Fh	93h	11-xxx-xxx	vector	
SETNB/SETAE mem8	0Fh	93h	mm-xxx-xxx	vector	
SETZ/SETE mreg8	0Fh	94h	11-ххх-ххх	vector	
SETZ/SETE mem8	0Fh	94h	mm-xxx-xxx	vector	
SETNZ/SETNE mreg8	0Fh	95h	11-ххх-ххх	vector	
SETNZ/SETNE mem8	0Fh	95h	mm-xxx-xxx	vector	
SETBE/SETNA mreg8	0Fh	96h	11-xxx-xxx	vector	
SETBE/SETNA mem8	0Fh	96h	mm-xxx-xxx	vector	
SETNBE/SETA mreg8	0Fh	97h	11-xxx-xxx	vector	
SETNBE/SETA mem8	0Fh	97h	mm-xxx-xxx	vector	
SETS mreg8	0Fh	98h	11-xxx-xxx	vector	
SETS mem8	0Fh	98h	mm-xxx-xxx	vector	
SETNS mreg8	0Fh	99h	11-xxx-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
SETNS mem8	0Fh	99h	mm-xxx-xxx	vector	
SETP/SETPE mreg8	0Fh	9Ah	11-xxx-xxx	vector	
SETP/SETPE mem8	0Fh	9Ah	mm-xxx-xxx	vector	
SETNP/SETPO mreg8	0Fh	9Bh	11-xxx-xxx	vector	
SETNP/SETPO mem8	0Fh	9Bh	mm-xxx-xxx	vector	
SETL/SETNGE mreg8	0Fh	9Ch	11-xxx-xxx	vector	
SETL/SETNGE mem8	0Fh	9Ch	mm-xxx-xxx	vector	
SETNL/SETGE mreg8	0Fh	9Dh	11-xxx-xxx	vector	
SETNL/SETGE mem8	0Fh	9Dh	mm-xxx-xxx	vector	
SETLE/SETNG mreg8	0Fh	9Eh	11-xxx-xxx	vector	
SETLE/SETNG mem8	0Fh	9Eh	mm-xxx-xxx	vector	
SETNLE/SETG mreg8	0Fh	9Fh	11-ххх-ххх	vector	
SETNLE/SETG mem8	0Fh	9Fh	mm-xxx-xxx	vector	
SGDT mem48	0Fh	01h	mm-000-xxx	vector	
SIDT mem48	0Fh	01h	mm-001-xxx	vector	
SHL/SAL mreg8, imm8	C0h		11-100-xxx	short	alux
SHL/SAL mem8, imm8	C0h		mm-100-xxx	vector	
SHL/SAL mreg16/32, imm8	C1h		11-100-xxx	short	alu
SHL/SAL mem16/32, imm8	C1h		mm-100-xxx	vector	
SHL/SAL mreg8, 1	D0h		11-100-xxx	short	alux
SHL/SAL mem8, 1	D0h		mm-100-xxx	vector	
SHL/SAL mreg16/32, 1	D1h		11-100-ххх	short	alu
SHL/SAL mem16/32, 1	D1h		mm-100-xxx	vector	
SHL/SAL mreg8, CL	D2h		11-100-xxx	short	alux
SHL/SAL mem8, CL	D2h		mm-100-xxx	vector	
SHL/SAL mreg16/32, CL	D3h		11-100-xxx	short	alu
SHL/SAL mem16/32, CL	D3h		mm-100-xxx	vector	
SHR mreg8, imm8	C0h		11-101-xxx	short	alux
SHR mem8, imm8	C0h		mm-101-xxx	vector	
SHR mreg16/32, imm8	C1h		11-101-xxx	short	alu
SHR mem16/32, imm8	C1h		mm-101-xxx	vector	
SHR mreg8, 1	D0h		11-101-xxx	short	alux
SHR mem8, 1	D0h		mm-101-xxx	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
SHR mreg16/32, 1	D1h		11-101-xxx	short	alu
SHR mem16/32, 1	D1h		mm-101-xxx	vector	
SHR mreg8, CL	D2h		11-101-xxx	short	alux
SHR mem8, CL	D2h		mm-101-xxx	vector	
SHR mreg16/32, CL	D3h		11-101-xxx	short	alu
SHR mem16/32, CL	D3h		mm-101-xxx	vector	
SHLD mreg16/32, reg16/32, imm8	0Fh	A4h	11-xxx-xxx	vector	
SHLD mem16/32, reg16/32, imm8	0Fh	A4h	mm-xxx-xxx	vector	
SHLD mreg16/32, reg16/32, CL	0Fh	A5h	11-xxx-xxx	vector	
SHLD mem16/32, reg16/32, CL	0Fh	A5h	mm-xxx-xxx	vector	
SHRD mreg16/32, reg16/32, imm8	0Fh	ACh	11-xxx-xxx	vector	
SHRD mem16/32, reg16/32, imm8	0Fh	ACh	mm-xxx-xxx	vector	
SHRD mreg16/32, reg16/32, CL	0Fh	ADh	11-xxx-xxx	vector	
SHRD mem16/32, reg16/32, CL	0Fh	ADh	mm-xxx-xxx	vector	
SLDT mreg16	0Fh	00h	11-000-ххх	vector	
SLDT mem16	0Fh	00h	mm-000-xxx	vector	
SMSW mreg16	0Fh	01h	11-100-xxx	vector	
SMSW mem16	0Fh	01h	mm-100-xxx	vector	
STC	F9h			vector	
STD	FDh			vector	
STI	FBh			vector	
STOSB mem8, AL	AAh			long	store, alux
STOSW mem16, AX	ABh			long	store, alux
STOSD mem32, EAX	ABh			long	store, alux
STR mreg16	0Fh	00h	11-001-ххх	vector	
STR mem16	0Fh	00h	mm-001-xxx	vector	
SUB mreg8, reg8	28h		11-ххх-ххх	short	alux
SUB mem8, reg8	28h		mm-xxx-xxx	long	load, alux, store
SUB mreg16/32, reg16/32	29h		11-xxx-xxx	short	alu
SUB mem16/32, reg16/32	29h		mm-xxx-xxx	long	load, alu, store
SUB reg8, mreg8	2Ah		11-xxx-xxx	short	alux
SUB reg8, mem8	2Ah		mm-xxx-xxx	short	load, alux
SUB reg16/32, mreg16/32	2Bh		11-ххх-ххх	short	alu

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
SUB reg16/32, mem16/32	2Bh		mm-xxx-xxx	short	load, alu
SUB AL, imm8	2Ch			short	alux
SUB EAX, imm16/32	2Dh			short	alu
SUB mreg8, imm8	80h		11-101-xxx	short	alux
SUB mem8, imm8	80h		mm-101-xxx	long	load, alux, store
SUB mreg16/32, imm16/32	81h		11-101-xxx	short	alu
SUB mem16/32, imm16/32	81h		mm-101-xxx	long	load, alu, store
SUB mreg16/32, imm8 (signed ext.)	83h		11-101-xxx	short	alux
SUB mem16/32, imm8 (signed ext.)	83h		mm-101-xxx	long	load, alux, store
SYSCALL	0Fh	05h		vector	
SYSRET	0Fh	07h		vector	
TEST mreg8, reg8	84h		11-ххх-ххх	short	alux
TEST mem8, reg8	84h		mm-xxx-xxx	vector	
TEST mreg16/32, reg16/32	85h		11-xxx-xxx	short	alu
TEST mem16/32, reg16/32	85h		mm-xxx-xxx	vector	
TEST AL, imm8	A8h			long	alux
TEST EAX, imm16/32	A9h			long	alu
TEST mreg8, imm8	F6h		11-000-ххх	long	alux
TEST mem8, imm8	F6h		mm-000-xxx	long	load, alux
TEST mreg16/32, imm16/32	F7h		11-000-ххх	long	alu
TEST mem16/32, imm16/32	F7h		mm-000-xxx	long	load, alu
VERR mreg16	0Fh	00h	11-100-xxx	vector	
VERR mem16	0Fh	00h	mm-100-xxx	vector	
VERW mreg16	0Fh	00h	11-101-xxx	vector	
VERW mem16	0Fh	00h	mm-101-xxx	vector	
WAIT	9Bh			vector	
WBINVD	0Fh	09h		vector	
WRMSR	0Fh	30h		vector	
XADD mreg8, reg8	0Fh	C0h	11-100-xxx	vector	
XADD mem8, reg8	0Fh	C0h	mm-100-xxx	vector	
XADD mreg16/32, reg16/32	0Fh	C1h	11-101-xxx	vector	
XADD mem16/32, reg16/32	0Fh	C1h	mm-101-xxx	vector	
XCHG reg8, mreg8	86h		11-ххх-ххх	vector	

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations
XCHG reg8, mem8	86h		mm-xxx-xxx	vector	
XCHG reg16/32, mreg16/32	87h		11-xxx-xxx	vector	
XCHG reg16/32, mem16/32	87h		mm-xxx-xxx	vector	
XCHG EAX, EAX	90h			short	limm
XCHG EAX, ECX	91h			long	alu, alu, alu
XCHG EAX, EDX	92h			long	alu, alu, alu
XCHG EAX, EBX	93h			long	alu, alu, alu
XCHG EAX, ESP	94h			long	alu, alu, alu
XCHG EAX, EBP	95h			long	alu, alu, alu
XCHG EAX, ESI	96h			long	alu, alu, alu
XCHG EAX, EDI	97h			long	alu, alu, alu
XLAT	D7h			vector	
XOR mreg8, reg8	30h		11-ххх-ххх	short	alux
XOR mem8, reg8	30h		mm-xxx-xxx	long	load, alux, store
XOR mreg16/32, reg16/32	31h		11-xxx-xxx	short	alu
XOR mem16/32, reg16/32	31h		mm-xxx-xxx	long	load, alu, store
XOR reg8, mreg8	32h		11-xxx-xxx	short	alux
XOR reg8, mem8	32h		mm-xxx-xxx	short	load, alux
XOR reg16/32, mreg16/32	33h		11-xxx-xxx	short	alu
XOR reg16/32, mem16/32	33h		mm-xxx-xxx	short	load, alu
XOR AL, imm8	34h			short	alux
XOR EAX, imm16/32	35h			short	alu
XOR mreg8, imm8	80h		11-110-xxx	short	alux
XOR mem8, imm8	80h		mm-110-xxx	long	load, alux, store
XOR mreg16/32, imm16/32	81h		11-110-xxx	short	alu
XOR mem16/32, imm16/32	81h		mm-110-xxx	long	load, alu, store
XOR mreg16/32, imm8 (signed ext.)	83h		11-110-ххх	short	alux
XOR mem16/32, imm8 (signed ext.)	83h		mm-110-xxx	long	load, alux, store

## Table 15. Floating-Point Instructions

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
F2XM1	D9h	F0h		short	float	
FABS	D9h	F1h		short	float	
FADD ST(0), ST(i)	D8h		11-000-ххх	short	float	*
FADD ST(0), mem32real	D8h		mm-000-xxx	short	fload, float	
FADD ST(i), ST(0)	DCh		11-000-ххх	short	float	*
FADD ST(0), mem64real	DCh		mm-000-xxx	short	fload, float	
FADDP ST(i), ST(0)	DEh		11-000-ххх	short	float	*
FBLD	DFh		mm-100-xxx	vector		
FBSTP	DFh		mm-110-xxx	vector		
FCHS	D9h	E0h		short	float	
FCLEX	DBh	E2h		vector		
FCOM ST(0), ST(i)	D8h		11-010-ххх	short	float	*
FCOM ST(0), mem32real	D8h		mm-010-xxx	short	fload, float	
FCOM ST(0), mem64real	DCh		mm-010-xxx	short	fload, float	
FCOMP ST(0), ST(i)	D8h		11-011-ххх	short	float	*
FCOMP ST(0), mem32real	D8h		mm-011-xxx	short	fload, float	
FCOMP ST(0), mem64real	DCh		mm-011-xxx	short	fload, float	
FCOMPP	DEh	D9h	11-011-001	short	float	
FCOS	D9h	FFh		short	float	
FDECSTP	D9h	F6h		short	float	
FDIV ST(0), ST(i) (single precision)	D8h		11-110-ххх	short	float	*
FDIV ST(0), ST(i) (double precision)	D8h		11-110-ххх	short	float	*
FDIV ST(0), ST(i) (extended precision)	D8h		11-110-ххх	short	float	*
FDIV ST(i), ST(0) (single precision)	DCh		11-111-ххх	short	float	*
FDIV ST(i), ST(0) (double precision)	DCh		11-111-ххх	short	float	*
FDIV ST(i), ST(0) (extended precision)	DCh		11-111-ххх	short	float	*
FDIV ST(0), mem32real	D8h		mm-110-xxx	short	fload, float	
FDIV ST(0), mem64real	DCh		mm-110-xxx	short	fload, float	
FDIVP ST(0), ST(i)	DEh		11-111-ххх	short	float	*
FDIVR ST(0), ST(i)	D8h		11-110-xxx	short	float	*
FDIVR ST(i), ST(0)	DCh		11-111-ххх	short	float	*
Note: * The last three bits of the modR/M byt	e select th	ne stack entr	y ST(i).	-		·

### Table 15. Floating-Point Instructions (continued)

	Byte	Byte	Byte	Decode Type	RISC86 Operations	Note
DIVR ST(0), mem32real	D8h		mm-111-xxx	short	fload, float	
DIVR ST(0), mem64real	DCh		mm-111-xxx	short	fload, float	
DIVRP ST(i), ST(0)	DEh		11-110-ххх	short	float	*
FREE ST(i)	DDh		11-000-ххх	short	float	*
FIADD ST(0), mem32int	DAh		mm-000-xxx	short	fload, float	
FIADD ST(0), mem16int	DEh		mm-000-xxx	short	fload, float	
FICOM ST(0), mem32int	DAh		mm-010-xxx	short	fload, float	
FICOM ST(0), mem16int	DEh		mm-010-xxx	short	fload, float	
FICOMP ST(0), mem32int	DAh		mm-011-xxx	short	fload, float	
FICOMP ST(0), mem16int	DEh		mm-011-xxx	short	fload, float	
FIDIV ST(0), mem32int	DAh		mm-110-xxx	short	fload, float	
FIDIV ST(0), mem16int	DEh		mm-110-xxx	short	fload, float	
FIDIVR ST(0), mem32int	DAh		mm-111-xxx	short	fload, float	
FIDIVR ST(0), mem16int	DEh		mm-111-xxx	short	fload, float	
FILD mem16int	DFh		mm-000-xxx	short	fload, float	
FILD mem32int	DBh		mm-000-xxx	short	fload, float	
FILD mem64int	DFh		mm-101-xxx	short	fload, float	
FIMUL ST(0), mem32int	DAh		mm-001-xxx	short	fload, float	
FIMUL ST(0), mem16int	DEh		mm-001-xxx	short	fload, float	
FINCSTP	D9h	F7h		short		
FINIT	DBh	E3h		vector		
FIST mem16int	DFh		mm-010-xxx	short	fload, float	
FIST mem32int	DBh		mm-010-xxx	short	fload, float	
FISTP mem16int	DFh		mm-011-xxx	short	fload, float	
FISTP mem32int	DBh		mm-011-xxx	short	fload, float	
FISTP mem64int	DFh		mm-111-xxx	short	fload, float	
FISUB ST(0), mem32int	DAh		mm-100-xxx	short	fload, float	
FISUB ST(0), mem16int	DEh		mm-100-xxx	short	fload, float	
FISUBR ST(0), mem32int	DAh		mm-101-xxx	short	fload, float	
FISUBR ST(0), mem16int	DEh		mm-101-xxx	short	fload, float	
FLD ST(i)	D9h		11-000-xxx	short	fload, float	*

Table 15.	Floating-Point	Instructions	(continued)
	i iouting i onit		(oomaoa)

	e RISC86 Operations	Note
000-xxx short	fload, float	
000-xxx short	fload, float	
101-xxx vector		
short	fload, float	
101-xxx vector		
100-xxx short	fload, float	
short	float	
short	float	
short	float	
short	float	
short	float	
short	float	
01-xxx short	float	*
01-xxx short	float	*
001-xxx short	fload, float	
001-xxx short	fload, float	
01-xxx short	float	*
short	float	
vector		
short	float	
100-xxx vector		
110-xxx vector		
short	float	
short	float	
vector		
short	float	
short	float	
short	float	
	short short	short float short float

Table 15. Floating-Point Instructions (continued)	Table 15.	Floating-Point	Instructions	(continued)
---	-----------	----------------	--------------	-------------

Instruction Mnemonic	First Byte	Second Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
FST mem32real	D9h		mm-010-xxx	short	fstore	
FST mem64real	DDh		mm-010-xxx	short	fstore	
FST ST(i)	DDh		11-010-xxx	short	fstore	*
FSTCW	D9h		mm-111-xxx	vector		
FSTENV	D9h		mm-110-xxx	vector		
FSTP mem32real	D9h		mm-011-xxx	short	fstore	
FSTP mem64real	DDh		mm-011-xxx	short	fstore	
FSTP mem80real	D9h		mm-111-xxx	vector		
FSTP ST(i)	DDh		11-011-ххх	short	float	*
FSTSW AX	DFh	E0h		vector		
FSTSW mem16	DDh		mm-111-xxx	vector		
FSUB ST(0), mem32real	D8h		mm-100-xxx	short	fload, float	
FSUB ST(0), mem64real	DCh		mm-100-xxx	short	fload, float	
FSUB ST(0), ST(i)	D8h		11-100-xxx	short	float	*
FSUB ST(i), ST(0)	DCh		11-101-xxx	short	float	*
FSUBP ST(0), ST(i)	DEh		11-101-xxx	short	float	*
FSUBR ST(0), mem32real	D8h		mm-101-xxx	short	fload, float	
FSUBR ST(0), mem64real	DCh		mm-101-xxx	short	fload, float	
FSUBR ST(0), ST(i)	D8h		11-100-xxx	short	float	*
FSUBR ST(i), ST(0)	DCh		11-101-xxx	short	float	*
FSUBRP ST(i), ST(0)	DEh		11-100-xxx	short	float	*
FTST	D9h	E4h		short	float	
FUCOM	DDh		11-100-xxx	short	float	
FUCOMP	DDh		11-101-xxx	short	float	
FUCOMPP	DAh	E9h		short	float	
FXAM	D9h	E5h		short	float	
FXCH	D9h		11-001-xxx	short	float	
FXTRACT	D9h	F4h		vector		
FYL2X	D9h	F1h		short	float	
FYL2XP1	D9h	F9h		short	float	
FWAIT	9Bh			vector		

#### Table 16. MMX<sup>™</sup> Instructions

Instruction Mnemonic	Prefix Byte(s)	First Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
EMMS	0Fh	77h		vector		
MOVD mmreg, mreg32	0Fh	6Eh	11-xxx-xxx	short	meu	**
MOVD mmreg, mem32	0Fh	6Eh	mm-xxx-xxx	short	mload	
MOVD mreg32, mmreg	0Fh	7Eh	11-ххх-ххх	short	mstore, load	**
MOVD mem32, mmreg	0Fh	7Eh	mm-xxx-xxx	short	mstore	
MOVQ mmreg1, mmreg2	0Fh	6Fh	11-ххх-ххх	short	meu	
MOVQ mmreg, mem64	0Fh	6Fh	mm-xxx-xxx	short	mload	
MOVQ mmreg2, mmreg1	0Fh	7Fh	11-ххх-ххх	short	meu	
MOVQ mem64, mmreg	0Fh	7Fh	mm-xxx-xxx	short	mstore	
PACKSSDW mmreg1, mmreg2	0Fh	6Bh	11-xxx-xxx	short	meu	
PACKSSDW mmreg, mem64	0Fh	6Bh	mm-xxx-xxx	short	mload, meu	
PACKSSWB mmreg1, mmreg2	0Fh	63h	11-ххх-ххх	short	meu	
PACKSSWB mmreg, mem64	0Fh	63h	mm-xxx-xxx	short	mload, meu	
PACKUSWB mmreg1, mmreg2	0Fh	67h	11-xxx-xxx	short	meu	
PACKUSWB mmreg, mem64	0Fh	67h	mm-xxx-xxx	short	mload, meu	
PADDB mmreg1, mmreg2	0Fh	FCh	11-xxx-xxx	short	meu	
PADDB mmreg, mem64	0Fh	FCh	mm-xxx-xxx	short	mload, meu	
PADDD mmreg1, mmreg2	0Fh	FEh	11-xxx-xxx	short	meu	
PADDD mmreg, mem64	0Fh	FEh	mm-xxx-xxx	short	mload, meu	
PADDSB mmreg1, mmreg2	0Fh	ECh	11-xxx-xxx	short	meu	
PADDSB mmreg, mem64	0Fh	ECh	mm-xxx-xxx	short	mload, meu	
PADDSW mmreg1, mmreg2	0Fh	EDh	11-xxx-xxx	short	meu	
PADDSW mmreg, mem64	0Fh	EDh	mm-xxx-xxx	short	mload, meu	
PADDUSB mmreg1, mmreg2	0Fh	DCh	11-xxx-xxx	short	meu	
PADDUSB mmreg, mem64	0Fh	DCh	mm-xxx-xxx	short	mload, meu	
PADDUSW mmreg1, mmreg2	0Fh	DDh	11-xxx-xxx	short	meu	
PADDUSW mmreg, mem64	0Fh	DDh	mm-xxx-xxx	short	mload, meu	
PADDW mmreg1, mmreg2	0Fh	FDh	11-ххх-ххх	short	meu	
PADDW mmreg, mem64	0Fh	FDh	mm-xxx-xxx	short	mload, meu	
PAND mmreg1, mmreg2	0Fh	DBh	11-ххх-ххх	short	meu	
PAND mmreg, mem64	0Fh	DBh	mm-xxx-xxx	short	mload, meu	
Note:	I	1			1	1

\*\* Bits 2, 1, and 0 of the modR/M byte select the integer register.

1D7

### Table 16. MMX<sup>™</sup> Instructions (continued)

Instruction Mnemonic	Prefix Byte(s)	First Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
PANDN mmreg1, mmreg2	0Fh	DFh	11-xxx-xxx	short	meu	
PANDN mmreg, mem64	0Fh	DFh	mm-xxx-xxx	short	mload, meu	
PCMPEQB mmreg1, mmreg2	0Fh	74h	11-ххх-ххх	short	meu	
PCMPEQB mmreg, mem64	0Fh	74h	mm-xxx-xxx	short	mload, meu	
PCMPEQD mmreg1, mmreg2	0Fh	76h	11-xxx-xxx	short	meu	
PCMPEQD mmreg, mem64	0Fh	76h	mm-xxx-xxx	short	mload, meu	
PCMPEQW mmreg1, mmreg2	0Fh	75h	11-xxx-xxx	short	meu	
PCMPEQW mmreg, mem64	0Fh	75h	mm-xxx-xxx	short	mload, meu	
PCMPGTB mmreg1, mmreg2	0Fh	64h	11-xxx-xxx	short	meu	
PCMPGTB mmreg, mem64	0Fh	64h	mm-xxx-xxx	short	mload, meu	
PCMPGTD mmreg1, mmreg2	0Fh	66h	11-xxx-xxx	short	meu	
PCMPGTD mmreg, mem64	0Fh	66h	mm-xxx-xxx	short	mload, meu	
PCMPGTW mmreg1, mmreg2	0Fh	65h	11-xxx-xxx	short	meu	
PCMPGTW mmreg, mem64	0Fh	65h	mm-xxx-xxx	short	mload, meu	
PMADDWD mmreg1, mmreg2	0Fh	F5h	11-ххх-ххх	short	meu	
PMADDWD mmreg, mem64	0Fh	F5h	mm-xxx-xxx	short	mload, meu	
PMULHW mmreg1, mmreg2	0Fh	E5h	11-xxx-xxx	short	meu	
PMULHW mmreg, mem64	0Fh	E5h	mm-xxx-xxx	short	mload, meu	
PMULLW mmreg1, mmreg2	0Fh	D5h	11-xxx-xxx	short	meu	
PMULLW mmreg, mem64	0Fh	D5h	mm-xxx-xxx	short	mload, meu	
POR mmreg1, mmreg2	0Fh	EBh	11-xxx-xxx	short	meu	
POR mmreg, mem64	0Fh	EBh	mm-xxx-xxx	short	mload, meu	
PSLLD mmreg1, mmreg2	0Fh	F2h	11-xxx-xxx	short	meu	
PSLLD mmreg, mem64	0Fh	F2h	mm-xxx-xxx	short	mload, meu	
PSLLD mmreg, imm8	0Fh	72h	11-110-xxx	short	meu	
PSLLQ mmreg1, mmreg2	0Fh	F3h	11-xxx-xxx	short	meu	
PSLLQ mmreg, mem64	0Fh	F3h	mm-xxx-xxx	short	mload, meu	
PSLLQ mmreg, imm8	0Fh	73h	11-110-xxx	short	meu	
PSLLW mmreg1, mmreg2	0Fh	F1h	11-ххх-ххх	short	meu	
PSLLW mmreg, mem64	0Fh	F1h	mm-xxx-xxx	short	mload, meu	
PSLLW mmreg, imm8	0Fh	71h	11-110-xxx	short	meu	
Note: ** Bits 2, 1, and 0 of the modR/M byte	e select the in	teger reg	iister.			

### Table 16. MMX<sup>™</sup> Instructions (continued)

Instruction Mnemonic	Prefix Byte(s)	First Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
PSRAD mmreg1, mmreg2	0Fh	E2h	11-xxx-xxx	short	meu	
PSRAD mmreg, mem64	0Fh	E2h	mm-xxx-xxx	short	mload, meu	
PSRAD mmreg, imm8	0Fh	72h	11-100-xxx	short	meu	
PSRAW mmreg1, mmreg2	0Fh	E1h	11-xxx-xxx	short	meu	
PSRAW mmreg, mem64	0Fh	E1h	mm-xxx-xxx	short	mload, meu	
PSRAW mmreg, imm8	0Fh	71h	11-100-xxx	short	meu	
PSRLD mmreg1, mmreg2	0Fh	D2h	11-ххх-ххх	short	meu	
PSRLD mmreg, mem64	0Fh	D2h	mm-xxx-xxx	short	mload, meu	
PSRLD mmreg, imm8	0Fh	72h	11-010-xxx	short	meu	
PSRLQ mmreg1, mmreg2	0Fh	D3h	11-ххх-ххх	short	meu	
PSRLQ mmreg, mem64	0Fh	D3h	mm-xxx-xxx	short	mload, meu	
PSRLQ mmreg, imm8	0Fh	73h	11-010-ххх	short	meu	
PSRLW mmreg1, mmreg2	0Fh	D1h	11-xxx-xxx	short	meu	
PSRLW mmreg, mem64	0Fh	D1h	mm-xxx-xxx	short	mload, meu	
PSRLW mmreg, imm8	0Fh	71h	11-010-ххх	short	meu	
PSUBB mmreg1, mmreg2	0Fh	F8h	11-xxx-xxx	short	meu	
PSUBB mmreg, mem64	0Fh	F8h	mm-xxx-xxx	short	mload, meu	
PSUBD mmreg1, mmreg2	0Fh	FAh	11-xxx-xxx	short	meu	
PSUBD mmreg, mem64	0Fh	FAh	mm-xxx-xxx	short	mload, meu	
PSUBSB mmreg1, mmreg2	0Fh	E8h	11-xxx-xxx	short	meu	
PSUBSB mmreg, mem64	0Fh	E8h	mm-xxx-xxx	short	mload, meu	
PSUBSW mmreg1, mmreg2	0Fh	E9h	11-xxx-xxx	short	meu	
PSUBSW mmreg, mem64	0Fh	E9h	mm-xxx-xxx	short	mload, meu	
PSUBUSB mmreg1, mmreg2	0Fh	D8h	11-xxx-xxx	short	meu	
PSUBUSB mmreg, mem64	0Fh	D8h	mm-xxx-xxx	short	mload, meu	
PSUBUSW mmreg1, mmreg2	0Fh	D9h	11-xxx-xxx	short	meu	
PSUBUSW mmreg, mem64	0Fh	D9h	mm-xxx-xxx	short	mload, meu	
PSUBW mmreg1, mmreg2	0Fh	F9h	11-ххх-ххх	short	meu	
PSUBW mmreg, mem64	0Fh	F9h	mm-xxx-xxx	short	mload, meu	
PUNPCKHBW mmreg1, mmreg2	0Fh	68h	11-xxx-xxx	short	meu	
PUNPCKHBW mmreg, mem64	0Fh	68h	mm-xxx-xxx	short	mload, meu	
Note: ** Bits 2, 1, and 0 of the modR/M by	te select the ini	teger reg	ister.			

Instruction Mnemonic	Prefix Byte(s)	First Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
PUNPCKHDQ mmreg1, mmreg2	0Fh	6Ah	11-xxx-xxx	short	meu	
PUNPCKHDQ mmreg, mem64	0Fh	6Ah	mm-xxx-xxx	short	mload, meu	
PUNPCKHWD mmreg1, mmreg2	0Fh	69h	11-xxx-xxx	short	meu	
PUNPCKHWD mmreg, mem64	0Fh	69h	mm-xxx-xxx	short	mload, meu	
PUNPCKLBW mmreg1, mmreg2	0Fh	60h	11-ххх-ххх	short	meu	
PUNPCKLBW mmreg, mem64	0Fh	60h	mm-xxx-xxx	short	mload, meu	
PUNPCKLDQ mmreg1, mmreg2	0Fh	62h	11-xxx-xxx	short	meu	
PUNPCKLDQ mmreg, mem64	0Fh	62h	mm-xxx-xxx	short	mload, meu	
PUNPCKLWD mmreg1, mmreg2	0Fh	61h	11-xxx-xxx	short	meu	
PUNPCKLWD mmreg, mem64	0Fh	61h	mm-xxx-xxx	short	mload, meu	
PXOR mmreg1, mmreg2	0Fh	EFh	11-xxx-xxx	short	meu	
PXOR mmreg, mem64	0Fh	EFh	mm-xxx-xxx	short	mload, meu	

#### Table 16. MMX<sup>™</sup> Instructions (continued)

#### Table 17. 3DNow!™ Instructions

Instruction Mnemonic	Prefix Byte(s)	Opcode Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
FEMMS	0Fh	0Eh		vector		
PAVGUSB mmreg1, mmreg2	0Fh, 0Fh	BFh	11-ххх-ххх	short	meu	
PAVGUSB mmreg, mem64	0Fh, 0Fh	BFh	mm-xxx-xxx	short	mload, meu	
PF2ID mmreg1, mmreg2	0Fh, 0Fh	1Dh	11-ххх-ххх	short	meu	
PF2ID mmreg, mem64	0Fh, 0Fh	1Dh	mm-xxx-xxx	short	mload, meu	
PFACC mmreg1, mmreg2	0Fh, 0Fh	AEh	11-ххх-ххх	short	meu	
PFACC mmreg, mem64	0Fh, 0Fh	AEh	mm-xxx-xxx	short	mload, meu	
PFADD mmreg1, mmreg2	0Fh, 0Fh	9Eh	11-ххх-ххх	short	meu	
PFADD mmreg, mem64	0Fh, 0Fh	9Eh	mm-xxx-xxx	short	mload, meu	
PFCMPEQ mmreg1, mmreg2	0Fh, 0Fh	B0h	11-ххх-ххх	short	meu	
PFCMPEQ mmreg, mem64	0Fh, 0Fh	B0h	mm-xxx-xxx	short	mload, meu	
PFCMPGE mmreg1, mmreg2	0Fh, 0Fh	90h	11-ххх-ххх	short	meu	

Notes:

1. For PREFETCH and PREFETCHW, the mem8 value refers to a byte address within the 32-byte line that will be prefetched.

2. PREFETCHW will be implemented in a future K86 processor. On the AMD-K6-2 processor, this instruction performs in the same manner as the PREFETCH instruction.

#### Table 17. 3DNow!<sup>™</sup> Instructions (continued)

Instruction Mnemonic	Prefix Byte(s)	Opcode Byte	ModR/M Byte	Decode Type	RISC86 Operations	Note
PFCMPGE mmreg, mem64	0Fh, 0Fh	90h	mm-xxx-xxx	short	mload, meu	
PFCMPGT mmreg1, mmreg2	0Fh, 0Fh	A0h	11-xxx-xxx	short	meu	
PFCMPGT mmreg, mem64	0Fh, 0Fh	A0h	mm-xxx-xxx	short	mload, meu	
PFMAX mmreg1, mmreg2	0Fh, 0Fh	A4h	11-ххх-ххх	short	meu	
PFMAX mmreg, mem64	0Fh, 0Fh	A4h	mm-xxx-xxx	short	mload, meu	
PFMIN mmreg1, mmreg2	0Fh, 0Fh	94h	11-ххх-ххх	short	meu	
PFMIN mmreg, mem64	0Fh, 0Fh	94h	mm-xxx-xxx	short	mload, meu	
PFMUL mmreg1, mmreg2	0Fh, 0Fh	B4h	11-ххх-ххх	short	meu	
PFMUL mmreg, mem64	0Fh, 0Fh	B4h	mm-xxx-xxx	short	mload, meu	
PFRCP mmreg1, mmreg2	0Fh, 0Fh	96h	11-ххх-ххх	short	meu	
PFRCP mmreg, mem64	0Fh, 0Fh	96h	mm-xxx-xxx	short	mload, meu	
PFRCPIT1 mmreg1, mmreg2	0Fh, 0Fh	A6h	11-ххх-ххх	short	meu	
PFRCPIT1 mmreg, mem64	0Fh, 0Fh	A6h	mm-xxx-xxx	short	mload, meu	
PFRCPIT2 mmreg1, mmreg2	0Fh, 0Fh	B6h	11-ххх-ххх	short	meu	
PFRCPIT2 mmreg, mem64	0Fh, 0Fh	B6h	mm-xxx-xxx	short	mload, meu	
PFRSQIT1 mmreg1, mmreg2	0Fh, 0Fh	A7h	11-ххх-ххх	short	meu	
PFRSQIT1 mmreg, mem64	0Fh, 0Fh	A7h	mm-xxx-xxx	short	mload, meu	
PFRSQRT mmreg1, mmreg2	0Fh, 0Fh	97h	11-xxx-xxx	short	meu	
PFRSQRT mmreg, mem64	0Fh, 0Fh	97h	mm-xxx-xxx	short	mload, meu	
PFSUB mmreg1, mmreg2	0Fh, 0Fh	9Ah	11-ххх-ххх	short	meu	
PFSUB mmreg, mem64	0Fh, 0Fh	9Ah	mm-xxx-xxx	short	mload, meu	
PFSUBR mmreg1, mmreg2	0Fh, 0Fh	AAh	11-ххх-ххх	short	meu	
PFSUBR mmreg, mem64	0Fh, 0Fh	AAh	mm-xxx-xxx	short	mload, meu	
PI2FD mmreg1, mmreg2	0Fh, 0Fh	0Dh	11-xxx-xxx	short	meu	
PI2FD mmreg, mem64	0Fh, 0Fh	0Dh	mm-xxx-xxx	short	mload, meu	
PMULHRW mmreg1, mmreg2	0Fh, 0Fh	B7h	11-ххх-ххх	short	meu	
PMULHRW mmreg1, mem64	0Fh, 0Fh	B7h	mm-xxx-xxx	short	mload, meu	
PREFETCH mem8	0Fh	0Dh	mm-000-xxx	vector	load	1
PREFETCHW mem8	0Fh	0Dh	mm-001-xxx	vector	load	1, 2

Notes:

1. For PREFETCH and PREFETCHW, the mem8 value refers to a byte address within the 32-byte line that will be prefetched.

2. PREFETCHW will be implemented in a future K86 processor. On the AMD-K6-2 processor, this instruction performs in the same manner as the PREFETCH instruction.

21850J/0-February 2000

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# 4 Signal Descriptions

## 4.1 Signal Terminology

The following terminology is used in this chapter:

- Driven—The processor actively pulls the signal up to the High-voltage state or pulls the signal down to the Low-voltage state.
- *Floated*—The the signal is not being driven by the processor (high-impedance state), which allows another device to drive this signal.
- Asserted—For all active-High signals, the term asserted means the signal is in the High-voltage state. For all active-Low signals, the term asserted means the signal is in the Low-voltage state.
- Negated—For all active-High signals, the term negated means the signal is in the Low-voltage state. For all active-Low signals, the term negated means the signal is in the High-voltage state.
- Sampled—The processor has measured the state of a signal at predefined points in time and will take the appropriate action based on the state of the signal. If a signal is not sampled by the processor, its assertion or negation has no effect on the operation of the processor.

Figure 52 on page 86 shows the signals grouped by function. The arrows in the figure indicate the direction of the signal, either into or out of the processor. Signals with double-headed arrows are bidirectional. Signals with pound signs (#) are active Low.

21850J/0-February 2000

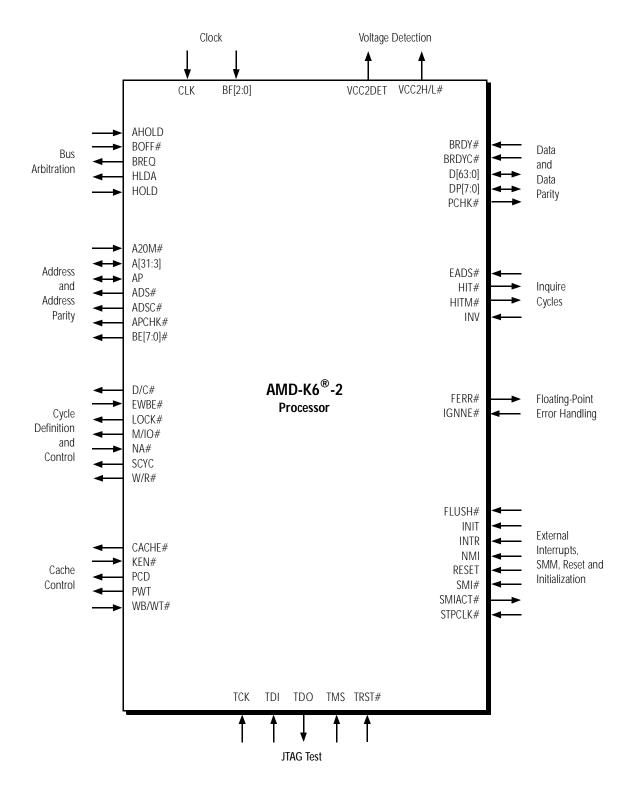


Figure 52. Logic Symbol Diagram

21850J/0-February 2000

### 4.2 A20M# (Address Bit 20 Mask)

#### Input

Summary A20M# is used to simulate the behavior of the 8086 when running in Real mode. The assertion of A20M# causes the processor to force bit 20 of the physical address to 0 prior to accessing the cache or driving out a memory bus cycle. The clearing of address bit 20 maps addresses that extend above the 8086 1-Mbyte limit to below 1 Mbyte.

Sampled The processor samples A20M# as a level-sensitive input on every clock edge. The system logic can drive the signal either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks.

The following list explains the effects of the processor sampling A20M# asserted under various conditions:

- Inquire cycles and writeback cycles are not affected by the state of A20M#.
- The assertion of A20M# in System Management Mode (SMM) is ignored.
- When A20M# is sampled asserted in Protected mode, it causes unpredictable processor operation. A20M# is only defined in Real mode.
- To ensure that A20M# is recognized before the first ADS# occurs following the negation of RESET, A20M# must be sampled asserted on the same clock edge that RESET is sampled negated or on one of the two subsequent clock edges.
- To ensure A20M# is recognized before the execution of an instruction, a serializing instruction must be executed between the instruction that asserts A20M# and the targeted instruction.

## 4.3 A[31:3] (Address Bus)

#### A[31:5] Bidirectional, A[4:3] Output

- SummaryA[31:3] contain the physical address for the current bus cycle.<br/>The processor drives addresses on A[31:3] during memory and<br/>I/O cycles, and cycle definition information during special bus<br/>cycles. The processor samples addresses on A[31:5] during<br/>inquire cycles.
- Driven, Sampled, and Floated ADS # and remain in the same state until the clock edge as ADS # and remain in the same state until the clock edge on which NA# or the last expected BRDY # of the cycle is sampled asserted. A[31:3] are driven during memory cycles, I/O cycles, special bus cycles, and interrupt acknowledge cycles. The processor continues to drive the address bus while the bus is idle.

*As Inputs:* The processor samples A[31:5] during inquire cycles on the clock edge on which EADS# is sampled asserted. Even though A4 and A3 are not used during the inquire cycle, they must be driven to a valid state and must meet the same timings as A[31:5].

A[31:3] are floated off the clock edge that AHOLD or BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

The processor resumes driving A[31:3] off the clock edge on which the processor samples AHOLD or BOFF# negated and off the clock edge on which the processor negates HLDA.

## 4.4 ADS# (Address Strobe)

#### Output

- Summary The assertion of ADS# indicates the beginning of a new bus cycle. The address bus and all cycle definition signals corresponding to this bus cycle are driven valid off the same clock edge as ADS#.
- Driven and Floated ADS # is asserted for one clock at the beginning of each bus cycle. For non-pipelined cycles, ADS # can be asserted as early as the clock edge after the clock edge on which the last expected BRDY # of the cycle is sampled asserted, resulting in a single idle state between cycles. For pipelined cycles if the processor is prepared to start a new cycle, ADS # can be asserted as early as one clock edge after NA # is sampled asserted.

If AHOLD is sampled asserted, ADS# is only driven in order to perform a writeback cycle due to an inquire cycle that hits a modified cache line.

The processor floats ADS# off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

## 4.5 ADSC# (Address Strobe Copy)

#### Output

SummaryADSC# has the identical function and timing as ADS#. In the<br/>event ADS# becomes too heavily loaded due to a large fanout in<br/>a system, ADSC# can be used to split the load across two<br/>outputs, which can improve system timing.

## 4.6 AHOLD (Address Hold)

#### Input

SummaryAHOLD can be asserted by the system to initiate one or more<br/>inquire cycles. To allow the system to drive the address bus<br/>during an inquire cycle, the processor floats A[31:3] and AP off<br/>the clock edge on which AHOLD is sampled asserted. The data<br/>bus and all other control and status signals remain under the<br/>control of the processor and are not floated. This allows a bus<br/>cycle that is in progress when AHOLD is sampled asserted to<br/>continue to completion. The processor resumes driving the<br/>address bus off the clock edge on which AHOLD is sampled asserted to<br/>continue to completion. The processor resumes driving the<br/>address bus off the clock edge on which AHOLD is sampled<br/>negated.If AHOLD is sampled asserted, ADS# is only asserted in order<br/>to perform a writeback cycle due to an inquire cycle that hits a<br/>modified cache line.

SampledThe processor samples AHOLD on every clock edge. AHOLD is<br/>recognized while INIT and RESET are sampled asserted.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.7 AP (Address Parity)

#### Bidirectional

Summary

AP contains the even parity bit for cache line addresses driven and sampled on A[31:5]. Even parity means that the total number of 1 bits on AP and A[31:5] is even. (A4 and A3 are not used for the generation or checking of address parity because these bits are not required to address a cache line.) AP is driven by the processor during processor-initiated cycles and is sampled by the processor during inquire cycles. If AP does not reflect even parity during an inquire cycle, the processor asserts APCHK# to indicate an address bus parity check. The processor does not take an internal exception as the result of detecting an address bus parity check, and system logic must respond appropriately to the assertion of this signal.

Driven, Sampled, and<br/>FloatedAs an Output: The processor drives AP valid off the clock edge<br/>on which ADS# is asserted until the clock edge on which NA# or<br/>the last expected BRDY# of the cycle is sampled asserted. AP is<br/>driven during memory cycles, I/O cycles, special bus cycles, and<br/>interrupt acknowledge cycles. The processor continues to drive<br/>AP while the bus is idle.

*As an Input:* The processor samples AP during inquire cycles on the clock edge on which EADS# is sampled asserted.

The processor floats AP off the clock edge that AHOLD or BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

The processor resumes driving AP off the clock edge on which the processor samples AHOLD or BOFF# negated and off the clock edge on which the processor negates HLDA.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.8 APCHK# (Address Parity Check)

#### Output

Summary If the processor detects an address parity error during an inquire cycle, APCHK# is asserted for one clock. The processor does not take an internal exception as the result of detecting an address bus parity check, and system logic must respond appropriately to the assertion of this signal.

The processor is designed so that APCHK# does not glitch, enabling the signal to be used as a clocking source for system logic.

Driven APCHK# is driven valid off the clock edge after the clock edge on which the processor samples EADS# asserted. It is negated off the next clock edge.

APCHK# is always driven except in the Tri-State Test mode.

## 4.9 BE[7:0]# (Byte Enables)

#### Output

Summary BE[7:0]# are used by the processor to indicate the valid data bytes during a write cycle and the requested data bytes during a read cycle. The byte enables can be used to derive address bits A[2:0], which are not physically part of the processor's address bus. The processor checks and generates valid data parity for the data bytes that are valid as defined by the byte enables. The eight byte enables correspond to the eight bytes of the data bus as follows:

- BE7#: D[63:56] BE3#: D[31:24]
  - BE6#: D[55:48] BE2#: D[23:16]
  - BE5#: D[47:40] BE1#: D[15:8]
  - BE4#: D[39:32] BE0#: D[7:0]

The processor expects data to be driven by the system logic on all eight bytes of the data bus during a burst cache-line read cycle, independent of the byte enables that are asserted.

The byte enables are also used to distinguish between special bus cycles as defined in Table 25 on page 128.

Driven and Floated BE[7:0]# are driven off the same clock edge as ADS# and remain in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted. BE[7:0]# are driven during memory cycles, I/O cycles, special bus cycles, and interrupt acknowledge cycles.

> The processor floats BE[7:0]# off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD. Unlike the address bus, BE[7:0]# are not floated in response to AHOLD.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.10 BF[2:0] (Bus Frequency)

#### **Inputs, Internal Pullups**

Summary BF[2:0] determine the internal operating frequency of the processor. The frequency of the CLK input signal is multiplied internally by a ratio determined by the state of these signals as defined in Table 18. BF[2:0] have weak internal pullups and default to the 3.5 multiplier if left unconnected.

State of BF[2:0] Inputs	Processor-Clock to Bus-Clock Ratio	
100b	2.5x	
101 b	3.0x	
110b	2.0x or 6.0x*	
111b	3.5x	
000b	4.5x	
001b	5.0x	
010b	4.0x	
011b	5.5x	
<i>Note:</i> * The ratio selected is dependent on the stepping of the Model 8. The 2.0x ratio is supported on the Model 8/[7:0], whereas the 6.0x ratio is supported on the Model 8/[F:8].		

 Table 18.
 Processor-to-Bus Clock Ratios

Sampled

BF[2:0] are sampled during the falling transition of RESET. They must meet a minimum setup time of 1.0 ms and a minimum hold time of two clocks relative to the negation of RESET.

### 4.11 BOFF# (Backoff)

#### Input

Summary	If BOFF# is sampled asserted, the processor unconditionally aborts any cycles in progress and transitions to a bus hold state by floating the following signals: A[31:3], ADS#, ADSC#, AP, BE[7:0]#, CACHE#, D[63:0], D/C#, DP[7:0], LOCK#, M/IO#, PCD, PWT, SCYC, and W/R#. These signals remain floated until BOFF# is sampled negated. This allows an alternate bus master or the system to control the bus.
	When BOFF# is sampled negated, any processor cycle that was
	aborted due to the assertion of BOFF# is restarted from the

aborted due to the assertion of BOFF# is restarted from the beginning of the cycle, regardless of the number of transfers that were completed. If BOFF# is sampled asserted on the same clock edge as BRDY# of a bus cycle of any length, then BOFF# takes precedence over the BRDY#. In this case, the cycle is aborted and restarted after BOFF# is sampled negated.

# SampledBOFF# is sampled on every clock edge. The processor floats its<br/>bus signals off the clock edge on which BOFF# is sampled<br/>asserted. These signals remain floated until the clock edge on<br/>which BOFF# is sampled negated.

BOFF# is recognized while INIT and RESET are sampled asserted.

## 4.12 BRDY# (Burst Ready)

#### Input, Internal Pullup

Summary BRDY # is asserted to the processor by system logic to indicate either that the data bus is being driven with valid data during a read cycle or that the data bus has been latched during a write cycle. If necessary, the system logic can insert bus cycle wait states by negating BRDY # until it is ready to continue the data transfer. BRDY # is also used to indicate the completion of special bus cycles.

Sampled BRDY# is sampled every clock edge within a bus cycle starting with the clock edge after the clock edge that negates ADS#. BRDY# is ignored while the bus is idle. The processor samples the following inputs on the clock edge on which BRDY# is sampled asserted: D[63:0], DP[7:0], and KEN# during read cycles, EWBE# during write cycles (if not masked off), and WB/WT# during read and write cycles. If NA# is sampled asserted prior to BRDY#, then KEN# and WB/WT# are sampled on the clock edge on which NA# is sampled asserted.

The number of times the processor expects to sample BRDY# asserted depends on the type of bus cycle, as follows:

- One time for a single-transfer cycle, a special bus cycle, or each of two cycles in an interrupt acknowledge sequence
- Four times for a burst cycle (once for each data transfer)

BRDY # can be held asserted for four consecutive clocks throughout the four transfers of the burst, or it can be negated to insert wait states.

21850J/0-February 2000

## 4.13 BRDYC# (Burst Ready Copy)

#### Input, Internal Pullup

BRDYC# has the identical function as BRDY#. In the event
BRDY# becomes too heavily loaded due to a large fanout or
loading in a system, BRDYC# can be used to reduce this
loading, which improves timing.

In addition, BRDYC# is sampled when RESET is negated to configure the drive strength of A[20:3], ADS#, HITM#, and W/R#. If BRDYC# is 0 during the falling transition of RESET, these particular outputs are configured using higher drive strengths than the standard strength. If BRDYC# is 1 during the falling transition of RESET, the standard strength is selected.

## SampledBRDYC# is sampled every clock edge within a bus cycle starting<br/>with the clock edge after the clock edge that negates ADS#.

BRDYC# is also sampled during the falling transition of RESET. If RESET is driven synchronously, BRDYC# must meet the specified hold time relative to the negation of RESET. If RESET is driven asynchronously, the minimum setup and hold time for BRDYC# relative to the negation of RESET is two clocks.

## 4.14 BREQ (Bus Request)

#### Output

SummaryBREQ is asserted by the processor to request the bus in order to<br/>complete an internally pending bus cycle. The system logic can<br/>use BREQ to arbitrate among the bus participants. If the<br/>processor does not own the bus, BREQ is asserted until the<br/>processor gains access to the bus in order to begin the pending<br/>cycle or until the processor no longer needs to run the pending<br/>cycle. If the processor currently owns the bus, BREQ is asserted<br/>with ADS#. The processor asserts BREQ for each assertion of<br/>ADS# but does not necessarily assert ADS# for each assertion of<br/>BREQ.DrivenBREQ is asserted off the same clock edge on which ADS# is

Driven BREQ is asserted off the same clock edge on which ADS# is asserted. BREQ can also be asserted off any clock edge, independent of the assertion of ADS#. BREQ can be negated one clock edge after it is asserted.

The processor always drives BREQ except in the Tri-State Test mode.

## 4.15 CACHE# (Cacheable Access)

#### Output

Summary For reads, CACHE# is asserted to indicate the cacheability of the current bus cycle. In addition, if the processor samples KEN# asserted, which indicates the driven address is cacheable, the cycle is a 32-byte burst read cycle. For write cycles, CACHE# is asserted to indicate the current bus cycle is a modified cache-line writeback. KEN# is ignored during writebacks. If CACHE# is not asserted, or if KEN# is sampled negated during a read cycle, the cycle is not cacheable and defaults to a single-transfer cycle.

Driven and Floated CACHE# is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted.

CACHE# is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

## 4.16 CLK (Clock)

#### Input

Summary The CLK signal is the bus clock for the processor and is the reference for all signal timings under normal operation (except for TDI, TDO, TMS, and TRST#). BF[2:0] determine the internal frequency multiplier applied to CLK to obtain the processor's core operating frequency. See "BF[2:0] (Bus Frequency)" on page 94 for a list of the processor-to-bus clock ratios.

SampledThe CLK signal must be stable a minimum of 1.0 ms prior to the<br/>negation of RESET to ensure the proper operation of the<br/>processor. See "CLK Switching Characteristics" on page 269 for<br/>details regarding the CLK specifications.

## 4.17 D/C# (Data/Code)

#### Output

*Summary* The processor drives D/C# during a memory bus cycle to indicate whether it is addressing data or executable code. D/C# is also used to define other bus cycles, including interrupt acknowledge and special cycles. See Table 25 on page 128 for more details.

Driven and Floated D/C# is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted. D/C# is driven during memory cycles, I/O cycles, special bus cycles, and interrupt acknowledge cycles.

D/C# is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

## 4.18 D[63:0] (Data Bus)

#### **Bidirectional**

- SummaryD[63:0] represent the processor's 64-bit data bus. Each of the<br/>eight bytes of data that comprise this bus is qualified as valid by<br/>its corresponding byte enable. See "BE[7:0]# (Byte Enables)"<br/>on page 93.
- Driven, Sampled, and<br/>FloatedAs Outputs: For single-transfer write cycles, the processor drives<br/>D[63:0] with valid data one clock edge after the clock edge on<br/>which ADS# is asserted and D[63:0] remain in the same state<br/>until the clock edge on which BRDY# is sampled asserted. If the<br/>cycle is a writeback—in which case four, 8-byte transfers<br/>occur—D[63:0] are driven one clock edge after the clock edge<br/>on which ADS# is asserted and are subsequently changed off<br/>the clock edge on which each BRDY# assertion of the burst<br/>cycle is sampled.

If the assertion of ADS# represents a pipelined write cycle that follows a read cycle, the processor does not drive D[63:0] until it is certain that contention on the data bus will not occur. In this case, D[63:0] are driven the clock edge after the last expected BRDY# of the previous cycle is sampled asserted.

*As Inputs:* During read cycles, the processor samples D[63:0] on the clock edge on which BRDY# is sampled asserted.

The processor always floats D[63:0] except when they are being driven during a write cycle as described above. In addition, D[63:0] are floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

## 4.19 DP[7:0] (Data Parity)

#### **Bidirectional**

Summary DP[7:0] are even parity bits for each valid byte of data—as defined by BE[7:0]#—driven and sampled on the D[63:0] data bus. Even parity means that the total number of 1 bits within each byte of data and its respective data parity bit is an even number. DP[7:0] are driven by the processor during write cycles and sampled by the processor during read cycles. If the processor detects bad parity on any valid byte of data during a read cycle, PCHK# is asserted for one clock beginning the clock edge after BRDY# is sampled asserted. The processor does not take an internal exception as the result of detecting a data parity check, and system logic must respond appropriately to the assertion of this signal.

The eight data parity bits correspond to the eight bytes of the data bus as follows:

- DP7: D[63:56] DP3: D[31:24]
  - DP6: D[55:48] DP2: D[23:16]
  - DP5: D[47:40] DP1: D[15:8]
  - DP4: D[39:32] DP0: D[7:0]

For systems that do not support data parity, DP[7:0] should be connected to  $V_{CC3}$  through pullup resistors.

Driven, Sampled, and<br/>FloatedAs Outputs: For single-transfer write cycles, the processor drives<br/>DP[7:0] with valid parity one clock edge after the clock edge on<br/>which ADS# is asserted and DP[7:0] remain in the same state<br/>until the clock edge on which BRDY# is sampled asserted. If the<br/>cycle is a writeback, DP[7:0] are driven one clock edge after the<br/>clock edge on which ADS# is asserted and are subsequently<br/>changed off the clock edge on which each BRDY# assertion of<br/>the burst cycle is sampled.As Inputs: During read cycles, the processor samples DP[7:0] on<br/>the clock edge BRDY# is sampled asserted.

The processor always floats DP[7:0] except when they are being driven during a write cycle as described above. In addition, DP[7:0] are floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in recognition of HOLD.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.20 EADS# (External Address Strobe)

#### Input

Summary System logic asserts EADS# during a cache inquire cycle to indicate that the address bus contains a valid address. EADS# can only be driven after the system logic has taken control of the address bus by asserting AHOLD or BOFF# or by receiving HLDA. The processor responds to the sampling of EADS# and the address bus by driving HIT#, which indicates if the inquired cache line exists in the processor's cache, and HITM#, which indicates if it is in the modified state.

Sampled If AHOLD or BOFF# is asserted by the system logic in order to execute a cache inquire cycle, the processor begins sampling EADS# two clock edges after AHOLD or BOFF# is sampled asserted. If the system logic asserts HOLD in order to execute a cache inquire cycle, the processor begins sampling EADS# two clock edges after the clock edge HLDA is asserted by the processor.

EADS# is ignored during the following conditions:

- One clock edge after the clock edge on which EADS# is sampled asserted
- Two clock edges after the clock edge on which ADS# is asserted
- When the processor is driving the address bus
- When the processor asserts HITM#

21850J/0-February 2000

## 4.21 EWBE# (External Write Buffer Empty)

## Input

Summary	The system logic can negate EWBE# to the processor to indicate that its external write buffers are full and that additional data cannot be stored at this time. This causes the processor to delay the following activities until EWBE# is sampled asserted:
	<ul> <li>The commitment of write hit cycles to cache lines in the modified state or exclusive state in the processor's cache</li> </ul>
	<ul> <li>The decode and execution of an instruction that follows a currently-executing serializing instruction</li> </ul>
	<ul> <li>The assertion or negation of SMIACT#</li> </ul>
	<ul> <li>The entering of the Halt state and the Stop Grant state</li> </ul>
	Negating EWBE# does not prevent the completion of any type of cycle that is currently in progress.
Sampled	The processor samples EWBE# on each clock edge that BRDY# is sampled asserted during all memory write cycles (except writeback cycles), I/O write cycles, and special bus cycles.
	If EWBE# is sampled negated, it is sampled on every clock edge until it is asserted, and then it is ignored until BRDY# is sampled asserted in the next write cycle or special cycle.
	On the AMD-K6-2 Model 8/[F:8] processor, if EFER[3] is set to 1, then EWBE# is ignored by the processor. For more information on the EFER settings and EWBE#, see "EWBE Control" on page 203.

## 4.22 FERR# (Floating-Point Error)

## Output

Summary	The assertion of FERR# indicates the occurrence of an unmasked floating-point exception resulting from the execution of a floating-point instruction. This signal is provided to allow the system logic to handle this exception in a manner consistent with IBM-compatible PC/AT systems. See "Handling Floating-Point Exceptions" on page 209 for a system logic implementation that supports floating-point exceptions.
	The state of the numeric error (NE) bit in CR0 does not affect the FERR#signal.
	The processor is designed so that FERR# does not glitch, enabling the signal to be used as a clocking source for system logic.
Driven	The processor asserts FERR# on the instruction boundary of the next floating-point instruction, MMX instruction, 3DNow! instruction, or WAIT instruction that occurs following the floating-point instruction that caused the unmasked floating-point exception—that is, FERR# is not asserted at the time the exception occurs. The IGNNE# signal does not affect the assertion of FERR#.
	FERR# is negated during the following conditions:
	■ Following the successful execution of the floating-point instructions FCLEX, FINIT, FSAVE, and FSTENV
	<ul> <li>Under certain circumstances, following the successful execution of the floating-point instructions FLDCW, FLDENV, and FRSTOR, which load the floating-point status word or the floating-point control word</li> </ul>
	<ul> <li>Following the falling transition of RESET</li> </ul>
	FERR# is always driven except in the Tri-State Test mode.
	See "IGNNE# (Ignore Numeric Exception)" on page 108 for more details on floating-point exceptions.

## 4.23 FLUSH# (Cache Flush)

#### Input

*Summary* In response to sampling FLUSH# asserted, the processor writes back any data cache lines that are in the modified state, invalidates all lines in the instruction and data caches, and then executes a flush acknowledge special cycle. See Table 25 on page 128 for the bus definition of special cycles.

In addition, FLUSH# is sampled when RESET is negated to determine if the processor enters the Tri-State Test mode. If FLUSH# is 0 during the falling transition of RESET, the processor enters the Tri-State Test mode instead of performing the normal RESET functions.

Sampled FLUSH# is sampled and latched as a falling edge-sensitive signal. During normal operation (not RESET), FLUSH# is sampled on every clock edge but is not recognized until the next instruction boundary. If FLUSH# is asserted synchronously, it can be asserted for a minimum of one clock. If FLUSH# is asserted asynchronously, it must have been negated for a minimum of two clocks, followed by an assertion of a minimum of two clocks.

FLUSH# is also sampled during the falling transition of RESET. If RESET and FLUSH# are driven synchronously, FLUSH# is sampled on the clock edge prior to the clock edge on which RESET is sampled negated. If RESET is driven asynchronously, the minimum setup and hold time for FLUSH#, relative to the negation of RESET, is two clocks.

## 4.24 HIT# (Inquire Cycle Hit)

#### Output

- SummaryThe processor asserts HIT# during an inquire cycle to indicate<br/>that the cache line is valid within the processor's instruction or<br/>data cache (also known as a cache hit). The cache line can be in<br/>the modified, exclusive, or shared state.
- DrivenHIT# is always driven—except in the Tri-State Test mode—and<br/>only changes state the clock edge after the clock edge on which<br/>EADS# is sampled asserted. It is driven in the same state until<br/>the next inquire cycle.

## 4.25 HITM# (Inquire Cycle Hit To Modified Line)

#### Output

Summary The processor asserts HITM# during an inquire cycle to indicate that the cache line exists in the processor's data cache in the modified state. The processor performs a writeback cycle as a result of this cache hit. If an inquire cycle hits a cache line that is currently being written back, the processor asserts HITM# but does not execute another writeback cycle. The system logic must not expect the processor to assert ADS# each time HITM# is asserted.

Driven HITM# is always driven—except in the Tri-State Test mode and, in particular, is driven to represent the result of an inquire cycle the clock edge after the clock edge on which EADS# is sampled asserted. If HITM# is negated in response to the inquire address, it remains negated until the next inquire cycle. If HITM# is asserted in response to the inquire address, it remains asserted throughout the writeback cycle and is negated one clock edge after the last BRDY# of the writeback is sampled asserted. 21850J/0-February 2000

## 4.26 HLDA (Hold Acknowledge)

#### Output

Summary When HOLD is sampled asserted, the processor completes the current bus cycles, floats the processor bus, and asserts HLDA in an acknowledgment that these events have been completed. The processor does not assert HLDA until the completion of a locked sequence of cycles. While HLDA is asserted, another bus master can drive cycles on the bus, including inquire cycles to the processor. The following signals are floated when HLDA is asserted: A[31:3], ADS#, ADSC#, AP, BE[7:0]#, CACHE#, D[63:0], D/C#, DP[7:0], LOCK#, M/IO#, PCD, PWT, SCYC, and W/R#.

The processor is designed so that HLDA does not glitch.

Driven HLDA is always driven except in the Tri-State Test mode. If a processor cycle is in progress while HOLD is sampled asserted, HLDA is asserted one clock edge after the last BRDY# of the cycle is sampled asserted. If the bus is idle, HLDA is asserted one clock edge after HOLD is sampled asserted. HLDA is negated one clock edge after the clock edge on which HOLD is sampled negated.

The assertion of HLDA is independent of the sampled state of BOFF#.

The processor floats the bus every clock in which HLDA is asserted.

## 4.27 HOLD (Bus Hold Request)

#### Input

Summary The system logic can assert HOLD to gain control of the processor's bus. When HOLD is sampled asserted, the processor completes the current bus cycles, floats the processor bus, and asserts HLDA in an acknowledgment that these events have been completed.

Sampled The processor samples HOLD on every clock edge. If a processor cycle is in progress while HOLD is sampled asserted, HLDA is asserted one clock edge after the last BRDY# of the cycle is sampled asserted. If the bus is idle, HLDA is asserted one clock edge after HOLD is sampled asserted. HOLD is recognized while INIT and RESET are sampled asserted.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.28 IGNNE# (Ignore Numeric Exception)

#### Input

Summary

IGNNE#, in conjunction with the numeric error (NE) bit in CR0, is used by the system logic to control the effect of an unmasked floating-point exception on a previous floating-point instruction during the execution of a floating-point instruction, MMX instruction, 3DNow! instruction, or the WAIT instruction hereafter referred to as the target instruction.

If an unmasked floating-point exception is pending and the target instruction is considered error-sensitive, then the relationship between NE and IGNNE# is as follows:

- If NE = 0, then:
  - If IGNNE# is sampled asserted, the processor ignores the floating-point exception and continues with the execution of the target instruction.
  - If IGNNE# is sampled negated, the processor waits until it samples IGNNE#, INTR, SMI#, NMI, or INIT asserted.

If IGNNE# is sampled asserted while waiting, the processor ignores the floating-point exception and continues with the execution of the target instruction. If INTR, SMI#, NMI, or INIT is sampled asserted while

waiting, the processor handles its assertion appropriately.

■ If NE = 1, the processor invokes the INT 10h exception handler.

If an unmasked floating-point exception is pending and the target instruction is considered error-insensitive, then the processor ignores the floating-point exception and continues with the execution of the target instruction.

FERR# is not affected by the state of the NE bit or IGNNE#. FERR# is always asserted at the instruction boundary of the target instruction that follows the floating-point instruction that caused the unmasked floating-point exception.

This signal is provided to allow the system logic to handle exceptions in a manner consistent with IBM-compatible PC/AT systems.

#### Sampled The processor samples IGNNE# as a level-sensitive input on every clock edge. The system logic can drive the signal either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks.

## 4.29 INIT (Initialization)

#### Input

SummaryThe assertion of INIT causes the processor to empty its<br/>pipelines, to initialize most of its internal state, and to branch<br/>to address FFFF\_FF0h—the same instruction execution<br/>starting point used after RESET. Unlike RESET, the processor<br/>preserves the contents of its caches, the floating-point state, the<br/>MMX state, Model-Specific Registers, the CD and NW bits of<br/>the CR0 register, and other specific internal resources.

INIT can be used as an accelerator for 80286 code that requires a reset to exit from Protected mode back to Real mode.

SampledINIT is sampled and latched as a rising edge-sensitive signal.<br/>INIT is sampled on every clock edge but is not recognized until<br/>the next instruction boundary. During an I/O write cycle, it must<br/>be sampled asserted a minimum of three clock edges before<br/>BRDY # is sampled asserted if it is to be recognized on the<br/>boundary between the I/O write instruction and the following<br/>instruction.

If INIT is asserted synchronously, it can be asserted for a minimum of one clock. If it is asserted asynchronously, it must have been negated for a minimum of two clocks, followed by an assertion of a minimum of two clocks.

## 4.30 INTR (Maskable Interrupt)

#### Input

Summary INTR is the system's maskable interrupt input to the processor. When the processor samples and recognizes INTR asserted, the processor executes a pair of interrupt acknowledge bus cycles and then jumps to the interrupt service routine specified by the interrupt number that was returned during the interrupt acknowledge sequence. The processor only recognizes INTR if the interrupt flag (IF) in the EFLAGS register equals 1.

Sampled The processor samples INTR as a level-sensitive input on every clock edge, but the interrupt request is not recognized until the next instruction boundary. The system logic can drive INTR either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks. In order to be recognized, INTR must remain asserted until an interrupt acknowledge sequence is complete.

## 4.31 INV (Invalidation Request)

#### Input

# *Summary* During an inquire cycle, the state of INV determines whether an addressed cache line that is found in the processor's instruction or data cache transitions to the invalid state or the shared state.

If INV is sampled asserted during an inquire cycle, the processor transitions the cache line (if found) to the invalid state, regardless of its previous state. If INV is sampled negated during an inquire cycle, the processor transitions the cache line (if found) to the shared state. In either case, if the cache line is found in the modified state, the processor writes it back to memory before changing its state.

*Sampled* INV is sampled on the clock edge on which EADS# is sampled asserted.

## 4.32 KEN# (Cache Enable)

## Input

Summary	If KEN# is sampled asserted, it indicates that the address presented by the processor is cacheable. If KEN# is sampled asserted and the processor intends to perform a cache-line fill (signified by the assertion of CACHE#), the processor executes a 32-byte burst read cycle and expects to sample BRDY# asserted a total of four times. If KEN# is sampled negated during a read cycle, a single-transfer cycle is executed and the processor does not cache the data. For write cycles, CACHE# is asserted to indicate the current bus cycle is a modified cache-line writeback. KEN# is ignored during writebacks.
	If PCD is asserted during a bus cycle, the processor does not cache any data read during that cycle, regardless of the state of KEN#. See "PCD (Page Cache Disable)" on page 115 for more details.
	If the processor has sampled the state of KEN# during a cycle, and that cycle is aborted due to the sampling of BOFF# asserted, the system logic must ensure that KEN# is sampled in the same state when the processor restarts the aborted cycle.
Sampled	KEN# is sampled on the clock edge on which the first BRDY# or NA# of a read cycle is sampled asserted. If the read cycle is a burst, KEN# is ignored during the last three assertions of BRDY#. KEN# is sampled during read cycles only when CACHE# is asserted.

## 4.33 LOCK# (Bus Lock)

#### Output

Summary

The processor asserts LOCK# during a sequence of bus cycles to ensure that the cycles are completed without allowing other bus masters to intervene. Locked operations consist of two to five bus cycles. LOCK# is asserted during the following operations:

- An interrupt acknowledge sequence
- Descriptor Table accesses
- Page Directory and Page Table accesses
- XCHG instruction
- An instruction with an allowable LOCK prefix

In order to ensure that locked operations appear on the bus and are visible to the entire system, any data operands addressed during a locked cycle that reside in the processor's cache are flushed and invalidated from the cache prior to the locked operation. If the cache line is in the modified state, it is written back and invalidated prior to the locked operation. Likewise, any data read during a locked operation is not cached.

The processor is designed so that LOCK# does not glitch.

Driven and Floated During a locked cycle, LOCK# is asserted off the same clock edge on which ADS# is asserted and remains asserted until the last BRDY# of the last bus cycle is sampled asserted. The processor negates LOCK# for at least one clock between consecutive sequences of locked operations to allow the system logic to arbitrate for the bus.

> LOCK# is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD. When LOCK# is floated due to BOFF# sampled asserted, the system logic is responsible for preserving the lock condition while LOCK# is in the high-impedance state.

21850J/0-February 2000

## 4.34 M/IO# (Memory or I/O)

#### Output

Summary The processor drives M/IO# during a bus cycle to indicate whether it is addressing the memory or I/O space. If M/IO# = 1, the processor is addressing memory or a memory-mapped I/O port as the result of an instruction fetch or an instruction that loads or stores data. If M/IO# = 0, the processor is addressing an I/O port during the execution of an I/O instruction. In addition, M/IO# is used to define other bus cycles, including interrupt acknowledge and special cycles. See Table 25 on page 128 for more details.

#### Driven and Floated M/IO# is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted. M/IO# is driven during memory cycles, I/O cycles, special bus cycles, and interrupt acknowledge cycles.

M/IO# is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 4.35 NA# (Next Address)

#### Input

Summary System logic asserts NA# to indicate to the processor that it is ready to accept another bus cycle pipelined into the previous bus cycle. ADS#, along with address and status signals, can be asserted as early as one clock edge after NA# is sampled asserted if the processor is prepared to start a new cycle. Because the processor allows a maximum of two cycles to be in progress at a time, the assertion of NA# is sampled while two cycles are in progress but ADS# is not asserted until the completion of the first cycle.

Sampled NA# is sampled every clock edge during bus cycles, starting one clock edge after the clock edge that negates ADS#, until the last expected BRDY# of the last executed cycle is sampled asserted (with the exception of the clock edge after the clock edge that negates the ADS# for a second pending cycle). Because the processor latches NA# when sampled, the system logic only needs to assert NA# for one clock.

## 4.36 NMI (Non-Maskable Interrupt)

#### Input

Summary When NMI is sampled asserted, the processor jumps to the interrupt service routine defined by interrupt number 02h. Unlike the INTR signal, software cannot mask the effect of NMI if it is sampled asserted by the processor. However, NMI is temporarily masked upon entering System Management Mode (SMM). In addition, an interrupt acknowledge cycle is not executed because the interrupt number is predefined.

If NMI is sampled asserted while the processor is executing the interrupt service routine for a previous NMI, the subsequent NMI remains pending until the completion of the execution of the IRET instruction at the end of the interrupt service routine.

Sampled NMI is sampled and latched as a rising edge-sensitive signal. During normal operation, NMI is sampled on every clock edge but is not recognized until the next instruction boundary. If it is asserted synchronously, it can be asserted for a minimum of one clock. If it is asserted asynchronously, it must have been negated for a minimum of two clocks, followed by an assertion of a minimum of two clocks.

## 4.37 PCD (Page Cache Disable)

#### Output

The processor drives PCD to indicate the operating system's Summary specification of cacheability for the page being addressed. System logic can use PCD to control external caching. If PCD is asserted, the addressed page is not cached. If PCD is negated, the cacheability of the addressed page depends upon the state of CACHE# and KEN#. The state of PCD depends upon the processor's operating mode and the state of certain bits in its control registers and TLB as follows: In Real mode, or in Protected and Virtual-8086 modes while paging is disabled (PG bit in CR0 set to 0): PCD output = CD bit in CR0 In Protected and Virtual-8086 modes while caching is enabled (CD bit in CR0 set to 0) and paging is enabled (PG bit in CR0 set to 1): For accesses to I/O space, page directory entries, and other non-paged accesses: PCD output = PCD bit in CR3 For accesses to 4-Kbyte page table entries or 4-Mbyte pages: PCD output = PCD bit in page directory entry For accesses to 4-Kbyte pages: PCD output = PCD bit in page table entry Driven and Floated PCD is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted. PCD is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD.

## 4.38 PCHK# (Parity Check)

## Output

Summary	The processor asserts PCHK# during read cycles if it detects an even parity error on one or more valid bytes of D[63:0] during a read cycle. (Even parity means that the total number of 1 bits within each byte of data and its respective data parity bit is even.) The processor checks data parity for the data bytes that are valid, as defined by BE[7:0]#, the byte enables.
	PCHK# is always driven but is only asserted for memory and I/O read bus cycles and the second cycle of an interrupt acknowledge sequence. PCHK# is not driven during any type of write cycles or special bus cycles. The processor does not take an internal exception as the result of detecting a data parity error, and system logic must respond appropriately to the assertion of this signal.
	The processor is designed so that PCHK# does not glitch, enabling the signal to be used as a clocking source for system logic.
Driven	PCHK# is always driven except in the Tri-State Test mode. For each BRDY# returned to the processor during a read cycle with a parity error detected on the data bus, PCHK# is asserted for one clock, one clock edge after BRDY# is sampled asserted.

## 4.39 **PWT (Page Writethrough)**

#### Output

Summary

The processor drives PWT to indicate the operating system's specification of the writeback state or writethrough state for the page being addressed. PWT, together with WB/WT#, specifies the data cache-line state during cacheable read misses and write hits to shared cache lines. See "WB/WT# (Writeback or Writethrough)" on page 125 for more details.

The state of PWT depends upon the processor's operating mode and the state of certain bits in its control registers and TLB as follows:

 In Real mode, or in Protected and Virtual-8086 modes while paging is disabled (PG bit in CR0 set to 0):

PWT output = 0 (writeback state)

- In Protected and Virtual-8086 modes while paging is enabled (PG bit in CR0 set to 1):
  - For accesses to I/O space, page directory entries, and other non-paged accesses:

PWT output = PWT bit in CR3

• For accesses to 4-Kbyte page table entries or 4-Mbyte pages:

**PWT output = PWT bit in page directory entry** 

• For accesses to 4-Kbyte pages:

PWT output = PWT bit in page table entry

## Driven and Floated PWT is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted.

PWT is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

#### 4.40 **RESET (Reset)**

#### Input

Summary When the processor samples RESET asserted, it immediately flushes and initializes all internal resources and its internal state including its pipelines and caches, the floating-point state, the MMX state, the 3DNow! state, and all registers, and then the processor jumps to address FFFF\_FF0h to start instruction execution.

The signals BRDYC# and FLUSH# are sampled during the falling transition of RESET to select the drive strength of selected output signals and to invoke the Tri-State Test mode, respectively. See these signal descriptions for more details.

SampledRESET is sampled as a level-sensitive input on every clock<br/>edge. System logic can drive the signal either synchronously or<br/>asynchronously.

During the initial power-on reset of the processor, RESET must remain asserted for a minimum of 1.0 ms after CLK and  $V_{CC}$  reach specification before it is negated.

During a warm reset, while CLK and  $V_{CC}$  are within their specification, RESET must remain asserted for a minimum of 15 clocks prior to its negation.

#### 4.41 **RSVD (Reserved)**

Summary

Reserved signals are a special class of pins that can be treated in one of the following ways:

- As no-connect (NC) pins, in which case these pins are left unconnected
- As pins connected to the system logic as defined by the industry-standard Super7 and Socket 7 interface
- Any combination of NC and Socket 7 pins

In any case, if the RSVD pins are treated accordingly, the normal operation of the AMD-K6-2 processor is not adversely affected in any manner.

See "Pin Designations" on page 299 for a list of the locations of the RSVD pins.

## 4.42 SCYC (Split Cycle)

#### Output

SummaryThe processor asserts SCYC during misaligned, locked transfers<br/>on the D[63:0] data bus. The processor generates additional bus<br/>cycles to complete the transfer of misaligned data.

For purposes of bus cycles, the term *aligned* means:

- Any 1-byte transfers
- 2-byte and 4-byte transfers that lie within 4-byte address boundaries
- **8**-byte transfers that lie within 8-byte address boundaries

# Driven and Floated SCYC is asserted off the same clock edge as ADS#, and negated off the clock edge on which NA# or the last expected BRDY# of the entire locked sequence is sampled asserted. SCYC is only valid during locked memory cycles.

SCYC is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD.

## 4.43 SMI# (System Management Interrupt)

#### Input, Internal Pullup

## SummaryThe assertion of SMI# causes the processor to enter System<br/>Management Mode (SMM). Upon recognizing SMI#, the<br/>processor performs the following actions, in the order shown:

- 1. Flushes its instruction pipelines
- 2. Completes all pending and in-progress bus cycles
- 3. Acknowledges the interrupt by asserting SMIACT# after sampling EWBE# asserted (if EWBE# is masked off, then SMIACT# is not affected by EWBE#)
- 4. Saves the internal processor state in SMM memory
- 5. Disables interrupts by clearing the interrupt flag (IF) in EFLAGS and disables NMI interrupts
- 6. Jumps to the entry point of the SMM service routine at the SMM base physical address which defaults to 0003\_8000h in SMM memory

AMD-K6<sup>®</sup>-2 Processor Data Sheet

See "System Management Mode (SMM)" on page 213 for more details regarding SMM.

Sampled SMI# is sampled and latched as a falling edge-sensitive signal. SMI# is sampled on every clock edge but is not recognized until the next instruction boundary. If SMI# is to be recognized on the instruction boundary associated with a BRDY#, it must be sampled asserted a minimum of three clock edges before the BRDY# is sampled asserted. If it is asserted synchronously, it can be asserted for a minimum of one clock. If it is asserted asynchronously, it must have been negated for a minimum of two clocks followed by an assertion of a minimum of two clocks.

A second assertion of SMI# while in SMM is latched but is not recognized until the SMM service routine is exited.

## 4.44 SMIACT# (System Management Interrupt Active)

#### Output

SummaryThe processor acknowledges the assertion of SMI# with the<br/>assertion of SMIACT# to indicate that the processor has<br/>entered System Management Mode (SMM). The system logic<br/>can use SMIACT# to enable SMM memory. See "SMI# (System<br/>Management Interrupt)" on page 119 for more details.

See "System Management Mode (SMM)" on page 213 for more details regarding SMM.

DrivenThe processor asserts SMIACT# after the last BRDY# of the last<br/>pending bus cycle is sampled asserted (including all pending<br/>write cycles) and after EWBE# is sampled asserted (if EWBE#<br/>is masked off, then SMIACT# is not affected by EWBE#).<br/>SMIACT# remains asserted until after the last BRDY# of the<br/>last pending bus cycle associated with exiting SMM is sampled<br/>asserted.

SMIACT# remains asserted during any flush, internal snoop, or writeback cycle due to an inquire cycle.

## 4.45 STPCLK# (Stop Clock)

#### Input, Internal Pullup

Summary	The assertion of STPCLK# causes the processor to enter the Stop Grant state, during which the processor's internal clock is stopped. From the Stop Grant state, the processor can subsequently transition to the Stop Clock state, in which the bus clock CLK is stopped. Upon recognizing STPCLK#, the processor performs the following actions, in the order shown:
	1. Flushes its instruction pipelines
	2. Completes all pending and in-progress bus cycles
	3. Acknowledges the STPCLK# assertion by executing a Stop Grant special bus cycle (see Table 25 on page 128)
	4. Stops its internal clock after BRDY# of the Stop Grant special bus cycle is sampled asserted and after EWBE# is sampled asserted (if EWBE# is masked off, then entry into the Stop Grant state is not affected by EWBE#)
	5. Enters the Stop Clock state if the system logic stops the bus clock CLK (optional)
	See "Clock Control" on page 245 for more details regarding clock control.
Sampled	STPCLK# is sampled as a level-sensitive input on every clock edge but is not recognized until the next instruction boundary. System logic can drive the signal either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks.
	STPCLK# must remain asserted until recognized, which is indicated by the completion of the Stop Grant special cycle.
4.46 TCK (Te	st Clock)
	Input, Internal Pullup
_	

Summary TCK is the clock for boundary-scan testing using the Test Access Port (TAP). See "Boundary-Scan Test Access Port (TAP)" on page 225 for details regarding the operation of the TAP controller.

Sampled	The processor always samples TCI	K, except while TRST# is
	asserted.	

## 4.47 TDI (Test Data Input)

#### Input, Internal Pullup

SummaryTDI is the serial test data and instruction input for<br/>boundary-scan testing using the Test Access Port (TAP). See<br/>"Boundary-Scan Test Access Port (TAP)" on page 225 for details<br/>regarding the operation of the TAP controller.

SampledThe processor samples TDI on every rising TCK edge but only<br/>while in the Shift-IR and Shift-DR states.

## 4.48 TDO (Test Data Output)

#### Output

SummaryTDO is the serial test data and instruction output for<br/>boundary-scan testing using the Test Access Port (TAP). See<br/>"Boundary-Scan Test Access Port (TAP)" on page 225 for details<br/>regarding the operation of the TAP controller.

Driven and Floated The processor drives TDO on every falling TCK edge but only while in the Shift-IR and Shift-DR states. TDO is floated at all other times.

## 4.49 TMS (Test Mode Select)

#### Input, Internal Pullup

SummaryTMS specifies the test function and sequence of state changes<br/>for boundary-scan testing using the Test Access Port (TAP). See<br/>"Boundary-Scan Test Access Port (TAP)" on page 225 for details<br/>regarding the operation of the TAP controller.

Sampled The processor samples TMS on every rising TCK edge. If TMS is sampled High for five or more consecutive clocks, the TAP controller enters its Test-Logic-Reset state, regardless of the controller state. This action is the same as that achieved by asserting TRST#.

## 4.50 TRST# (Test Reset)

#### Input, Internal Pullup

- SummaryThe assertion of TRST# initializes the Test Access Port (TAP) by<br/>resetting its state machine to the Test-Logic-Reset state. See<br/>"Boundary-Scan Test Access Port (TAP)" on page 225 for details<br/>regarding the operation of the TAP controller.
- SampledTRST# is a completely asynchronous input that does not require<br/>a minimum setup and hold time relative to TCK. See Table 69<br/>on page 282 for the minimum pulse width requirement.

## 4.51 VCC2DET (V<sub>CC2</sub> Detect)

#### Output

- SummaryVCC2DET is internally tied to  $V_{SS}$  (logic level 0) to indicate to<br/>the system logic that it must supply the specified dual-voltage<br/>requirements to the  $V_{CC2}$  and  $V_{CC3}$  pins. The  $V_{CC2}$  pins supply<br/>voltage to the processor core, independent of the voltage<br/>supplied to the I/O buffers on the  $V_{CC3}$  pins. Upon sampling<br/>VCC2DET Low, system logic should sample VCC2H/L# to<br/>identify core voltage requirements.
- Driven VCC2DET always equals 0 and is never floated—even during the Tri-State Test mode.

## 4.52 VCC2H/L# (V<sub>CC2</sub> High/Low)

#### Output

Summary VCC2H/L# is internally tied to  $V_{SS}$  (logic level 0) to indicate to the system logic that it must supply the specified processor core voltage to the  $V_{CC2}$  pins. The  $V_{CC2}$  pins supply voltage to the processor core, independent of the voltage supplied to the I/O buffers on the  $V_{CC3}$  pins. Upon sampling VCC2DET Low to identify dual-voltage processor requirements, system logic should sample VCC2H/L# to identify the core voltage requirements for 2.9V and 3.2V products (High) or 2.2V and 2.4 V products (Low).

DrivenVCC2H/L# always equals 0 and is never floated for 2.2V and<br/>2.4 V products—even during the Tri-State Test mode. To ensure<br/>proper operation for 2.9V and 3.2V products, system logic that

AMD-K6<sup>®</sup>-2 Processor Data Sheet

samples VCC2H/L# should design a weak pullup resistor for this signal.

Table 19.         Output Pin Float Conditions
---

Na	me	Floated At:	Note
VCC2	DET	Always Driven	*
VCC2F	1/L#	Always Driven	*
Note: * All outputs except VCC2DET, VCC2H/L#, and TDO float during the Tri-State Test mode.			

## 4.53 W/R# (Write/Read)

#### Output

- SummaryThe processor drives W/R# to indicate whether it is performing<br/>a write or a read cycle on the bus. In addition, W/R# is used to<br/>define other bus cycles, including interrupt acknowledge and<br/>special cycles. See Table 25 on page 128 for more details.
- Driven and Floated W/R# is driven off the same clock edge as ADS# and remains in the same state until the clock edge on which NA# or the last expected BRDY# of the cycle is sampled asserted. W/R# is driven during memory cycles, I/O cycles, special bus cycles, and interrupt acknowledge cycles.

W/R# is floated off the clock edge that BOFF# is sampled asserted and off the clock edge that the processor asserts HLDA in response to HOLD.

21850J/0-February 2000

## 4.54 WB/WT# (Writeback or Writethrough)

#### Input

Summary	WB/WT#, together with PWT, specifies the data cache-line state
-	during cacheable read misses and write hits to shared cache
	lines.

If WB/WT# = 0 or PWT = 1 during a cacheable read miss or write hit to a shared cache line, the accessed line is cached in the shared state. This is referred to as the writethrough state because all write cycles to this cache line are driven externally on the bus.

If WB/WT# = 1 and PWT = 0 during a cacheable read miss or a write hit to a shared cache line, the accessed line is cached in the exclusive state. Subsequent write hits to the same line cause its state to transition from exclusive to modified. This is referred to as the writeback state because the data cache can contain modified cache lines that are subject to be written back—referred to as a writeback cycle—as the result of an inquire cycle, an internal snoop, a flush operation, or the WBINVD instruction.

Sampled WB/WT# is sampled on the clock edge that the first BRDY# or NA# of a bus cycle is sampled asserted. If the cycle is a burst read, WB/WT# is ignored during the last three assertions of BRDY#. WB/WT# is sampled during memory read and non-writeback write cycles and is ignored during all other types of cycles.

Name	Туре	Note	Name	Туре	Note
A20M#	Asynchronous	1	IGNNE#	Asynchronous	1
AHOLD	Synchronous		INIT	Asynchronous	2
BF[2:0]	Synchronous	4	INTR	Asynchronous	1
BOFF#	Synchronous		INV	Synchronous	
BRDY#	Synchronous		KEN#	Synchronous	
BRDYC#	Synchronous	7	NA#	Synchronous	
CLK	Clock		NMI	Asynchronous	2
EADS#	Synchronous		RESET	Asynchronous	5, 6
EWBE#	Synchronous	8	SMI#	Asynchronous	2
FLUSH#	Asynchronous	2, 3	STPCLK#	Asynchronous	1
HOLD	Synchronous		WB/WT#	Synchronous	

#### Table 20. Input Pin Types

Notes:

1. These level-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must be asserted for a minimum pulse width of two clocks.

2. These edge-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must have been negated at least two clocks prior to assertion and must remain asserted at least two clocks.

3. FLUSH# is also sampled during the falling transition of RESET and can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met relative to the clock edge before the clock edge on which RESET is sampled negated. If asserted asynchronously, FLUSH# must meet a minimum setup and hold time of two clocks relative to the negation of RESET.

4. BF[2:0] are sampled during the falling transition of RESET. They must meet a minimum setup time of 1.0 ms and a minimum hold time of two clocks relative to the negation of RESET.

5. During the initial power-on reset of the processor, RESET must remain asserted for a minimum of 1.0 ms after CLK and V<sub>CC</sub> reach specification before it is negated.

6. During a warm reset, while CLK and  $V_{CC}$  are within their specification, RESET must remain asserted for a minimum of 15 clocks prior to its negation.

7. BRDYC# is also sampled during the falling transition of RESET. If RESET is driven synchronously, BRDYC# must meet the specified hold time relative to the negation of RESET. If asserted asynchronously, BRDYC# must meet a minimum setup and hold time of two clocks relative to the negation of RESET.

8. On the AMD-K6-2 processor Model 8/[F:8], if EFER[3] is set to 1, then EWBE# is ignored by the processor.

Name	Floated At: (Note 1)	Note	Name	Floated At: (Note 1)	Note
A[4:3]	HLDA, AHOLD, BOFF#	2, 3	HLDA	Always Driven	
ADS#	HLDA, BOFF#	2	LOCK#	HLDA, BOFF#	2
ADSC#	HLDA, BOFF#	2	M/IO#	HLDA, BOFF#	2
APCHK#	Always Driven		PCD	HLDA, BOFF#	2
BE[7:0]#	HLDA, BOFF#	2	PCHK#	Always Driven	
BREQ	Always Driven		PWT	HLDA, BOFF#	2
CACHE#	HLDA, BOFF#	2	SCYC	HLDA, BOFF#	2
D/C#	HLDA, BOFF#	2	SMIACT#	Always Driven	
FERR#	Always Driven		VCC2DET	Always Driven	
HIT#	Always Driven		VCC2H/L#	Always Driven	
HITM#	Always Driven		W/R#	HLDA, BOFF#	2

#### Table 21. Output Pin Float Conditions

Notes:

1. All outputs except VCC2DET, VCC2H/L#, and TDO float during the Tri-State Test mode.

2. Floated off the clock edge that BOFF# is sampled asserted and off the clock edge that HLDA is asserted.

3. Floated off the clock edge that AHOLD is sampled asserted.

Table 22. Input/Output Pin Float Conditions	
---	--

Name	Floated At: (Note 1)	Note
A[31:5]	HLDA, AHOLD, BOFF#	2,3
AP	HLDA, AHOLD, BOFF#	2,3
D[63:0]	HLDA, BOFF#	2
DP[7:0]	HLDA, BOFF#	2
Notosi		

Notes:

1. All outputs except VCC2DET and TDO float during the Tri-State Test mode.

2. Floated off the clock edge that BOFF# is sampled asserted and off the clock edge that HLDA is asserted.

3. Floated off the clock edge that AHOLD is sampled asserted.

#### Table 23. Test Pins

Name	Туре	Note
ТСК	Clock	
TDI	Input	Sampled on the rising edge of TCK
TDO	Output	Driven on the falling edge of TCK
TMS	Input	Sampled on the rising edge of TCK
TRST#	Input	Asynchronous (Independent of TCK)

## Table 24. Bus Cycle Definition

Bus Cycle Initiated	G	Generated by the System			
	M/IO#	D/C#	W/R#	CACHE#	KEN#
Code Read, Instruction Cache Line Fill	1	0	0	0	0
Code Read, Noncacheable	1	0	0	1	х
Code Read, Noncacheable	1	0	0	Х	1
Encoding for Special Cycle	0	0	1	1	х
Interrupt Acknowledge	0	0	0	1	х
I/O Read	0	1	0	1	х
I/O Write	0	1	1	1	х
Memory Read, Data Cache Line Fill	1	1	0	0	0
Memory Read, Noncacheable	1	1	0	1	х
Memory Read, Noncacheable	1	1	0	Х	1
Memory Write, Data Cache Writeback	1	1	1	0	х
Memory Write, Noncacheable	1	1	1	1	Х
<i>Note:</i> <i>x means "don't care"</i>					

## Table 25. Special Cycles

Special Cycle	A4	BE7#	BE6#	BE5#	BE4#	BE3#	BE2#	BE1#	BE0#	#OI/W	D/C#	W/R#	CACHE#	KEN#
Stop Grant	1	1	1	1	1	1	0	1	1	0	0	1	1	Х
Flush Acknowledge (FLUSH# sampled asserted)	0	1	1	1	0	1	1	1	1	0	0	1	1	х
Writeback (WBINVD instruction)	0	1	1	1	1	0	1	1	1	0	0	1	1	х
Halt	0	1	1	1	1	1	0	1	1	0	0	1	1	Х
Flush (INVD, WBINVD instruction)	0	1	1	1	1	1	1	0	1	0	0	1	1	х
Shutdown	0	1	1	1	1	1	1	1	0	0	0	1	1	Х
Note: x means "don't care"														

# 5 **Bus Cycles**

The following sections describe and illustrate the timing and relationship of bus signals during various types of bus cycles. A representative set of bus cycles is illustrated.

## 5.1 Timing Diagrams

The timing diagrams illustrate the signals on the external local bus as a function of time, as measured by the bus clock (CLK). Throughout this chapter, the term *clock* refers to a single bus-clock cycle. A clock extends from one rising CLK edge to the next rising CLK edge. The processor samples and drives most signals relative to the rising edge of CLK. The exceptions to this rule include the following:

- BF[2:0]—Sampled on the falling edge of RESET
- FLUSH#, BRDYC#—Sampled on the falling edge of RESET, also sampled on the rising edge of CLK
- All inputs and outputs are sampled relative to TCK in Boundary-Scan Test Mode. Inputs are sampled on the rising edge of TCK, outputs are driven off of the falling edge of TCK.

For each signal in the timing diagrams, the High level represents 1, the Low level represents 0, and the Middle level represents the floating (high-impedance) state. When both the High and Low levels are shown, the meaning depends on the signal. A single signal indicates 'don't care'. In the case of bus activity, if both High and Low levels are shown, it indicates the processor, alternate master, or system logic is driving a value, but this value may or may not be valid. (For example, the value on the address bus is valid only during the assertion of ADS#, but addresses are also driven on the bus at other times.) Figure 53 defines the different waveform representations.

21850J/0-February 2000

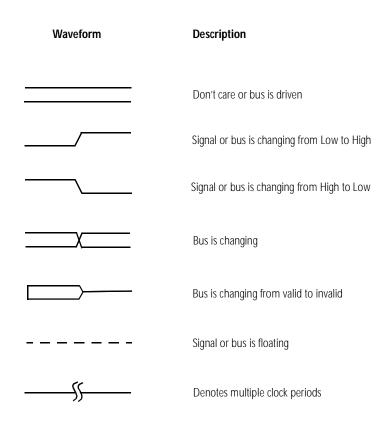
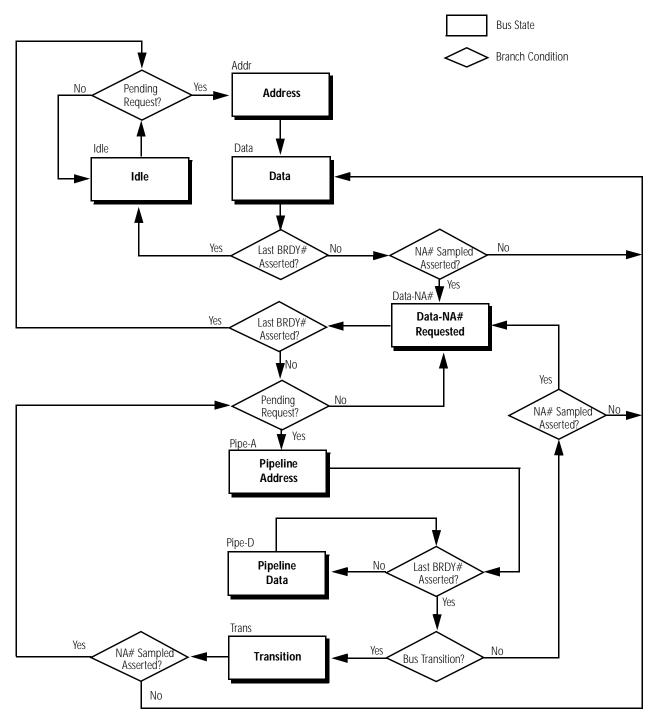


Figure 53. Waveform Definitions

For all active-High signals, the term *asserted* means the signal is in the High-voltage state and the term *negated* means the signal is in the Low-voltage state. For all active-Low signals, the term *asserted* means the signal is in the Low-voltage state and the term *negated* means the signal is in the High-voltage state.

## 5.2 Bus State Machine Diagram



*Note:* The processor transitions to the IDLE state on the clock edge on which BOFF# or RESET is sampled asserted.

#### Figure 54. Bus State Machine Diagram

Idle	The processor does not drive the system bus in the Idle state and remains in this state until a new bus cycle is requested. The processor enters this state off the clock edge on which the last BRDY# of a cycle is sampled asserted during the following conditions:
	<ul> <li>The processor is in the Data state</li> <li>The processor is in the Data-NA# Requested state and no internal pending cycle is requested</li> </ul>
	In addition, the processor is forced into this state when the system logic asserts RESET or BOFF#. The transition to this state occurs on the clock edge on which RESET or BOFF# is sampled asserted.
Address	In this state, the processor drives ADS# to indicate the beginning of a new bus cycle by validating the address and control signals. The processor remains in this state for one clock and unconditionally enters the Data state on the next clock edge.
Data	In the Data state, the processor drives the data bus during a write cycle or expects data to be returned during a read cycle. The processor remains in this state until either NA# or the last BRDY# is sampled asserted. If the last BRDY# is sampled asserted or both the last BRDY# and NA# are sampled asserted on the same clock edge, the processor enters the Idle state. If NA# is sampled asserted first, the processor enters the Data-NA# Requested state.
Data-NA# Requested	If the processor samples NA# asserted while in the Data state and the current bus cycle is not completed (the last BRDY# is not sampled asserted), it enters the Data-NA# Requested state. The processor remains in this state until either the last BRDY# is sampled asserted or an internal pending cycle is requested. If the last BRDY# is sampled asserted before the processor drives a new bus cycle, the processor enters the Idle state (no internal pending cycle is requested) or the Address state (processor has a internal pending cycle).
Pipeline Address	In this state, the processor drives ADS# to indicate the beginning of a new bus cycle by validating the address and control signals. In this state, the processor is still waiting for the current bus cycle to be completed (until the last BRDY# is

sampled asserted). If the last BRDY# is not sampled asserted, the processor enters the Pipeline Data state.

If the processor samples the last BRDY# asserted in this state, it determines if a bus transition is required between the current bus cycle and the pipelined bus cycle. A bus transition is required when the data bus direction changes between bus cycles, such as a memory write cycle followed by a memory read cycle. If a bus transition is required, the processor enters the Transition state for one clock to prevent data bus contention. If a bus transition is not required, the processor enters the Data state.

The processor does not transition to the Data-NA# Requested state from the Pipeline Address state because the processor does not begin sampling NA# until it has exited the Pipeline Address state.

**Pipeline Data**Two bus cycles are concurrently executing in this state. The<br/>processor cannot issue any additional bus cycles until the<br/>current bus cycle is completed. The processor drives the data<br/>bus during write cycles or expects data to be returned during<br/>read cycles for the current bus cycle until the last BRDY# of the<br/>current bus cycle is sampled asserted.

If the processor samples the last BRDY# asserted in this state, it determines if a bus transition is required between the current bus cycle and the pipelined bus cycle. If the bus transition is required, the processor enters the Transition state for one clock to prevent data bus contention. If a bus transition is not required, the processor enters the Data state (NA# was not sampled asserted) or the Data-NA# Requested state (NA# was sampled asserted).

**Transition** The processor enters this state for one clock during data bus transitions and enters the Data state on the next clock edge if NA# is not sampled asserted. The sole purpose of this state is to avoid bus contention caused by bus transitions during pipeline operation.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

## 5.3 Memory Reads and Writes

	The AMD-K6-2 processor performs single or burst memory bus cycles. The single-transfer memory bus cycle transfers 1, 2, 4, or 8 bytes and requires a minimum of two clocks. Misaligned instructions or operands result in a split cycle, which requires multiple transactions on the bus. A burst cycle consists of four back-to-back 8-byte (64-bit) transfers on the data bus.
Single-Transfer Memory Read and Write	Figure 55 shows a single-transfer read from memory, followed by two single-transfer writes to memory. For the memory read cycle, the processor asserts ADS# for one clock to validate the bus cycle and also drives A[31:3], BE[7:0]#, D/C#, W/R#, and M/IO# to the bus. The processor then waits for the system logic to return the data on D[63:0] (with DP[7:0] for parity checking) and assert BRDY#. The processor samples BRDY# on every clock edge starting with the clock edge after the clock edge that negates ADS#. See "BRDY# (Burst Ready)" on page 96.
	During the read cycle, the processor drives PCD, PWT, and CACHE# to indicate its caching and cache-coherency intent for the access. The system logic returns KEN# and WB/WT# to either confirm or change this intent. If the processor asserts PCD and negates CACHE#, the accesses are noncacheable, even though the system logic asserts KEN# during the BRDY# to indicate its support for cacheability. The processor (which drives CACHE#) and the system logic (which drives KEN#) must agree in order for an access to be cacheable.
	The processor can drive another cycle (in this example, a write cycle) by asserting ADS# off the next clock edge after BRDY# is sampled asserted. Therefore, an idle clock is guaranteed between any two bus cycles. The processor drives D[63:0] with valid data one clock edge after the clock edge on which ADS# is asserted. To minimize processor idle times, the system logic stores the address and data in write buffers, returns BRDY#, and performs the store to memory later. If the processor samples EWBE# negated during a write cycle, it suspends certain activities until EWBE# is sampled asserted. See "EWBE# (External Write Buffer Empty)" on page 103. In Figure 55, the second write cycle occurs during the execution of a serializing instruction. The processor delays the following cycle until EWBE# is sampled asserted.

	Read Cycle	Write Cycle	Write Cycle (Next Cycle Delayed	by EWBE#)
	ADDR DATA IDLE ADDR	DATA DATA IDLE ADDR	r data data idle idle i	dle idle addr
CLK /				
A[31:3] <b>[</b>	X X	χ		Х
BE[7:0]# <b>[</b>	Х Х	χ		Х
ADS#				
M/IO#				
D/C#				
W/R#	/			
BREQ	/			
D[63:0] ·		-()	_()	
DP[7:0] ·		-()	_()	
CACHE#				
EWBE#			/	L
KEN#			\/	
BRDY#				
WB/WT#			/ \	

Figure 55. Non-Pipelined Single-Transfer Memory Read/Write and Write Delayed by EWBE#

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Misaligned Single-Transfer Memory Read and Write Figure 56 shows a misaligned (split) memory read followed by a misaligned memory write. Any cycle that is not aligned as defined in "SCYC (Split Cycle)" on page 119 is considered misaligned. When the processor encounters a misaligned access, it determines the appropriate pair of bus cycles—each with its own ADS# and BRDY#—required to complete the access.

The AMD-K6-2 processor performs misaligned memory reads and memory writes using least-significant bytes (LSBs) first followed by most-significant bytes (MSBs). Table 26 shows the order. In the first memory read cycle in Figure 56, the processor reads the least-significant bytes. Immediately after the processor samples BRDY# asserted, it drives the second bus cycle to read the most-significant bytes to complete the misaligned transfer.

Table 26. Bus-Cycle Order During Misaligned Transfers

Type of Access	First Cycle	Second Cycle
Memory Read	LSBs	MSBs
Memory Write	LSBs	MSBs

Similarly, the misaligned memory write cycle in Figure 56 on page 137 transfers the LSBs to the memory bus first. In the next cycle, after the processor samples BRDY# asserted, the MSBs are written to the memory bus.

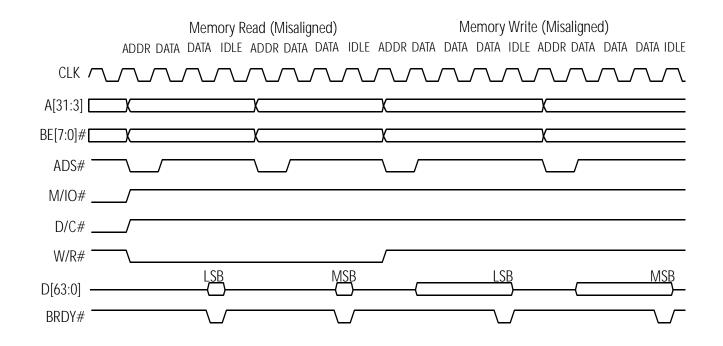


Figure 56. Misaligned Single-Transfer Memory Read and Write

#### Burst Reads and Pipelined Burst Reads

Figure 57 shows normal burst read cycles and a pipelined burst read cycle. The AMD-K6-2 processor drives CACHE# and ADS# together to specify that the current bus cycle is a burst cycle. If the processor samples KEN# asserted with the first BRDY#, it performs burst transfers. During the burst transfers, the system logic must ignore BE[7:0]# and must return all eight bytes beginning at the starting address the processor asserts on A[31:3]. Depending on the starting address, the system logic must determine the successive quadword addresses (A[4:3]) for each transfer in a burst, as shown in Table 27. The processor expects the second, third, and fourth quadwords to occur in the sequences shown in Table 27.

Address Driven By Processor on A[4:3]	A[4:3] Addresses of Subsequent Quadwords* Generated By System Logic			
Quadword 1	Quadword 2 Quadword 3 Quadword 4			
00b	01b	10b	11b	
01b	00b	11b	10b	
10b	11b	00b	01b	
11b	10b	01b	00b	
Note: * quadword = 8 bytes				

Table 27.	A[4:3] Address-Generation Sequence During Bursts
-----------	--

In Figure 57, the processor drives CACHE# throughout all burst read cycles. In the first burst read cycle, the processor drives ADS# and CACHE#, then samples BRDY# on every clock edge starting with the clock edge after the clock edge that negates ADS#. The processor samples KEN# asserted on the clock edge on which the first BRDY# is sampled asserted, executes a 32-byte burst read cycle, and expects a total of four BRDY# signals. An ideal no-wait state access is shown in Figure 57, whereas most system logic solutions add wait states between the transfers.

The second burst read cycle illustrates a similar sequence, but the processor samples NA# asserted on the same clock edge that the first BRDY# is sampled asserted. NA# assertion indicates the system logic is requesting the processor to output the next address early (also known as a pipeline transfer request). Without waiting for the current cycle to complete, the processor drives ADS# and related signals for the next burst cycle. Pipelining can reduce processor cycle-to-cycle idle times.

#### Preliminary Information

	Burst Read ADDR DATA DATA DATA DATA		Pipelined Burst Read DATA PIPE DATA DATA DATA DATA NA -ADDR	IDI F
CLK 🦳				
A[31:3]	ADDR1	ADDR2	ADDR3	
BE[7:0]#	X	χ	X	
ADS#	/			
M/IO#				
D/C#				
W/R#				
NA#				
D[63:0] —	DATA1		DATA3	<u> </u>
CACHE#				
KEN#				
BRDY#				

Figure 57. Burst Reads and Pipelined Burst Reads

**Burst Writeback** Figure 58 shows a burst read followed by a writeback transaction. The AMD-K6-2 processor initiates writebacks under the following conditions:

- *Replacement*—If a cache-line fill is initiated for a cache line currently filled with valid entries, the processor selects a line for replacement based on a least-recently-used (LRU) algorithm for the instruction cache, and a least-recently-allocated (LRA) algorithm for the data cache. Before a replacement is made to a L1 data cache line that is in the modified state, the modified line is scheduled to be written back to memory.
- Internal Snoop—The processor snoops its instruction cache during read or write misses to its data cache, and it snoops its data cache during read misses to its instruction cache. This snooping is performed to determine whether the same address is stored in both caches, a situation that is taken to imply the occurrence of self-modifying code. If a snoop hits a data cache line in the modified state, the line is written back to memory before being invalidated.
- WBINVD Instruction—When the processor executes a WBINVD instruction, it writes back all modified lines in the data cache and then invalidates all lines in both caches.
- Cache Flush—When the processor samples FLUSH# asserted, it executes a flush acknowledge special cycle and writes back all modified lines in the data cache and then invalidates all lines in both caches.

The processor drives writeback cycles during inquire or cache flush cycles. The writeback shown in Figure 58 is caused by a cache-line replacement. The processor completes the burst read cycle that fills the cache line. Immediately following the burst read cycle is the burst writeback cycle that represents the modified line to be written back to memory. D[63:0] are driven one clock edge after the clock edge on which ADS# is asserted and are subsequently changed off the clock edge on which each of the four BRDY# signals of the burst cycle are sampled asserted.

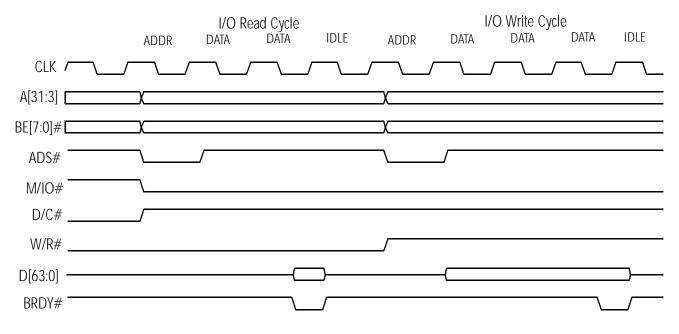
	Burst Read	Burst Writeback from L1 Cache
	addr data data data data idle	ADDR DATA DATA DATA DATA IDLE
CLK /		
A[31:3]	χ	χχ
BE[7:0]#	χ	χχ
ADS#		\\
CACHE#		
M/IO#		
D/C#	/	
W/R#		
D[63:0] —	()()	()()
KEN#		//
BRDY#	///	
WB/WT#		

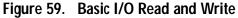
Figure 58. Burst Writeback due to Cache-Line Replacement

## 5.4 I/O Read and Write

Basic I/O Read and Write The processor accesses I/O when it executes an I/O instruction (for example, IN or OUT). Figure 59 shows an I/O read followed by an I/O write. The processor drives M/IO# Low and D/C# High during I/O cycles. In this example, the first cycle shows a single wait state I/O read cycle. It follows the same sequence as a single-transfer memory read cycle. The processor drives ADS# to initiate the bus cycle, then it samples BRDY# on every clock edge starting with the clock edge after the clock edge that negates ADS#. The system logic must return BRDY# to complete the cycle. When the processor samples BRDY# asserted, it can assert ADS# for the next cycle off the next clock edge. (In this example, an I/O write cycle.)

The I/O write cycle is similar to a memory write cycle, but the processor drives M/IO# low during an I/O write cycle. The processor asserts ADS# to initiate the bus cycle. The processor drives D[63:0] with valid data one clock edge after the clock edge on which ADS# is asserted. The system logic must assert BRDY# when the data is properly stored to the I/O destination. The processor samples BRDY# on every clock edge starting with the clock edge after the clock edge that negates ADS#. In this example, two wait states are inserted while the processor waits for BRDY# to be asserted.





# Misaligned I/O Read and Write

Table 28 shows the misaligned I/O read and write cycle order executed by the AMD-K6-2 processor. In Figure 60, the least-significant bytes (LSBs) are transferred first. Immediately after the processor samples BRDY# asserted, it drives the second bus cycle to transfer the most-significant bytes (MSBs) to complete the misaligned bus cycle.

Type of Access	First Cycle	Second Cycle
I/O Read	LSBs	MSBs
I/O Write	LSBs	MSBs

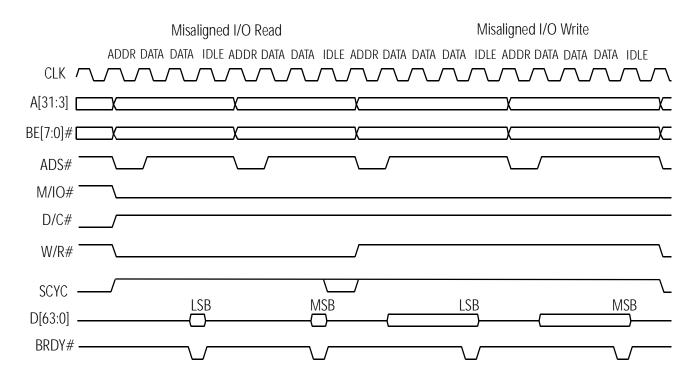


Figure 60. Misaligned I/O Transfer

## 5.5 Inquire and Bus Arbitration Cycles

The AMD-K6-2 processor provides built-in level-one data and instruction caches. Each cache is 32 Kbytes and two-way set-associative. The system logic or other bus master devices can initiate an inquire cycle to maintain cache/memory coherency. In response to the inquire cycle, the processor compares the inquire address with its cache tag addresses in both caches, and, if necessary, updates the MESI state of the cache line and performs writebacks to memory.

An inquire cycle can be initiated by asserting AHOLD, BOFF#, or HOLD. AHOLD is exclusively used to support inquire cycles. During AHOLD-initiated inquire cycles, the processor only floats the address bus. BOFF# provides the fastest access to the bus because it aborts any processor cycle that is in-progress, whereas AHOLD and HOLD both permit an in-progress bus cycle to complete. During HOLD-initiated and BOFF#-initiated inquire cycles, the processor floats all of its bus-driving signals.

Hold and HoldThe system logic or another bus device can assert HOLD to<br/>initiate an inquire cycle or to gain full control of the bus. When<br/>the AMD-K6-2 processor samples HOLD asserted, it completes<br/>any in-progress bus cycle and asserts HLDA to acknowledge<br/>release of the bus. The processor floats the following signals off<br/>the same clock edge that HLDA is asserted:

- ▲ A[31:3] DP[7:0]
  - ADS# LOCK#
  - AP# M/IO#
  - BE[7:0]#
- CACHE#

D[63:0]

■ PWT

PCD

- SCYC
- D/C# W/R#

Figure 61 shows a basic HOLD/HLDA operation. In this example, the processor samples HOLD asserted during the memory read cycle. It continues the current memory read cycle until BRDY# is sampled asserted. The processor drives HLDA and floats its outputs one clock edge after the last BRDY# of the cycle is sampled asserted. The system logic can assert HOLD for as long as it needs to utilize the bus. The processor samples HOLD on

144

every clock edge but does not assert HLDA until any in-progress cycle or sequence of locked cycles is completed.

When the processor samples HOLD negated during a hold acknowledge cycle, it negates HLDA off the next clock edge. The processor regains control of the bus and can assert ADS# off the same clock edge on which HLDA is negated.

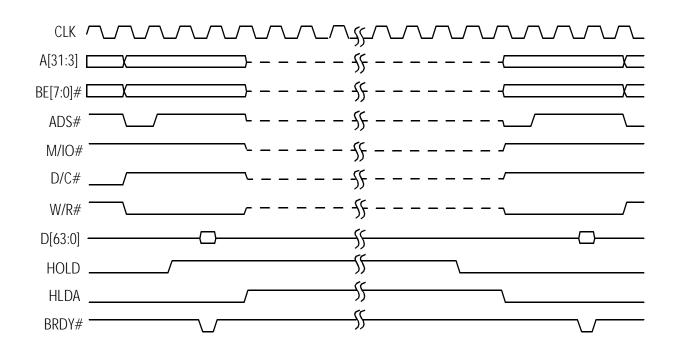


Figure 61. Basic HOLD/HLDA Operation

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

HOLD-Initiated Inquire Hit to Shared or Exclusive Line Figure 62 shows a HOLD-initiated inquire cycle. In this example, the processor samples HOLD asserted during the burst memory read cycle. The processor completes the current cycle (until the last expected BRDY# is sampled asserted), asserts HLDA and floats its outputs as described on page 144.

The system logic drives an inquire cycle within the hold acknowledge cycle. It asserts EADS#, which validates the inquire address on A[31:5]. If EADS# is sampled asserted before HOLD is sampled negated, the processor recognizes it as a valid inquire cycle.

In Figure 62, the processor asserts HIT# and negates HITM# on the clock edge after the clock edge on which EADS# is sampled asserted, indicating the current inquire cycle hit a shared or exclusive cache line. (*S*hared and exclusive cache lines have not been modified and do not need to be written back.) During an inquire cycle, the processor samples INV to determine whether the addressed cache line found in the processor's instruction or data cache transitions to the invalid state or the shared state. In this example, the processor samples INV asserted with EADS#, which invalidates the cache line.

The system logic can negate HOLD off the same clock edge on which EADS# is sampled asserted. The processor continues driving HIT# in the same state until the next inquire cycle. HITM# is not asserted unless HIT# is asserted. 21850J/0-February 2000

AMD-K6<sup>®</sup>-2 Processor Data Sheet

	Burst Memory Read	Inquire
CLK /		
A[31:3] <b>[</b>		
BE[7:0]#		
ADS#		/
M/IO#		
D/C#	L .	
W/R#	r ·	
HIT#		
HITM#		
D[63:0]	()()	
KEN#		
BRDY#		
HOLD .		
HLDA .		
EADS#		
INV .		

Figure 62. HOLD-Initiated Inquire Hit to Shared or Exclusive Line

**HOLD-Initiated** 

Inquire Hit to Modified Line

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

Figure 63 shows the same sequence as Figure 62, but in Figure 63 the inquire cycle hits a modified line and the processor asserts both HIT# and HITM#. In this example, the processor performs a writeback cycle immediately after the inquire cycle. It updates the modified cache line to external memory (normally, external cache or DRAM). The processor uses the address (A[31:5]) that was latched during the inquire cycle to perform the writeback cycle. The processor asserts HITM# throughout the writeback cycle and negates HITM# one clock edge after the last expected BRDY# of the writeback is sampled asserted.

When the processor samples EADS# during the inquire cycle, it also samples INV to determine the cache line MESI state after the inquire cycle. If INV is sampled asserted during an inquire cycle, the processor transitions the line (if found) to the invalid state, regardless of its previous state. The cache line invalidation operation is not visible on the bus. If INV is sampled negated during an inquire cycle, the processor transitions the line (if found) to the shared state. In Figure 63 the processor samples INV asserted during the inquire cycle.

In a HOLD-initiated inquire cycle, the system logic can negate HOLD off the same clock edge on which EADS# is sampled asserted. The processor drives HIT# and HITM# on the clock edge after the clock edge on which EADS# is sampled asserted.

21850J/0-February 2000

	Burst Memory Read	Inquire	Writeback Cycle
CLK			
A[31:3]			
BE[7:0]#			
ADS#			
M/IO#	ــــــ		
D/C#	~		
W/R#	r <b>-</b> -		
HIT#			
HITM#			/
D[63:0]	—( <b>—</b> )( <b>—</b> )( <b>—</b> )( <b>—</b> )		_(()()()()
KEN#			
BRDY#	///		
HOLD			
HLDA	/		
EADS#		$\checkmark$	
INV			

Figure 63. HOLD-Initiated Inquire Hit to Modified Line

**AHOLD-Initiated** 

**Inquire Miss** 

AHOLD can be asserted by the system to initiate one or more inquire cycles. To allow the system to drive the address bus during an inquire cycle, the processor floats A[31:3] and AP off the clock edge on which AHOLD is sampled asserted. The data bus and all other control and status signals remain under the control of the processor and are not floated. This functionality allows a bus cycle in progress when AHOLD is sampled asserted to continue to completion. The processor resumes driving the address bus off the clock edge on which AHOLD is sampled negated.

In Figure 64, the processor samples AHOLD asserted during the memory burst read cycle, and it floats the address bus off the same clock edge on which it samples AHOLD asserted. While the processor still controls the bus, it completes the current cycle until the last expected BRDY# is sampled asserted. The system logic drives EADS# with an inquire address on A[31:5] during an inquire cycle. The processor samples EADS# asserted and compares the inquire address to its tag address in both the instruction and data caches. In Figure 64, the inquire address misses the tag address in the processor (both HIT# and HITM# are negated). Therefore, the processor proceeds to the next cycle when it samples AHOLD negated. (The processor can drive a new cycle by asserting ADS# off the same clock edge that it samples AHOLD negated.)

For an AHOLD-initiated inquire cycle to be recognized, the processor must sample AHOLD asserted for at least two consecutive clocks before it samples EADS# asserted. If the processor detects an address parity error during an inquire cycle, APCHK# is asserted for one clock. The system logic must respond appropriately to the assertion of this signal.

	Read	Inquire
CLK /		
A[31:3]		<u></u>
BE[7:0]#	χ	χ
AP -	(	
APCHK#		
ADS#		
HIT#		
HITM#		
D[63:0] -	()()()	
KEN#		
BRDY#		
AHOLD -		
EADS#		
INV _		

Figure 64. AHOLD-Initiated Inquire Miss

AMD-K6<sup>®</sup>-2 Processor Data Sheet

AHOLD-Initiated Inquire Hit to Shared or Exclusive Line In Figure 65, the processor asserts HIT# and negates HITM# off the clock edge after the clock edge on which EADS# is sampled asserted, indicating the current inquire cycle hits either a shared or exclusive line. (HIT# is driven in the same state until the next inquire cycle.) The processor samples INV asserted during the inquire cycle and transitions the line to the invalid state regardless of its previous state.

During an AHOLD-initiated inquire cycle, the processor samples AHOLD on every clock edge until it is negated. In Figure 65, the processor asserts ADS# off the same clock on which AHOLD is sampled negated. If the inquire cycle hits a modified line, the processor performs a writeback cycle before it drives a new bus cycle. The next section describes the AHOLD-initiated inquire cycle that hits a modified line.

	Burst Memory Read Inquire
CLK /	
A[31:3]	·
BE[7:0]#	XX
ADS#	
M/IO#	
D/C#	
W/R#	
HIT# -	
HITM#	
D[63:0] -	
KEN# -	
BRDY#	
AHOLD .	
EADS#	
INV .	

Figure 65. AHOLD-Initiated Inquire Hit to Shared or Exclusive Line

AMD-K6<sup>®</sup>-2 Processor Data Sheet

AHOLD-Initiated Inquire Hit to Modified Line	Figure 66 shows an AHOLD-initiated inquire cycle that hits a modified line. During the inquire cycle in this example, the processor asserts both HIT# and HITM# on the clock edge after the clock edge that it samples EADS# asserted. This condition indicates that the cache line exists in the processor's data cache in the modified state.
	If the inquire cycle hits a modified line, the processor performs a writeback cycle immediately after the inquire cycle to update the modified cache line to shared memory (normally external cache or DRAM). In Figure 66, the system logic holds AHOLD asserted throughout the inquire cycle and the processor writeback cycle. In this case, the processor is not driving the address bus during the writeback cycle because AHOLD is sampled asserted. The system logic writes the data to memory by using its latched copy of the inquire cycle address. If the processor samples AHOLD negated before it performs the writeback cycle, it drives the writeback cycle by using the address (A[31:5]) that it latched during the inquire cycle.
	If INV is sampled asserted during an inquire cycle, the processor transitions the line (if found) to the invalid state, regardless of its previous state (the cache invalidation operation is not visible on the bus). If INV is sampled negated during an inquire cycle, the processor transitions the line (if found) to the shared state. In either case, if the line is found in the modified state, the processor writes it back to memory before changing its state. Figure 66 shows that the processor samples INV asserted during the inquire cycle and invalidates the cache line after the inquire cycle.

	Burst Memory Read	Inquire	Writeback	
CLK				
A[31:3]		□		
BE[7:0]#		(		
ADS#	/		/	
M/IO#				
D/C#				
W/R#		ſ		
HIT#				
HITM#				
D[63:0] —		)		<u> </u>
KEN#				
BRDY#				
AHOLD	/			
EADS#	· · · · · · · · · · · · · · · · · · ·			
INV		∕¬		

Figure 66. AHOLD-Initiated Inquire Hit to Modified Line

AHOLD Restriction When the system logic drives an AHOLD-initiated inquire cycle, it must assert AHOLD for at least two clocks before it asserts EADS#. This requirement guarantees the processor recognizes and responds to the inquire cycle properly. The processor's 32 address bus drivers turn on almost immediately after AHOLD is sampled negated. If the processor switches the data bus (D[63:0] and DP[7:0]) during a write cycle off the same clock edge that switches the address bus (A[31:3] and AP), the processor switches 102 drivers simultaneously, which can lead to ground-bounce spikes. Therefore, before negating AHOLD the following restrictions must be observed by the system logic:

- When the system logic negates AHOLD during a write cycle, it must ensure that AHOLD is not sampled negated on the clock edge on which BRDY# is sampled asserted (See Figure 67).
- When the system logic negates AHOLD during a writeback cycle, it must ensure that AHOLD is not sampled negated on the clock edge on which ADS# is negated (See Figure 67).
- When a write cycle is pipelined into a read cycle, AHOLD must not be sampled negated on the clock edge after the clock edge on which the last BRDY# of the read cycle is sampled asserted to avoid the processor simultaneously driving the data bus (for the pending write cycle) and the address bus off this same clock edge.

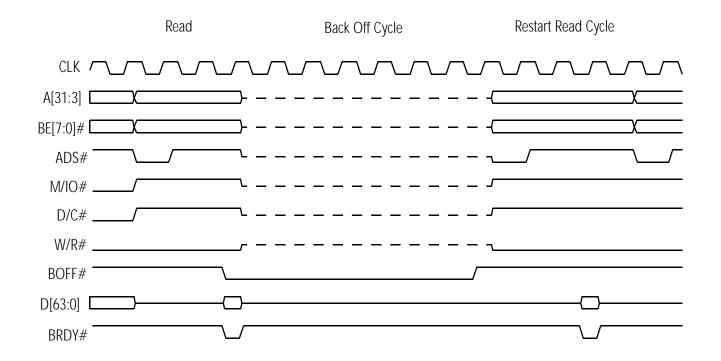
CLK	
ADS#	
W/R#	
HITM#	
EADS#	
D[63:0]	()()()()
BRDY#	
	Legal AHOLD negation during write cycle
AHOLD	
	Illegal AHOLD negation during write cycle
	The system must ensure that AHOLD is not sampled negated on the clock edge that ADS# is negated.
	The system must ensure that AHOLD is not sampled negated on the clock edge on which BRDY# is sample asserted.

## Figure 67. AHOLD Restriction

**Bus Backoff (BOFF#)** BOFF# provides the fastest response among bus-hold inputs. Either the system logic or another bus master can assert BOFF# to gain control of the bus immediately. BOFF# is also used to resolve potential deadlock problems that arise as a result of inquire cycles. The processor samples BOFF# on every clock edge. If BOFF# is sampled asserted, the processor unconditionally aborts any cycles in progress and transitions to a bus hold state. (See "BOFF# (Backoff)" on page 95.) Figure 68 shows a read cycle that is aborted when the processor samples BOFF# asserted even though BRDY# is sampled asserted on the same clock edge. The read cycle is restarted after BOFF# is sampled negated (KEN# must be in the same state during the restarted cycle as its state during the aborted cycle).

> During a BOFF#-initiated inquire cycle that hits a shared or exclusive line, the processor samples BOFF# negated and restarts any bus cycle that was aborted when BOFF# was asserted. If a BOFF#-initiated inquire cycle hits a modified line, the processor performs a writeback cycle before it restarts the aborted cycle.

> If the processor samples BOFF# asserted on the same clock edge that it asserts ADS#, ADS# is floated but the system logic may erroneously interpret ADS# as asserted. In this case, the system logic must properly interpret the state of ADS# when BOFF# is negated.





Locked Cycles	The processor asserts LOCK# during a sequence of bus cycles to ensure the cycles are completed without allowing other bus masters to intervene. Locked operations can consist of two to five cycles. LOCK# is asserted during the following operations:
	<ul> <li>An interrupt acknowledge sequence</li> </ul>
	<ul> <li>Descriptor Table accesses</li> </ul>
	<ul> <li>Page Directory and Page Table accesses</li> </ul>
	<ul> <li>XCHG instruction</li> </ul>
	<ul> <li>An instruction with an allowable LOCK prefix</li> </ul>
	In order to ensure that locked operations appear on the bus and are visible to the entire system, any data operands addressed during a locked cycle that reside in the processor's cache are flushed and invalidated from the cache prior to the locked operation. If the cache line is in the modified state, it is written back and invalidated prior to the locked operation. Likewise, any data read during a locked operation is not cached. The processor negates LOCK# for at least one clock between consecutive sequences of locked operations to allow the system logic to arbitrate for the bus.
	The processor asserts SCYC during misaligned locked transfers on the D[63:0] data bus. The processor generates additional bus cycles to complete the transfer of misaligned data.
Basic Locked Operation	Figure 69 shows a pair of read-write bus cycles. It represents a typical read-modify-write locked operation. The processor asserts LOCK# off the same clock edge that it asserts ADS# of the first bus cycle in the locked operation and holds it asserted until the last expected BRDY# of the last bus cycle in the locked operation is sampled asserted. (The processor negates LOCK# off the same clock edge.)

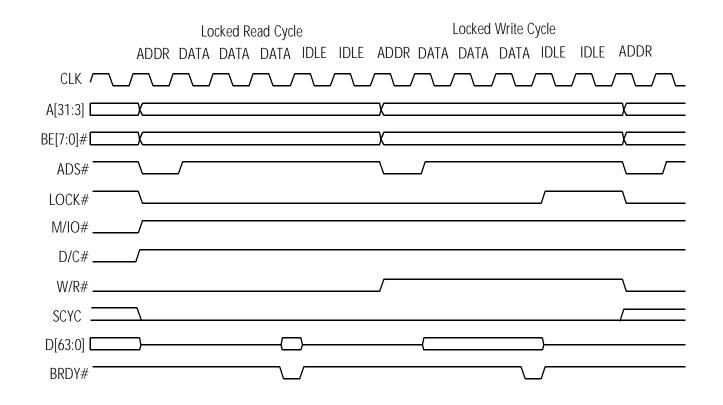


Figure 69. Basic Locked Operation

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Locked Operation with BOFF# Intervention Figure 70 shows BOFF# asserted within a locked read-write pair of bus cycles. In this example, the processor asserts LOCK# with ADS# to drive a locked memory read cycle followed by a locked memory write cycle. During the locked memory write cycle in this example, the processor samples BOFF# asserted. The processor immediately aborts the locked memory write cycle and floats all its bus-driving signals, including LOCK#. The system logic or another bus master can initiate an inquire cycle or drive a new bus cycle one clock edge after the clock edge on which BOFF# is sampled asserted. If the system logic drives a BOFF#-initiated inquire cycle and hits a modified line, the processor performs a writeback cycle before it restarts the locked cycle (the processor asserts LOCK# during the writeback cycle).

In Figure 70, the processor immediately restarts the aborted locked write cycle by driving the bus off the clock edge on which BOFF# is sampled negated. The system logic must ensure the processor results for interrupted and uninterrupted locked cycles are consistent. That is, the system logic must guarantee the memory accessed by the processor is not modified during the time another bus master controls the bus.

	Locked Read Cycle	Aborted Write Cycle	Restart Write Cycle
CLK ~			
A[31:3]	Х		)
BE[7:0]#	X		)
ADS#	r –		
LOCK#	r –		/¯
M/IO#			
D/C#			
W/R#	/		
BOFF#		/	
D[63:0]			_()
BRDY#			

Figure 70. Locked Operation with BOFF# Intervention

Interrupt

Acknowledge

AMD-K6<sup>®</sup>-2 Processor Data Sheet

In response to recognizing the system's maskable interrupt (INTR), the processor drives an interrupt acknowledge cycle at the next instruction boundary. During an interrupt acknowledge cycle, the processor drives a locked pair of read cycles as shown in Figure 71. The first read cycle is not functional, and the second read cycle returns the interrupt number on D[7:0] (00h–FFh). Table 29 shows the state of the signals during an interrupt acknowledge cycle.

Table 29.	Interrupt Acknowledge Operation Definition	
-----------	--	--

Processor Outputs	First Bus Cycle	Second Bus Cycle
D/C#	Low	Low
M/IO#	Low	Low
W/R#	Low	Low
BE[7:0]#	EFh	FEh (low byte enabled)
A[31:3]	0000_0000h	0000_0000h
D[63:0]	(ignored)	Interrupt number expected from interrupt controller on D[7:0]

The system logic can drive INTR either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks. To ensure it is recognized, INTR must remain asserted until an interrupt acknowledge sequence is complete. Interrupt Acknowledge Cycles

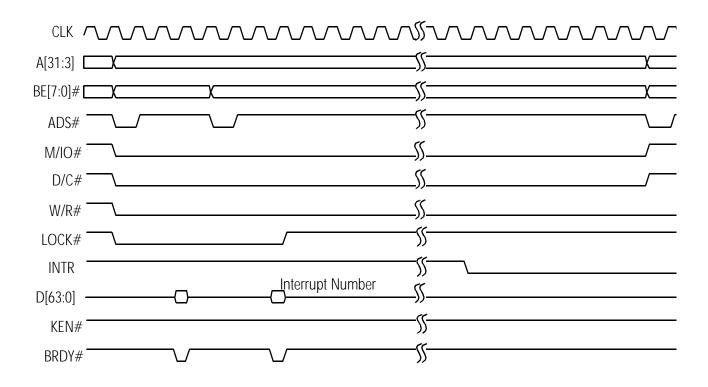


Figure 71. Interrupt Acknowledge Operation

# 5.6 Special Bus Cycles

The AMD-K6-2 processor drives special bus cycles that include stop grant, flush acknowledge, cache writeback invalidation, halt, cache invalidation, and shutdown cycles. During all special cycles, D/C# = 0, M/IO# = 0, and W/R# = 1. BE[7:0]# and A[31:3] are driven to differentiate among the special cycles, as shown in Table 30. The system logic must return BRDY# in response to all processor special cycles.

BE[7:0]#	A[4:3]*	Special Bus Cycle	Cause
FBh	10b	Stop Grant	STPCLK# sampled asserted
EFh	00b	Flush Acknowledge	FLUSH# sampled asserted
F7h	00b	Writeback	WBINVD instruction
FBh	00b	Halt	HLT instruction
FDh	00b	Flush	INVD,WBINVD instruction
FEh	00b	Shutdown	Triple fault
Note: * A[3]	1:5] = 0		

Table 30. Encodings For Special Bus Cycles

#### Basic Special Bus Cycle

Figure 72 shows a basic special bus cycle. The processor drives D/C# = 0, M/IO# = 0, and W/R# = 1 off the same clock edge that it asserts ADS#. In this example, BE[7:0]# = FBh and A[31:3] = 0000\_0000h, which indicates that the special cycle is a halt special cycle (See Table 30). A halt special cycle is generated after the processor executes the HLT instruction.

If the processor samples FLUSH# asserted, it writes back any data cache lines that are in the modified state and invalidates all lines in the instruction and data cache. The processor then drives a flush acknowledge special cycle.

If the processor executes a WBINVD instruction, it drives a writeback special cycle after the processor completes invalidating and writing back the cache lines.



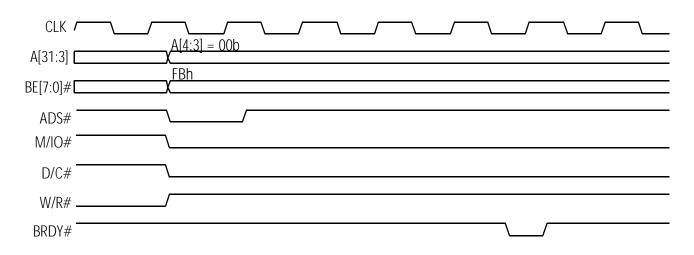


Figure 72. Basic Special Bus Cycle (Halt Cycle)

Shutdown Cycle In Figure 73, a shutdown (triple fault) occurs in the first half of the waveform, and a shutdown special cycle follows in the second half. The processor enters shutdown when an interrupt or exception occurs during the handling of a double fault (INT 8), which amounts to a triple fault. When the processor encounters a triple fault, it stops its activity on the bus and generates the shutdown special bus cycle (BE[7:0]# = FEh).

The system logic must assert NMI, INIT, RESET, or SMI# to get the processor out of the shutdown state.

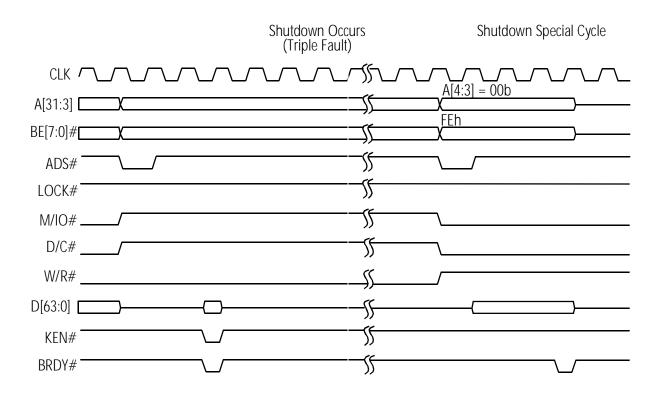


Figure 73. Shutdown Cycle

**Stop Grant and Stop Clock States** Figure 74 and Figure 75 show the processor transition from normal execution to the Stop Grant state, then to the Stop Clock state, back to the Stop Grant state, and finally back to normal execution. The series of transitions begins when the processor samples STPCLK# asserted. On recognizing a STPCLK# interrupt at the next instruction retirement boundary, the processor performs the following actions, in the order shown:

- 1. Its instruction pipelines are flushed
- 2. All pending and in-progress bus cycles are completed
- 3. The STPCLK# assertion is acknowledged by executing a Stop Grant special bus cycle
- 4. Its internal clock is stopped after BRDY# of the Stop Grant special bus cycle is sampled asserted and after EWBE# is sampled asserted (if EWBE# is masked off, then entry into the Stop Grant state is not affected by EWBE#)
- 5. The Stop Clock state is entered if the system logic stops the bus clock CLK (optional)

STPCLK# is sampled as a level-sensitive input on every clock edge but is not recognized until the next instruction boundary. The system logic drives the signal either synchronously or asynchronously. If it is asserted asynchronously, it must be asserted for a minimum pulse width of two clocks. STPCLK# must remain asserted until recognized, which is indicated by the completion of the Stop Grant special cycle.

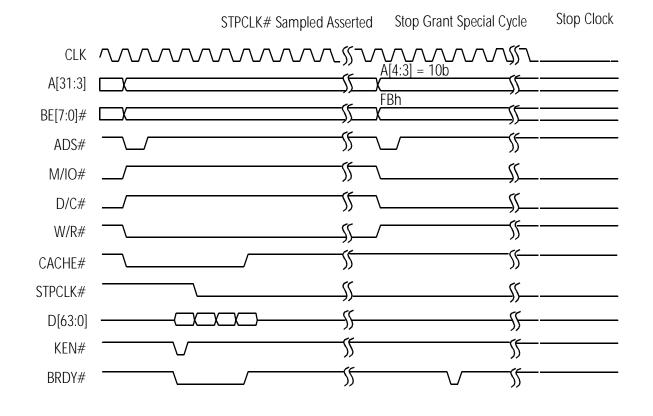


Figure 74. Stop Grant and Stop Clock Modes, Part 1

**Preliminary Information** 

21850J/0-February 2000

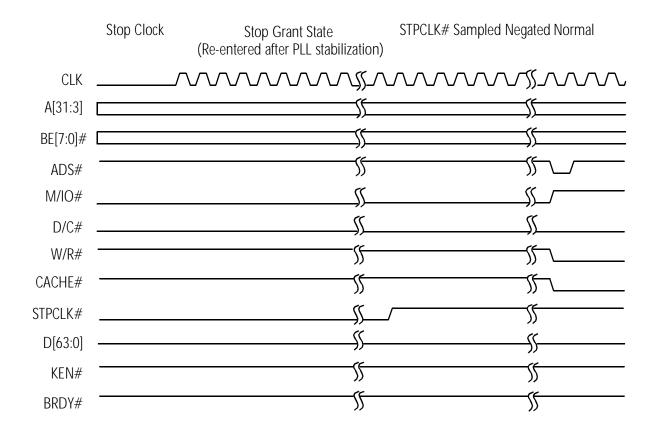


Figure 75. Stop Grant and Stop Clock Modes, Part 2

AMD-K6<sup>®</sup>-2 Processor Data Sheet

INIT-Initiated Transition from Protected Mode to Real Mode INIT is typically asserted in response to a BIOS interrupt that writes to an I/O port. This interrupt is often in response to a Ctrl-Alt-Del keyboard input. The BIOS writes to a port (similar to port 64h in the keyboard controller) that asserts INIT. INIT is also used to support 80286 software that must return to Real mode after accessing extended memory in Protected mode.

The assertion of INIT causes the processor to empty its pipelines, initialize most of its internal state, and branch to address FFFF\_FFOh—the same instruction execution starting point used after RESET. Unlike RESET, the processor preserves the contents of its caches, the floating-point state, the MMX state, Model-Specific Registers (MSRs), the CD and NW bits of the CR0 register, the time stamp counter, and other specific internal resources.

Figure 76 shows an example in which the operating system writes to an I/O port, causing the system logic to assert INIT. The sampling of INIT asserted starts an extended microcode sequence that terminates with a code fetch from FFFF\_FF0h, the reset location. INIT is sampled on every clock edge but is not recognized until the next instruction boundary. During an I/O write cycle, it must be sampled asserted a minimum of three clock edges before BRDY# is sampled asserted if it is to be recognized on the boundary between the I/O write instruction and the following instruction. If INIT is asserted synchronously, it can be asserted for a minimum of one clock. If it is asserted asynchronously, it must have been negated for a minimum of two clocks.

INIT Sampled Asserted	Code Fetch
	<u>}</u>
	<u>۲</u>
	<u> </u>
	<u></u>
	<u>}</u>
<b></b>	
	<u>\$</u>
	<u></u>
	<u></u>

Figure 76. INIT-Initiated Transition from Protected Mode to Real Mode

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# 6 **Power-on Configuration and Initialization**

On power-on the system logic must reset the AMD-K6-2 processor by asserting the RESET signal. When the processor samples RESET asserted, it immediately flushes and initializes all internal resources and its internal state, including its pipelines and caches, the floating-point state, the MMX and 3DNow! states, and all registers. Then the processor jumps to address FFFF\_FF0h to start instruction execution.

#### 6.1 Signals Sampled During the Falling Transition of RESET

- **FLUSH#** FLUSH# is sampled on the falling transition of RESET to determine if the processor begins normal instruction execution or enters Tri-State Test mode. If FLUSH# is High during the falling transition of RESET, the processor unconditionally runs its Built-In Self Test (BIST), performs the normal reset functions, then jumps to address FFFF\_FF0h to start instruction execution. (See "Built-In Self-Test (BIST)" on page 223 for more details.) If FLUSH# is Low during the falling transition of RESET, the processor enters Tri-State Test mode. (See "Tri-State Test Mode" on page 224 and "FLUSH# (Cache Flush)" on page 105 for more details.)
- **BF[2:0]** The internal operating frequency of the processor is determined by the state of the bus frequency signals BF[2:0] when they are sampled during the falling transition of RESET. The frequency of the CLK input signal is multiplied internally by a ratio defined by BF[2:0]. (See "BF[2:0] (Bus Frequency)" on page 94 for the processor-clock to bus-clock ratios.)
- **BRDYC#** BRDYC# is sampled on the falling transition of RESET to configure the drive strength of A[20:3], ADS#, HITM#, and W/R#. If BRDYC# is Low during the fall of RESET, these outputs are configured using higher drive strengths than the standard strength. If BRDYC# is High during the fall of RESET, the standard strength is selected. (See "BRDYC# (Burst Ready Copy)" on page 97 for more details.)

# 6.2 **RESET Requirements**

During the initial power-on reset of the processor, RESET must remain asserted for a minimum of 1.0 ms after CLK and  $V_{CC}$  reach specification. (See "CLK Switching Characteristics" on page 269 for clock specifications. See "Electrical Data" on page 255 for  $V_{CC}$  specifications.)

During a warm reset while CLK and  $V_{CC}$  are within specification, RESET must remain asserted for a minimum of 15 clocks prior to its negation.

## 6.3 State of Processor After RESET

# **Output Signals** Table 31 shows the state of all processor outputs and bidirectional signals immediately after RESET is sampled asserted.

Signal	State	Signal	State
A[31:3], AP	Floating	LOCK#	High
ADS#, ADSC#	High	M/IO#	Low
APCHK#	High	PCD	Low
BE[7:0]#	Floating	PCHK#	High
BREQ	Low	PWT	Low
CACHE#	High	SCYC	Low
D/C#	Low	SMIACT#	High
D[63:0], DP[7:0]	Floating	TDO	Floating
FERR#	High	VCC2DET	Low
HIT#	High	VCC2H/L#	Low
HITM#	High	W/R#	Low
HLDA	Low	-	-

 Table 31.
 Output Signal State After RESET

#### Registers

Table 32 on page 177 shows the state of all architecture registers and Model-Specific Registers (MSRs) after the processor has completed its initialization due to the recognition of the assertion of RESET.

Register	State (hex)	Notes
GDTR	base:0000_0000h limit:0FFFh	
IDTR	base:0000_0000h limit:0FFFh	
TR	0000h	
LDTR	0000h	
EIP	FFFF_FF0h	
EFLAGS	0000_0002h	
EAX	0000_0000h	1
EBX	0000_0000h	
ECX	0000_0000h	
EDX	0000_058Xh	2
ESI	0000_0000h	
EDI	0000_0000h	
EBP	0000_0000h	
ESP	0000_0000h	
CS	F000h	
SS	0000h	
DS	0000h	
ES	0000h	
FS	0000h	
GS	0000h	
FPU Stack R7–R0	0000_0000_0000_0000_0000h	3
FPU Control Word	0040h	3
FPU Status Word	0000h	3
FPU Tag Word	5555h	3
FPU Instruction Pointer	0000_0000_0000h	3
FPU Data Pointer	0000_0000_0000h	3
FPU Opcode Register	000_0000_000b	3

#### Table 32. Register State After RESET

If EAX is non-zero, BIST failed.

2. EDX contains the AMD-K6-2 processor signature, where X indicates the processor Stepping ID.

3. The contents of these registers are preserved following the recognition of INIT.

4. The CD and NW bits of CR0 are preserved following the recognition of INIT.

5. UWCCR, PSOR, and PFIR are implemented only on AMD-K6-2 processor Model 8/[F:8].

 "S" represents the Stepping. "B" represents PSOR[3:0], where PSOR[3] equals 0, and PSOR[2:0] is equal to the value of the BF[2:0] signals sampled during the falling transition of RESET.

6000_0010h	ł
	4
0000_0000h	
0000_0000h	
0000_0000h	
0000_0400h	
FFFF_0FF0h	
0000_0000h	
0000_0000h	
0000_0000h	
0000_0000h	
0000_0000_0000_0000h	3
0000_0000_0000_0000h (Model 8/[7:0]) 0000_0000_0000_0002h (Model 8/[F:8])	3
,	3
 0000_0000_0000_0000h	3
0000_0000_0000_0000h	3, 5
0000_0000_0000_01SBh	3, 5, 6
0000_0000_0000_0000h	3, 5
	0000_0000h           0000_0400h           FFFF_0FF0h           0000_0000h           0000_0000h           0000_0000h           0000_0000h           0000_0000h           0000_0000h           0000_0000h           0000_0000_0000h           0000_0000_0000h           0000_0000_0000_0000h           0000_0000_0000_0000h           0000_0000_0000_0000h           0000_0000_0000h (Model 8/[7:0])           0000_0000_0000h (Model 8/[F:8])           0000_0000_0000h (Model 8/[F:8])           0000_0000_0000h (Model 8/[F:8])           00000_0000_0000h (Model 8/[F:8])           0000_0000_0000h (Model 8/[F:8])           0000_0000_0000h (Model 8/[F:8])           0000_0000_0000_0000h (Model 8/[F:8])

Table 32. Register State After RESET (continued)

4. The CD and NW bits of CR0 are preserved following the recognition of INIT.

5. UWCCR, PSOR, and PFIR are implemented only on AMD-K6-2 processor Model 8/[F:8].

"S" represents the Stepping. "B" represents PSOR[3:0], where PSOR[3] equals 0, and PSOR[2:0] is equal to the value of the BF[2:0] signals sampled during the falling transition of 6. RESET.

21850J/0-February 2000

AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 6.4 State of Processor After INIT

The recognition of the assertion of INIT causes the processor to empty its pipelines, to initialize most of its internal state, and to branch to address FFFF\_FF0h—the same instruction execution starting point used after RESET. Unlike RESET, the processor preserves the contents of its caches, the floating-point state, the MMX and 3DNow! states, MSRs, and the CD and NW bits of the CR0 register.

The edge-sensitive interrupts FLUSH# and SMI# are sampled and preserved during the INIT process and are handled accordingly after the initialization is complete. However, the processor resets any pending NMI interrupt upon sampling INIT asserted.

INIT can be used as an accelerator for 80286 code that requires a reset to exit from Protected mode back to Real mode.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

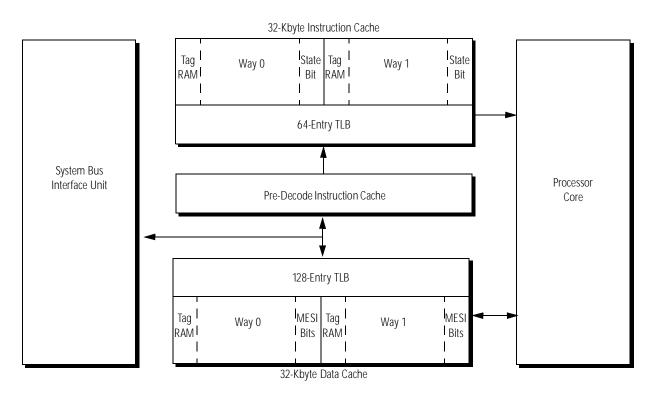
21850J/0-February 2000

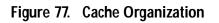
AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 7 Cache Organization

The following sections describe the basic architecture and resources of the AMD-K6-2 processor internal caches.

The performance of the AMD-K6-2 processor is enhanced by a writeback level-one (L1) cache. The cache is organized as a separate 32-Kbyte instruction cache and a 32-Kbyte data cache, each with two-way set associativity (See Figure 77). The cache line size is 32 bytes, and lines are fetched from main memory using an efficient, pipelined burst transaction. As the instruction cache is filled, each instruction byte is analyzed for instruction boundaries using predecode logic. Predecoding annotates each instruction byte with information that later enables the decoders to efficiently decode multiple instructions simultaneously. Translation lookaside buffers (TLB) are also used to translate linear addresses to physical addresses. The instruction cache is associated with a 64-entry TLB while the data cache is associated with a 128-entry TLB.







The processor cache design takes advantage of a sectored organization (See Figure 78). Each sector consists of 64 bytes configured as two 32-byte cache lines. The two cache lines of a sector share a common tag but have separate MESI (modified, exclusive, shared, invalid) bits that track the state of each cache line.

#### Instruction Cache Line

Tag	Cache Line 0	Byte 31	Predecode Bits	Byte 30	Predecode Bits	 	Byte 0	Predecode Bits	1 MESI Bit
Address	Cache Line 1	Byte 31	Predecode Bits	Byte 30	Predecode Bits	 	Byte 0	Predecode Bits	1 MESI Bit

#### Data Cache Line

Tag	Cache Line 0	Byte 31	Byte 30	 	Byte 0	2 MESI Bits
Address	Cache Line 1	Byte 31	Byte 30	 	Byte 0	2 MESI Bits

- **Note:** Instruction-cache lines have only two coherency states (valid or invalid) rather than the four MESI coherency states of data-cache lines. Only two states are needed for the instruction cache because these lines are read-only.
- Figure 78. Cache Sector Organization

## 7.1 MESI States in the Data Cache

The state of each line in the caches is tracked by the MESI bits. The coherency of these states or MESI bits is maintained by internal processor snoops and external inquire cycles by the system logic. The following four states are defined for the data cache:

- *Modified*—This line has been modified and is different from main memory.
- *Exclusive*—This line is not modified and is the same as main memory. If this line is written to, it becomes Modified.
- *Shared*—If a cache line is in the shared state it means that the same line can exist in more than one cache system.
- *Invalid*—The information in this line is not valid.

## 7.2 Predecode Bits

Decoding x86 instructions is particularly difficult because the instructions vary in length, ranging from 1 to 15 bytes long. Predecode logic supplies the predecode bits associated with

each instruction byte. The predecode bits indicate the number of bytes to the start of the next x86 instruction. The predecode bits are passed with the instruction bytes to the decoders where they assist with parallel x86 instruction decoding. The predecode bits use memory separate from the 32-Kbyte instruction cache. The predecode bits are stored in an extended instruction cache alongside each x86 instruction byte as shown in Figure 78.

## 7.3 Cache Operation

The operating modes for the caches are configured by software using the not writethrough (NW) and cache disable (CD) bits of control register 0 (CR0 bits 29 and 30, respectively). These bits are used in all operating modes.

When the CD and NW bits are both set to 0, the cache is fully enabled. This is the standard operating mode for the cache. If a read miss occurs when the processor reads from the cache, a line fill (32-byte burst read) on the system bus occurs in order to fetch the cache line. Write hits to the cache are updated, while write misses and writes to shared lines cause external memory updates. Refer to Table 36 on page 195 for a summary of cache read and write cycles and the effect of these operations on the cache MESI state.

**Note:** A write allocate operation can modify the behavior of write misses to the cache. See "Write Allocate" on page 188.

When CD is set to 0 and NW is set to 1, an invalid mode of operation exists that causes a general protection fault to occur.

When CD is set to 1 (disabled) and NW is set to 0, the cache fill mechanism is disabled but the contents of the cache are still valid. The processor reads from the cache and, if a read miss occurs, no line fill takes place. Write hits to the cache are updated, while write misses and writes to shared lines cause external memory updates. If PWT is driven Low and WB/WT# is sampled High, a write hit to a shared line changes the cacheline state to exclusive.

When the CD and NW bits are both set to 1, the cache is fully disabled. Even though the cache is disabled, the contents are not necessarily invalid. The processor reads from the cache and, if a read miss occurs, no line fill takes place. If a write hit

occurs, the cache is updated but an external memory update does not occur. If a data line is in the exclusive state during a write hit, the cache-line state is changed to modified. Cache lines in the shared state remain in the shared state after a write hit. Write misses access external memory directly.

The operating system can control the cacheability of a page. The paging mechanism is controlled by CR3, the Page Directory Entry (PDE), and the Page Table Entry (PTE). Within CR3, PDE, and PTE are Page Cache Disable (PCD) and Page Writethrough (PWT) bits. The values of the PCD and PWT bits used in Table 33 and Table 34 are taken from either the PTE or PDE. For more information see the descriptions of PCD and PWT on pages 115 and 117, respectively.

Table 33 describes how the PWT signal is driven based on the values of the PWT bits and the PG bit of CR0.

PWT Bit*	PG Bit of CR0	PWT Signal					
1	1	High					
0	1	Low					
1	0	Low					
0 0 Low							
Note: * PWT is taken from PTE or PDE							

Table 33. PWT Signal Generation

Table 34 describes how the PCD signal is driven based on the values of the CD bit of CR0, the PCD bits, and the PG bit of CR0.

Table 34. PCD Signal Generation

CD Bit of CR0	PCD Bit*	PG Bit of CR0	PCD Signal
1	Х	Х	High
0	1	1	High
0	0	1	Low
0	1	0	Low
0	0	0	Low
Note: * PCD is taken	from PTE or PDE		

Table 35 describes how the CACHE# signal is driven based on the cycle type, the CI bit of TR12, the PCD signal, and the UWCCR model-specific register.

#### Table 35. CACHE# Signal Generation

Cycle Type	CI Bit of TR12	PCD Signal	Access Within WC/UC Range*	CACHE#
Writebacks	Х	Х	Х	Low
Unlocked Reads	0	0	0	Low
Locked Reads	Х	Х	Х	High
Single Writes	Х	Х	Х	High
Any Cycle Except Writebacks	1	Х	Х	High
Any Cycle Except Writebacks	Х	1	Х	High
Any Cycle Except Writebacks	Х	Х	1	High
Note: * WC and UC refer to Write-C			s as defined in the UV	VCCR, and only

applies to the AMD-K6-2 processor Model 8/[F:8].

**Cache-Related Signals** Complete descriptions of the signals that control cacheability and cache coherency are given on the following pages:

- CACHE#—page 98
- EADS#—page 102
- FLUSH#—page 105
- HIT#—page 106
- HITM#—page 106
- INV—page 110
- KEN#—page 111
- PCD—page 115
- PWT—page 117
- WB/WT#—page 125

#### 7.4 Cache Disabling and Flushing

To completely disable all cache accesses, the CD bit must be set to 1 and the cache must be completely flushed.

There are three different methods for flushing the cache. The first method relies on the system logic and other two methods rely on software.

For the system logic to flush the cache, the processor must sample FLUSH# asserted. In this method, the processor writes back any data cache lines that are in the modified state, invalidates all lines in the instruction and data caches, and then executes a flush acknowledge special cycle (See Table 25 on page 128).

The second method for flushing the caches is for software to execute the WBINVD instruction which causes all modified lines to first be written back to memory, then marks all cache lines as invalid. Alternatively, if writing modified lines back to memory is not necessary, the INVD instruction can be used to invalidate all cache lines.

The third and final method for flushing the caches is to make use of the Page Flush/Invalidate Register (PFIR), which allows cache invalidation and optional flushing of a specific 4-Kbyte page from the linear address space. The PFIR is only supported on the AMD-K6-2 processor Model 8/[F:8] (see "PFIR" on page 197). Unlike the previous two methods of flushing the caches, this particular method requires the software to be aware of which specific pages must be flushed and invalidated.

## 7.5 Cache-Line Fills

The processor performs a cache-line fill for any area of system memory defined as cacheable. If an area of system memory is not explicitly defined as uncacheable by the software or system logic, or implicitly treated as uncacheable by the processor, then the memory access is assumed to be cacheable.

Software can prevent caching of certain pages by setting the PCD bit in the PDE or PTE. Additionally, for the AMD-K6-2 processor Model 8/[F:8], software can define regions of memory as uncacheable or write combinable by programming the MTRRs in the UWCCR MSR (see "Memory Type Range Registers" on page 205). Write-combinable memory is defined as uncacheable.

The system logic also has control of the cacheability of bus cycles. If it determines the address is not cacheable, system logic negates the KEN# signal when asserting the first BRDY# or NA# of a cycle.

21850J/0-February 2000

The processor does not cache certain memory accesses such as locked operations. In addition, the processor does not cache PDE or PTE memory reads in the L1 cache (referred to as *page table walks*).

When the processor needs to read memory, the processor drives a read cycle onto the bus. If the cycle is cacheable, the processor asserts CACHE#. If the cycle is not cacheable, a non-burst, single-transfer read takes place. The processor waits for the system logic to return the data and assert a single BRDY# (See Figure 55 on page 135). If the cycle is cacheable, the processor executes a 32-byte burst read cycle. The processor expects a total of four BRDY# signals for a burst read cycle to take place (See Figure 57 on page 139).

Cache-line fills initiate 32-byte burst read cycles from memory on the system bus for the instruction cache and the data cache. If a data-cache line being filled replaces a modified line, the modified contents of the line are copied to a 32-byte writeback (copyback) buffer in the bus interface unit while the new line is being read.

#### 7.6 Cache-Line Replacements

As programs execute and task switches occur, some cache lines eventually require replacement.

Instruction cache lines are replaced using a Least Recently Used (LRU) algorithm. If line replacement is required, lines are replaced when read cache misses occur.

The data cache uses a slightly different approach to line replacement. If a miss occurs, and a replacement is required, lines are replaced by using a Least Recently Allocated (LRA) algorithm.

Two forms of cache misses and associated cache fills can take place—a tag-miss cache fill and a tag-hit cache fill. In the case of a tag-miss cache fill, the miss is due to a tag mismatch, in which case the required cache line is filled from external memory, and the cache line within the sector that was not required is marked as invalid. In the case of a tag-hit cache fill, the address matches the tag, but the requested cache line is marked as invalid. The required cache line is filled from external memory, and the cache line within the sector that is not required remains in the same cache state.

## 7.7 Write Allocate

Write allocate, if enabled, occurs when the processor has a pending memory write cycle to a cacheable line and the line does not currently reside in the data cache. In this case, the processor performs a 32-byte burst read cycle to fetch the data-cache line addressed by the pending write cycle. The data associated with the pending write cycle is merged with the recently-allocated data-cache line and stored in the processor's data cache. The final MESI state of the cache line depends on the state of the WB/WT# and PWT signals during the burst read cycle and the subsequent L1 data cache write hit (See Table 36 on page 195 to determine the cache-line states and the access types following a cache read miss and cache write hit).

If a data-cache line fetch from memory is attempted because the write allocate misses the data cache, and KEN# is sampled negated, the processor does not perform an allocation. In this case, the pending write cycle is executed as a single write cycle on the system bus.

During write allocates, a 32-byte burst read cycle is executed in place of a non-burst write cycle. While the burst read cycle generally takes longer to execute than the non-burst write cycle, performance gains are realized on subsequent write cycle hits to the write-allocated cache line. Due to the nature of software, memory accesses tend to occur in proximity of each other (principle of locality). The likelihood of additional write hits to the write-allocated cache line is high.

The following is a description of three mechanisms by which the AMD-K6-2 processor performs write allocations. A write allocate is performed when any one or more of these mechanisms indicates that a pending write is to a cacheable area of memory.

#### Write to a Cacheable Page Every time the processor performs a cache line fill, the address of the page in which the cache line resides is saved in the Cacheability Control Register (CCR). The page address of subsequent write cycles is compared with the page address stored in the CCR. If the two addresses are equal, then the processor performs a write allocate because the page has already been determined to be cacheable.

When the processor performs a cache line fill from a different page than the address saved in the CCR, the CCR is updated with the new page address.

- Write to a Sector If the address of a pending write cycle matches the tag address of a valid cache sector, but the addressed cache line within the sector is marked invalid (a sector hit but a cache line miss), then the processor performs a write allocate. The pending write cycle is determined to be cacheable because the sector hit indicates the presence of at least one valid cache line in the sector. The two cache lines within a sector are guaranteed by design to be within the same page.
- Write Allocate Limit The AMD-K6-2 processor uses two mechanisms that are programmable within the Write Handling Control Register (WHCR) to enable write allocations for write cycles that address a definable area, or a special 1-Mbyte memory area. The format of the WHCR differs between the AMD-K6-2 processor Model 8/[7:0] and the AMD-K6-2 processor Model 8/[F:8].

WHCR – Model 8/[7:0]. This WHCR contains three fields—the WCDE bit, the Write Allocate Enable Limit (WAELIM) field, and the Write Allocate Enable 15-to-16-Mbyte (WAE15M) bit (See Figure 79 on page 189).

For proper functionality, always program the WCDE bit to 0.

63			9	8	7	1	0
				0	WAELIM		W A 1 5 M
Reserved							
WAELIM Writ	Description ays program to 0 e Allocate Enable Limit e Allocate Enable 15-to-16-Mbyte	Bits 8 7-1 0					

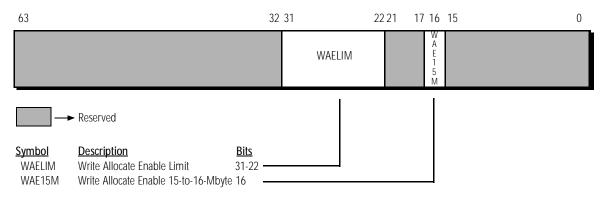


#### Figure 79. Write Handling Control Register (WHCR) – Model 8/[7:0]

Write Allocate Enable Limit – Model 8/[7:0]. The WAELIM field is 7 bits wide. This field, multiplied by 4 Mbytes, defines an upper memory limit. Any pending write cycle that addresses memory below this limit causes the processor to perform a write allocate

(assuming the address is not within a range where write allocates are disallowed). Write allocate is disabled for memory accesses at and above this limit unless the processor determines a pending write cycle is cacheable by means of one of the other write allocate mechanisms—"Write to a Cacheable Page" and "Write to a Sector." The maximum value of this memory limit is  $((2^7 - 1) \cdot 4 \text{ Mbytes}) = 508 \text{ Mbytes}$ . When all the bits in this field are set to 0, all memory is above this limit and the write allocate mechanism is disabled (even if all bits in the WAELIM field are set to 0, write allocates can still occur due to the "Write to a Cacheable Page" and "Write to a Sector" mechanisms).

WHCR – Model 8/[F:8]. This WHCR contains two fields—the Write Allocate Enable Limit (WAELIM) field, and the Write Allocate Enable 15-to-16-Mbyte (WAE15M) bit (see Figure 80).



Note: Hardware RESET initializes this MSR to all zeros.

#### Figure 80. Write Handling Control Register (WHCR) – Model 8/[F:8]

Write Allocate Enable Limit – Model 8/[F:8]. The WAELIM field is 10 bits wide. This field, multiplied by 4 Mbytes, defines an upper memory limit. Any pending write cycle that addresses memory below this limit causes the processor to perform a write allocate (assuming the address is not within a range where write allocates are disallowed). Write allocate is disabled for memory accesses at and above this limit unless the processor determines a pending write cycle is cacheable by means of one of the other write allocate mechanisms—"Write to a Cacheable Page" and "Write to a Sector." The maximum value of this limit is  $((2^{10}-1) \cdot 4 \text{ Mbytes}) = 4092 \text{ Mbytes}$ . When all the bits in this field are set to 0, all memory is above this limit and the write allocate mechanism is disabled (even if all bits in the WAELIM field are

21850J/0-February 2000

set to 0, write allocates can still occur due to the "Write to a Cacheable Page" and "Write to a Sector" mechanisms).

Write Allocate Enable 15-to-16-Mbyte – All Steppings. The Write Allocate Enable 15-to-16-Mbyte (WAE15M) bit is used to enable write allocations for memory write cycles that address the 1 Mbyte of memory between 15 Mbytes and 16 Mbytes. This bit must be set to 1 to allow write allocate in this memory area. This bit is provided to account for a small number of uncommon memory-mapped I/O adapters that use this particular memory address space. If the system contains one of these peripherals, the bit should be set to 0 (even if the WAE15M bit is set to 0, write allocates can still occur between 15 Mbytes and 16 Mbytes due to the "Write to a Cacheable Page" and "Write to a Sector" mechanisms). The WAE15M bit is ignored if the value in the WAELIM field is set to less than 16 Mbytes.

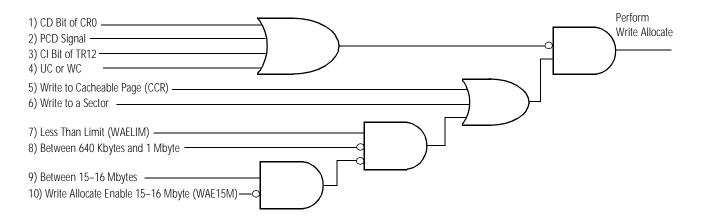
By definition a write allocate is not performed in the memory area between 640 Kbytes and 1 Mbyte unless the processor determines a pending write cycle is cacheable by means of one of the other write allocate mechanisms—"Write to a Cacheable Page" and "Write to a Sector." It is not considered safe to perform write allocations between 640 Kbytes and 1 Mbyte (000A\_0000h to 000F\_FFFFh) because it is considered a noncacheable region of memory.

For AMD-K6-2 processor Model 8/[F:8], if a memory region is defined as write-combinable or uncacheable by a MTRR, write allocates are not performed in that region.

Write Allocate Logic<br/>Mechanisms andFigure 81 shows the logic flow for all the mechanisms involved<br/>with write allocate for memory bus cycles. The left side of the<br/>diagram (the text) describes the conditions that need to be true<br/>in order for the value of that line to be a 1. Items 1 to 4 of the<br/>diagram are related to general cache operation and items 5 to<br/>10 are related to the write allocate mechanisms.

For more information about write allocate, see the Implementation of Write Allocate in the  $K86^{TM}$  Processors Application Note, order# 21326.





#### Figure 81. Write Allocate Logic Mechanisms and Conditions

The following list describes the corresponding items in Figure 81:

- 1. *CD Bit of CR0*—When the cache disable (CD) bit within control register 0 (CR0) is set to 1, the cache fill mechanism for both reads and writes is disabled and write allocate does not occur.
- 2. *PCD Signal*—When the PCD (page cache disable) signal is driven High, caching for that page is disabled, even if KEN# is sampled asserted, and write allocate does not occur.
- 3. *CI Bit of TR12*—When the cache inhibit bit of Test Register 12 is set to 1, L1 cache fills are disabled and write allocate does not occur.
- 4. UC or WC—If a pending write cycle addresses a region of memory defined as write combinable or uncacheable by an MTRR, write allocates are not performed in that region. MTRRs are only supported in the AMD-K6-2 processor Model 8/[F:8]. For all other steppings, treat this condition as equal to 0.
- 5. Write to a Cacheable Page (CCR)—A write allocate is performed if the processor knows that a page is cacheable. The CCR is used to store the page address of the last cache fill for a read miss. See "Write to a Cacheable Page" on page 188 for a detailed description of this condition.

- 6. Write to a Sector—A write allocate is performed if the address of a pending write cycle matches the tag address of a valid cache sector but the addressed cache line within the sector is invalid. See "Write to a Sector" on page 189 for a detailed description of this condition.
- 7. Less Than Limit (WAELIM)—The write allocate limit mechanism determines if the memory area being addressed is less than the limit set in the WAELIM field of WHCR. If the address is less than the limit, write allocate for that memory address is performed as long as conditions 8 through 10 do not prevent write allocate (even if conditions 8 and 10 attempt to prevent write allocate, condition 5 or 6 allows write allocate to occur).
- 8. Between 640 Kbytes and 1 Mbyte—Write allocate is not performed in the memory area between 640 Kbytes and 1 Mbyte. It is not considered safe to perform write allocations between 640 Kbytes and 1 Mbyte (000A\_0000h to 000F\_FFFFh) because this area of memory is considered a noncacheable region of memory (even if condition 8 attempts to prevent write allocate, condition 5 or 6 allows write allocate to occur).
- 9. *Between 15–16 Mbytes*—If the address of a pending write cycle is in the 1 Mbyte of memory between 15 Mbytes and 16 Mbytes, and the WAE15M bit is set to 1, write allocate for this cycle is enabled.
- 10. Write Allocate Enable 15–16 Mbytes (WAE15M)—This condition is associated with the Write Allocate Limit mechanism and affects write allocate only if the limit specified by the WAELIM field is greater than or equal to 16 Mbytes. If the memory address is between 15 Mbytes and 16 Mbytes, and the WAE15M bit in the WHCR is set to 0, write allocate for this cycle is disabled (even if condition 10 attempts to prevent write allocate, condition 5 or 6 allows write allocate to occur).

AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 7.8 Prefetching

Hardware The AMD-K6-2 processor conditionally performs cache prefetching which results in the filling of the required cache Prefetching line first, and a prefetch of the second cache line making up the other half of the sector. From the perspective of the external bus, the two cache-line fills typically appear as two 32-byte burst read cycles occurring back-to-back or, if allowed, as pipelined cycles. The burst read cycles do not occur back-to-back (wait states occur) if the processor is not ready to start a new cycle, if higher priority data read or write requests exist, or if NA# (next address) was sampled negated. Wait states can also exist between burst cycles if the processor samples AHOLD or BOFF# asserted. The 3DNow! technology includes an instruction called Software Prefetching PREFETCH that allows a cache line to be prefetched into the data cache. Unlike prefetching under hardware control,

data cache. Unlike prefetching under hardware control, software prefetching only fetches the cache line specified by the operand of the PREFETCH instruction, and does not attempt to fetch the other cache line in the sector. The PREFETCH instruction format is defined in Table 17, "3DNow!<sup>™</sup> Instructions," on page 81. For more detailed information, see the 3DNow!<sup>™</sup> Technology Manual, order# 21928.

# 7.9 Cache States

Table 36 shows all the possible cache-line states before and after program-generated accesses to individual cache lines. The table includes the correspondence between MESI states and writethrough or writeback states for lines in the data cache.

Туре		Cooks State Defens	Access	Cache State After Access		
		Cache State Before Access	Type <sup>1</sup>	MESI State <sup>8</sup>	Writeback Writethrough State	
Cache Read	Read Miss	invalid	single read from bus	invalid	-	
		invalid	burst read from bus, fill cache <sup>2</sup>	shared or exclusive <sup>3</sup>	writethrough or writeback <sup>3</sup>	
	Read Hit	exclusive	-	exclusive	writeback	
		modified	-	modified	writeback	
		shared	-	shared	writethrough	
Cache Write	Write Miss	invalid	single write to bus <sup>4</sup>	invalid	-	
		invalid	burst read from bus, fill cache, write to cache <sup>5</sup>	modified <sup>6</sup>	_	
		invalid	burst read from bus, fill cache, write to cache, single write to bus <sup>5</sup>	shared <sup>7</sup>	_	
	Write Hit	exclusive or modified	write to cache	modified	writeback	
		shared	write to cache, single write to bus	shared or exclusive <sup>3</sup>	writethrough or writeback <sup>3</sup>	

#### Table 36. Data Cache States for Read and Write Accesses

Notes:

1. Single read, single write, cache update, and writethrough = 1 to 8 bytes. Line fill = 32-byte burst read.

2. If CACHE# is driven Low and KEN# is sampled asserted.

3. If PWT is driven Low and WB/WT# is sampled High, the line is cached in the exclusive (writeback) state. If PWT is driven High or WB/WT# is sampled Low, the line is cached in the shared (writethrough) state.

4. Assumes the write allocate conditions as specified in "Write Allocate" on page 188 are not met.

5. Assumes the write allocate conditions as specified in "Write Allocate" on page 188 are met.

6. Assumes PWT is driven Low and WB/WT# is sampled High.

7. Assumes PWT is driven High or WB/WT# is sampled Low.

8. The final MESI state assumes that the state of the WB/WT# signal remains the same for all accesses to a particular cache line.
 Not applicable or none.

AMD-K6<sup>®</sup>-2 Processor Data Sheet

#### 7.10 Cache Coherency

Different ways exist to maintain coherency between the system memory and cache memories. Inquire cycles, internal snoops, FLUSH#, WBINVD, INVD, and line replacements all prevent inconsistencies between memories.

**Inquire Cycles** Inquire cycles are bus cycles initiated by system logic which ensure coherency between the caches and main memory. In systems with multiple bus masters, system logic maintains cache coherency by driving inquire cycles to the processor. System logic initiates inquire cycles by asserting AHOLD, BOFF#, or HOLD to obtain control of the address bus and then driving EADS#, INV (optional), and an inquire address (A[31:5]). This type of bus cycle causes the processor to compare the tags for both its instruction and data caches with the inquire address. If there is a hit to a shared or exclusive line in the data cache or a valid line in the instruction cache, the processor asserts HIT#. If the compare hits a modified line in the data cache, the processor asserts HIT# and HITM#. If HITM# is asserted, the processor writes the modified line back to memory. If INV was sampled asserted with EADS#, a hit invalidates the line. If INV was sampled negated with EADS#, a hit leaves the line in the shared state or transitions it from the exclusive or modified state to the shared state.

> Table 37 on page 199 shows the effects of inquire cycles performed with INV equal to 0 (non-invalidating) and INV equal to 1 (invalidating)—snoops, and invalidations.

# Internal Snooping Internal snooping is initiated by the processor (rather than system logic) during certain cache accesses. It is used to maintain coherency between the instruction cache and the data cache.

The processor automatically snoops its instruction cache during read or write misses to its data cache, and it snoops its data cache during read misses to its instruction cache. Table 37 summarizes the actions taken during this internal snooping. If an internal snoop hits its target, the processor does the following:

- Data cache snoop during an instruction-cache read miss—If modified, the line in the data cache is written back on the system bus to external memory. Regardless of its state, the data-cache line is invalidated and the instruction cache performs a burst read cycle from external memory.
- Instruction cache snoop during a data cache miss—The line in the instruction cache is marked invalid, and the data-cache read or write is performed as defined in Table 36 on page 195.
- **FLUSH#** In response to sampling FLUSH# asserted, the processor writes back any data cache lines that are in the modified state and then marks all lines in the instruction and data caches as invalid.
- **PFIR** The AMD-K6-2 processor Model 8/[F:8] processor contains the Page Flush/Invalidate Register (PFIR) that allows cache invalidation and optional flushing of a specific 4-Kbyte page from the linear address space (see Figure 82). When the PFIR is written to (using the WRMSR instruction), the invalidation and, optionally, the flushing begins. The total amount of cache in the AMD-K6-2 processor is 64 Kbytes. Using this register can result in a much lower cycle count for flushing particular pages versus flushing the entire cache.

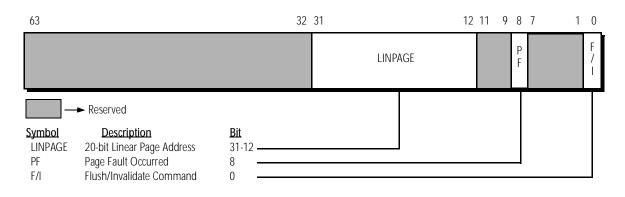


Figure 82. Page Flush/Invalidate Register (PFIR)-MSR C000\_0088h

LINPAGE. This 20-bit field must be written with bits 31:12 of the linear address of the 4-Kbyte page that is to be invalidated and optionally flushed from the L1 cache.

PF. If an attempt to invalidate or flush a page results in a page fault, the processor sets the PF bit to 1, and the invalidate or flush operation is not performed (even though invalidate operations do not normally generate page faults). In this case, an actual page fault exception is not generated. If the PF bit equals 0 after an invalidate or flush operation, then the operation executed successfully. The PF bit must be read after every write to the PFIR register to determine if the invalidate or flush operation executed successfully.

F/I. This bit is used to control the type of action that occurs to the specified linear page. If a 0 is written to this bit, the operation is a flush, in which case all cache lines in the modified state within the specified page are written back to memory, after which the entire page is invalidated. If a 1 is written to this bit, the operation is an invalidation, in which case the entire page is invalidated without the occurrence of any writebacks.

- **WBINVD and INVD** These x86 instructions cause all cache lines to be marked as invalid. WBINVD writes back modified lines before marking all cache lines invalid. INVD does not write back modified lines.
- Cache-LineReplacing lines in the instruction or data cache, according to<br/>the line replacement algorithms described in "Cache-Line<br/>Fills" on page 186, ensures coherency between main memory<br/>and the caches.

Table 37 on page 199 shows all possible cache-line states before and after various cache-related operations.

pe of Operation	Cache State Before Operation	Memory Access			ter Operation Writeback	
			MESI State		Writethrough State	
	shared or		INV=0	shared	writethrough	
Inquire	exclusive	-	INV=1	invalid	invalid	
Cycle	modified	writeback to bus	INV=0	shared	writethrough	
	moumeu	WHICEDACK ID DUS	INV=1	invalid	invalid	
Internal	shared or	_		L		
Snoop	exclusive		inv	alid	invalid	
энсор	modified	writeback to bus				
FLUSH#	shared or	_				
Signal	exclusive		inv	alid	invalid	
9	modified	writeback to bus				
PFIR*	shared or	_				
(F/I = 0)	exclusive		inv	alid	invalid	
	modified	writeback to bus				
PFIR*	_	_	invalid		invalid	
(F/I = 1)						
WBINVD	shared or	-	invalid		invalid	
Instruction	exclusive					
	modified	writeback to bus				
INVD	_	_	inv	alid	invalid	
Instruction						

Table 37.         Cache States for Inquire Cycles, Snoops, Flushes, and Invalidation
--

The AMD-K6-2 processor Model 8/[F:8] supports the PFIR.

# Cache SnoopingTable 38 shows the conditions under which snooping occurs in<br/>the AMD-K6-2 processor and the resources that are snooped.

#### Table 38. Snoop Action

		Snooping Action		
Type of A	ccess	Instruction Cache	Data Cache	
System L	ogic	yes <sup>1</sup>	yes <sup>1</sup>	
Instruction	Read Miss	-	yes <sup>2</sup>	
Cache	Read Hit	-	no	
	Read Miss	yes <sup>3</sup>	_	
Data	Read Hit	no	_	
Cache	Write Miss	yes <sup>3</sup>	_	
	Write Hit	no	-	
	System L Instruction Cache Data	Instruction Cache Read Hit Read Miss Read Miss Read Hit Cache Write Miss Write	Type of Access     Instruction Cache       System Logic     yes <sup>1</sup> System Logic     yes <sup>1</sup> Instruction Cache     Miss       Instruction Cache     Read       Miss     -       Read     -       Hit     -       Read     yes <sup>3</sup> Read     Hit       Data     Read       Miss     yes <sup>3</sup> Write     yes <sup>3</sup> Write     po	

1. The processor's response to an inquire cycle depends on the state of the INV input signal and the state of the cache line as follows:

For the instruction cache, if INV is sampled negated, the line remains invalid or valid, but if INV is sampled asserted, the line is invalidated.

For the data cache, if INV is sampled negated, valid lines remain in or transition to the shared state, a modified data cache line is written back before the line is marked shared (with HITM# asserted), and invalid lines remain invalid. For the data cache, if INV is sampled asserted, the line is marked invalid. Modified lines are written back before invalidation.

- 2. If an internal snoop hits a modified line in the data cache, the line is written back and invalidated. Then the instruction cache performs a burst read from memory.
- 3. If an internal snoop hits a line in the instruction cache, the instruction cache line is invalidated and the data-cache read or write is performed from memory.
- Not applicable.

### 7.11 Writethrough versus Writeback Coherency States

The terms *writethrough* and *writeback* apply to two related concepts in a read-write cache like the AMD-K6-2 processor L1 data cache. The following conditions apply to both the writethrough and writeback modes:

- Memory Writes—A relationship exists between external memory writes and their concurrence with cache updates:
  - An external memory write that occurs concurrently with a cache update to the same location is a writethrough. Writethroughs are driven as single cycles on the bus.
  - An external memory write that occurs after the processor has modified a cache line is a writeback. Writebacks are driven as burst cycles on the bus.
- Coherency State—A relationship exists between MESI coherency states and writethrough-writeback coherency states of lines in the cache as follows:
  - Shared and invalid MESI lines are in the writethrough state.
  - Modified and exclusive MESI lines are in the writeback state.

### 7.12 A20M# Masking of Cache Accesses

Although the processor samples A20M# as a level-sensitive input on every clock edge, it should only be asserted in Real mode. The processor applies the A20M# masking to its tags, through which all programs access the caches. Therefore, assertion of A20M# affects all addresses (cache and external memory), including the following:

- Cache-line fills (caused by read misses or write allocates)
- Cache writethroughs (caused by write misses or write hits to lines in the shared state)

However, A20M# does not mask writebacks or invalidations caused by the following actions:

- Internal snoops
- Inquire cycles
- The FLUSH# signal
- Writing to the PFIR (AMD-K6-2/[F:8] only)
- The WBINVD instruction

### 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

## 8 Write Merge Buffer

The AMD-K6-2 processor Model 8/[F:8] contains an 8-byte write merge buffer that allows the processor to conditionally combine data from multiple noncacheable write cycles into this merge buffer. The merge buffer operates in conjunction with the Memory Type Range Registers (MTRRs). Refer to "Memory Type Range Registers" on page 205 for a description of the MTRRs.

Merging multiple write cycles into a single write cycle reduces processor bus utilization and processor stalls, thereby increasing the overall system performance.

### 8.1 EWBE Control

The presence of the merge buffer creates the potential to perform out-of-order write cycles relative to the processor's L1 cache. In general, the ordering of write cycles that are driven externally on the system bus and those that hit the processor's cache can be controlled by the EWBE# signal. See "EWBE# (External Write Buffer Empty)" on page 103 for more information. If EWBE# is sampled negated, the processor delays the commitment of write cycles to cache lines in the modified state or exclusive state in the processor's cache. Therefore, the system logic can enforce strong ordering by negating EWBE# until the external write cycle is complete, thereby ensuring that a subsequent write cycle that hits the cache does not complete ahead of the external write cycle.

However, the addition of the write merge buffer introduces the potential for out-of-order write cycles to occur between writes to the merge buffer and writes to the processor's cache. Because these writes occur entirely within the processor and are not sent out to the processor bus, the system logic is not able to enforce strong ordering with the EWBE# signal.

The EWBE control (EWBEC) bits in the EFER register provide a mechanism for enforcing three different levels of write ordering in the presence of the write merge buffer:

 EFER[3] is defined as the Global EWBE Disable (GEWBED). When GEWBED equals 1, the processor does not attempt to enforce any write ordering internally or externally (the EWBE# signal is ignored). This is the maximum performance setting. • EFER[2] is defined as the Speculative EWBE Disable (SEWBED). SEWBED only affects the processor when GEWBED equals 0. If GEWBED equals 0 and SEWBED equals 1, the processor enforces strong ordering for all internal write cycles with the exception of write cycles addressed to a range of memory defined as uncacheable (UC) or write-combining (WC) by the MTRRs. In addition, the processor samples the EWBE# signal. If EWBE# is sampled negated, the processor delays the commitment of write cycles to processor cache lines in the modified state or exclusive state until EWBE# is sampled asserted.

This setting provides performance comparable to, but slightly less than, the performance obtained when GEWBED equals 1 because some degree of write ordering is maintained.

If GEWBED equals 0 and SEWBED equals 0, the processor enforces strong ordering for all internal and external write cycles. In this setting, the processor assumes, or *speculates*, that strong order must be maintained between writes to the merge buffer and writes that hit the processor's cache. Once the merge buffer is written out to the processor's bus, the EWBE# signal is sampled. If EWBE# is sampled negated, the processor delays the commitment of write cycles to processor cache lines in the modified state or exclusive state until EWBE# is sampled asserted.

This setting is the default after RESET and provides the lowest performance of the three settings because full write ordering is maintained.

Table 39 summarizes the three settings of the EWBEC field for the EFER register, along with the effect of write ordering and performance. For more information on the EFER register, see "Extended Feature Enable Register (EFER)–Model 8/[F:8]" on page 50.

Table 39.	EWBEC	Settings
-----------	-------	----------

EFER[3] (GEWBED)	EFER[2] (SEWBED)	Write Ordering	Performance
1	0 or 1	None	Best
0	1	All except UC/WC	Close-to-Best
0	0	All	Slowest

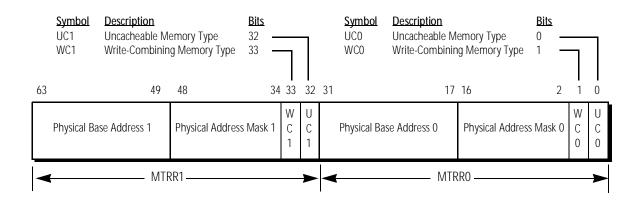
21850J/0-February 2000

### 8.2 Memory Type Range Registers

The AMD-K6-2 processor Model 8/[F:8] provides two variablerange Memory Type Range Registers (MTRRs)—MTRR0 and MTRR1—that each specify a range of memory. Each range can be defined as one of the following memory types:

- Uncacheable (UC) memory—Memory read cycles are sourced directly from the specified memory address and the processor does not allocate a cache line. Memory write cycles are targeted at the specified memory address and a write allocation does not occur.
- Write-Combining (WC) memory—Memory read cycles are sourced directly from the specified memory address and the processor does not allocate a cache line. The processor conditionally combines data from multiple noncacheable write cycles that are addressed within this range into a merge buffer. Merging multiple write cycles into a single write cycle reduces processor bus utilization and processor stalls, thereby increasing the overall system performance. This memory type is applicable for linear video frame buffers.

UC/WC Cacheability<br/>Control Register<br/>(UWCCR)The MTRRs are accessed by addressing the 64-bit MSR known<br/>as the UC/WC Cacheability Control Register (UWCCR). The<br/>MSR address of the UWCCR is C000\_0085h. Following reset, all<br/>bits in the UWCCR register are set to 0. MTRR0 (lower 32 bits<br/>of the UWCCR register) defines the size and memory type of<br/>range 0 and MTRR1 (upper 32 bits) defines the size and<br/>memory type of range 1 (see Figure 83).



#### Figure 83. UC/WC Cacheability Control Register (UWCCR)-MSR C000\_0085h (Model 8/[F:8])

Physical Base Address n (n=0, 1). This address is the 15 mostsignificant bits of the physical base address of the memory range. The least-significant 17 bits of the base address are not needed because the base address is by definition always aligned on a 128-Kbyte boundary.

Physical Address Mask n (n=0, 1). This value is the 15 mostsignificant bits of a physical address mask that is used to define the size of the memory range. This mask is logically ANDed with both the physical base address field of the UWCCR register and the physical address generated by the processor. If the results of the two AND operations are equal, then the generated physical address is considered within the range. That is, if:

Mask & Physical Base Address = Mask & Physical Address Generated

then the physical address generated by the processor is in the range.

WCn (n=0, 1). When set to 1, this memory range is defined as write combinable (refer to Table 40). Write-combinable memory is uncacheable.

UCn (n=0, 1). When set to 1, this memory range is defined as uncacheable (refer to Table 40).

 Table 40.
 WC/UC Memory Type

WCn	UCn	Memory Type
0	0	No effect on cacheability or write combining
1	0	Write-combining memory range (uncacheable)
0 or 1	1	Uncacheable memory range

Memory-Range Restrictions. The following rules regarding the address alignment and size of each range must be adhered to when programming the physical base address and physical address mask fields of the UWCCR register:

- The minimum size of each range is 128 Kbytes.
- The physical base address must be aligned on a 128-Kbyte boundary.
- The physical base address must be *range-size aligned*. For example, if the size of the range is 1 Mbyte, then the physical base address must be aligned on a 1-Mbyte boundary.
- All bits set to 1 in the physical address mask must be contiguous. Likewise, all bits set to 0 in the physical address mask must be contiguous. For example:

111\_111\_1100\_0000b is a valid physical address mask

111\_1111\_101\_0000b is invalid

Table 41 lists the valid physical address masks and the resulting range sizes that can be programmed in the UWCCR register.

Masks	Size
111_1111_1111_111b	128 Kbytes
111_1111_1111_1110b	256 Kbytes
111_1111_1111_1100b	512 Kbytes
111_1111_1111_1000b	1 Mbyte
111_1111_1111_0000b	2 Mbytes
111_1111_1110_0000b	4 Mbytes
111_1111_1100_0000b	8 Mbytes

 Table 41.
 Valid Masks and Range Sizes

Masks	Size
111_1111_1000_0000b	16 Mbytes
111_1111_0000_0000b	32 Mbytes
111_1110_0000_0000b	64 Mbytes
111_1100_0000_0000b	128 Mbytes
111_1000_0000_0000b	256 Mbytes
111_0000_0000_0000b	512 Mbytes
110_0000_0000_0000b	1 Gbyte
100_0000_0000_0000b	2 Gbytes
000_0000_0000_0000b	4 Gbytes

 Table 41.
 Valid Masks and Range Sizes (continued)

**Example**. Suppose that the range of memory from 16 Mbytes to 32 Mbytes is uncacheable, and the 8-Mbyte range of memory on top of 1 Gbyte is write-combinable. Range 0 is defined as the uncacheable range, and range 1 is defined as the write-combining range.

Extracting the 15 most-significant bits of the 32-bit physical base address that corresponds to 16 Mbytes (0100\_0000h) yields a physical base address 0 field of 000\_0000\_1000\_0000b. Because the uncacheable range size is 16 Mbytes, the physical mask value 0 field is 111\_111\_1000\_0000b, according to Table 41. Bit 1 of the UWCCR register (WC0) is set to 0 and bit 0 of the UWCCR register is set to 1 (UC0).

Extracting the 15 most-significant bits of the 32-bit physical base address that corresponds to 1 Gbyte (4000\_0000h) yields a physical base address 1 field of 010\_0000\_0000\_0000b. Because the write-combining range size is 8 Mbytes, the physical mask value 1 field is 111\_111\_1100\_0000b, according to Table 41. Bit 33 of the UWCCR register (WC1) is set to 1 and bit 32 of the UWCCR register is set to 0 (UC1).

## 9 Floating-Point and Multimedia Execution Units

### 9.1 Floating-Point Execution Unit

The AMD-K6-2 processor contains an IEEE 754-compatible and 854-compatible floating-point execution unit designed to accelerate the performance of software that utilizes the x86 floating-point instruction set. Floating-point software is typically written to manipulate numbers that are very large or very small, that require a high degree of precision, or that result from complex mathematical operations such as transcendentals. Applications that take advantage of floating-point operations include geometric calculations for graphics acceleration, scientific, statistical, and engineering applications, and business applications that use large amounts of high-precision data.

The high-performance floating-point execution unit contains an adder unit, a multiplier unit, and a divide/square root unit. These low-latency units can execute floating-point instructions in as few as two processor clocks. To increase performance, the processor is designed to simultaneously decode most floating-point instructions with most short-decodeable instructions.

See "Software Environment" on page 21 for a description of the floating-point data types, registers, and instructions.

Handling The AMD-K6-2 processor provides the following two types of **Floating-Point** exception handling for floating-point exceptions: **Exceptions** If the numeric error (NE) bit in CR0 is set to 1, the processor invokes the interrupt 10h handler. In this manner, the floating-point exception is completely handled by software. If the NE bit in CR0 is set to 0, the processor requires external logic to generate an interrupt on the INTR signal in order to handle the exception. External Logic The processor provides the FERR# (Floating-Point Error) and Support of IGNNE# (Ignore Numeric Error) signals to allow the external **Floating-Point** logic to generate the interrupt in a manner consistent with Exceptions IBM-compatible PC/AT systems. The assertion of FERR# indicates the occurrence of an unmasked floating-point exception resulting from the execution of a floating-point

instruction. IGNNE# is used by the external hardware to control the effect of an unmasked floating-point exception. Under certain circumstances, if IGNNE# is sampled asserted, the processor ignores the floating-point exception.

Figure 84 illustrates an implementation of external logic for supporting floating-point exceptions. The following example explains the operation of the external logic in Figure 84:

As the result of a floating-point exception, the processor asserts FERR#. The assertion of FERR# and the sampling of IGNNE# negated indicates the processor has stopped instruction execution and is waiting for an interrupt. The assertion of FERR# leads to the assertion of INTR by the interrupt controller. The processor acknowledges the interrupt and jumps to the corresponding interrupt service routine in which an I/O write cycle to address port F0h leads to the assertion of IGNNE#. When IGNNE# is sampled asserted, the processor ignores the floating-point exception and continues instruction execution. When the processor negates FERR#, the external logic negates IGNNE#.

See "FERR# (Floating-Point Error)" on page 104 and "IGNNE# (Ignore Numeric Exception)" on page 108 for more details.

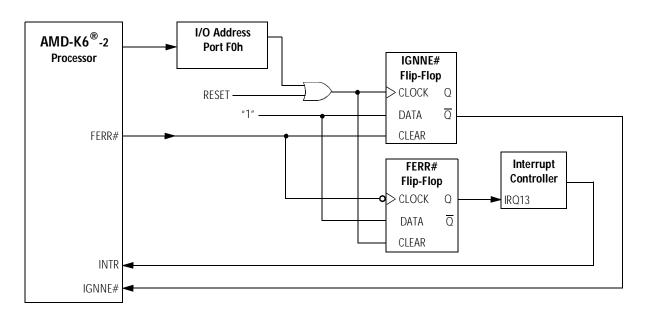


Figure 84. External Logic for Supporting Floating-Point Exceptions

21850J/0-February 2000

### 9.2 Multimedia and 3DNow!<sup>™</sup> Execution Units

The multimedia and 3DNow! execution units of the AMD-K6-2 processor are designed to accelerate the performance of software written using the industry-standard MMX instructions and the new 3DNow! instructions. Applications that can take advantage of the MMX and 3DNow! instructions include graphics, video and audio compression and decompression, speech recognition, and telephony applications.

The multimedia execution unit can execute MMX instructions in a single processor clock. All MMX and 3DNow! arithmetic instructions are pipelined for higher performance. To increase performance, the processor is designed to simultaneously decode all MMX and 3DNow! instructions with most other instructions.

For more information on MMX instructions, see the  $AMD-K6^{\textcircled{R}}$ *Processor Multimedia Technology Manual*, order# 20726. For more information on 3DNow! instructions, see the  $3DNow!^{TM}$ *Technology Manual*, order# 21928.

### 9.3 Floating-Point and MMX<sup>™</sup>/3DNow!<sup>™</sup> Instruction Compatibility

Registers	The eight 64-bit MMX registers (which are also utilized by 3DNow! instructions) are mapped on the floating-point stack. This enables backward compatibility with all existing software. For example, the register saving event that is performed by operating systems during task switching requires no changes to the operating system. The same support provided in an operating system's interrupt 7 handler (Device Not Available) for saving and restoring the floating-point registers also supports saving and restoring the MMX registers.
Exceptions	There are no new exceptions defined for supporting the MMX and 3DNow! instructions. All exceptions that occur while decoding or executing an MMX or 3DNow! instruction are handled in existing exception handlers without modification.
FERR# and IGNNE#	MMX instructions and 3DNow! instructions do not generate floating-point exceptions. However, if an unmasked floating-point exception is pending, the processor asserts FERR# at the instruction boundary of the next floating-point



instruction, MMX instruction, 3DNow! instruction or WAIT instruction.

The sampling of IGNNE# asserted only affects processor operation during the execution of an error-sensitive floating-point instruction, MMX instruction, 3DNow! instruction or WAIT instruction when the NE bit in CR0 is set to 0.

## **10** System Management Mode (SMM)

### 10.1 Overview

SMM is an alternate operating mode entered by way of a system management interrupt (SMI#) and handled by an interrupt service routine. SMM is designed for system control activities such as power management. These activities appear transparent to conventional operating systems like DOS and Windows. SMM is primarily targeted for use by the Basic Input Output System (BIOS) and specialized low-level device drivers. The code and data for SMM are stored in the SMM memory area, which is isolated from main memory.

The processor enters SMM by the assertion of the SMI# interrupt and the processor's acknowledgment by the assertion of SMIACT#. At this point the processor saves its state into the SMM memory state-save area and jumps to the SMM service routine. The processor returns from SMM when it executes the RSM (resume) instruction from within the SMM service routine. Subsequently, the processor restores its state from the SMM save area, negates SMIACT#, and resumes execution with the instruction following the point where it entered SMM.

The following sections summarize the SMM state-save area, entry into and exit from SMM, exceptions and interrupts in SMM, memory allocation and addressing in SMM, and the SMI# and SMIACT# signals.

### **10.2 SMM Operating Mode and Default Register Values**

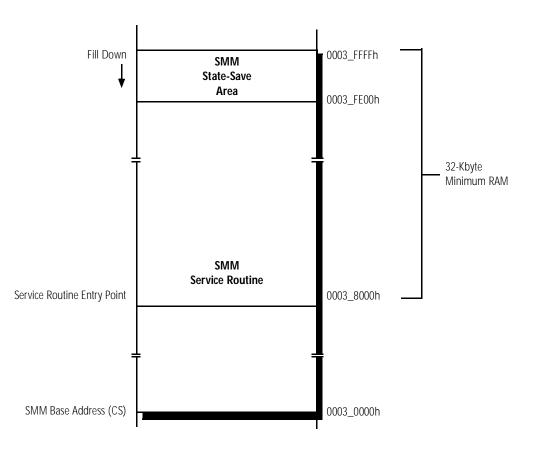
The software environment within SMM has the following characteristics:

- Addressing and operation in Real mode
- 4-Gbyte segment limits
- Default 16-bit operand, address, and stack sizes, although instruction prefixes can override these defaults
- Control transfers that do not override the default operand size truncate the EIP to 16 bits

- Far jumps or calls cannot transfer control to a segment with a base address requiring more than 20 bits, as in Real mode segment-base addressing
- A20M# is masked
- Interrupt vectors use the Real-mode interrupt vector table
- The IF flag in EFLAGS is cleared (INTR not recognized)
- The TF flag in EFLAGS is cleared
- The NMI and INIT interrupts are disabled
- Debug register DR7 is cleared (debug traps disabled)

Figure 85 shows the default map of the SMM memory area. It consists of a 64-Kbyte area, between 0003\_0000h and 0003\_FFFFh, of which the top 32 Kbytes (0003\_8000h to 0003\_FFFFh) must be populated with RAM. The default code-segment (CS) base address for the area—called the SMM base address—is at 0003\_0000h. The top 512 bytes (0003\_FE00h to 0003\_FFFFh) contain a fill-down SMM state-save area. The default entry point for the SMM service routine is 0003\_8000h.

21850J/0-February 2000



#### Figure 85. SMM Memory

Table 42 shows the initial state of registers when entering SMM.

 Table 42.
 Initial State of Registers in SMM

Registers	SMM Initial State
General Purpose Registers	unmodified
EFLAGS	0000_0002h
CRO	PE, EM, TS, and PG are cleared (bits 0, 2, 3, and 31). The other bits are unmodified.
DR7	0000_0400h
GDTR, LDTR, IDTR, TSSR, DR6	unmodified
EIP	0000_8000h
CS	0003_0000h
DS, ES, FS, GS, SS	0000_0000h

#### 10.3 **SMM State-Save Area**

When the processor acknowledges an SMI# interrupt by asserting SMIACT#, it saves its state in a 512-byte SMM state-save area shown in Table 43. The save begins at the top of the SMM memory area (SMM base address + FFFFh) and fills down to SMM base address + FE00h.

Table 43 shows the offsets in the SMM state-save area relative to the SMM base address. The SMM service routine can alter any of the read/write values in the state-save area.

Address Offset	Contents Saved
FFFCh	CRO
FFF8h	CR3
FFF4h	EFLAGS
FFF0h	EIP
FFECh	EDI
FFE8h	ESI
FFE4h	EBP
FFE0h	ESP
FFDCh	EBX
FFD8h	EDX
FFD4h	ECX
FFD0h	EAX
FFCCh	DR6
FFC8h	DR7
FFC4h	TR
FFC0h	LDTR Base
FFBCh	GS
FFB8h	FS
FFB4h	DS
FFB0h	SS
FFACh	CS
FFA8h	ES

Table 43. SMM State-Save Area Map

Only contains information if SMI# is asserted during a valid I/O bus cycle.

Address Offset	Contents Saved
FFA4h	I/O Trap Dword
FFA0h	-
FF9Ch	I/O Trap EIP*
FF98h	_
FF94h	-
FF90h	IDT Base
FF8Ch	IDT Limit
FF88h	GDT Base
FF84h	GDT Limit
FF80h	TSS Attr
FF7Ch	TSS Base
FF78h	TSS Limit
FF74h	_
FF70h	LDT High
FF6Ch	LDT Low
FF68h	GS Attr
FF64h	GS Base
FF60h	GS Limit
FF5Ch	FS Attr
FF58h	FS Base
FF54h	FS Limit
FF50h	DS Attr
FF4Ch	DS Base
FF48h	DS Limit
FF44h	SS Attr
FF40h	SS Base
FF3Ch	SS Limit
FF38h	CS Attr
FF34h	CS Base
FF30h	CS Limit
FF2Ch	ES Attr

#### Table 43. SMM State-Save Area Map (continued)

Only contains information if SMI# is asserted during a valid I/O bus cycle. \*

Address Offset	Contents Saved
FF28h	ES Base
Address Offset           FF28h           FF24h           FF20h           FF10h           FF10h           FF10h           FF10h           FF0Ch           FF00h           FF08h           FF08h           FF04h           FF02h           FF02h           FF00h           FF00h           FF02h           FF00h           FF02h           FF00h           FF00h           FF00h           FEF8h           FEF7h-FE00h	ES Limit
FF20h	_
FF1Ch	_
FF18h	_
FF14h	CR2
FF10h	CR4
FF0Ch	I/O Restart ESI*
FF08h	I/O Restart ECX*
FF04h	I/O Restart EDI*
FF02h	HALT Restart Slot
FF00h	I/O Trap Restart Slot
FEFCh	SMM RevID
FEF8h	SMM Base
	_

Table 43. SMM State-Save Area Map (continued)

Only contains information if SMI# is asserted during a valid I/O bus cycle.

#### **SMM Revision Identifier** 10.4

The SMM revision identifier at offset FEFCh in the SMM state-save area specifies the version of SMM and the extensions that are available on the processor. The SMM revision identifier fields are as follows:

- Bits 31–18—Reserved
- *Bit 17*—SMM base address relocation (1 = enabled)
- *Bit 16*—I/O trap restart (1 = enabled)
- Bits 15-0—SMM revision level for the AMD-K6-2 processor = 0002h

0002h

Table 44 shows the format of the SMM Revision Identifier.

Iddle 44. S			
31–18	17	16	15–0
Reserved	SMM Base Relocation	I/O Trap Extension	SMM Revision Level

1

### **10.5** SMM Base Address

0

During RESET, the processor sets the base address of the code-segment (CS) for the SMM memory area—the SMM base address—to its default, 0003\_0000h. The SMM base address at offset FEF8h in the SMM state-save area can be changed by the SMM service routine to any address that is aligned to a 32-Kbyte boundary. (Locations not aligned to a 32-Kbyte boundary cause the processor to enter the Shutdown state when executing the RSM instruction.)

1

In some operating environments it may be desirable to relocate the 64-Kbyte SMM memory area to a high memory area in order to provide more low memory for legacy software. During system initialization, the base of the 64-Kbyte SMM memory area is relocated by the BIOS. To relocate the SMM base address, the system enters the SMM handler at the default address. This handler changes the SMM base address location in the SMM state-save area, copies the SMM handler to the new location, and exits SMM.

The next time SMM is entered, the processor saves its state at the new base address. This new address is used for every SMM entry until the SMM base address in the SMM state-save area is changed or a hardware reset occurs.

### 10.6 Halt Restart Slot

During entry into SMM, the halt restart slot at offset FF02h in the SMM state-save area indicates if SMM was entered from the Halt state. Before returning from SMM, the halt restart slot (offset FF02h) can be written to by the SMM service routine to specify whether the return from SMM takes the processor back to the Halt state or to the next instruction after the HLT instruction.

Upon entry into SMM, the halt restart slot is defined as follows:

- *Bits 15–1*—Reserved
- *Bit 0*—Point of entry to SMM:
  - 1 = entered from Halt state
  - 0 = not entered from Halt state

After entry into the SMI handler and before returning from SMM, the halt restart slot can be written using the following definition:

- Bits 15–1—Reserved
- *Bit 0*—Point of return when exiting from SMM:
  - 1 = return to Halt state
  - 0 = return to next instruction after the HLT instruction

If the return from SMM takes the processor back to the Halt state, the HLT instruction is not re-executed, but the Halt special bus cycle is driven on the bus after the return.

### 10.7 I/O Trap Dword

If the assertion of SMI# is recognized during the execution of an I/O instruction, the I/O trap dword at offset FFA4h in the SMM state-save area contains information about the instruction. The fields of the I/O trap dword are configured as follows:

- *Bits 31–16*—I/O port address
- *Bits 15–4*—Reserved
- Bit 3—REP (repeat) string operation
   (1 = REP string, 0 = not a REP string)
- Bit 2—I/O string operation (1 = I/O string, 0 = not an I/O string)
- *Bit 1*—Valid I/O instruction (1 = valid, 0 = invalid)
- *Bit 0*—Input or output instruction (1 = INx, 0 = OUTx)

Table 45 shows the format of the I/O trap dword.

Table 45. I/O Trap Dword Configuration

31–16	15–4	3	2	1	0
I/O Port Address	Reserved	REP String Operation	I/O String Operation	Valid I/O Instruction	Input or Output

The I/O trap dword is related to the I/O trap restart slot (see "I/O Trap Restart Slot"). If bit 1 of the I/O trap dword is set by the processor, it means that SMI# was asserted during the execution of an I/O instruction. The SMI handler tests bit 1 to see if there is a valid I/O instruction trapped. If the I/O instruction is valid, the SMI handler is required to ensure the I/O trap restart slot is set properly. The I/O trap restart slot informs the processor whether it should re-execute the I/O instruction after the RSM or execute the instruction following the trapped I/O instruction.

*Note:* If SMI# is sampled asserted during an I/O bus cycle a minimum of three clock edges before BRDY# is sampled asserted, the associated I/O instruction is guaranteed to be trapped by the SMI handler.

### 10.8 I/O Trap Restart Slot

The I/O trap restart slot at offset FF00h in the SMM state-save area specifies whether the trapped I/O instruction should be re-executed on return from SMM. This slot in the state-save area is called the *I/O instruction restart* function. Re-executing a trapped I/O instruction is useful, for example, if an I/O write occurs to a disk that is powered down. The system logic monitoring such an access can assert SMI#. Then the SMM service routine would query the system logic, detect a failed I/O write, take action to power-up the I/O device, enable the I/O trap restart slot feature, and return from SMM.

The fields of the I/O trap restart slot are defined as follows:

- *Bits 31–16*—Reserved
- *Bits 15–0*—I/O instruction restart on return from SMM:
  - 0000h = execute the next instruction after the trapped I/O instruction
  - 00FFh = re-execute the trapped I/O instruction

Table 46 shows the format of the I/O trap restart slot.

 Table 46.
 I/O Trap Restart Slot

31–16	15–0						
	I/O Instruction restart on return from SMM:						
Reserved	0000h = execute the next instruction after the trapped I/O						
	00FFh = re-execute the trapped I/O instruction						

The processor initializes the I/O trap restart slot to 0000h upon entry into SMM. If SMM was entered due to a trapped I/O instruction, the processor indicates the validity of the I/O instruction by setting or clearing bit 1 of the I/O trap dword at offset FFA4h in the SMM state-save area. The SMM service routine should test bit 1 of the I/O trap dword to determine if a valid I/O instruction was being executed when entering SMM and before writing the I/O trap restart slot. If the I/O instruction is valid, the SMM service routine can safely rewrite the I/O trap restart slot with the value 00FFh, which causes the processor to re-execute the trapped I/O instruction is invalid, writing the I/O trap restart slot has undefined results.

If a second SMI# is asserted and a valid I/O instruction was trapped by the first SMM handler, the processor services the second SMI# prior to re-executing the trapped I/O instruction. The second entry into SMM never has bit 1 of the I/O trap dword set, and the second SMM service routine must not rewrite the I/O trap restart slot.

During a simultaneous SMI# I/O instruction trap and debug breakpoint trap, the AMD-K6-2 processor first responds to the SMI# and postpones recognizing the debug exception until after returning from SMM via the RSM instruction. If the debug registers DR3–DR0 are used while in SMM, they must be saved and restored by the SMM handler. The processor automatically saves and restores DR7–DR6. If the I/O trap restart slot in the SMM state-save area contains the value 00FFh when the RSM instruction is executed, the debug trap does not occur until after the I/O instruction is re-executed.

### 10.9 Exceptions, Interrupts, and Debug in SMM

During an SMI# I/O trap, the exception/interrupt priority of the AMD-K6-2 processor changes from its normal priority. The normal priority places the debug traps at a priority higher than the sampling of the FLUSH# or SMI# signals. However, during an SMI# I/O trap, the sampling of the FLUSH# or SMI# signals takes precedence over debug traps.

The processor recognizes the assertion of NMI within SMM immediately after the completion of an IRET instruction. Once NMI is recognized within SMM, NMI recognition remains enabled until SMM is exited, at which point NMI masking is restored to the state it was in before entering SMM.

## 11 Test and Debug

The AMD-K6-2 processor implements various test and debug modes to enable the functional and manufacturing testing of systems and boards that use the processor. In addition, the debug features of the processor allow designers to debug the instruction execution of software components. This chapter describes the following test and debug features:

- Built-In Self-Test (BIST)—The BIST, which is invoked after the falling transition of RESET, runs internal tests that exercise most on-chip RAM structures.
- *Tri-State Test Mode*—A test mode that causes the processor to float its output and bidirectional pins.
- Boundary-Scan Test Access Port (TAP)—The Joint Test Action Group (JTAG) test access function defined by the IEEE Standard Test Access Port and Boundary-Scan Architecture (IEEE 1149.1-1990) specification.
- *Level-One (L1) Cache Inhibit*—A feature that disables the processor's internal L1 instruction and data caches.
- *Debug Support*—Consists of all x86-compatible software debug features, including the debug extensions.

### 11.1 Built-In Self-Test (BIST)

Following the falling transition of RESET, the processor unconditionally runs its BIST. The internal resources tested during BIST include the following:

- L1 instruction and data caches
- Instruction and Data Translation Lookaside Buffers (TLBs)

The contents of the EAX general-purpose register after the completion of reset indicate if the BIST was successful. If EAX contains 0000\_0000h, then BIST was successful. If EAX is non-zero, the BIST failed. Following the completion of the BIST, the processor jumps to address FFFF\_FF0h to start instruction execution, regardless of the outcome of the BIST.

The BIST takes approximately 295,000 processor clocks to complete.

### **11.2 Tri-State Test Mode**

The Tri-State Test mode causes the processor to float its output and bidirectional pins, which is useful for board-level manufacturing testing. In this mode, the processor is electrically isolated from other components on a system board, allowing automated test equipment (ATE) to test components that drive the same signals as those the processor floats.

If the FLUSH# signal is sampled Low during the falling transition of RESET, the processor enters the Tri-State Test mode. (See "FLUSH# (Cache Flush)" on page 105 for the specific sampling requirements.) The signals floated in the Tri-State Test mode are as follows:

■ A[31:3]	■ D/C#	■ M/IO#
■ ADS#	■ D[63:0]	■ PCD
■ ADSC#	■ DP[7:0]	■ PCHK#
■ AP	■ FERR#	■ PWT
■ APCHK#	■ HIT#	SCYC
■ BE[7:0]#	■ HITM#	■ SMIACT#
■ BREQ	HLDA	■ W/R#
■ CACHE#	■ LOCK#	

The VCC2DET, VCC2H/L#, and TDO signals are the only outputs not floated in the Tri-State Test mode. VCC2DET and VCC2H/L# must remain Low to ensure the system continues to supply the specified processor core voltage to the  $V_{CC2}$  pins. TDO is never floated because the Boundary-Scan Test Access Port must remain enabled at all times, including during the Tri-State Test mode.

The Tri-State Test mode is exited when the processor samples RESET asserted.

21850J/0-February 2000

### **11.3 Boundary-Scan Test Access Port (TAP)**

The boundary-scan Test Access Port (TAP) is an IEEE standard that defines synchronous scanning test methods for complex logic circuits, such as boards containing a processor. The AMD-K6-2 processor supports the TAP standard defined in the *IEEE Standard Test Access Port and Boundary-Scan Architecture* (*IEEE 1149.1-1990*) specification.

Boundary scan testing uses a shift register consisting of the serial interconnection of boundary-scan cells that correspond to each I/O buffer of the processor. This non-inverting register chain, called a Boundary Scan Register (BSR), can be used to capture the state of every processor pin and to drive every processor output and bidirectional pin to a known state.

Each BSR of every component on a board that implements the boundary-scan architecture can be serially interconnected to enable component interconnect testing.

**Test Access Port** The TAP consists of the following:

- Test Access Port (TAP) Controller—The TAP controller is a synchronous, finite state machine that uses the TMS and TDI input signals to control a sequence of test operations. See "TAP Controller State Machine" on page 234 for a list of TAP states and their definition.
- Instruction Register (IR)—The IR contains the instructions that select the test operation to be performed and the Test Data Register (TDR) to be selected. See "TAP Registers" on page 226 for more details on the IR.
- Test Data Registers (TDR)—The three TDRs are used to process the test data. Each TDR is selected by an instruction in the Instruction Register (IR). See "TAP Registers" on page 226 for a list of these registers and their functions.

# **TAP Signals**The test signals associated with the TAP controller are as<br/>follows:

■ *TCK*—The Test Clock for all TAP operations. The rising edge of TCK is used for sampling TAP signals, and the falling edge of TCK is used for asserting TAP signals. The state of the TMS signal sampled on the rising edge of TCK causes

the state transitions of the TAP controller to occur. TCK can be stopped in the logic 0 or 1 state.

- *TDI*—The Test Data Input represents the input to the most significant bit of all TAP registers, including the IR and all test data registers. Test data and instructions are serially shifted by one bit into their respective registers on the rising edge of TCK.
- *TDO*—The Test Data Output represents the output of the least significant bit of all TAP registers, including the IR and all test data registers. Test data and instructions are serially shifted by one bit out of their respective registers on the falling edge of TCK.
- *TMS*—The Test Mode Select input specifies the test function and sequence of state changes for boundary-scan testing. If TMS is sampled High for five or more consecutive clocks, the TAP controller enters its reset state.
- TRST#—The Test Reset signal is an asynchronous reset that unconditionally causes the TAP controller to enter its reset state.

Refer to "Electrical Data" on page 255 and "Signal Switching Characteristics" on page 269 to obtain the electrical specifications of the test signals.

TAP RegistersThe AMD-K6-2 processor provides an Instruction Register (IR)<br/>and three Test Data Registers (TDR) to support the<br/>boundary-scan architecture. The IR and one of the TDRs—the<br/>Boundary-Scan Register (BSR)—consist of a shift register and<br/>an output register. The shift register is loaded in parallel in the<br/>Capture states. (See "TAP Controller State Machine" on page<br/>234 for a description of the TAP controller states.) In addition,<br/>the shift register is loaded and shifted serially in the Shift<br/>states. The output register is loaded in parallel from its<br/>corresponding shift register in the Update states.

**Instruction Register (IR).** The IR is a 5-bit register, without parity, that determines which instruction to run and which test data register to select. When the TAP controller enters the Capture-IR state, the processor loads the following bits into the IR shift register:

- 01b—Loaded into the two least significant bits, as specified by the IEEE 1149.1 standard
- 000b—Loaded into the three most significant bits

Loading 00001b into the IR shift register during the Capture-IR state results in loading the SAMPLE/PRELOAD instruction.

For each entry into the Shift-IR state, the IR shift register is serially shifted by one bit toward the TDO pin. During the shift, the most significant bit of the IR shift register is loaded from the TDI pin.

The IR output register is loaded from the IR shift register in the Update-IR state, and the current instruction is defined by the IR output register. See "TAP Instructions" on page 233 for a list and definition of the instructions supported by the AMD-K6-2 processor.

Boundary Scan Register (BSR). The BSR is a Test Data Register consisting of the interconnection of 152 boundary-scan cells. Each output and bidirectional pin of the processor requires a two-bit cell, where one bit corresponds to the pin and the other bit is the output enable for the pin. When a 0 is shifted into the enable bit of a cell, the corresponding pin is floated, and when a 1 is shifted into the enable bit, the pin is driven valid. Each input pin requires a one-bit cell that corresponds to the pin. The last cell of the BSR is reserved and does not correspond to any processor pin.

The total number of bits that comprise the BSR is 281. The order of the bits in the BSR differs between the Model 8/[7:0] and the Model 8/[F:8] processors. Table 47 on page 229 and Table 48 on page 231 list the order of these bits, respectively, where TDI is the input to bit 280, and TDO is driven from the output of bit 0. The entries listed as *pin\_E* (where *pin* is an output or bidirectional signal) are the enable bits.

If the BSR is the register selected by the current instruction and the TAP controller is in the Capture-DR state, the processor loads the BSR shift register as follows:

- If the current instruction is SAMPLE/PRELOAD, then the current state of each input, output, and bidirectional pin is loaded. A bidirectional pin is treated as an output if its enable bit equals 1, and it is treated as an input if its enable bit equals 0.
- If the current instruction is EXTEST, then the current state of each input pin is loaded. A bidirectional pin is treated as an input, regardless of the state of its enable.



While in the Shift-DR state, the BSR shift register is serially shifted toward the TDO pin. During the shift, bit 280 of the BSR is loaded from the TDI pin.

The BSR output register is loaded with the contents of the BSR shift register in the Update-DR state. If the current instruction is EXTEST, the processor's output pins, as well as those bidirectional pins that are enabled as outputs, are driven with their corresponding values from the BSR output register.

Bit	Pin/Enable										
280	D35_E	247	D21	214	D4_E	181	A3	148	A20	115	A16
279	D35	246	D18_E	213	D4	180	A31_E	147	A13_E	114	FERR_E
278	D29_E	245	D18	212	DP0_E	179	A31	146	A13	113	FERR#
277	D29	244	D19_E	211	DP0	178	A21_E	145	DP7_E	112	HIT_E
276	D33_E	243	D19	210	HOLD	177	A21	144	DP7	111	HIT#
275	D33	242	D16_E	209	BOFF#	176	A30_E	143	BE6_E	110	BE7_E
274	D27_E	241	D16	208	AHOLD	175	A30	142	BE6#	109	BE7#
273	D27	240	D17_E	207	STPCLK#	174	A7_E	141	A12_E	108	NA#
272	DP3_E	239	D17	206	INIT	173	A7	140	A12	107	ADSC_E
271	DP3	238	D15_E	205	IGNNE#	172	A24_E	139	CLK	106	ADSC#
270	D25_E	237	D15	204	BF1	171	A24	138	BE4_E	105	BE5_E
269	D25	236	DP1_E	203	BF2	170	A18_E	137	BE4#	104	BE5#
268	D0_E	235	DP1	202	RESET	169	A18	136	A10_E	103	WB/WT#
267	D0	234	D13_E	201	BF0	168	A5_E	135	A10	102	PWT_E
266	D30_E	233	D13	200	FLUSH#	167	A5	134	D63_E	101	PWT
265	D30	232	D6_E	199	INTR	166	A22_E	133	D63	100	BE3_E
264	DP2_E	231	D6	198	NMI	165	A22	132	BE2_E	99	BE3#
263	DP2	230	D14_E	197	SMI#	164	EADS#	131	BE2#	98	BREQ_E
262	D2_E	229	D14	196	A25_E	163	A4_E	130	A15_E	97	BREQ
261	D2	228	D11_E	195	A25	162	A4	129	A15	96	PCD_E
260	D28_E	227	D11	194	A23_E	161	HITM_E	128	BRDY#	95	PCD
259	D28	226	D1_E	193	A23	160	HITM#	127	BE1_E	94	WR_E
258	D24_E	225	D1	192	A26_E	159	A9_E	126	BE1#	93	W/R#
257	D24	224	D12_E	191	A26	158	A9	125	A14_E	92	SMIACT_E
256	D26_E	223	D12	190	A29_E	157	SCYC_E	124	A14	91	SMIACT#
255	D26	222	D10_E	189	A29	156	SCYC	123	BRDYC#	90	EWBE#
254	D22_E	221	D10	188	A28_E	155	A8_E	122	BEO_E	89	DC_E
253	D22	220	D7_E	187	A28	154	A8	121	BEO#	88	D/C#
252	D23_E	219	D7	186	A27_E	153	A19_E	120	A17_E	87	APCHK_E
251	D23	218	D8_E	185	A27	152	A19	119	A17	86	APCHK#
250	D20_E	217	D8	184	A11_E	151	A6_E	118	KEN#	85	CACHE_E
249	D20	216	D9_E	183	A11	150	A6	117	A20M#	84	CACHE#
248	D21_E	215	D9	182	A3_E	149	A20_E	116	A16_E	83	ADS_E

 Table 47.
 Boundary Scan Bit Definitions for Model 8/[7:0]

		,					- •	•			
Bit	Pin/Enable										
82	ADS#	68	DP6_E	54	D53_E	40	D43_E	26	D38_E	12	D3_E
81	AP_E	67	DP6	53	D53	39	D43	25	D38	11	D3
80	AP	66	D54_E	52	D47_E	38	D62_E	24	D58_E	10	D39_E
79	INV	65	D54	51	D47	37	D62	23	D58	9	D39
78	HLDA_E	64	D50_E	50	D59_E	36	D49_E	22	D42_E	8	D32_E
77	HLDA	63	D50	49	D59	35	D49	21	D42	7	D32
76	PCHK_E	62	D56_E	48	D51_E	34	DP4_E	20	D36_E	6	D5_E
75	PCHK#	61	D56	47	D51	33	DP4	19	D36	5	D5
74	LOCK_E	60	D55_E	46	D45_E	32	D46_E	18	D60_E	4	D37_E
73	LOCK#	59	D55	45	D45	31	D46	17	D60	3	D37
72	MIO_E	58	D48_E	44	D61_E	30	D41_E	16	D40_E	2	D31_E
71	M/IO#	57	D48	43	D61	29	D41	15	D40	1	D31
70	D52_E	56	D57_E	42	DP5_E	28	D44_E	14	D34_E	0	Reserved
69	D52	55	D57	41	DP5	27	D44	13	D34		

 Table 47.
 Boundary Scan Bit Definitions for Model 8/[7:0] (continued)

Bit	Pin/Enable										
280	D35_E	247	D19	214	BF1	181	A24	148	A14	115	BE7#
279	D35	246	D16_E	213	BF2	180	A18_E	147	A17_E	114	PCD_E
278	D29_E	245	D16	212	RESET	179	A18	146	A17	113	PCD
277	D29	244	D17_E	211	BF0	178	A5_E	145	A16_E	112	DC_E
276	D33_E	243	D17	210	FLUSH#	177	A5	144	A16	111	D/C#
275	D33	242	D15_E	209	INTR	176	EADS#	143	HIT_E	110	WR_E
274	D27_E	241	D15	208	NMI	175	A22_E	142	HIT#	109	W/R#
273	D27	240	DP1_E	207	SMI#	174	A22	141	ADS_E	108	NA#
272	DP0_E	239	DP1	206	A25_E	173	AHOLD	140	ADS#	107	PWT_E
271	DP0	238	D13_E	205	A25	172	HITM_E	139	CLK	106	PWT
270	DP3_E	237	D13	204	A26_E	171	HITM#	138	ADSC_E	105	CACHE_E
269	DP3	236	D6_E	203	A26	170	A4_E	137	ADSC#	104	CACHE#
268	D25_E	235	D6	202	A29_E	169	A4	136	BEO_E	103	WB/WT#
267	D25	234	D14_E	201	A29	168	A9_E	135	BEO#	102	MIO_E
266	D0_E	233	D14	200	A28_E	167	A9	134	AP_E	101	M/IO#
265	D0	232	D11_E	199	A28	166	A8_E	133	AP	100	BREQ_E
264	D30_E	231	D11	198	A23_E	165	A8	132	BE1_E	99	BREQ
263	D30	230	D1_E	197	A23	164	A19_E	131	BE1#	98	SCYC_E
262	DP2_E	229	D1	196	A27_E	163	A19	130	BE2_E	97	SCYC
261	DP2	228	D12_E	195	A27	162	BOFF#	129	BE2#	96	LOCK_E
260	D2_E	227	D12	194	A11_E	161	A6_E	128	BRDY#	95	LOCK#
259	D2	226	D10_E	193	A11	160	A6	127	BE3_E	94	APCHK_E
258	D28_E	225	D10	192	A3_E	159	A20_E	126	BE3#	93	APCHK#
257	D28	224	D7_E	191	A3	158	A20	125	BE4_E	92	PCHK_E
256	D24_E	223	D7	190	A31_E	157	A13_E	124	BE4#	91	PCHK#
255	D24	222	D8_E	189	A31	156	A13	123	BRDYC#	90	EWBE#
254	D26_E	221	D8	188	A21_E	155	A12_E	122	BE5_E	89	SMIACT_E
253	D26	220	D9_E	187	A21	154	A12	121	BE5#	88	SMIACT#
252	D21_E	219	D9	186	A30_E	153	A10_E	120	BE6_E	87	FERR_E
251	D21	218	HOLD	185	A30	152	A10	119	BE6#	86	FERR#
250	D18_E	217	STPCLK#	184	A7_E	151	A15_E	118	KEN#	85	D20_E
249	D18	216	INIT	183	A7	150	A15	117	INV	84	D20
248	D19_E	215	IGNNE#	182	A24_E	149	A14_E	116	BE7_E	83	D22_E

 Table 48.
 Boundary Scan Bit Definitions for Model 8/[F:8]

Bit	Pin/Enable										
82	D22	68	D54_E	54	D47_E	40	D62_E	26	D38_E	12	D3_E
81	D23_E	67	D54	53	D47	39	D62	25	D38	11	D3
80	D23	66	D50_E	52	D59_E	38	D49_E	24	D58_E	10	D39_E
79	A20M#	65	D50	51	D59	37	D49	23	D58	9	D39
78	HLDA_E	64	D56_E	50	D51_E	36	DP4_E	22	D42_E	8	D32_E
77	HLDA	63	D56	49	D51	35	DP4	21	D42	7	D32
76	DP7_E	62	D55_E	48	D45_E	34	D4_E	20	D36_E	6	D5_E
75	DP7	61	D55	47	D45	33	D4	19	D36	5	D5
74	D63_E	60	D48_E	46	D61_E	32	D46_E	18	D60_E	4	D37_E
73	D63	59	D48	45	D61	31	D46	17	D60	3	D37
72	D52_E	58	D57_E	44	DP5_E	30	D41_E	16	D40_E	2	D31_E
71	D52	57	D57	43	DP5	29	D41	15	D40	1	D31
70	DP6_E	56	D53_E	42	D43_E	28	D44_E	14	D34_E	0	Reserved
69	DP6	55	D53	41	D43	27	D44	13	D34		

Table 48.	Boundary	Scan Bit Definitions for	r Model 8/[F:8] (continued)
-----------	----------	--------------------------	-----------------------------

Device Identification Register (DIR). The DIR is a 32-bit Test Data Register selected during the execution of the IDCODE instruction. The fields of the DIR and their values are shown in Table 49 and are defined as follows:

- *Version Code*—This 4-bit field is incremented by AMD manufacturing for each major revision of silicon.
- *Part Number*—This 16-bit field identifies the specific processor model.
- Manufacturer—This 11-bit field identifies the manufacturer of the component (AMD).
- *LSB*—The least significant bit (LSB) of the DIR is always set to 1, as specified by the IEEE 1149.1 standard.

 Table 49.
 Device Identification Register

Version Code	Part Number	Manufacturer	LSB
(Bits 31–28)	(Bits 27–12)	(Bits 11–1)	(Bit 0)
Xh	0580h	0000000001b	1b

Bypass Register (BR). The BR is a Test Data Register consisting of a 1-bit shift register that provides the shortest path between TDI and TDO. When the processor is not involved in a test operation, the BR can be selected by an instruction to allow the transfer of test data through the processor without having to serially scan the test data through the BSR. This functionality preserves the state of the BSR and significantly reduces test time.

The BR register is selected by the BYPASS and HIGHZ instructions as well as by any instructions not supported by the AMD-K6-2 processor.

TAP InstructionsThe processor supports the three instructions required by the<br/>IEEE 1149.1 standard—EXTEST, SAMPLE/PRELOAD, and<br/>BYPASS—as well as two additional optional instructions—<br/>IDCODE and HIGHZ.

Table 50 shows the complete set of TAP instructions supported by the processor along with the 5-bit Instruction Register encoding and the register selected by each instruction.

Instruction	Encoding	Register	Description
EXTEST <sup>1</sup>	00000b	BSR	Sample inputs and drive outputs
SAMPLE / PRELOAD	00001b	BSR	Sample inputs and outputs, then load the BSR
IDCODE	00010b	DIR	Read DIR
HIGHZ	00011b	BR	Float outputs and bidirectional pins
BYPASS <sup>2</sup>	00100b-11110b	BR	Undefined instruction, execute the BYPASS instruction
BYPASS <sup>3</sup>	11111b	BR	Connect TDI to TDO to bypass the BSR

#### Table 50. Supported Tap Instructions

Notes:

1. Following the execution of the EXTEST instruction, the processor must be reset in order to return to normal, non-test operation.

2. These instruction encodings are undefined on the AMD-K6-2 processor and default to the BYPASS instruction.

3. Because the TDI input contains an internal pullup, the BYPASS instruction is executed if the TDI input is not connected or open during an instruction scan operation. The BYPASS instruction does not affect the normal operational state of the processor.

EXTEST. When the EXTEST instruction is executed, the processor loads the BSR shift register with the current state of the input and bidirectional pins in the Capture-DR state and drives the output and bidirectional pins with the corresponding values from the BSR output register in the Update-DR state.

**SAMPLE/PRELOAD**. The SAMPLE/PRELOAD instruction performs two functions. These functions are as follows:

- During the Capture-DR state, the processor loads the BSR shift register with the current state of every input, output, and bidirectional pin.
- During the Update-DR state, the BSR output register is loaded from the BSR shift register in preparation for the next EXTEST instruction.

The SAMPLE/PRELOAD instruction does not affect the normal operational state of the processor.

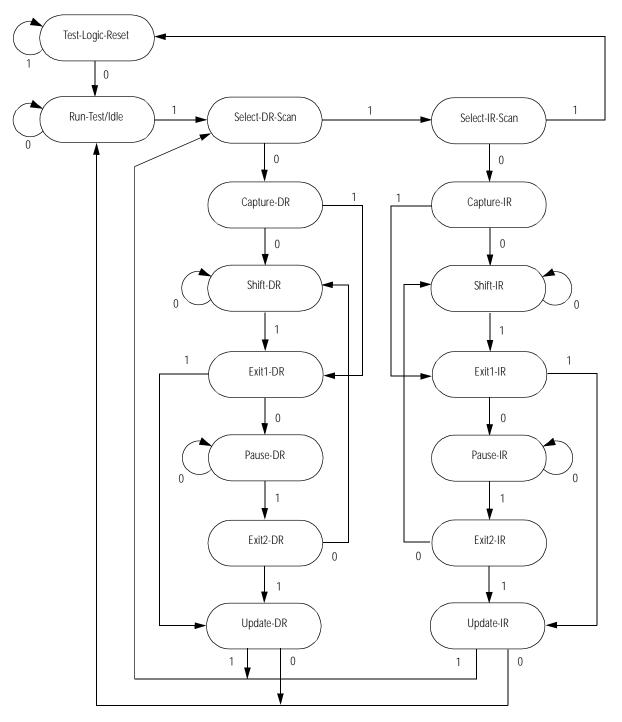
**BYPASS**. The BYPASS instruction selects the BR register, which reduces the boundary-scan length through the processor from 281 to one (TDI to BR to TDO). The BYPASS instruction does not affect the normal operational state of the processor.

**IDCODE**. The IDCODE instruction selects the DIR register, allowing the device identification code to be shifted out of the processor. This instruction is loaded into the IR when the TAP controller is reset. The IDCODE instruction does not affect the normal operational state of the processor.

HIGHZ. The HIGHZ instruction forces all output and bidirectional pins to be floated. During this instruction, the BR is selected and the normal operational state of the processor is not affected.

TAP Controller StateThe TAP controller state diagram is shown in Figure 86 on pageMachine235. State transitions occur on the rising edge of TCK. The logic0 or 1 next to the states represents the value of the TMS signal<br/>sampled by the processor on the rising edge of TCK.

DD



IEEE Std 1149.1-1990, Copyright © 1990. IEEE. All rights reserved

Figure 86. TAP State Diagram

The states of the TAP controller are described as follows:

Test-Logic-Reset. This state represents the initial reset state of the TAP controller and is entered when the processor samples RESET asserted, when TRST# is asynchronously asserted, and when TMS is sampled High for five or more consecutive clocks. In addition, this state can be entered from the Select-IR-Scan state. The IR is initialized with the IDCODE instruction, and the processor's normal operation is not affected in this state.

**Capture-DR**. During the SAMPLE/PRELOAD instruction, the processor loads the BSR shift register with the current state of every input, output, and bidirectional pin. During the EXTEST instruction, the processor loads the BSR shift register with the current state of every input and bidirectional pin.

**Capture-IR**. When the TAP controller enters the Capture-IR state, the processor loads 01b into the two least significant bits of the IR shift register and loads 000b into the three most significant bits of the IR shift register.

Shift-DR. While in the Shift-DR state, the selected TDR shift register is serially shifted toward the TDO pin. During the shift, the most significant bit of the TDR is loaded from the TDI pin.

Shift-IR. While in the Shift-IR state, the IR shift register is serially shifted toward the TDO pin. During the shift, the most significant bit of the IR is loaded from the TDI pin.

**Update-DR**. During the SAMPLE/PRELOAD instruction, the BSR output register is loaded with the contents of the BSR shift register. During the EXTEST instruction, the output pins, as well as those bidirectional pins defined as outputs, are driven with their corresponding values from the BSR output register.

**Update-IR**. In this state, the IR output register is loaded from the IR shift register, and the current instruction is defined by the IR output register.

The following states have no effect on the normal or test operation of the processor other than as shown in Figure 86 on page 235:

- Run-Test/Idle—This state is an idle state between scan operations.
- Select-DR-Scan—This is the initial state of the test data register state transitions.
- Select-IR-Scan—This is the initial state of the Instruction Register state transitions.
- Exit1-DR—This state is entered to terminate the shifting process and enter the Update-DR state.
- Exit1-IR—This state is entered to terminate the shifting process and enter the Update-IR state.
- Pause-DR—This state is entered to temporarily stop the shifting process of a Test Data Register.
- Pause-IR—This state is entered to temporarily stop the shifting process of the Instruction Register.
- Exit2-DR—This state is entered in order to either terminate the shifting process and enter the Update-DR state or to resume shifting following the exit from the Pause-DR state.
- Exit2-IR—This state is entered in order to either terminate the shifting process and enter the Update-IR state or to resume shifting following the exit from the Pause-IR state.

# 11.4 L1 Cache Inhibit

#### Purpose

The AMD-K6-2 processor provides a means for inhibiting the normal operation of its L1 instruction and data caches while still supporting an external cache. This capability allows system designers to disable the L1 cache during the testing and debug of an external cache.

If the Cache Inhibit bit (bit 3) of Test Register 12 (TR12) is set to 0, the processor's L1 cache is enabled and operates as described in "Cache Organization" on page 181. If the Cache Inhibit bit is set to 1, the L1 cache is disabled and no new cache lines are allocated. Even though new allocations do not occur, valid L1 cache lines remain valid and are read by the processor when a requested address hits a cache line. In addition, the processor continues to support inquire cycles initiated by the

system logic, including the execution of writeback cycles when a modified cache line is hit.

While the L1 is inhibited, the processor continues to drive the PCD output signal appropriately, which system logic can use to control external caching.

In order to completely disable the L1 cache so no valid lines exist in the cache, the Cache Inhibit bit must be set to 1 and the cache must be flushed in one of the following ways:

- Asserting the FLUSH# input signal
- Executing the WBINVD instruction
- Executing the INVD instruction (modified cache lines are not written back to memory)
- Make use of the Page Flush/Invalidate Register (PFIR) (AMD-K6-2/[F:8] only)(see "PFIR" on page 197)

# 11.5 Debug

The AMD-K6-2 processor implements the standard x86 debug functions, registers, and exceptions. In addition, the processor supports the I/O breakpoint debug extension. The debug feature assists programmers and system designers during software execution tracing by generating exceptions when one or more events occur during processor execution. The exception handler, or debugger, can be written to perform various tasks, such as displaying the conditions that caused the breakpoint to occur, displaying and modifying register or memory contents, or single-stepping through program execution.

The following sections describe the debug registers and the various types of breakpoints and exceptions that the processor supports.

# **Debug Registers** Figures 87 through 90 show the 32-bit debug registers supported by the processor.

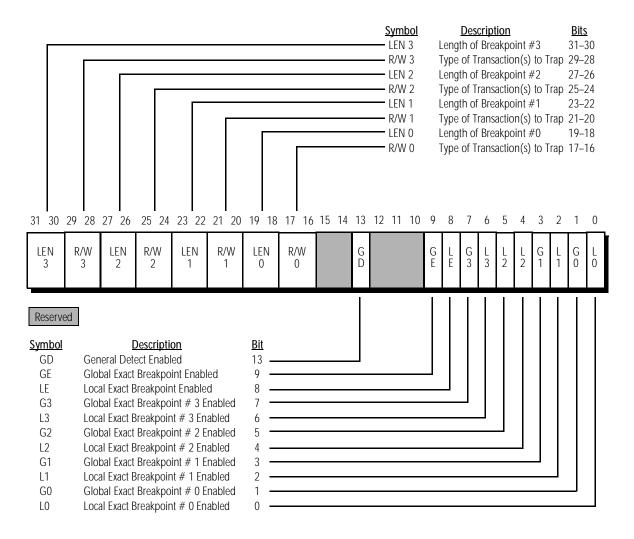
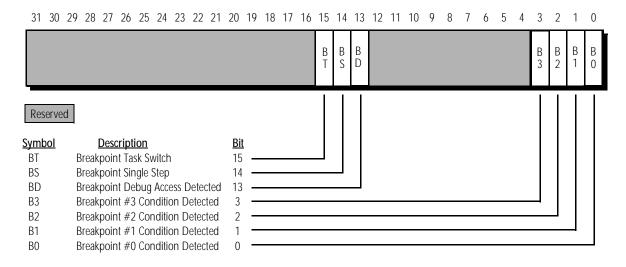


Figure 87. Debug Register DR7

AMD-K6<sup>®</sup>-2 Processor Data Sheet



#### Figure 88. Debug Register DR6

DR5

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Reserved

#### DR4

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Reserved

#### Figure 89. Debug Registers DR5 and DR4

DR3

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 3 32-bit Linear Address

DR2

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 2 32-bit Linear Address

DR1

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

Breakpoint 1 32-bit Linear Address

DR0

31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0 Breakpoint 0 32-bit Linear Address

#### Figure 90. Debug Registers DR3, DR2, DR1, and DR0

DR3-DR0. The processor allows the setting of up to four breakpoints. DR3-DR0 contain the linear addresses for breakpoint 3 through breakpoint 0, respectively, and are compared to the linear addresses of processor cycles to determine if a breakpoint occurs. Debug register DR7 defines the specific type of cycle that must occur in order for the breakpoint to occur.

**DR5–DR4**. When debugging extensions are disabled (bit 3 of CR4 is set to 0), the DR5 and DR4 registers are mapped to DR7 and DR6, respectively, in order to be software compatible with previous generations of x86 processors. When debugging

extensions are enabled (bit 3 of CR4 is set to 1), any attempt to load DR5 or DR4 results in an undefined opcode exception. Likewise, any attempt to store DR5 or DR4 also results in an undefined opcode exception.

DR6. If a breakpoint is enabled in DR7, and the breakpoint conditions as defined in DR7 occur, then the corresponding B-bit (B3-B0) in DR6 is set to 1. In addition, any other breakpoints defined using these particular breakpoint conditions are reported by the processor by setting the appropriate B-bits in DR6, regardless of whether these breakpoints are enabled or disabled. However, if a breakpoint is not enabled, a debug exception does not occur for that breakpoint.

If the processor decodes an instruction that writes or reads DR7 through DR0, the BD bit (bit 13) in DR6 is set to 1 (if enabled in DR7) and the processor generates a debug exception. This operation allows control to pass to the debugger prior to debug register access by software.

If the Trap Flag (bit 8) of the EFLAGS register is set to 1, the processor generates a debug exception after the successful execution of every instruction (single-step operation) and sets the BS bit (bit 14) in DR6 to indicate the source of the exception.

When the processor switches to a new task and the debug trap bit (T-bit) in the corresponding Task State Segment (TSS) is set to 1, the processor sets the BT bit (bit 15) in DR6 and generates a debug exception.

DR7. When set to 1, L3–L0 locally enable breakpoints 3 through 0, respectively. L3–L0 are set to 0 whenever the processor executes a task switch. Setting L3–L0 to 0 disables the breakpoints and ensures that these particular debug exceptions are only generated for a specific task.

When set to 1, G3–G0 globally enable breakpoints 3 through 0, respectively. Unlike L3–L0, G3–G0 are not set to 0 whenever the processor executes a task switch. Not setting G3–G0 to 0 allows breakpoints to remain enabled across all tasks. If a breakpoint is enabled globally but disabled locally, the global enable overrides the local enable.

The LE (bit 8) and GE (bit 9) bits in DR7 have no effect on the operation of the processor and are provided in order to be software compatible with previous generations of x86 processors.

When set to 1, the GD bit in DR7 (bit 13) enables the debug exception associated with the BD bit (bit 13) in DR6. This bit is set to 0 when a debug exception is generated.

LEN3-LEN0 and RW3-RW0 are two-bit fields in DR7 that specify the length and type of each breakpoint as defined in Table 51.

LEN Bits <sup>1</sup>	RW Bits	Breakpoint		
00b	00b <sup>2</sup>	Instruction Execution		
00b		One-byte Data Write		
01b	01b	Two-byte Data Write		
11b		Four-byte Data Write		
00b		One-byte I/O Read or Write		
01b	10b <sup>3</sup>	Two-byte I/O Read or Write		
11b		Four-byte I/O Read or Write		
00b		One-byte Data Read or Write		
01b	11b	Two-byte Data Read or Write		
11b		Four-byte Data Read or Write		
Notes:	•	•		

Table 51. DR7 LEN and RW Definitions

1. LEN bits equal to 10b is undefined.

2. When RW equals 00b, LEN must be equal to 00b.

3. When RW equals 10b, debugging extensions (DE) must be enabled (bit 3 of CR4 must be set to 1). If DE is set to 0, then RW equal to 10b is undefined.

#### **Debug Exceptions**

A debug exception is categorized as either a debug trap or a debug fault. A debug trap calls the debugger following the execution of the instruction that caused the trap. A debug fault calls the debugger prior to the execution of the instruction that caused the fault. All debug traps and faults generate either an Interrupt 01h or an Interrupt 03h exception.

- Enabled breakpoints for data and I/O cycles
- Single Step Trap

exception:

Task Switch Trap

The following events are considered debug faults that cause the processor to generate an Interrupt 01h exception:

- Enabled breakpoints for instruction execution
- **BD** bit in DR6 set to 1

**Interrupt 03h.** The INT 3 instruction is defined in the x86 architecture as a breakpoint instruction. This instruction causes the processor to generate an Interrupt 03h exception. This exception is a debug trap because the debugger is called following the execution of the INT 3 instruction.

The INT 3 instruction is a one-byte instruction (opcode CCh) typically used to insert a breakpoint in software by writing CCh to the address of the first byte of the instruction to be trapped (the target instruction). Following the trap, if the target instruction is to be executed, the debugger must replace the INT 3 instruction with the first byte of the target instruction.

# 12 Clock Control

The AMD-K6-2 processor supports five modes of clock control. The processor can transition between these modes to maximize performance, to minimize power dissipation, or to provide a balance between performance and power. (See "Power Dissipation" on page 259 for the maximum power dissipation of the AMD-K6-2 processor within the normal and reduced-power states.)

The five clock-control states supported are as follows:

- Normal State: The processor is running in Real Mode, Virtual-8086 Mode, Protected Mode, or System Management Mode (SMM). In this state, all clocks are running—including the external bus clock CLK and the internal processor clock—and the full features and functions of the processor are available.
- Halt State: This low-power state is entered following the successful execution of the HLT instruction. During this state, the internal processor clock is stopped.
- Stop Grant State: This low-power state is entered following the recognition of the assertion of the STPCLK# signal. During this state, the internal processor clock is stopped.
- **Stop Grant Inquire State**: This state is entered from the Halt state and the Stop Grant state as the result of a system-initiated inquire cycle.
- **Stop Clock State**: This low-power state is entered from the Stop Grant state when the CLK signal is stopped.

The following sections describe each of the four low-power states. Figure 91 on page 250 illustrates the clock control state transitions.

21850J/0-February 2000

# AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 12.1 Halt State

#### Enter Halt State

During the execution of the HLT instruction, the AMD-K6-2 processor executes a Halt special cycle. After BRDY# is sampled asserted during this cycle, and then EWBE# is also sampled asserted (if not masked off), the processor enters the Halt state in which the processor disables most of its internal clock distribution. In order to support the following operations, the internal phase-lock loop (PLL) still runs, and some internal resources are still clocked in the Halt state:

- Inquire Cycles: The processor continues to sample AHOLD, BOFF#, and HOLD in order to support inquire cycles that are initiated by the system logic. The processor transitions to the Stop Grant Inquire state during the inquire cycle. After returning to the Halt state following the inquire cycle, the processor does not execute another Halt special cycle.
- Flush Cycles: The processor continues to sample FLUSH#. If FLUSH# is sampled asserted, the processor performs the flush operation in the same manner as it is performed in the Normal state. Upon completing the flush operation, the processor executes the Halt special cycle which indicates the processor is in the Halt state.
- Time Stamp Counter (TSC): The TSC continues to count in the Halt state.
- Signal Sampling: The processor continues to sample INIT, INTR, NMI, RESET, and SMI#.

After entering the Halt state, all signals driven by the processor retain their state as they existed following the completion of the Halt special cycle.

# **Exit Halt State** The AMD-K6-2 processor remains in the Halt state until it samples INIT, INTR (if interrupts are enabled), NMI, RESET, or SMI# asserted. If any of these signals is sampled asserted, the processor returns to the Normal state and performs the corresponding operation. All of the normal requirements for recognition of these input signals apply within the Halt state.

# **12.2 Stop Grant State**

**Enter Stop Grant** After recognizing the assertion of STPCLK#, the AMD-K6-2 State processor flushes its instruction pipelines, completes all pending and in-progress bus cycles, and acknowledges the STPCLK# assertion by executing a Stop Grant special bus cycle. After BRDY# is sampled asserted during this cycle, and then EWBE# is also sampled asserted (if not masked off), the processor enters the Stop Grant state. The Stop Grant state is like the Halt state in that the processor disables most of its internal clock distribution in the Stop Grant state. In order to support the following operations, the internal PLL still runs, and some internal resources are still clocked in the Stop Grant state: Inquire cycles: The processor transitions to the Stop Grant Inquire state during an inquire cycle. After returning to the Stop Grant state following the inquire cycle, the processor does not execute another Stop Grant special cycle. Time Stamp Counter (TSC): The TSC continues to count in the Stop Grant state. Signal Sampling: The processor continues to sample INIT, INTR, NMI, RESET, and SMI#. FLUSH# is not recognized in the Stop Grant state (unlike while in the Halt state). Upon entering the Stop Grant state, all signals driven by the processor retain their state as they existed following the completion of the Stop Grant special cycle. **Exit Stop Grant State** The AMD-K6-2 processor remains in the Stop Grant state until it samples STPCLK# negated or RESET asserted. If STPCLK# is sampled negated, the processor returns to the Normal state in less than 10 bus clock (CLK) periods. After the transition to the Normal state, the processor resumes execution at the instruction boundary on which STPCLK# was initially recognized. If STPCLK# is recognized as negated in the Stop Grant state and subsequently sampled asserted prior to returning to the

and subsequently sampled asserted prior to returning to the Normal state, the AMD-K6-2 processor guarantees that a minimum of one instruction is executed prior to re-entering the Stop Grant state.

If INIT, INTR (if interrupts are enabled), FLUSH#, NMI, or SMI# are sampled asserted in the Stop Grant state, the processor latches the edge-sensitive signals (INIT, FLUSH#, NMI, and SMI#), but otherwise does not exit the Stop Grant state to service the interrupt. When the processor returns to the Normal state due to sampling STPCLK# negated, any pending interrupts are recognized after returning to the Normal state. To ensure their recognition, all of the normal requirements for these input signals apply within the Stop Grant state.

If RESET is sampled asserted in the Stop Grant state, the processor immediately returns to the Normal state and the reset process begins.

# **12.3** Stop Grant Inquire State

Enter Stop GrantThe Stop Grant Inquire state is entered from the Stop GrantInquire StateThe Stop Grant Inquire state is entered from the Stop Grantstate or the Halt state when EADS# is sampled asserted during<br/>an inquire cycle initiated by the system logic. The AMD-K6-2<br/>processor responds to an inquire cycle in the same manner as in<br/>the Normal state by driving HIT# and HITM#. If the inquire<br/>cycle hits a modified data cache line, the processor performs a<br/>writeback cycle.

Exit Stop GrantFollowing the completion of any writeback, the processorInquire Statereturns to the state from which it entered the Stop GrantInquire state.Inquire state.

# **12.4 Stop Clock State**

Enter Stop ClockIf the CLK signal is stopped while the AMD-K6-2 processor is in<br/>the Stop Grant state, the processor enters the Stop Clock state.<br/>Because all internal clocks and the PLL are not running in the<br/>Stop Clock state, the Stop Clock state represents the<br/>minimum-power state of all clock control states. The CLK signal<br/>must be held Low while it is stopped.

The Stop Clock state cannot be entered from the Halt state.

INTR is the only input signal that is allowed to change states while the processor is in the Stop Clock state. However, INTR is not sampled until the processor returns to the Stop Grant state. All other input signals must remain unchanged in the Stop Clock state. 21850J/0-February 2000

**Exit Stop Clock State** The AMD-K6-2 processor returns to the Stop Grant state from the Stop Clock state after the CLK signal is started and the internal PLL has stabilized. PLL stabilization is achieved after the CLK signal has been running within its specification for a minimum of 1.0 ms.

The frequency of CLK when exiting the Stop Clock state can be different than the frequency of CLK when entering the Stop Clock state.

The state of the BF[2:0] signals when exiting the Stop Clock state is ignored because the BF[2:0] signals are only sampled during the falling transition of RESET.

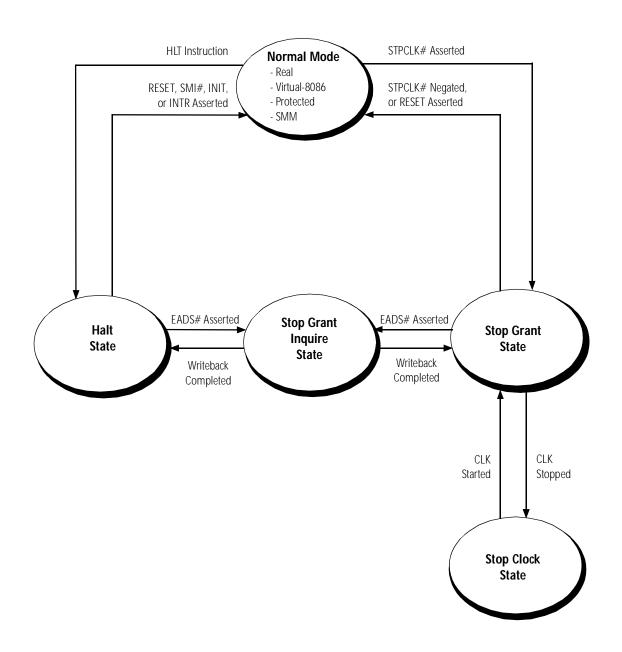


Figure 91. Clock Control State Transitions

# 13 Power and Grounding

### **13.1 Power Connections**

The AMD-K6-2 processor is a dual voltage device. Two separate supply voltages are required:  $V_{CC2}$  and  $V_{CC3}.$   $V_{CC2}$  provides the core voltage for the processor and  $V_{CC3}$  provides the I/O voltage. See "Electrical Data" on page 255 for the value and range of  $V_{CC2}$  and  $V_{CC3}$ .

There are 28  $V_{CC2},$  32  $V_{CC3},$  and 68  $V_{SS}$  pins on the AMD-K6-2 processor. (See "Pin Designations" on page 299 for all power and ground pin designations.) The large number of power and ground pins are provided to ensure that the processor and package maintain a clean and stable power distribution network.

For proper operation and functionality, all  $V_{CC2}$ ,  $V_{CC3}$ , and  $V_{SS}$  pins must be connected to the appropriate planes in the circuit board. The power planes have been arranged in a pattern to simplify routing and minimize crosstalk on the circuit board. The isolation region between two voltage planes must be at least 0.254mm if they are in the same layer of the circuit board. (See Figure 92 on page 252.) In order to maintain a low-impedance current sink and reference, the ground plane must never be split.

Although the AMD-K6-2 processor has two separate supply voltages, there are no special power sequencing requirements. The best procedure is to minimize the time between which  $V_{CC2}$  and  $V_{CC3}$  are either both on or both off.

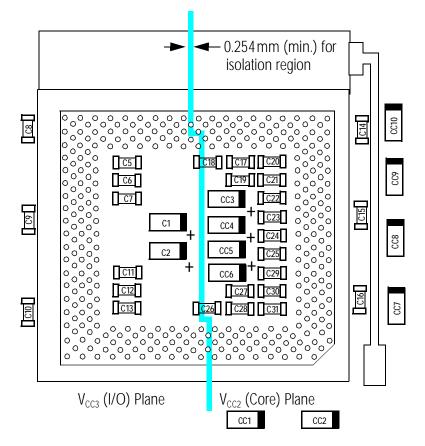


Figure 92. Suggested Component Placement

# **13.2 Decoupling Recommendations**

In addition to the isolation region mentioned in "Power Connections" on page 251, adequate decoupling capacitance is required between the two system power planes and the ground plane to minimize ringing and to provide a low-impedance path for return currents. Suggested decoupling capacitor placement is shown in Figure 92.

Surface mounted capacitors should be used under the processor's ZIF socket to minimize resistance and inductance in the lead lengths while maintaining minimal height. For information and recommendations about the specific value, quantity, and location of the capacitors, see the AMD-K6<sup>®</sup> Processor Power Supply Design Application Note, order# 21103.

## **13.3 Pin Connection Requirements**

For proper operation, the following requirements for signal pin connections must be met:

- Do not drive address and data signals into large capacitive loads at high frequencies. If necessary, use buffer chips to drive large capacitive loads.
- Leave all NC (no-connect) pins unconnected.
- Unused inputs should always be connected to an appropriate signal level.
  - Active Low inputs that are not being used should be connected to  $V_{CC3}$  through a 20-kohm pullup resistor.
  - Active High inputs that are not being used should be connected to GND through a pulldown resistor.
- Reserved signals can be treated in one of the following ways:
  - As no-connect (NC) pins, in which case these pins are left unconnected
  - As pins connected to the system logic as defined by the industry-standard Super7 and Socket 7 interface
  - Any combination of NC and Socket 7 pins
- Keep trace lengths to a minimum.

# 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

#### **Electrical Data** 14

This chapter consists of two sections, where each section provides the electrical specifications of the AMD-K6-2 processor based on specific Ordering Part Number (OPN) suffixes. See "Ordering Information" on page 303 for a complete list and description of the valid OPN combinations.

#### 14.1 Electrical Data for OPN Suffixes AHX, 400AFQ, and AFR

The electrical specifications provided in this section pertain to the following OPNs:

AMD-K6-2/475AHX AMD-K6-2/450AHX

- AMD-K6-2/400AFQ
- AMD-K6-2/380AFR AMD-K6-2/366AFR
- AMD-K6-2/350AFR
- AMD-K6-2/333AFR AMD-K6-2/300AFR
- AMD-K6-2/266AFR

Note: The electrical specifications for the AMD-K6-2/400AFR OPN are provided in "Electrical Data for OPN Suffixes AGR, AFX, and 400AFR" on page 260.

**Operating Ranges** The AMD-K6-2 processor is designed to provide functional operation if the voltage and temperature parameters are within the limits defined in Table 52.

Parameter	Minimum	Typical	Maximum	Comments			
V <sub>CC2</sub>	2.1 V	2.2 V	2.3 V	Note 1, 2			
VCC2	2.3 V	2.4 V	2.5 V	Note 1, 3			
V <sub>CC3</sub>	V <sub>CC3</sub> 3.135 V 3.30 V 3.6 V						
			70°C	Note 4			
T <sub>CASE</sub>	0°C		65°C	Note 5			
			60°C	Note 6			
Notes:	•	•	•				
1. V <sub>CC2</sub> and	V <sub>CC3</sub> are referenced f	from V <sub>SS</sub> .					
2. V <sub>CC2</sub> speci	2. $V_{CC2}$ specification for 2.2 V component.						
3. V <sub>CC2</sub> speci	002						
<ol> <li>Case temperature range required for AMD-K6-2/xxxAFR valid ordering part number combinations, where "xxx" represents the processor core frequency.</li> </ol>							
5. Case temp	perature range req	uired for AMD-K6-2	2/xxxAHX valid orde	ering part number			

Table 52. Operating Ranges for OPN Suffixes AHX, 400AFQ, and AFR

- combinations, where "xxx" represents the processor core frequency.
- Case temperature range required for AMD-K6-2/xxxAFQ valid ordering part number 6 combinations, where "xxx" represents the processor core frequency.

#### **Absolute Ratings** The AMD-K6-2 processor is not designed to be operated beyond the operating ranges listed in Table 52. Exposure to conditions outside these operating ranges for extended periods of time can affect long-term reliability. Permanent damage can occur if the absolute ratings listed in Table 53 are exceeded.

Parameter	Minimum	Maximum	Comments				
V <sub>CC2</sub>	–0.5 V	2.6 V					
V <sub>CC3</sub>	–0.5 V	3.6 V					
V <sub>PIN</sub>	–0.5 V	$\begin{array}{l} \mbox{V}_{\mbox{CC3}}\mbox{+}0.5\mbox{ V}\mbox{ and}\\ \leq 4.0\mbox{ V} \end{array}$	Note				
T <sub>CASE</sub> (under bias)	–65°C	+110°C					
T <sub>STORAGE</sub>							
<i>Note:</i> <i>V</i> <sub>PIN</sub> (the voltage on any I/O pin) must not be greater than 0.5 V above the voltage being							

Table 53. Absolute Ratings for OPN Suffixes AHX, 400AFQ, and AFR

applied to  $V_{CC3}$ . In addition, the  $V_{PIN}$  voltage must never exceed 4.0 V.

#### **DC Characteristics** The DC characteristics of the AMD-K6-2 processor are shown in Table 54.

Iddle 34. DC Characteristics for OPIN Suffixes ARA, 400APQ, and APK	Table 54.	DC Characteristics for OPN Suffixes AHX, 400AFQ, and AFR
---	-----------	--

Symbol	Paramotor Description	Prelin	ninary Data	Comments	
Symbol	Parameter Description	Min	Мах	comments	
V <sub>IL</sub>	Input Low Voltage	–0.3 V	+0.8 V		
V <sub>IH</sub>	Input High Voltage	2.0 V	V <sub>CC3</sub> +0.3V	Note 1	
V <sub>OL</sub>	Output Low Voltage		0.4 V	I <sub>OL</sub> = 4.0-mA load	
V <sub>OH</sub>	Output High Voltage	2.4 V		I <sub>OH</sub> = 3.0-mA load	

Notes:

 $V_{CC3}$  refers to the voltage being applied to  $V_{CC3}$  during functional operation. 1.

 $V_{CC2} = 2.3 \text{ V}$  – The maximum power supply current must be taken into account when designing a power supply. 2.

3.  $V_{CC2} = 2.5 V - The maximum power supply current must be taken into account when designing a power supply.$ 

4.  $V_{CC3} = 3.6 V - The maximum power supply current must be taken into account when designing a power supply.$ 

5. Refers to inputs and I/O without an internal pullup resistor and  $0 \le V_{IN} \le V_{CC3}$ 

6. Refers to inputs with an internal pullup and  $V_{II} = 0.4 V$ .

7. Refers to inputs with an internal pulldown and  $V_{IH} = 2.4$  V.

8. This specification applies to components using a CLK frequency of 66 MHz.

9. This specification applies to components using a CLK frequency of 95 MHz.

Symbol	Decemptor Description	Prelir	ninary Data	Commonto	
Symbol	Parameter Description	Min	Мах	- Comments	
			7.35 A	266 MHz, Note 2, 8	
I <sub>CC2</sub>			8.45 A	300 MHz, Note 2, 8, 10	
			9.40 A	333 MHz, Note 2, 8, 9	
	2.2 V Power Supply Current		9.85 A	350 MHz, Note 2, 10	
			10.30 A	366 MHz, Note 2, 8	
			10.70 A	380 MHz, Note 2, 9	
			11.25 A	400 MHz, Note 2, 8, 10	
	2.4 V Power Supply Current		12.50 A	450 MHz, Note 3, 10	
	2.4 v Power Supply Current		13.00 A	475 MHz, Note 3, 9	
			0.54 A	266 MHz, Note 4, 8	
			0.56 A	300 MHz, Note 4, 8, 10	
			0.58 A	333 MHz, Note 4, 8, 9	
			0.60 A	350 MHz, Note 4, 10	
I <sub>CC3</sub>	3.3 V Power Supply Current		0.60 A	366 MHz, Note 4, 8	
			0.61 A	380 MHz, Note 4, 9	
			0.62 A	400 MHz, Note 4, 8, 10	
			0.66 A	450 MHz, Note 4, 10	
			0.67 A	475 MHz, Note 4, 9	
Ι <sub>LI</sub>	Input Leakage Current		±15 μA	Note 5	
I <sub>LO</sub>	Output Leakage Current		±15 μA	Note 5	
I <sub>IL</sub>	Input Leakage Current Bias with Pullup		–400 μA	Note 6	
I <sub>IH</sub>	Input Leakage Current Bias with Pulldown		200 µA	Note 7	
C <sub>IN</sub>	Input Capacitance		10 pF		
C <sub>OUT</sub>	Output Capacitance		15 pF		

#### Table 54. DC Characteristics for OPN Suffixes AHX, 400AFQ, and AFR (continued)

Notes:

1.  $V_{CC3}$  refers to the voltage being applied to  $V_{CC3}$  during functional operation.

2.  $V_{CC2} = 2.3 V - The maximum power supply current must be taken into account when designing a power supply.$ 

3.  $V_{CC2} = 2.5 V - The maximum power supply current must be taken into account when designing a power supply.$ 

4.  $V_{CC3} = 3.6 V - The maximum power supply current must be taken into account when designing a power supply.$ 

5. Refers to inputs and I/O without an internal pullup resistor and  $0 \le V_{IN} \le V_{CC3}$ .

6. Refers to inputs with an internal pullup and  $V_{IL} = 0.4 V$ .

7. Refers to inputs with an internal pulldown and  $V_{IH} = 2.4 V$ .

8. This specification applies to components using a CLK frequency of 66 MHz.

9. This specification applies to components using a CLK frequency of 95 MHz.

#### Table 54. DC Characteristics for OPN Suffixes AHX, 400AFQ, and AFR (continued)

9. This specification applies to components using a CLK frequency of 95 MHz.

# **Power Dissipation** Table 55 contains the typical and maximum power dissipation of the AMD-K6-2 processor during normal and reduced power states.

Table 55. Typical and Maximum Power Dissipation for OPN Suffixes AHX, 400AFQ, and AFR

Clock Control State	266 MHz <sup>6</sup>	300 MHz <sup>6,8</sup>	333 MHz <sup>6,7</sup>	350 MHz <sup>8</sup>	366 MHz <sup>6</sup>	380 MHz <sup>7</sup>	400 MHz <sup>6,8</sup>	450 MHz <sup>8</sup>	475 MHz <sup>7</sup>	Notes
Thermal Power (Maximum)	14.70 W	17.20 W	19.00 W	19.95 W	20.80 W	21.60 W	22.70 W	28.40 W	29.60 W	1, 2
Thermal Power (Typical)	8.85 W	10.35 W	11.40 W	11.98 W	12.48 W	12.95 W	13.65 W	17.05 W	17.75 W	3
Stop Grant / Halt (Maximum)	3.90 W	3.92 W	3.94 W	3.96 W	3.96 W	3.97 W	3.98 W	6.50 W	6.51 W	4
Stop Clock (Maximum)	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	6.00 W	6.00 W	5

Notes:

1. The maximum power dissipated in the normal clock control state must be taken into account when designing a solution for thermal dissipation for the AMD-K6-2 processor.

2. Maximum power is determined for the worst-case instruction sequence or function for the listed clock control states with  $V_{CC2} = 2.2 V$  (for the 2.2 V component) or  $V_{CC2} = 2.4 V$  (for the 2.4 V component) and  $V_{CC3} = 3.3 V$ .

3. Typical power is determined for the typical instruction sequences or functions associated with normal system operation with  $V_{CC2} = 2.2 V$  (for the 2.2 V component) or  $V_{CC2} = 2.4 V$  (for the 2.4 V component) and  $V_{CC3} = 3.3 V$ .

4. The CLK signal and the internal PLL are still running but most internal clocking has stopped.

5. The CLK signal, the internal PLL, and all internal clocking has stopped.

6. This specification applies to components using a CLK frequency of 66 MHz.

7. This specification applies to components using a CLK frequency of 95 MHz.

# AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 14.2 Electrical Data for OPN Suffixes AGR, AFX, and 400AFR

The electrical specifications provided in this section pertain to the following OPNs:

	AMD-K6-2/550AGR		AMD-K6-2/533AFX		AMD-K6-2/500AFX
--	-----------------	--	-----------------	--	-----------------

AMD-K6-2/475AFX ■ AMD-K6-2/450AFX ■ AMD-K6-2/400AFR

**Note:** The electrical specifications for all frequencies of the OPN suffix AFR other than 400 MHz are provided in "Electrical Data for OPN Suffixes AHX, 400AFQ, and AFR" on page 255.

**Operating Ranges** The AMD-K6-2 processor is designed to provide functional operation if the voltage and temperature parameters are within the limits defined in Table 56.

Table 56. Operating Ranges for OPN Suffixes AGR, AFX, and 400AFR

Parameter	Minimum	Typical	Maximum	Comments		
V <sub>CC2</sub> 2.1 V 2.2 V 2.3 V Note						
V <sub>CC2</sub> 2.2 V 2.3 V 2.4 V Not						
V <sub>CC3</sub> 3.135 V 3.30 V 3.6 V Note						
T <sub>CASE</sub> 0°C 70°C						
T <sub>CASE</sub>	Note 5					
Notes:         1.       V <sub>CC2</sub> and V <sub>CC3</sub> are referenced from V <sub>SS</sub> 2.       V <sub>CC2</sub> specification for 2.2 V components.         3.       V <sub>CC2</sub> specification for 2.3 V components.         4.       Case temperature range required for AMD-K6-2/550AGR and AMD-K6-2/400AFR ordering part numbers.         5.       Case temperature range required for AMD-K6-2/xxxAHX valid ordering part number						

#### The AMD-K6-2 processor is not designed to be operated beyond **Absolute Ratings** the operating ranges listed in Table 56. Exposure to conditions outside these operating ranges for extended periods of time can affect long-term reliability. Permanent damage can occur if the absolute ratings listed in Table 57 are exceeded.

Parameter	Minimum	Maximum	Comments				
V <sub>CC2</sub>	–0.5 V	2.5 V					
V <sub>CC3</sub>	–0.5 V	3.6 V					
V <sub>PIN</sub>	–0.5 V	$V_{CC3}$ + 0.5 V and $\leq$ 4.0 V	Note				
T <sub>CASE</sub> (under bias)	–65°C	+110°C					
T <sub>STORAGE</sub>	–65°C	+150°C					
<i>Note:</i> <i>V<sub>PIN</sub> (the voltage on any I/O pin) must not be greater than 0.5 V above the voltage being</i>							

Table 57. Absolute Ratings for OPN Suffixes AGR, AFX, and 400AFR

applied to  $V_{CC3}$ . In addition, the  $V_{PIN}$  voltage must never exceed 4.0 V.

#### **DC Characteristics** The DC characteristics of the AMD-K6-2 processor are shown in Table 58.

Table 58. DC Characteristics for OPN Suffixes AGR, AFX, and 400AFR

Symbol	Parameter Description	Prelin	ninary Data	Comments	
	Parameter Description	Min	Мах	comments	
V <sub>IL</sub>	Input Low Voltage	–0.3 V	+0.8 V		
V <sub>IH</sub>	Input High Voltage	2.0 V	V <sub>CC3</sub> +0.3V	Note 1	
V <sub>OL</sub>	Output Low Voltage		0.4 V	I <sub>OL</sub> = 4.0-mA load	
V <sub>OH</sub>	Output High Voltage	2.4 V		I <sub>OH</sub> = 3.0-mA load	

Notes:

1.  $V_{CC3}$  refers to the voltage being applied to  $V_{CC3}$  during functional operation.

2.  $V_{CC2} = 2.3 V - The maximum power supply current must be taken into account when designing a power supply.$ 

3.  $V_{CC2} = 2.4 V - The maximum power supply current must be taken into account when designing a power supply.$ 

4.  $V_{CC3} = 3.6 V - The maximum power supply current must be taken into account when designing a power supply.$ 

5. Refers to inputs and I/O without an internal pullup resistor and  $0 \le V_{IN} \le V_{CC3}$ 

6. Refers to inputs with an internal pullup and  $V_{II} = 0.4 V$ .

7. Refers to inputs with an internal pulldown and  $V_{IH} = 2.4$  V.

8. This specification applies to components using a CLK frequency of 66 MHz.

9. This specification applies to components using a CLK frequency of 95 MHz.

10. This specification applies to components using a CLK frequency of 100 MHz.

11. This specification applies to components using a CLK frequency of 97 MHz.

12. The specifications provided for the 533 MHz component are identical to the specifications of the 500 MHz component.

Symbol	Daramator Description	Prelir	ninary Data	Comments	
Symbol	Parameter Description	Min	Мах	comments	
			10.00 A	400 MHz, Note 2, 8, 10	
			11.25 A	450 MHz, Note 2, 10	
I <sub>CC2</sub>	2.2 V Power Supply Current		11.90 A	475 MHz, Note 2, 9	
			12.50 A	500 MHz, Note 2, 10	
			12.30 A	533 MHz, Note 2, 11, 12	
I <sub>CC2</sub>	2.3 V Power Supply Current		13.00 A	550 MHz, Note 3, 10	
			0.62 A	400 MHz, Note 4, 8, 10	
			0.66 A	450 MHz, Note 4, 10	
I <sub>CC3</sub>	3.3 V Power Supply Current		0.67 A	475 MHz, Note 4, 9	
1003			0.69 A	500 MHz, Note 4, 10	
				533 MHz, Note 4, 11, 12	
				550 MHz 4, 10	
Ι <sub>LI</sub>	Input Leakage Current		±15 μA	Note 5	
I <sub>LO</sub>	Output Leakage Current		±15 μA	Note 5	
۱ <sub>IL</sub>	Input Leakage Current Bias with Pullup		–400 μA	Note 6	
I <sub>IH</sub>	Input Leakage Current Bias with Pulldown	Input Leakage Current Bias with Pulldown 200 µA		Note 7	
C <sub>IN</sub>	Input Capacitance 10 pF		10 pF		
C <sub>OUT</sub>	Output Capacitance 15 pF				
C <sub>OUT</sub>	I/O Capacitance	20 pF			
C <sub>CLK</sub>	CLK Capacitance	10 pF			
C <sub>TIN</sub>	Test Input Capacitance (TDI, TMS, TRST#)	10 pF			
C <sub>TOUT</sub>	Test Output Capacitance (TDO)		15 pF		

#### Table 58. DC Characteristics for OPN Suffixes AGR, AFX, and 400AFR (continued)

Notes:

1.  $V_{CC3}$  refers to the voltage being applied to  $V_{CC3}$  during functional operation.

2.  $V_{CC2} = 2.3 V - The maximum power supply current must be taken into account when designing a power supply.$ 

3.  $V_{CC2} = 2.4 \text{ V} - \text{The maximum power supply current must be taken into account when designing a power supply.}$ 

4.  $V_{CC3} = 3.6 \text{ V} - \text{The maximum power supply current must be taken into account when designing a power supply.}$ 

5. Refers to inputs and I/O without an internal pullup resistor and  $0 \le V_{IN} \le V_{CC3.}$ 

6. Refers to inputs with an internal pullup and  $V_{II} = 0.4 V$ .

7. Refers to inputs with an internal pulldown and  $V_{IH} = 2.4$  V.

8. This specification applies to components using a CLK frequency of 66 MHz.

9. This specification applies to components using a CLK frequency of 95 MHz.

10. This specification applies to components using a CLK frequency of 100 MHz.

11. This specification applies to components using a CLK frequency of 97 MHz.

12. The specifications provided for the 533 MHz component are identical to the specifications of the 500 MHz component.

Symbol	Parameter Description	Preliminary Data		Comments		
Symbol		Min	Max	comments		
C <sub>TCK</sub>	TCK Capacitance		10 pF			
<ol> <li>2. V<sub>CC2</sub></li> <li>3. V<sub>CC2</sub></li> <li>4. V<sub>CC3</sub></li> <li>5. Refe</li> <li>6. Refe</li> <li>7. Refe</li> <li>8. This</li> <li>9. This</li> <li>10. This</li> <li>11. This</li> </ol>	<i>tes:</i> 1. $V_{CC3}$ refers to the voltage being applied to $V_{CC3}$ during functional operation. 2. $V_{CC2} = 2.3 V$ – The maximum power supply current must be taken into account when designing a p 3. $V_{CC2} = 2.4 V$ – The maximum power supply current must be taken into account when designing a p 4. $V_{CC3} = 3.6 V$ – The maximum power supply current must be taken into account when designing a p 5. Refers to inputs and I/O without an internal pullup resistor and $0 \le V_{IN} \le V_{CC3}$ . 6. Refers to inputs with an internal pullup and $V_{IL} = 0.4 V$ . 7. Refers to inputs with an internal pulldown and $V_{IH} = 2.4 V$ . 8. This specification applies to components using a CLK frequency of 66 MHz. 9. This specification applies to components using a CLK frequency of 100 MHz.					

#### Table 58. DC Characteristics for OPN Suffixes AGR, AFX, and 400AFR (continued)

# **Power Dissipation** Table 59 contains the typical and maximum power dissipation of the AMD-K6-2 processor during normal and reduced power states.

Table FO	True is all and Marine D		for ODNI Confficient A	
ladie 59.	Typical and Maximum P	ower Dissipation	TOP OPIN SUTTIXES A	GR, AFX, and 400AFR

Clock Control State	400 MHz <sup>6,8</sup>	450 MHz <sup>8</sup>	475 MHz <sup>7</sup>	500 MHz <sup>8</sup>	533 MHz <sup>9,10</sup>	550 MHz <sup>8</sup>	Notes
Thermal Power (Maximum)	16.90 W	18.80 W	19.80 W	20.75 W		25.00 W	1, 2
Thermal Power (Typical)	10.15 W	11.30 W	11.90 W	12.45 W		15.00 W	3
Stop Grant / Halt (Maximum)	4.40 W	4.44 W	4.45 W	4.46 W		4.87 W	4
Stop Clock (Maximum)	4.00 W	4.00 W	4.00 W	4.00 W		4.37 W	5

Notes:

1. The maximum power dissipated in the normal clock control state must be taken into account when designing a solution for thermal dissipation for the AMD-K6-2 processor.

2. Maximum power is determined for the worst-case instruction sequence or function for the listed clock control states with  $V_{CC2} = 2.2 V$  (for 2.2 V components) or  $V_{CC2} = 2.3 V$  (for 2.3 V components) and  $V_{CC3} = 3.3 V$ .

3. Typical power is determined for the typical instruction sequences or functions associated with normal system operation with  $V_{CC2} = 2.2 V$  (for 2.2 V components) or  $V_{CC2} = 2.3 V$  (for 2.3 V components) and  $V_{CC3} = 3.3 V$ .

4. The CLK signal and the internal PLL are still running but most internal clocking has stopped.

5. The CLK signal, the internal PLL, and all internal clocking has stopped.

6. This specification applies to components using a CLK frequency of 66 MHz.

7. This specification applies to components using a CLK frequency of 95 MHz.

8. This specification applies to components using a CLK frequency of 100 MHz.

9. This specification applies to components using a CLK frequency of 97 MHz.

10. The specifications provided for the 533 MHz component are identical to the specifications of the 500 MHz component.

# 15 I/O Buffer Characteristics

All of the AMD-K6-2 processor inputs, outputs, and bidirectional buffers are implemented using a 3.3V buffer design. In addition, a subset of the processor I/O buffers include a second, higher drive strength option. These buffers can be configured to provide the higher drive strength for applications that place a heavier load on these I/O signals.

AMD has developed two I/O buffer models that represent the characteristics of each of the two possible drive strength configurations supported by the AMD-K6-2 processor. These two models are called the Standard I/O Model and the Strong I/O Model.

AMD developed the two models to allow system designers to perform analog simulations of AMD-K6-2 processor signals that interface with the system logic. Analog simulations are used to determine a signal's time of flight from source to destination and to ensure that the system's signal quality requirements are met. Signal quality measurements include overshoot, undershoot, slope reversal, and ringing.

# 15.1 Selectable Drive Strength

The AMD-K6-2 processor samples the BRDYC# input during the falling transition of RESET to configure the drive strength of A[20:3], ADS#, HITM# and W/R#. If BRDYC# is 0 during the fall of RESET, these particular outputs are configured using the higher drive strength. If BRDYC# is 1 during the fall of RESET, the standard drive strength is selected for all I/O buffers.

Table 60 shows the relationship between BRDYC# and the two available drive strengths — K6STD and K6STG.

Table 60. A[20:3], ADS#, HITM#, and W/R# Strength Selection

Drive Strength	BRDYC#	I/O Buffer Name
Strength 1 (standard)	1	K6STD
Strength 2 (strong)	0	K6STG

# 15.2 I/O Buffer Model

AMD provides models of the AMD-K6-2 processor I/O buffers for system designers to use in board-level simulations. These I/O buffer models conform to the *I/O Buffer Information Specification (IBIS)*. The Standard I/O Model uses K6STD, the standard I/O buffer representation, for all I/O buffers. The Strong I/O Model uses K6STG, the stronger I/O buffer representation for A[20:3], ADS#, HITM#, and W/R#, and uses K6STD for the remainder of the I/O buffers.

Both I/O models contain voltage versus current (V/I) and voltage versus time (V/T) data tables for accurate modeling of I/O buffer behavior.

The following list characterizes the properties of each I/O buffer model:

- All data tables contain minimum, typical, and maximum values to allow for worst-case, typical, and best-case simulations, respectively.
- The pullup, pulldown, power clamp, and ground clamp device V/I tables contain enough data points to accurately represent the nonlinear nature of the V/I curves. In addition, the voltage ranges provided in these tables extend beyond the normal operating range of the AMD-K6-2 processor for those simulators that yield more accurate results based on this wider range. Figure 93 and Figure 94 on page 267 illustrate the min/typ/max pulldown and pullup V/I curves for K6STD between 0V and 3.3V.
- The rising and falling ramp rates are specified.
- The min/typ/max V<sub>CC3</sub> operating range is specified as 3.135 V, 3.3 V, and 3.6 V, respectively.
- $V_{il} = 0.8 V$ ,  $V_{ih} = 2.0 V$ , and  $V_{meas} = 1.5 V$
- The R/L/C of the package is modeled.
- The capacitance of the silicon die is modeled.
- The model assumes a test load resistance of  $50\Omega$

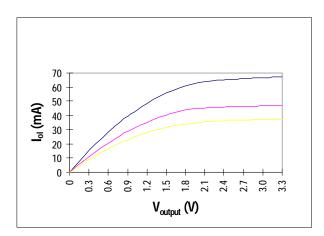
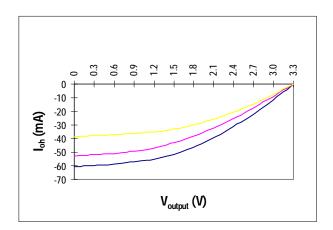


Figure 93. K6STD Pulldown V/I Curves





# 15.3 I/O Model Application Note

For the AMD-K6-2 processor I/O Buffer IBIS Models and their application, refer to the *AMD-K6<sup>®</sup> Processor I/O Model (IBIS) Application Note*, order# 21084.

# 15.4 I/O Buffer AC and DC Characteristics

See "Signal Switching Characteristics" on page 269 for the AMD-K6-2 processor AC timing specifications.

See "Electrical Data" on page 255 for the AMD-K6-2 processor DC specifications.

# 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# **16** Signal Switching Characteristics

The AMD-K6-2 processor signal switching characteristics are presented in Table 61 through Table 70. Valid delay, float, setup, and hold timing specifications are listed. These specifications are provided for the system designer to determine if the timings necessary for the processor to interface with the system logic are met. Table 61 and Table 62 contain the switching characteristics of the CLK input. Table 63 through Table 66 contain the timings for the normal operation signals. Table 67 and Table 68 contain the timings for RESET and the configuration signals. Table 69 and Table 70 contain the timings for the test operation signals.

All signal timings provided are:

- Measured between CLK, TCK, or RESET at 1.5 V and the corresponding signal at 1.5 V—this applies to input and output signals that are switching from Low to High, or from High to Low
- Based on input signals applied at a slew rate of 1 V/ns between 0 V and 3 V (rising) and 3 V to 0 V (falling)
- Valid within the operating ranges given in "Operating Ranges" on page 255
- Based on a load capacitance (C<sub>L</sub>) of 0 pF

### **16.1 CLK Switching Characteristics**

Table 61 and Table 62 contain the switching characteristics of the CLK input to the AMD-K6-2 processor for 100-MHz and 66-MHz bus operation, respectively, as measured at the voltage levels indicated by Figure 95 on page 271.

The CLK Period Stability specifies the variance (jitter) allowed between successive periods of the CLK input measured at 1.5 V. This parameter must be considered as one of the elements of clock skew between the AMD-K6-2 processor and the system logic.

# 16.2 Clock Switching Characteristics for 100-MHz Bus Operation

Symbol	Devementer Description	Prelimin	ary Data	<b>Γ</b> :	Commonto
Symbol	Parameter Description	Min	Мах	Figure	Comments
	Frequency	33.3 MHz	100 MHz		In Normal Mode
t <sub>1</sub>	CLK Period	10.0 ns		95	In Normal Mode
t <sub>2</sub>	CLK High Time	3.0 ns		95	
t <sub>3</sub>	CLK Low Time	3.0 ns		95	
t <sub>4</sub>	CLK Fall Time	0.15 ns	1.5 ns	95	
t <sub>5</sub>	CLK Rise Time	0.15 ns	1.5 ns	95	
	CLK Period Stability		± 250 ps		Note
Note:	L	<b>-</b>			1

#### Table 61. CLK Switching Characteristics for 100-MHz Bus Operation

Jitter frequency power spectrum peaking must occur at frequencies greater than (Frequency of CLK)/3 or less than 500 kHz.

# 16.3 Clock Switching Characteristics for 66-MHz Bus Operation

Table 62.	CLK Switching Characteristics for 66-MHz Bus Operation
-----------	--

Symbol	Deremeter Description	Prelimin	ary Data	Figure	Commonto
Symbol	Parameter Description	Min	Мах	Figure	Comments
	Frequency	33.3 MHz	66.6 MHz		In Normal Mode
t <sub>1</sub>	CLK Period	15.0 ns	30.0 ns	95	In Normal Mode
t <sub>2</sub>	CLK High Time	4.0 ns		95	
t <sub>3</sub>	CLK Low Time	4.0 ns		95	
t <sub>4</sub>	CLK Fall Time	0.15 ns	1.5 ns	95	
t <sub>5</sub>	CLK Rise Time	0.15 ns	1.5 ns	95	
	CLK Period Stability		± 250 ps		Note
Note: Jitter freq	uency power spectrum peaking must occur a	at frequencies gre	ater than (Freque	ency of CLK)/3 or	r less than 500 kHz.

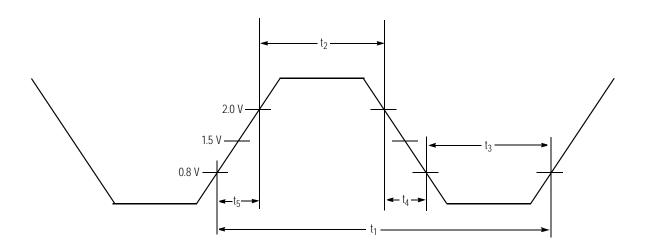


Figure 95. CLK Waveform

## 16.4 Valid Delay, Float, Setup, and Hold Timings

Valid delay and float timings are given for output signals during functional operation and are given relative to the rising edge of CLK. During boundary-scan testing, valid delay and float timings for output signals are with respect to the falling edge of TCK. The maximum valid delay timings are provided to allow a system designer to determine if setup times to the system logic can be met. Likewise, the minimum valid delay timings are used to analyze hold times to the system logic.

The setup and hold time requirements for the AMD-K6-2 processor input signals must be met by the system logic to assure the proper operation of the AMD-K6-2 processor. The setup and hold timings during functional and boundary-scan test mode are given relative to the rising edge of CLK and TCK, respectively.

# 16.5 Output Delay Timings for 100-MHz Bus Operation

Sumah a l	Decemptor Description	Prelimir	nary Data	<b>F</b> igure	Comments
Symbol	Parameter Description	Min	Мах	Figure	
t <sub>6</sub>	A[31:3] Valid Delay	1.1 ns	4.0 ns	97	
t <sub>7</sub>	A[31:3] Float Delay		7.0 ns	98	
t <sub>8</sub>	ADS# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>9</sub>	ADS# Float Delay		7.0 ns	98	
t <sub>10</sub>	ADSC# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>11</sub>	ADSC# Float Delay		7.0 ns	98	
t <sub>12</sub>	AP Valid Delay	1.0 ns	5.5 ns	97	
t <sub>13</sub>	AP Float Delay		7.0 ns	98	
t <sub>14</sub>	APCHK# Valid Delay	1.0 ns	4.5 ns	97	
t <sub>15</sub>	BE[7:0]# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>16</sub>	BE[7:0]# Float Delay		7.0 ns	98	
t <sub>17</sub>	BREQ Valid Delay	1.0 ns	4.0 ns	97	
t <sub>18</sub>	CACHE# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>19</sub>	CACHE# Float Delay		7.0 ns	98	
t <sub>20</sub>	D/C# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>21</sub>	D/C# Float Delay		7.0 ns	98	
t <sub>22</sub>	D[63:0] Write Data Valid Delay	1.3 ns	4.5 ns	97	
t <sub>23</sub>	D[63:0] Write Data Float Delay		7.0 ns	98	
t <sub>24</sub>	DP[7:0] Write Data Valid Delay	1.3 ns	4.5 ns	97	
t <sub>25</sub>	DP[7:0] Write Data Float Delay		7.0 ns	98	
t <sub>26</sub>	FERR# Valid Delay	1.0 ns	4.5 ns	97	
t <sub>27</sub>	HIT# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>28</sub>	HITM# Valid Delay	1.1 ns	4.0 ns	97	
t <sub>29</sub>	HLDA Valid Delay	1.0 ns	4.0 ns	97	
t <sub>30</sub>	LOCK# Valid Delay	1.1 ns	4.0 ns	97	
t <sub>31</sub>	LOCK# Float Delay		7.0 ns	98	
t <sub>32</sub>	M/IO# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>33</sub>	M/IO# Float Delay		7.0 ns	98	

### Table 63. Output Delay Timings for 100-MHz Bus Operation

Symbol		Prelimir	nary Data	Figuro	0 a man a mba
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>34</sub>	PCD Valid Delay	1.0 ns	4.0 ns	97	
t <sub>35</sub>	PCD Float Delay		7.0 ns	98	
t <sub>36</sub>	PCHK# Valid Delay	1.0 ns	4.5 ns	97	
t <sub>37</sub>	PWT Valid Delay	1.0 ns	4.0 ns	97	
t <sub>38</sub>	PWT Float Delay		7.0 ns	98	
t <sub>39</sub>	SCYC Valid Delay	1.0 ns	4.0 ns	97	
t <sub>40</sub>	SCYC Float Delay		7.0 ns	98	
t <sub>41</sub>	SMIACT# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>42</sub>	W/R# Valid Delay	1.0 ns	4.0 ns	97	
t <sub>43</sub>	W/R# Float Delay		7.0 ns	98	

### Table 63. Output Delay Timings for 100-MHz Bus Operation (continued)

# 16.6 Input Setup and Hold Timings for 100-MHz Bus Operation

Sumbol	Parameter Description	Prelimin	ary Data	Figure	Commente
Symbol		Min	Мах	Figure	Comments
t <sub>44</sub>	A[31:5] Setup Time	3.0 ns		99	
t <sub>45</sub>	A[31:5] Hold Time	1.0 ns		99	
t <sub>46</sub>	A20M# Setup Time	3.0 ns		99	Note 1
t <sub>47</sub>	A20M# Hold Time	1.0 ns		99	Note 1
t <sub>48</sub>	AHOLD Setup Time	3.5 ns		99	
t <sub>49</sub>	AHOLD Hold Time	1.0 ns		99	
t <sub>50</sub>	AP Setup Time	1.7 ns		99	
t <sub>51</sub>	AP Hold Time	1.0 ns		99	
t <sub>52</sub>	BOFF# Setup Time	3.5 ns		99	
t <sub>53</sub>	BOFF# Hold Time	1.0 ns		99	
t <sub>54</sub>	BRDY# Setup Time	3.0 ns		99	
t <sub>55</sub>	BRDY# Hold Time	1.0 ns		99	
t <sub>56</sub>	BRDYC# Setup Time	3.0 ns		99	
t <sub>57</sub>	BRDYC# Hold Time	1.0 ns		99	
t <sub>58</sub>	D[63:0] Read Data Setup Time	1.7 ns		99	
t <sub>59</sub>	D[63:0] Read Data Hold Time	1.5 ns		99	
t <sub>60</sub>	DP[7:0] Read Data Setup Time	1.7 ns		99	
t <sub>61</sub>	DP[7:0] Read Data Hold Time	1.5 ns		99	
t <sub>62</sub>	EADS# Setup Time	3.0 ns		99	
t <sub>63</sub>	EADS# Hold Time	1.0 ns		99	
t <sub>64</sub>	EWBE# Setup Time	1.7 ns		99	
t <sub>65</sub>	EWBE# Hold Time	1.0 ns		99	
t <sub>66</sub>	FLUSH# Setup Time	1.7 ns		99	Note 2
t <sub>67</sub>	FLUSH# Hold Time	1.0 ns		99	Note 2

#### Table 64. Input Setup and Hold Timings for 100-MHz Bus Operation

Notes:

1. These level-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must be asserted for a minimum pulse width of two clocks.

2. These edge-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must have been negated at least two clocks prior to assertion and must remain asserted at least two clocks.

Sumbol	Deremotor Description	Prelimin	ary Data	Figure	Commonte
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>68</sub>	HOLD Setup Time	1.7 ns		99	
t <sub>69</sub>	HOLD Hold Time	1.5 ns		99	
t <sub>70</sub>	IGNNE# Setup Time	1.7 ns		99	Note 1
t <sub>71</sub>	IGNNE# Hold Time	1.0 ns		99	Note 1
t <sub>72</sub>	INIT Setup Time	1.7 ns		99	Note 2
t <sub>73</sub>	INIT Hold Time	1.0 ns		99	Note 2
t <sub>74</sub>	INTR Setup Time	1.7 ns		99	Note 1
t <sub>75</sub>	INTR Hold Time	1.0 ns		99	Note 1
t <sub>76</sub>	INV Setup Time	1.7 ns		99	
t <sub>77</sub>	INV Hold Time	1.0 ns		99	
t <sub>78</sub>	KEN# Setup Time	3.0 ns		99	
t <sub>79</sub>	KEN# Hold Time	1.0 ns		99	
t <sub>80</sub>	NA# Setup Time	1.7 ns		99	
t <sub>81</sub>	NA# Hold Time	1.0 ns		99	
t <sub>82</sub>	NMI Setup Time	1.7 ns		99	Note 2
t <sub>83</sub>	NMI Hold Time	1.0 ns		99	Note 2
t <sub>84</sub>	SMI# Setup Time	1.7 ns		99	Note 2
t <sub>85</sub>	SMI# Hold Time	1.0 ns		99	Note 2
t <sub>86</sub>	STPCLK# Setup Time	1.7 ns		99	Note 1
t <sub>87</sub>	STPCLK# Hold Time	1.0 ns		99	Note 1
t <sub>88</sub>	WB/WT# Setup Time	1.7 ns		99	
t <sub>89</sub>	WB/WT# Hold Time	1.0 ns		99	
	I				

#### Table 64. Input Setup and Hold Timings for 100-MHz Bus Operation (continued)

Notes:

1. These level-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must be asserted for a minimum pulse width of two clocks.

2. These edge-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must have been negated at least two clocks prior to assertion and must remain asserted at least two clocks.

# 16.7 Output Delay Timings for 66-MHz Bus Operation

Sumbol	Parameter Description	Prelimi	nary Data	Figure	Comments
Symbol	Parameter Description	Min	Мах	Figure	
t <sub>6</sub>	A[31:3] Valid Delay	1.1 ns	6.3 ns	97	
t <sub>7</sub>	A[31:3] Float Delay		10.0 ns	98	
t <sub>8</sub>	ADS# Valid Delay	1.0 ns	6.0 ns	97	
t <sub>9</sub>	ADS# Float Delay		10.0 ns	98	
t <sub>10</sub>	ADSC# Valid Delay	1.0 ns	7.0 ns	97	
t <sub>11</sub>	ADSC# Float Delay		10.0 ns	98	
t <sub>12</sub>	AP Valid Delay	1.0 ns	8.5 ns	97	
t <sub>13</sub>	AP Float Delay		10.0 ns	98	
t <sub>14</sub>	APCHK# Valid Delay	1.0 ns	8.3 ns	97	
t <sub>15</sub>	BE[7:0]# Valid Delay	1.0 ns	7.0 ns	97	
t <sub>16</sub>	BE[7:0]# Float Delay		10.0 ns	98	
t <sub>17</sub>	BREQ Valid Delay	1.0 ns	8.0 ns	97	
t <sub>18</sub>	CACHE# Valid Delay	1.0 ns	7.0 ns	97	
t <sub>19</sub>	CACHE# Float Delay		10.0 ns	98	
t <sub>20</sub>	D/C# Valid Delay	1.0 ns	7.0 ns	97	
t <sub>21</sub>	D/C# Float Delay		10.0 ns	98	
t <sub>22</sub>	D[63:0] Write Data Valid Delay	1.3 ns	7.5 ns	97	
t <sub>23</sub>	D[63:0] Write Data Float Delay		10.0 ns	98	
t <sub>24</sub>	DP[7:0] Write Data Valid Delay	1.3 ns	7.5 ns	97	
t <sub>25</sub>	DP[7:0] Write Data Float Delay		10.0 ns	98	
t <sub>26</sub>	FERR# Valid Delay	1.0 ns	8.3 ns	97	
t <sub>27</sub>	HIT# Valid Delay	1.0 ns	6.8 ns	97	
t <sub>28</sub>	HITM# Valid Delay	1.1 ns	6.0 ns	97	
t <sub>29</sub>	HLDA Valid Delay	1.0 ns	6.8 ns	97	
t <sub>30</sub>	LOCK# Valid Delay	1.1 ns	7.0 ns	97	
t <sub>31</sub>	LOCK# Float Delay		10.0 ns	98	
t <sub>32</sub>	M/IO# Valid Delay	1.0 ns	5.9 ns	97	
t <sub>33</sub>	M/IO# Float Delay		10.0 ns	98	

### Table 65. Output Delay Timings for 66-MHz Bus Operation

Sumbol		Prelimi	nary Data	Figure	0
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>34</sub>	PCD Valid Delay	1.0 ns	7.0 ns	97	
t <sub>35</sub>	PCD Float Delay		10.0 ns	98	
t <sub>36</sub>	PCHK# Valid Delay	1.0 ns	1.0 ns 7.0 ns		
t <sub>37</sub>	PWT Valid Delay	1.0 ns	7.0 ns	97	
t <sub>38</sub>	PWT Float Delay		10.0 ns	98	
t <sub>39</sub>	SCYC Valid Delay	1.0 ns	7.0 ns	97	
t <sub>40</sub>	SCYC Float Delay		10.0 ns	98	
t <sub>41</sub>	SMIACT# Valid Delay	1.0 ns	1.0 ns 7.3 ns		
t <sub>42</sub>	W/R# Valid Delay	1.0 ns	7.0 ns	97	
t <sub>43</sub>	W/R# Float Delay		10.0 ns	98	

#### Table 65. Output Delay Timings for 66-MHz Bus Operation (continued)

# 16.8 Input Setup and Hold Timings for 66-MHz Bus Operation

Symbol	Daramator Description	Prelimin	ary Data	Figure	Commonte
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>44</sub>	A[31:5] Setup Time	6.0 ns		99	
t <sub>45</sub>	A[31:5] Hold Time	1.0 ns		99	
t <sub>46</sub>	A20M# Setup Time	5.0 ns		99	Note 1
t <sub>47</sub>	A20M# Hold Time	1.0 ns		99	Note 1
t <sub>48</sub>	AHOLD Setup Time	5.5 ns		99	
t <sub>49</sub>	AHOLD Hold Time	1.0 ns		99	
t <sub>50</sub>	AP Setup Time	5.0 ns		99	
t <sub>51</sub>	AP Hold Time	1.0 ns		99	
t <sub>52</sub>	BOFF# Setup Time	5.5 ns		99	
t <sub>53</sub>	BOFF# Hold Time	1.0 ns		99	
t <sub>54</sub>	BRDY# Setup Time	5.0 ns		99	
t <sub>55</sub>	BRDY# Hold Time	1.0 ns		99	
t <sub>56</sub>	BRDYC# Setup Time	5.0 ns		99	
t <sub>57</sub>	BRDYC# Hold Time	1.0 ns		99	
t <sub>58</sub>	D[63:0] Read Data Setup Time	2.8 ns		99	
t <sub>59</sub>	D[63:0] Read Data Hold Time	1.5 ns		99	
t <sub>60</sub>	DP[7:0] Read Data Setup Time	2.8 ns		99	
t <sub>61</sub>	DP[7:0] Read Data Hold Time	1.5 ns		99	
t <sub>62</sub>	EADS# Setup Time	5.0 ns		99	
t <sub>63</sub>	EADS# Hold Time	1.0 ns		99	
t <sub>64</sub>	EWBE# Setup Time	5.0 ns		99	
t <sub>65</sub>	EWBE# Hold Time	1.0 ns		99	
t <sub>66</sub>	FLUSH# Setup Time	5.0 ns		99	Note 2
t <sub>67</sub>	FLUSH# Hold Time	1.0 ns		99	Note 2

#### Table 66. Input Setup and Hold Timings for 66-MHz Bus Operation

Notes:

1. These level-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must be asserted for a minimum pulse width of two clocks.

2. These edge-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must have been negated at least two clocks prior to assertion and must remain asserted at least two clocks.

Sumbol	Deremotor Description	Prelimin	ary Data	Figure	Commonte
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>68</sub>	HOLD Setup Time	5.0 ns		99	
t <sub>69</sub>	HOLD Hold Time	1.5 ns		99	
t <sub>70</sub>	IGNNE# Setup Time	5.0 ns		99	Note 1
t <sub>71</sub>	IGNNE# Hold Time	1.0 ns		99	Note 1
t <sub>72</sub>	INIT Setup Time	5.0 ns		99	Note 2
t <sub>73</sub>	INIT Hold Time	1.0 ns		99	Note 2
t <sub>74</sub>	INTR Setup Time	5.0 ns		99	Note 1
t <sub>75</sub>	INTR Hold Time	1.0 ns		99	Note 1
t <sub>76</sub>	INV Setup Time	5.0 ns		99	
t <sub>77</sub>	INV Hold Time	1.0 ns		99	
t <sub>78</sub>	KEN# Setup Time	5.0 ns		99	
t <sub>79</sub>	KEN# Hold Time	1.0 ns		99	
t <sub>80</sub>	NA# Setup Time	4.5 ns		99	
t <sub>81</sub>	NA# Hold Time	1.0 ns		99	
t <sub>82</sub>	NMI Setup Time	5.0 ns		99	Note 2
t <sub>83</sub>	NMI Hold Time	1.0 ns		99	Note 2
t <sub>84</sub>	SMI# Setup Time	5.0 ns		99	Note 2
t <sub>85</sub>	SMI# Hold Time	1.0 ns		99	Note 2
t <sub>86</sub>	STPCLK# Setup Time	5.0 ns		99	Note 1
t <sub>87</sub>	STPCLK# Hold Time	1.0 ns		99	Note 1
t <sub>88</sub>	WB/WT# Setup Time	4.5 ns		99	
t <sub>89</sub>	WB/WT# Hold Time	1.0 ns		99	
	I				

#### Table 66. Input Setup and Hold Timings for 66-MHz Bus Operation (continued)

Notes:

1. These level-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must be asserted for a minimum pulse width of two clocks.

2. These edge-sensitive signals can be asserted synchronously or asynchronously. To be sampled on a specific clock edge, setup and hold times must be met. If asserted asynchronously, they must have been negated at least two clocks prior to assertion and must remain asserted at least two clocks.

# **16.9 RESET and Test Signal Timing**

#### Table 67. RESET and Configuration Signals for 100-MHz Bus Operation

Symbol	Decemptor Description	Prelimina	ary Data	Figure	Comments
	Parameter Description	Min	Мах	rigure	
t <sub>90</sub>	RESET Setup Time	1.7 ns		100	
t <sub>91</sub>	RESET Hold Time	1.0 ns		100	
t <sub>92</sub>	RESET Pulse Width, V <sub>CC</sub> and CLK Stable	15 clocks		100	
t <sub>93</sub>	RESET Active After V <sub>CC</sub> and CLK Stable	1.0 ms		100	
t <sub>94</sub>	BF[2:0] Setup Time	1.0 ms		100	Note 3
t <sub>95</sub>	BF[2:0] Hold Time	2 clocks		100	Note 3
t <sub>96</sub>	BRDYC# Hold Time	1.0 ns		100	Note 4
t <sub>97</sub>	BRDYC# Setup Time	2 clocks		100	Note 2
t <sub>98</sub>	BRDYC# Hold Time	2 clocks		100	Note 2
t99	FLUSH# Setup Time	1.7 ns		100	Note 1
t <sub>100</sub>	FLUSH# Hold Time	1.0 ns		100	Note 1
t <sub>101</sub>	FLUSH# Setup Time	2 clocks		100	Note 2
t <sub>102</sub>	FLUSH# Hold Time	2 clocks		100	Note 2

Notes:

1. To be sampled on a specific clock edge, setup and hold times must be met the clock edge before the clock edge on which RESET is sampled negated.

2. If asserted asynchronously, these signals must meet a minimum setup and hold time of two clocks relative to the negation of RESET.

3. BF[2:0] must meet a minimum setup time of 1.0 ms and a minimum hold time of two clocks relative to the negation of RESET.

4. If RESET is driven synchronously, BRDYC# must meet the specified hold time relative to the negation of RESET.

Cumhal	Deventer Description	Prelimina	ary Data	<b>F</b> :	0
Symbol	Parameter Description	Min	Мах	Figure	Comments
t <sub>90</sub>	RESET Setup Time	5.0 ns		100	
t <sub>91</sub>	RESET Hold Time	1.0 ns		100	
t <sub>92</sub>	RESET Pulse Width, V <sub>CC</sub> and CLK Stable	15 clocks		100	
t93	RESET Active After V <sub>CC</sub> and CLK Stable	1.0 ms		100	
t <sub>94</sub>	BF[2:0] Setup Time	1.0 ms		100	Note 3
t <sub>95</sub>	BF[2:0] Hold Time	2 clocks		100	Note 3
t <sub>96</sub>	BRDYC# Hold Time	1.0 ns		100	Note 4
t <sub>97</sub>	BRDYC# Setup Time	2 clocks		100	Note 2
t <sub>98</sub>	BRDYC# Hold Time	2 clocks		100	Note 2
t99	FLUSH# Setup Time	5.0 ns		100	Note 1
t <sub>100</sub>	FLUSH# Hold Time	1.0 ns		100	Note 1
t <sub>101</sub>	FLUSH# Setup Time	2 clocks		100	Note 2
t <sub>102</sub>	FLUSH# Hold Time	2 clocks		100	Note 2

#### Table 68. RESET and Configuration Signals for 66-MHz Bus Operation

Notes:

1. To be sampled on a specific clock edge, setup and hold times must be met the clock edge before the clock edge on which RESET is sampled negated.

2. If asserted asynchronously, these signals must meet a minimum setup and hold time of two clocks relative to the negation of RESET.

3. BF[2:0] must meet a minimum setup time of 1.0 ms and a minimum hold time of two clocks relative to the negation of RESET.

4. If RESET is driven synchronously, BRDYC# must meet the specified hold time relative to the negation of RESET.

Symbol	Decemptor Deceription	Prelimin	ary Data	Figuro	Commonto
	Parameter Description	Min	Мах	Figure	Comments
	TCK Frequency		25 MHz	101	
t <sub>103</sub>	TCK Period	40.0 ns		101	
t <sub>104</sub>	TCK High Time	14.0 ns		101	
t <sub>105</sub>	TCK Low Time	14.0 ns		101	
t <sub>106</sub>	TCK Fall Time		5.0 ns	101	Note 1, 2
t <sub>107</sub>	TCK Rise Time		5.0 ns	101	Note 1, 2
t <sub>108</sub>	TRST# Pulse Width	30.0 ns		102	Asynchronous

### Table 69. TCK Waveform and TRST# Timing at 25 MHz

Notes:

1. Rise/Fall times can be increased by 1.0 ns for each 10 MHz that TCK is run below its maximum frequency of 25 MHz.

2. Rise/Fall times are measured between 0.8 V and 2.0 V.

#### Table 70. Test Signal Timing at 25 MHz

Symbol	Parameter Description	Prelimin	nary Data	<b>F</b> igure	Natas	
Symbol	Parameter Description	Min	Мах	Figure	Notes	
t <sub>109</sub>	TDI Setup Time	5.0 ns		103	Note 2	
t <sub>110</sub>	TDI Hold Time	9.0 ns		103	Note 2	
t <sub>111</sub>	TMS Setup Time	5.0 ns		103	Note 2	
t <sub>112</sub>	TMS Hold Time	9.0 ns		103	Note 2	
t <sub>113</sub>	TDO Valid Delay	3.0 ns	13.0 ns	103	Note 1	
t <sub>114</sub>	TDO Float Delay		16.0 ns	103	Note 1	
t <sub>115</sub>	All Outputs (Non-Test) Valid Delay	3.0 ns	13.0 ns	103	Note 1	
t <sub>116</sub>	All Outputs (Non-Test) Float Delay		16.0 ns	103	Note 1	
t <sub>117</sub>	All Inputs (Non-Test) Setup Time	5.0 ns		103	Note 2	
t <sub>118</sub>	All Inputs (Non-Test) Hold Time	9.0 ns		103	Note 2	

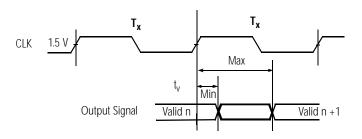
1. Parameter is measured from the TCK falling edge.

2. Parameter is measured from the TCK rising edge.

תכ

WAVEFORM	INPUTS	OUTPUTS
	Must be steady	Steady
$\overline{}$	Can change from High to Low	Changing from High to Low
	Can change from Low to High	Changing from Low to High
	Don't care, any change permitted	Changing, State Unknown
	(Does not apply)	Center line is high impedance state

Figure 96. Diagrams Key

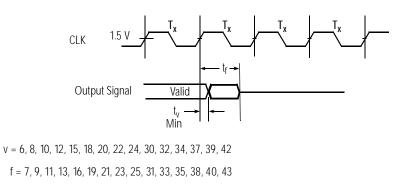


 $v=6,\,8,\,10,\,12,\,14,\,15,\,17,\,18,\,20,\,22,\,24,\,26,\,27,\,28,\,29,\,30,\,32,\,34,\,36,\,37,\,39,\,41,\,42$ 

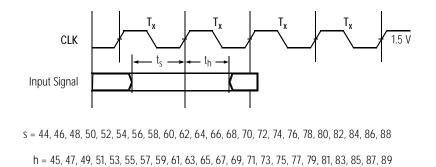
## Figure 97. Output Valid Delay Timing

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000



#### Figure 98. Maximum Float Delay Timing



#### Figure 99. Input Setup and Hold Timing

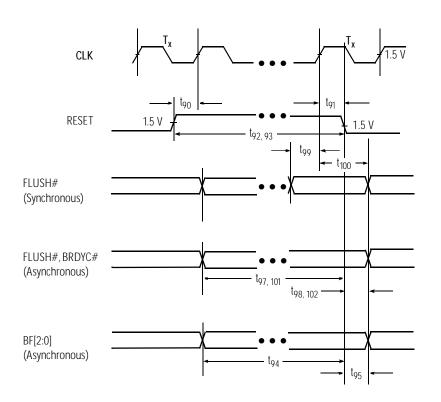
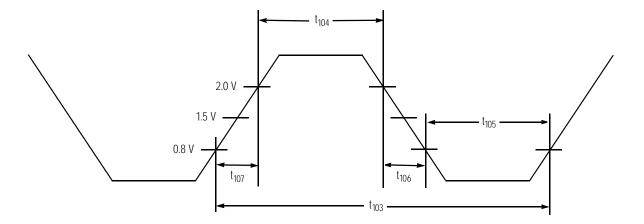
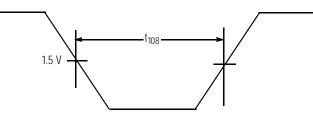


Figure 100. Reset and Configuration Timing

21850J/0-February 2000



#### Figure 101. TCK Waveform



#### Figure 102. TRST# Timing

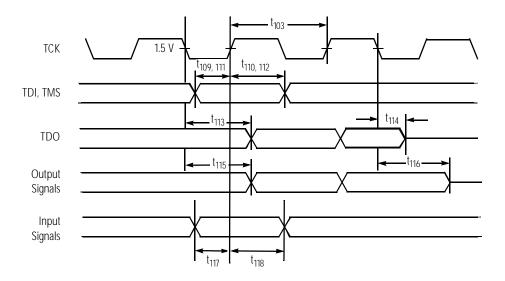


Figure 103. Test Signal Timing Diagram

# **17** Thermal Design

## **17.1** Package Thermal Specifications

The AMD-K6-2 processor operating specification calls for the case temperature ( $T_C$ ) to be in the range of 0°C to 70°C, 0°C to 65°C, or 0°C to 60°C. The ambient temperature ( $T_A$ ) is not specified as long as the case temperature is not violated. The case temperature must be measured on the top center of the package. Table 71 and Table 72 show the AMD-K6-2 processor thermal specifications for all valid OPN suffixes.

	Table 71.	Package Thermal Specification for OPN Suffixes AHX, AFQ, and AFR
--	-----------	--

	Maximum Thermal Power										
θ <sub>JC</sub> Junction-Case		2.4 V Component									
	266 MHz	300 MHz	333 MHz	350 MHz	366 MHz	380 MHz	400 MHz*	450 MHz	475 MHz		
1.0 °C/W	14.70 W	17.20 W	19.00 W	19.95 W	20.80 W	21.60 W	22.70 W	28.40 W	29.60 W		
Stop Grant Mode	3.90 W	3.92 W	3.94 W	3.96 W	3.96 W	3.97 W	3.98 W	6.50 W	6.51 W		
Stop Clock Mode	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	3.50 W	6.00 W	6.00 W		
T <sub>C</sub> Case Temperature		0°C-70°C 0°C-						0°C–65°C			
<i>Note:</i> * Not applicable to OPI	N AMD-K6-2/	/400AFR. Rei	fer to Table 7	72 on page 2	89 for the A	MD-K6-2/40	OAFR specific	cations.			

## 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

288

	Maximum Thermal Power								
θ <sub>JC</sub> Junction-Case		2.2	2.3 V Component						
	400 MHz <sup>1</sup>	450 MHz	475 MHz	500 MHz	533 MHz <sup>2</sup>	550 MHz			
1.0 °C/W	16.90 W	18.80 W	19.80 W	20.75 W		25.00 W			
Stop Grant Mode	4.40 W	4.44 W	4.45 W	4.46 W		4.87 W			
Stop Clock Mode	4.00 W	4.00 W 4.00 W 4.00 W		4.37 W					
T <sub>C</sub> Case Temperature	0°C–70°C	0°C-65°C				0°C–70°C			
Notes:									

#### Table 72. Package Thermal Specification for OPN Suffixes AGR, AFX, and 400AFR

1. Specifications are applicable to OPN AMD-K6-2/400AFR.

2. The specifications provided for the 533 MHz component are identical to the specifications of the 500 MHz component.

Figure 104 on page 290 shows the thermal model of a processor with a passive thermal solution. The case-to-ambient temperature ( $T_{CA}$ ) can be calculated from the following equation:

$$T_{CA} = P_{MAX} \bullet \theta_{CA}$$
$$= P_{MAX} \bullet (\theta_{IF} + \theta_{SA})$$

Where:

P <sub>MAX</sub>	= Maximum Power Consumption
θ <sub>CA</sub>	= Case-to-Ambient Thermal Resistance
$\theta_{ F}$	= Interface Material Thermal Resistance
$\theta_{SA}$	= Sink-to-Ambient Thermal Resistance

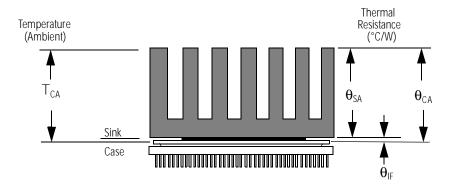


Figure 104. Thermal Model

Figure 105 illustrates the case-to-ambient temperature ( $T_{CA}$ ) in relation to the power consumption (X-axis) and the thermal resistance (Y-axis). If the power consumption and case temperature are known, the thermal resistance ( $\theta_{CA}$ ) requirement can be calculated for a given ambient temperature ( $T_A$ ) value.

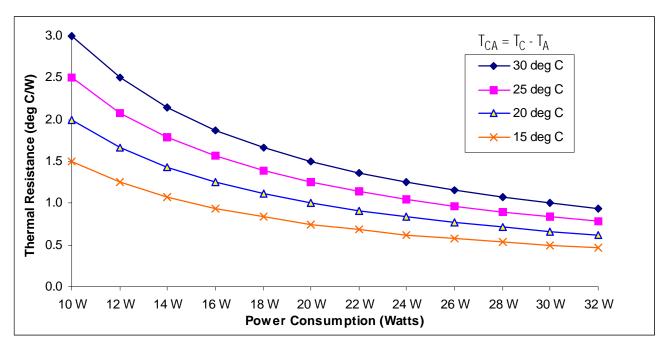


Figure 105. Power Consumption versus Thermal Resistance

The thermal resistance of a heatsink is determined by the heat dissipation surface area, the material and shape of the heatsink, and the airflow volume across the heatsink. In general, the larger the surface area the lower the thermal resistance.

The required thermal resistance of a heatsink  $(\theta_{SA})$  can be calculated using the following example:

If:

Then:

$$\theta_{CA} \le \left(\frac{T_C - T_A}{P_{MAX}}\right) = \frac{20^{\circ}C}{29.60W} = 0.676 (^{\circ}C/W)$$

Thermal grease is recommended as interface material because it provides the lowest thermal resistance ( $\cong 0.20^{\circ}C/W$ ). The required thermal resistance ( $\theta_{SA}$ ) of the heatsink in this example is calculated as follows:

$$\theta_{SA} = \theta_{CA} - \theta_{IF} = 0.676 - 0.20 = 0.476(°C/W)$$

Heat Dissipation Path Figure 106 illustrates the heat dissipation path of the processor. Due to the lower thermal resistance between the processor die junction and case, most of the heat generated by the processor is transferred from the top surface of the case. The small amount of heat generated from the bottom side of the processor where the processor socket blocks the convection can be safely ignored.

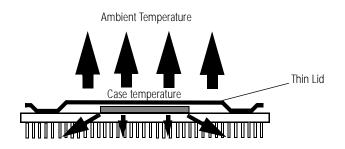


Figure 106. Processor Heat Dissipation Path

Measuring Case Temperature The processor case temperature is measured to ensure that the thermal solution meets the processor's operational specification. This temperature should be measured on the top center of the package, where most of the heat is dissipated. Figure 107 shows the correct location for measuring the case temperature. If a heatsink is installed while measuring, the thermocouple must be installed into the heatsink via a small hole drilled through the heatsink base (for example, 1/16 of an inch). The thermocouple is then attached to the base of the heatsink and the small hole filled using thermal epoxy, allowing the tip of the thermocouple to touch the top of the processor case.

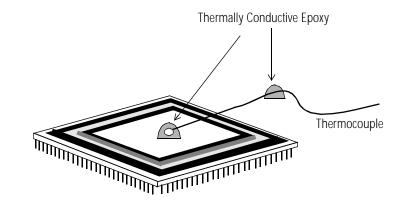


Figure 107. Measuring Case Temperature

## **17.2** Layout and Airflow Considerations

**Voltage Regulator** A voltage regulator is required to support the lower voltage (3.3 V and lower) to the processor. In most applications, the voltage regulator is designed with power transistors. As a result, additional heatsinks are required to dissipate the heat from the power transistors. Figure 108 shows the voltage regulator placed parallel to the processor with the airflow aligned with the devices. With this alignment, the heat generated by the voltage regulator has minimal effect on the processor.

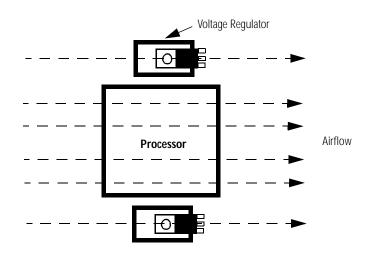


Figure 108. Voltage Regulator Placement

A heatsink and fan combination can deliver much better thermal performance than a heatsink alone. More importantly, with a fan/sink the airflow requirements in a system design are not as critical. A unidirectional heatsink with a fan moves air from the top of the heatsink to the side. In this case, the best location for the voltage regulator is on the side of the processor in the path of the airflow exiting the fan sink (see Figure 109). This location guarantees that the heatsinks on both the processor and the regulator receive adequate air circulation.

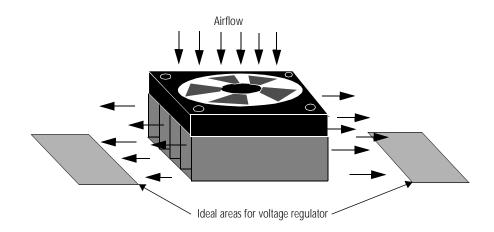


Figure 109. Airflow for a Heatsink with Fan

Airflow Management in a System Design Complete airflow management in a system is important. In addition to the volume of air, the path of the air is also important. Figure 110 shows the airflow in a dual-fan system. The fan in the front end pulls cool air into the system through intake slots in the chassis. The power supply fan forces the hot air out of the chassis. The thermal performance of the heatsink can be maximized if it is located in the shaded area, where it receives greatest benefit from this air exchange system.

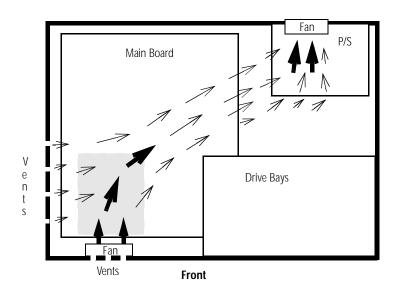


Figure 110. Airflow Path in a Dual-Fan System

Figure 111 shows the airflow management in a system using the ATX form-factor. The orientation of the power supply fan and the motherboard are modified in the ATX platform design. The power supply fan pulls cool air through the chassis and across the processor. The processor is located near the power supply fan, where it can receive adequate airflow without an auxiliary fan. The arrangement significantly improves the airflow across the processor with minimum installation cost.

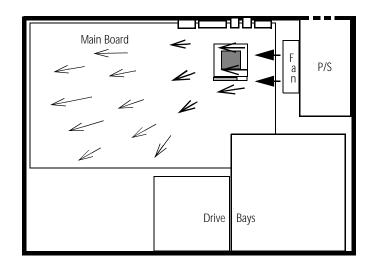


Figure 111. Airflow Path in an ATX Form-Factor System



For more information about thermal design considerations, see the AMD-K6<sup>®</sup> Processor Thermal Solution Design Application Note, order# 21085.

21850J/0-February 2000

AMD-K6<sup>®</sup>-2 Processor Data Sheet

# 18 Pin Description Diagram

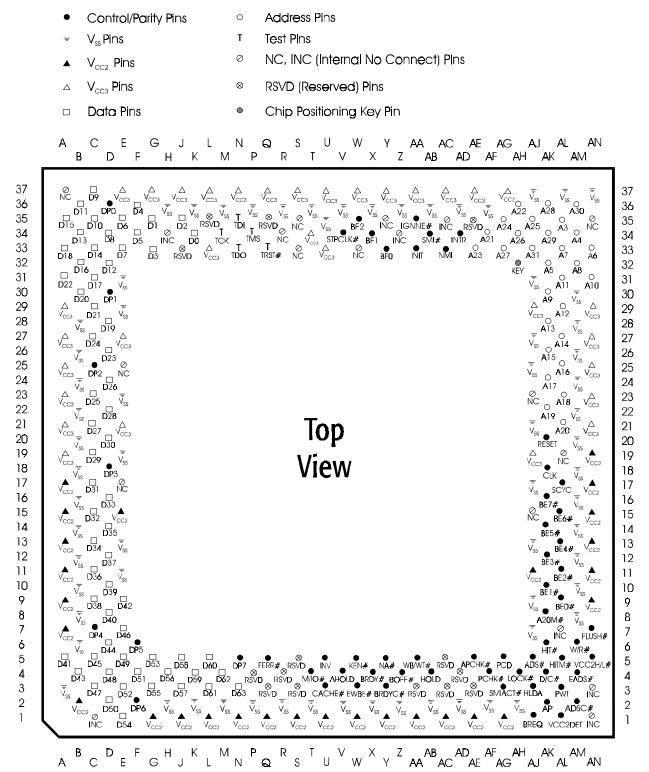


Figure 112. AMD-K6<sup>®</sup>-2 Processor Top-Side View

AMD-K6<sup>®</sup>-2 Processor Data Sheet

Control/Parity Pins     Addr	ess Pins
------------------------------	----------

- V<sub>ss</sub>Pins T Test Pins
- △ V<sub>cc3</sub> Pins ⊗ RSVD (Reserved) Pins
- Data Pins
   Chip Positioning Key Pin

 $\begin{smallmatrix} 1 & & 3 & & 5 & & 7 & & 9 & & 11 & & 13 & & 15 & & 17 & & 19 & & 21 & & 23 & & 25 & & 27 & & 29 & & 31 & & 33 & & 35 & & 37 \\ 2 & & 4 & & 6 & & 8 & & 10 & & 12 & & 14 & & 16 & & 18 & & 20 & & 22 & & 24 & & 26 & & 28 & & 30 & & 32 & & 34 & & 36 \\ \end{smallmatrix}$ 

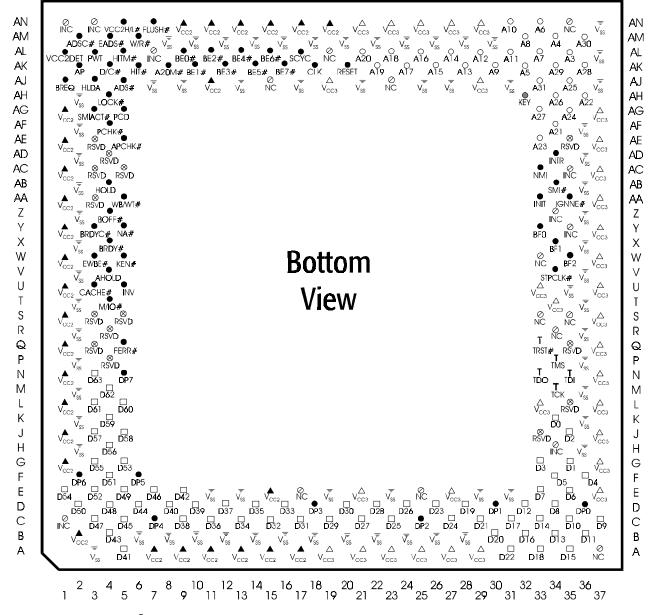


Figure 113. AMD-K6<sup>®</sup>-2 Processor Pin-Side View

# **19 Pin Designations**

Address		Data Control		Test		NC	V <sub>cc2</sub>	V <sub>cc3</sub>	V <sub>ss</sub>		
Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin No.	Pin No.	Pin No.	Pin No.
Pin	Pin	Pin	Pin	Pin	Pin	Pin Name TCK TDI TDO TMS TRST#	Pin	Pin	Pin	Pin	Pin

# AMD-K6<sup>®</sup>-2 Processor Functional Grouping

## 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000

# 20 Package Specifications

## 20.1 321-Pin Staggered CPGA Package Specification

Cume he al		Millimeters		Inches				
Symbol	Min	Мах	Notes	Min	Мах	Notes		
А	49.28	49.78		1.940	1.960			
В	45.59	45.85		1.795	1.805			
С	31.01	32.89		1.221	1.295			
D	44.90	45.10		1.768	1.776			
E	2.91	3.63		0.115	0.143			
F	1.30	1.52		0.051	0.060			
G	3.05	3.30		0.120	0.130			
Н	0.43	0.51		0.017	0.020			
М	2.29	2.79		0.090	0.110			
Ν	1.14	1.40		0.045	0.055			
d	1.52	2.29		0.060	0.090			
е	1.52	2.54		0.060	0.100			
f	_	0.13	Flatness	_	0.005	Flatness		

#### Table 73. 321-Pin Staggered CPGA Package Specification

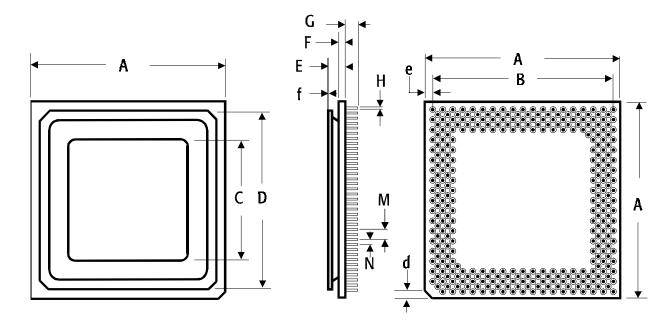
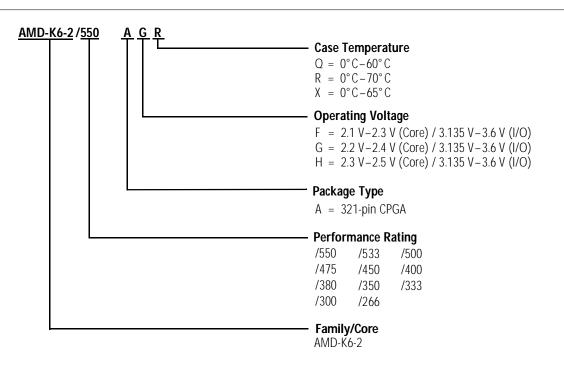


Figure 114. 321-Pin Staggered CPGA Package Specification

# 21 Ordering Information

# Standard AMD-K6<sup>®</sup>-2 Processor Model 8 Products

AMD standard products are available in several operating ranges. The ordering part number (OPN) is formed by a combination of the elements below.



OPN	Package Type	Operating Voltage	Case Temperature		
AMD-K6-2/550AGR	321-pin CPGA	2.2V-2.4V (Core)	0°C-70°C		
AIVID-KO-2/000AGK	SZI-PIII CPGA	3.135V-3.6V (I/O)	0 0 - 70 0		
AMD-K6-2/533AFX	221 nin CDCA	2.1V-2.3V (Core)	0°C-65°C		
ΑΙΨΙΔ-ΚΟ-Ζ/533ΑΓΧ	321-pin CPGA	3.135V-3.6V (I/O)	0 0-00 0		
		221 pip CPCA 2.1V-2.3V (Core)			
AMD-K6-2/500AFX	321-pin CPGA	3.135V-3.6V (I/O)	0°C-65°C		
Note:					
This table lists con AMD sales office to combinations.	figurations planned to be confirm availability of sp	supported in volume for this pecific valid combinations and	device. Consult the local to check on newly-released		

OPN	Package Type	Operating Voltage	Case Temperature					
AMD-K6-2/475AFX	321-pin CPGA	2.1V-2.3V (Core)	0°C-65°C					
ΑΙΝΙΔ-ΝΟ-Ζ/4/ ΟΑΓΛ	SZI-PIII CPGA	3.135V-3.6V (I/O)						
AMD-K6-2/475AHX	221 pip CDCA	2.3V-2.5V (Core)						
ΑΙΜΟ-ΚΟ-2/4/ 3ΑΠΛ	521-pill CPGA	3.135V-3.6V (I/O)	0°C-65°C					
AMD-K6-2/450AFX	321-pin CPGA	2.1V-2.3V (Core)	0°C-65°C					
AMD-R0-2/450ALX	521-pin CFGA	3.135V-3.6V (I/O)	0 0-05 0					
AMD-K6-2/450AHX	321-pin CPGA	2.3V-2.5V (Core)	0°C-65°C					
AWD-R0-2/450AHA	521-pin CFGA	3.135V-3.6V (I/O)	0 0-05 0					
AMD-K6-2/400AFR	321-pin CPGA	2.1V-2.3V (Core)	0°C-70°C					
AIVID-K0-2/400AFK	521-pill CPGA	3.135V-3.6V (I/O)	0 0-70 0					
	221 pip CDCA	2.1V-2.3V (Core)	0°C-60°C					
AMD-K6-2/400AFQ	321-pin CPGA	3.135V-3.6V (I/O)	0 0 - 00 0					
AMD-K6-2/380AFR	201 pip CDCA	2.1V-2.3V (Core)	0°C-70°C					
AIVID-N0-2/300AFK	321-pin CPGA	3.135V-3.6V (I/O)	0 0 - 70 0					
AMD-K6-2/366AFR	321-pin CPGA	2.1V-2.3V (Core)	0°C-70°C					
AIVID-N0-2/300AFK	SZT-PIT CPGA	3.135V-3.6V (I/O)	0 0 - 70 0					
AMD-K6-2/350AFR	321-pin CPGA	2.1V-2.3V (Core)	0°C-70°C					
AIVID-K0-2/330AFK	SZI-PIII CPGA	3.135V-3.6V (I/O)	0 0 - 70 0					
	221 pip CDCA	2.1V-2.3V (Core)	0°C-70°C					
AMD-K6-2/333AFR	321-pin CPGA	3.135V-3.6V (I/O)	0 0 - 70 0					
	221 pip CDCA	2.1V-2.3V (Core)	0°C 70°C					
AMD-K6-2/300AFR	321-pin CPGA	3.135V-3.6V (I/O)	0°C-70°C					
		2.1V-2.3V (Core)	000 7000					
AMD-K6-2/266AFR	321-pin CPGA	3.135V-3.6V (I/O)	0°C-70°C					

This table lists configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly-released combinations.

# Index

### **Numerics**

100-MHz Bus
clock switching characteristics
input setup and hold timings
output delay timings
321-Pin Staggered CPGA Package1
specification
3DNow! Technology1-3, 7, 9–10, 13–17, 21, 54, 116,
execution unit
instruction compatibility, floating-point and 209
instructions
register operation
registers
66-MHz Bus
clock switching characteristics
input setup and hold timings
output delay timings

## A

A[20:3]
A[31:3]
A20M#
A20M# Masking of Cache Accesses
Absolute Ratings
Accelerated Graphic Port (AGP)1, 3
Acknowledge, Interrupt
Address
bus 86–91, 100, 127, 148, 152, 154, 194
hold
parity
parity check
stack, return
ADS#
ADSC#
AGP1, 3
AHOLD
-initiated inquire hit to modified line
-initiated inquire hit to shared or exclusive line 150
-initiated inquire miss148
restriction
Airflow
consideration, layout and
management
Allocate, Write
AP
APCHK#
Architecture
internal
Asserted

#### В

# 

BIST 221
Bits, Predecode
Block Diagram
BOFF#
locked operation with 160
Boundary Scan
register (BSR) 225
test access port (TAP) 223
BR 231
Branch execution unit
history table
logic
prediction
prediction logic 17-18
target cache
BRDY#
BRDYC#
BREQ
BSR 225
Buffer Characteristics, I/O 263
Buffer Model, I/O
Built-In Self-Test
Burst
reads
reads, pipelined
ready
ready copy
writeback
Bus
100-MHz 1, 3
address
arbitration cycles, inquire and 142
backoff
cycles
cycles, special 164
data . 88, 91, 94, 98-99, 114, 117, 130-132, 148, 154, 158
enables 91
frequency
hold request 105
lock 110
request
state machine diagram 129
Bus States
address
data
idle
pipeline address
pipeline data
transition
BYPASS Instruction 232
Bypass Register

## С

Cache																											. 9
branch target .																											
coherency	 •	•		•	•	•	•			•	•		• •			•	•	•	•	•	•	•	•	•	•	1	94
disabling																											
enable	 •	•	 •	•	•	•	•	 •	•	•	•	•	•	 •	•	•	•	•	•	•	•	•	•	•	•	1	09

flush
inhibit, L1
L1 1, 38, 179, 190, 194, 199, 221
MESI states in the data
operation
organization
snooping
states
writeback
CACHE#
Cacheable
access
page, write to a
Cache-Line
fills
replacement
Cache-Related Signals
Capture-DR state
Capture-IR state
Case Temperature
Centralized Scheduler
Ceramic Pin Grid Array (CPGA)1, 299
Characteristics
I/O buffer
I/O Buffer AC and DC
CLK
Clock
control
Clock States
halt
stop clock167, 246–247
stop grant167, 245
stop grant inquire
Coherency States, Writethrough vs. Writeback 199
Coherency, Cache
Compatibility, Floating-Point, MMX, and 3DNow!
Instructions
Configuration and Initialization, Power-on173
Connection Requirements, Pin 251
Connections, Power
Control
Control register
Control register
Control       register       32         unit, scheduler/instruction       8         Counter, Time Stamp       38
Control register
Controlregister32unit, scheduler/instruction8Counter, Time Stamp38CPGA1, 299, 302Cycle
Control       register       32         unit, scheduler/instruction       8         Counter, Time Stamp       38         CPGA       1, 299, 302         Cycle       hold and hold acknowledge       142
Control       register
Control register32 unit, scheduler/instruction32 wnit, scheduler/instruction8Counter, Time Stamp38CPGA1, 299, 302Cycle hold and hold acknowledge142 shutdown166Cycles
Control register
Control register32 unit, scheduler/instruction32 wnit, scheduler/instruction8Counter, Time Stamp38CPGA1, 299, 302Cycle hold and hold acknowledge142 shutdown166Cycles
Control       register
Control       register
Control register
Control       register
Control register
$\begin{array}{c} \mbox{Control} & & & & & & & & & & & & & & & & & & &$
Control       register

## D

D/C#	
D[63:0]Data	98
bus88, 91, 94, 98–99, 114, 117, 130–132, 148, 154,	158
	180
parity	
Data Types	00
3DNow!	30
floating-point register	
integer	23
MMX	29
Data/Code	97
DC Characteristics	259
Debug	236
	241
Debug Registers	236
DR3-DR0	239
DR5-DR4	239
DR6	240
DR7	240
Decode, Instruction	12
Decoders	. 7
Decoupling Recommendations	250
Descriptions, Signal	
Design, Thermal	285
Designations, Pin	
Device Identification Register	230
Diagram, Pin Description	295
Diagrams, Timing.	127
DIR	230
Disabling, Cache	183
Dissipation, Power	261
DP[7:0]	99
DR3-DR0	239
DR5-DR4	239
DR6	240
DR7	240
Drive Strength, Selectable	263
Driven	83

## Ε

EADS# 100
EFER
EFLAGS Register
Electrical Data
Environment, Software 21
EWBE Control (EWBEC) 201
EWBE# 101, 201, 244
Exception 89–90, 99, 102, 114, 166, 209, 220, 240–242
flags
floating-point
handler
machine check
Exceptions
and interrupts 49
debug
floating-point 207
handling floating-point 207
interrupts, and debug in SMM 220
MMX
Execution Unit
3DNow!
branch

floating-point
load
multimedia
register X
register Y 7, 14, 16–17
store
Execution Units 1, 6–8, 15
External
address strobe 100
write buffer empty 101
EXTEST Instruction

# F

FERR#102, 208–209
Fetch, Instruction
Float Conditions
Floated
Floating-Point
and MMX/3DNow! instruction compatibility 209
and multimedia execution units
error
execution unit
handling exceptions 207
register data types
registers
FLUSH#103, 173, 195, 222, 244
Frequency 247, 268, 280
operating
Frequency Multiplier
Functional Unit
multimedia

# G

Gate Descriptor.	. 4	6, 4	9
General-Purpose Registers		2	2
Global EWBE Disable (GEWBED)		. 20	1
Grounding, Power and		. 24	9

## Η

Halt State
Handling Floating-Point Exceptions
Heat Dissipation Path
HIGHZ Instruction
History Table, Branch
Hit to
modified line
modified line, AHOLD-initiated inquire
modified line, HOLD-initiated inquire
shared or exclusive line, AHOLD-initiated inquire 150
shared or exclusive line, HOLD-initiated inquire 144
HIT#
HITM#104, 263–264
HLDA
HOLD
-initiated inquire hit to modified line146
-initiated inquire hit to shared or exclusive line 144
Hold
acknowledge
and hold acknowledge cycle142
timing

I	
I/O	
buffer AC and DC characteristics	5
buffer characteristics	
buffer model	
misaligned read and write	
read and write	
trap dword	
trap restart slot 21	
IBIS	
IDCODE Instruction	
IEEE 7541, 25, 20 IEEE 854	
IGNNE#	
Ignore Numeric Exception	
INIT	
-initiated transition from protected mode to real mode 17	
state of processor after	7
Initialization	7
power-on configuration and	3
Input Setup and Hold Timings for 100-MHz bus operation	9
66-MHz bus operation	ء 6
Inquire	
and bus arbitration cycles	2
cycle hit	)4
cycle hit to modified line 10	
cycles85–90, 100, 104–105, 118, 123, 138, 142, 144	
	Q
miss, AHOLD-initiated 14	łO
Instruction	
Instruction decode1	2
Instruction         1           decode         1           fetch         1           pointer         2	2 1 25
Instruction decode1 fetch1 pointer2 prefetch2	2 1 25
Instruction decode1 fetch1 pointer2 prefetch2 Instructions	2 1 25 9
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20	2 1 25 9
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNos!       81, 20         EMMS       1	2 1 25 9 9
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1	2 1 5 9 9 4
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19	2 9 9 4 6
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20	2 9 9 4 6 9
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19	2 9 9 4 6 9 2
Instruction       4ecode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19	2 9 9 4 6 9 2 4
Instruction       decode       1         decode       1         fetch       1         pointer       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19	2 1 5 9 9 4 9 9 2 4 9 9 2 4 1 6 9 2 4 1 6
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         instructions       3         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2	2 1 5 9 9 4 9 9 2 4 9 9 2 4 1 6 9 2 4 1 6
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         prefetch       81, 20         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       23         WBINVD       19         Integer Data Types       2         Internal       2	2 1 5 9 9 4 4 0 9 2 4 1 6 3
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         prefetch       81, 20         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture       5–1	2 1 2 5 9 9 4 9 9 9 4 9 9 9 2 4 1 9 9 2 4 1 9 9 9 2 4 1 9 9 9 2 4 1 9 9 9 2 4 1 9 9 9 2 4 1 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9
Instruction       decode       1         fetch       1         pointer.       2         prefetch       2         prefetch       81, 20         Instructions       3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture       5–1         snooping       19	$     \begin{array}{c}       2 \\       2 \\       9 \\       9 \\       9 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       9 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       9 \\       3 \\       9 \\       9 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       9 \\       4 \\       9 \\       2 \\       9 \\       4 \\       9 \\       2 \\       9 \\       9 \\       4 \\       9 \\       2 \\       4 \\       9 \\       2 \\       9 \\       9 \\       4 \\       9 \\       2 \\       9 \\       9 \\       9 \\       4 \\       9 \\       9 \\       4 \\       9 \\       9 \\       4 \\       9 \\       7 \\     $
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         prefetch       81, 20         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	211259 994406 99254 11063 994 904 904 904 7,
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177         207–209, 212, 220, 241, 24	21259 994466 9924311 9944 99254 994 9947,
Instruction       1         decode       1         fetch       1         pointer.       2         prefetch       2         instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	22 125 9 9446 9241 1623 944 1623 944 1623 16333 16333 16333 16333 16333 16333
Instruction       decode       1         fetch       1         pointer.       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	211259 9944 1259 9944 12554 125554 125554 125554 125554 125556 125556 125556 125556 125556 125556 1255666 1255666 12556666 125566666666666666666666666666666666666
Instruction       decode       1         fetch       1         pointer.       2         prefetch       2         instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       23         WBINVD       19         Internal       3         architecture       5-1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	221259 $924400$ $92543100$ $22543100$ $222111$
Instruction       1         decode       1         fetch       1         pointer.       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       3         architecture       5-1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	221259 9 9 4 4 6 9 9 2 4 4 6 9 9 2 4 4 6 9 9 2 4 4 1 6 9 9 2 4 1 1 6 2 2 1 1 1 7 , 6 2 2 2 1 1 1 7 7 , 7
Instruction       decode       1         fetch       1         pointer.       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       23         WBINVD       19         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	$2 \cdot 1 \cdot 2 \cdot $
Instruction       1         decode       1         fetch       1         pointer.       2         prefetch       2         Instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       3         architecture       5-1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	$2 \\ 1 \\ 2 \\ 2 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3$
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       23         WBINVD       19         Integer Data Types       23         WBINVD       19         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	$2 \cdot 1 \cdot 2 \cdot 2 \cdot 3 \cdot 2 \cdot 2 \cdot 2 \cdot 2 \cdot 2 \cdot 2 \cdot 2$
Instruction       1         decode       1         fetch       1         pointer       2         prefetch       2         instructions       3DNow!         3DNow!       81, 20         EMMS       1         FEMMS       1         INVD       19         MMX       77, 20         PREFETCH       10, 19         supported by the AMD-K6-2 processor       5         TAP       23         WBINVD       19         Integer Data Types       2         Internal       architecture         architecture       5–1         snooping       19         Interrupt       108, 117, 162, 166–167, 170, 177	22 + 22 + 22 + 22 + 22 + 22 + 22 + 22

type of
nterrupts
01h
03h
10h
exceptions and
INTR
IRQ13
NMI
NTR
NV
nvalidation Request 108
NVD Instruction

## Κ

# L

L1 Cache
inhibit
Limit, Write Allocate 187
Line Fills, Cache 184
LOCK#
Locked
cycles
operation with BOFF# intervention
operation, basic158
Logic
branch
branch-prediction
external support of floating-point exceptions 207

## Μ

M/IO#
Machine Check Exception
Maskable Interrupt
MCAR
MCTR
Memory
or I/O
read and write, misaligned single-transfer
read and write, single-transfer
reads and writes
type range register (MTRR) 52, 189–190, 203
MESI 1, 9, 142, 146, 180, 192, 197, 199
bit
states in the data cache
Microarchitecture
enhanced RISC86 6
overview, AMD-K6-2 processor5
Misaligned
I/O read and write141
single-transfer memory read and write
MMX Technology
exceptions
instruction compatibility, floating-point and
instruction compatibility, noating-point and
· · · · · · · · · · · · · · · · · · ·
register operation
registers
Mode, Tri-State Test
Model-Specific Registers (MSR)
MSR

MTRR	3
execution unit	9
functional unit	6

## Ν

NA#		 				 		 					112
Negated								 					. 83
Next Address	 •		•				•	 		•			112
NMI								 		1	12	2,	244
No-Connect Pins	 •							 		1	16	6,	251
Non-Maskable Interrupt								 					112
Non-Pipelined													

## 0

Operating Ranges	253,	258
Operation, Cache		181
Organization, Cache	179,	201
Output Delay Timings		
for 100-MHz bus operation		270
for 66-MHz bus operation		274
Output Signals		174

## Ρ

Package	
specifications	
thermal specifications	285
Page	
cache disable	113
directory entry (PDE) 44–45,	182
table entry (PTE) 44, 46,	182
writethrough	115
Paging	. 43
Parity	132
bit	114
check	114
error	224
flags	. 31
PCD	
РСНК#	
PFIR	
Pin	
connection requirements	251
description diagram	295
designations	
Pipeline	136
control	. 16
register X and Y	. 16
six-stage	6, 8
Pipelined9, 16, 112, 131, 136-137, 154, 179,	192
burst reads	136
cycles	, 98
design	. 15
Pointer, Instruction	. 25
Power	
and grounding	
connections	
dissipation 257,	
Power-on Configuration and Initialization	
Predecode Bits	180

Prefetching	••	••	••	•••	 	• •	•	•••		• •	•			. 10,	192
PSOR					 							50	, 53,	175-	176
PWT Instruction .	••	••	•••	•••	 		•	•••	•••		•	•••		••••	115

# R

Ranges, Operating
Ratings, Absolute
Read and Write
basic I/O
misaligned I/O141
Reads, Burst Reads and Pipelined Burst
Register
boundary scan
bypass (BR)
data Types, floating-point
debug
floating-point
general-purpose
SYSCALL/SYSRET Target Address (STAR)
Register X
execution unit
Register X and X
pipelines
Register Y
execution unit
Registers
3DNow!
descriptors and gates 46
device identification (DIR) 230
DR3-DR0
DR5-DR4
DR6
DR7
EELACC 91
EFLAGS
extended feature enable register (EFER)

## S

•	
SAMPLE/PRELOAD Instruction	232
Sampled	83
Scheduler centralized	14
instruction control unit	
SCYC	
Sector, Write to a	
descriptor 24, 46	_18
registers	24
task state	
usage	
Selectable Drive Strength	
Shift-DR stateShift-IR state	
Shutdown Cycle	166
Signal	
descriptions	83
switching characteristics	267
terminologytiming, RESET and test	
Signals	210
A[20:3]	264
A[31:3]	
A20M#	212
ADS#	264
ADSC#	87
AHOLD	244
AP	
APCHK#	
BE[7:0]# BF[2:0]	
BF[2:0]	
BRDY#	
BRDYC#	
BREQ.	
CACHE#	
cache-related	
CLK	
D/C#	
D[63:0] DP[7:0]	
EADS#	
EWBE# 101, 201,	
FERR#	
FLUSH# 103, 173, 195, 222,	
HIT#	
HITM#	
HLDA	105
HOLD	
IGNNE#	
INIT 107,	
INTR 108,	
INV	
KEN# LOCK#	
	111
	112
NMI	244
output	
PCD	
PCHK# PWT	
1 W 1	11)

RESET	4
RSVD	
sampled during RESET 173	
SCYC	
SMI# 117, 211, 244	
SMIACT#	
STPCLK#119, 24	5
TAP	3
ТСК	9
TDI	
TDO	
TMS	
TRST#	
VCC2DET	
W/R#	
WB/WT#	
SIMD	0
	9
Single Instruction Multiple Data (SIMD)2, 9	
Single-Transfer Memory Read and Write	
SMI# 117, 211, 244	
SMIACT#	
SMM	
base address	
default register values	
halt restart slot	/ 0
I/O trap restart slot	
operating mode	
revision identifier	6
state-save area	
Snoop	
Snooping	-
	0
cache	8
cache	
	4
internal	4 1
internal	4 1
internal	4 1 5
internal	4 1 5
internal	4 1 5 1, 5
internal	4 1 5 1, 5 9
internal	4 1 5 1,5 95
internal	4 5 1,5 952
internal	41 5,5 9527
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 51,5 95278
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 51,5 95278
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 <sub>1</sub> ,5 952789 7
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 I, 5 952789 74
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 742
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 742
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 J, 5 952789 7424
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 I, 5 952789 7424 9
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 1,5 952789 7424 97
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 7424 976
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 7424 9766
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 7424 97665
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 L, 5 952789 7424 976654
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 1,5 952789 7424 9766543
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 244         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 1,5 952789 7424 97665437
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41         5         952789         7424         976654378
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 54,5 952789 7424 9766543788
internal       194         Software Environment       2         Special       2         bus cycle       94, 119, 164–167, 218, 243         cycle       101, 103, 119, 126, 138, 164, 166–167, 184	41 5 1,5 952789 7424 97665437882

output delay timings for 100-MHz bus output delay timings for 66-MHz bus signal valid delay, float, setup, and hold timings	 	 	274 267
SYSCALL			
SYSCALL/SYSRET Target Address Register (STA)	R)		. 37,
	40,	50,	176
SYSRETSystem	•••		. 71
design, airflow management in a			291
management interrupt			117
management interrupt active			
management mode (SMM)	• •	• • •	211

## Т

Table, Branch History   22	18 23
TAP Controller States capture-DR	• •
capture-IR	
shift-DR	
state machine	
test-logic-reset	
update-DR	
update-IR	
TAP Instructions	
BYPASS	
EXTEST	
HIGHZ	32
IDCODE	32
SAMPLE/PRELOAD 25	
TAP Registers 22	24
instruction register (IR) 22	
TAP Signals 22	
Target Cache, Branch	
Task State Segment	
ТСК 1	
TDI	
TDO 12	
Temperature	
case	89
Terminology, Signals	83
Test	~~
access port, boundary-scan	
and debug	
clock	
data input	
-logic-reset state	
mode select	24 20
mode, tri-state	22
register 12 (TR12)	
reset	
Thermal	
design	
design	00
heat dissipation path 22	89
heat dissipation path	
layout and airflow consideration	90
layout and airflow consideration       29         measuring case temperature       21         package specifications       21	90 89 85
layout and airflow consideration	90 89 85
layout and airflow consideration       29         measuring case temperature       24         package specifications       24         Time Stamp Counter       24         Timing Diagram       24	90 89 85 38
layout and airflow consideration29measuring case temperature24package specifications24Time Stamp Counter37Timing Diagram24test signal24	90 89 85 38 84
layout and airflow consideration29measuring case temperature24package specifications24Time Stamp Counter37Timing Diagram24test signal24	90 89 85 38 84
layout and airflow consideration       29         measuring case temperature       24         package specifications       24         Time Stamp Counter       24         Timing Diagram       24	90 89 85 38 84 71
layout and airflow consideration29measuring case temperature21package specifications21Time Stamp Counter21Timing Diagram21test signal21Timing Diagrams127, 133–12	90 89 85 38 84 71 79 20

Index

21850J/0-February 2000

#### Transition from Protected Mode to Real Mode,

INIT-Initiated1	70
Translation Lookaside Buffer (TLB) 1	79
Trap Dword, I/O	18
Tri-State Test Mode 2	22
TRST# 1	21
TSC 37–38, 50, 176, 244–2	45
TSS 42, 48–49, 215, 2	40

## U

Uncacheable Memory				52,	202-203
UWCCR	50,	52,	174-176,	183-184,	203-206

## V

VCC2DET	
Voltage 121, 128, 249, 253-254,	258-259, 264, 267
ranges	
regulator	

### W

W/R#122, 263–264
WAE15M
WAELIM
WB/WT#
WBINVD Instruction
WCDE
WHCR
Write
handling control register (WHCR)
to a cacheable page
to a sector
Write Allocate 181, 186–187, 190–191
enable
enable limit
limit
logic mechanisms and conditions
Write Merge Buffer 201
Write/Read
Writeback 96, 98-99, 109, 115, 118, 123, 126, 138-139,
burst
cache
cycles 85, 87-88, 101, 104, 123, 138, 146, 150, 152,
or writethrough
Write-combining Memory
Writethrough vs. Writeback Coherency States 199

## 

AMD-K6<sup>®</sup>-2 Processor Data Sheet

21850J/0-February 2000